C8051F55x/56x/57x

Mixed Signal ISP Flash MCU Family

Analog Peripherals
- **12-Bit ADC**
  - Up to 200 ksps
  - Up to 32 external single-ended inputs
  - VREF from on-chip VREF, external pin or V_{DD}
  - Internal or external start of conversion source
  - Built-in temperature sensor
- **Two Comparators**
  - Programmable hysteresis and response time
  - Configurable as interrupt or reset source
  - Low current

On-Chip Debug
- On-chip debug circuitry facilitates full speed, non-intrusive in-system debug (no emulator required)
- Provides breakpoints, single stepping, inspect/modify memory and registers
- Superior performance to emulation systems using ICE-chips, target pods, and sockets
- Low cost, complete development kit

Supply Voltage 1.8 to 5.25 V
- Typical operating current: 19 mA at 50 MHz
- Typical stop mode current: 1 µA

High-Speed 8051 µC Core
- Pipelined instruction architecture; executes 70% of instructions in 1 or 2 system clocks
- Up to 50 MIPS throughput with 50 MHz clock
- Expanded interrupt handler

Memory
- 2304 bytes internal data RAM (256 + 2048 XRAM)
- 32 or 16 kB Flash; In-system programmable in 512-byte Sectors

Digital Peripherals
- 33, 25, or 18 Port I/O; All 5 V tolerant
- CAN 2.0 Controller—no crystal required
- LIN 2.1 Controller (Master and Slave capable); no crystal required
- Hardware enhanced UART, SMBus™, and enhanced SPI™ serial ports
- Four general purpose 16-bit counter/timers
- 16-bit programmable counter array (PCA) with six capture/compare modules and enhanced PWM functionality

Clock Sources
- Internal 24 MHz with ±0.5% accuracy for CAN and master LIN operation
- External oscillator: Crystal, RC, C, or clock (1 or 2 pin modes)
- Can switch between clock sources on-the-fly; useful in power saving modes

Packages
- 40-pin QFN (C8051F568-9 and ‘F570-5)
- 32-pin QFP/QFN (C8051F560-7)
- 24-pin QFN (C8051F550-7)

Automotive Qualified
- Temperature Range: –40 to +125 °C
- Compliant to AEC-Q100

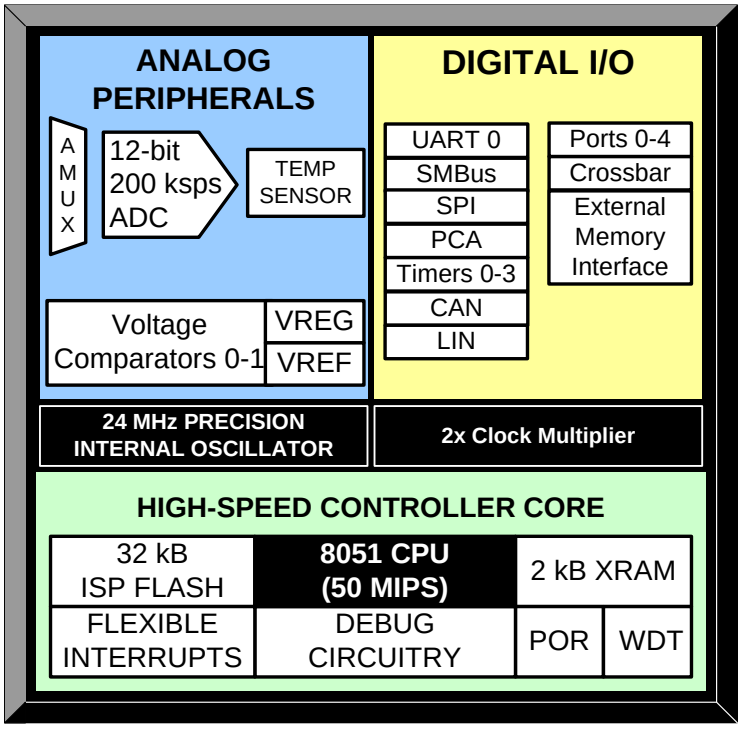

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Table of Contents

1. System Overview 16
2. Ordering Information 20
3. Pin Definitions 22
4. Package Specifications 28
4.1. QFN-40 Package Specifications 28
4.2. QFP-32 Package Specifications 30
4.3. QFN-32 Package Specifications 32
4.4. QFN-24 Package Specifications 34
5. Electrical Characteristics 36
5.1. Absolute Maximum Specifications 36
5.2. Electrical Characteristics 37
6. 12-Bit ADC (ADC0) 47
6.1. Modes of Operation 48
6.1.1. Starting a Conversion 48
6.1.2. Tracking Modes 48
6.1.3. Timing 49
6.1.4. Burst Mode 50
6.2. Output Code Formatting 52
6.2.1. Settling Time Requirements 52
6.3. Selectable Gain 53
6.3.1. Calculating the Gain Value 53
6.3.2. Setting the Gain Value 55
6.4. Programmable Window Detector 61
6.4.1. Window Detector In Single-Ended Mode 63
6.5. ADC0 Analog Multiplexer 65
6.6. Temperature Sensor 67
7. Voltage Reference 68
8. Comparators 70
8.1. Comparator Multiplexer 76
9. Voltage Regulator (REG0) 79
10. CIP-51 Microcontroller 81
10.1. Performance 81
10.2. Instruction Set 83
10.2.1. Instruction and CPU Timing 83
10.3. CIP-51 Register Descriptions 87
10.4. Serial Number Special Function Registers (SFRs) 91
11. Memory Organization 92
11.1. Program Memory 92
11.1.1. MOVX Instruction and Program Memory 93
11.2. Data Memory 93
11.2.1. Internal RAM 93
12. Special Function Registers 95
12.1. SFR Paging 95

12.2. Interrupts and SFR Paging 95
12.3. SFR Page Stack Example 97
13. Interrupts 112
13.1. MCU Interrupt Sources and Vectors 112
13.1.1. Interrupt Priorities 113
13.1.2. Interrupt Latency 113
13.2. Interrupt Register Descriptions 115
13.3. External Interrupts INT0 and INT1 122
14. Flash Memory 124
14.1. Programming The Flash Memory 124
14.1.1. Flash Lock and Key Functions 124
14.1.2. Flash Erase Procedure 125
14.1.3. Flash Write Procedure 125
14.1.4. Flash Write Optimization 126
14.2. Non-volatile Data Storage 127
14.3. Security Options 127
14.4. Flash Write and Erase Guidelines 129
14.4.1. V_{DD} Maintenance and the V_{DD} monitor 129
14.4.2. PSWE Maintenance 130
14.4.3. System Clock 130
15. Power Management Modes 135
15.1. Idle Mode 135
15.2. Stop Mode 136
15.3. Suspend Mode 136
16. Reset Sources 138
16.1. Power-On Reset 139
16.2. Power-Fail Reset/VDD Monitor 139
16.3. External Reset 141
16.4. Missing Clock Detector Reset 141
16.5. Comparator0 Reset 142
16.6. PCA Watchdog Timer Reset 142
16.7. Flash Error Reset 142
16.8. Software Reset 142
17. External Data Memory Interface and On-Chip XRAM 144
17.1. Accessing XRAM 144
17.1.1. 16-Bit MOVX Example 144
17.1.2. 8-Bit MOVX Example 144
17.2. Configuring the External Memory Interface 145
17.3. Port Configuration 145
17.4. Multiplexed Mode 149
17.5. Memory Mode Selection 150
17.5.1. Internal XRAM Only 150
17.5.2. Split Mode without Bank Select 150
17.5.3. Split Mode with Bank Select 151
17.5.4. External Only 151

17.6. Timing 151
17.6.1. Multiplexed Mode 153
18. Oscillators and Clock Selection 157
18.1. System Clock Selection 157
18.2. Programmable Internal Oscillator 159
18.2.1. Internal Oscillator Suspend Mode 159
18.3. Clock Multiplier 162
18.4. External Oscillator Drive Circuit 164
18.4.1. External Crystal Example 166
18.4.2. External RC Example 167
18.4.3. External Capacitor Example 167
19. Port Input/Output 169
19.1. Port I/O Modes of Operation 170
19.1.1. Port Pins Configured for Analog I/O 170
19.1.2. Port Pins Configured For Digital I/O 170
19.1.3. Interfacing Port I/O in a Multi-Voltage System 171
19.2. Assigning Port I/O Pins to Analog and Digital Functions 171
19.2.1. Assigning Port I/O Pins to Analog Functions 171
19.2.2. Assigning Port I/O Pins to Digital Functions 171
19.2.3. Assigning Port I/O Pins to External Digital Event Capture Functions 172
19.3. Priority Crossbar Decoder 172
19.4. Port I/O Initialization 174
19.5. Port Match 179
19.6. Special Function Registers for Accessing and Configuring Port I/O 183
20. Local Interconnect Network (LIN0) 193
20.1. Software Interface with the LIN Controller 194
20.2. LIN Interface Setup and Operation 194
20.2.1. Mode Definition 194
20.2.2. Baud Rate Options: Manual or Autobaud 194
20.2.3. Baud Rate Calculations: Manual Mode 194
20.2.4. Baud Rate Calculations—Automatic Mode 196
20.3. LIN Master Mode Operation 197
20.4. LIN Slave Mode Operation 198
20.5. Sleep Mode and Wake-Up 199
20.6. Error Detection and Handling 199
20.7. LIN Registers 200
20.7.1. LIN Direct Access SFR Registers Definitions 200
20.7.2. LIN Indirect Access SFR Registers Definitions 202
21. Controller Area Network (CAN0) 210
21.1. Bosch CAN Controller Operation 211
21.1.1. CAN Controller Timing 211
21.1.2. CAN Register Access 212
21.1.3. Example Timing Calculation for 1 Mbit/Sec Communication 212
21.2. CAN Registers 214
21.2.1. CAN Controller Protocol Registers 214

21.2.2. Message Object Interface Registers 214
21.2.3. Message Handler Registers 214
21.2.4. CAN Register Assignment 215
22. SMBus 218
22.1. Supporting Documents 219
22.2. SMBus Configuration 219
22.3. SMBus Operation 219
22.3.1. Transmitter Vs. Receiver 220
22.3.2. Arbitration 220
22.3.3. Clock Low Extension 220
22.3.4. SCL Low Timeout 220
22.3.5. SCL High (SMBus Free) Timeout 221
22.4. Using the SMBus 221
22.4.1. SMBus Configuration Register 221
22.4.2. SMB0CN Control Register 225
22.4.3. Data Register 228
22.5. SMBus Transfer Modes 228
22.5.1. Write Sequence (Master) 229
22.5.2. Read Sequence (Master) 230
22.5.3. Write Sequence (Slave) 231
22.5.4. Read Sequence (Slave) 232
22.6. SMBus Status Decoding 232
23. UART0 235
23.1. Baud Rate Generator 235
23.2. Data Format 237
23.3. Configuration and Operation 238
23.3.1. Data Transmission 238
23.3.2. Data Reception 238
23.3.3. Multiprocessor Communications 240
24. Enhanced Serial Peripheral Interface (SPI0) 246
24.1. Signal Descriptions 247
24.1.1. Master Out, Slave In (MOSI) 247
24.1.2. Master In, Slave Out (MISO) 247
24.1.3. Serial Clock (SCK) 247
24.1.4. Slave Select (NSS) 247
24.2. SPI0 Master Mode Operation 248
24.3. SPI0 Slave Mode Operation 250
24.4. SPI0 Interrupt Sources 250
24.5. Serial Clock Phase and Polarity 251
24.6. SPI Special Function Registers 252
25. Timers 259
25.1. Timer 0 and Timer 1 261
25.1.1. Mode 0: 13-bit Counter/Timer 261
25.1.2. Mode 1: 16-bit Counter/Timer 262
25.1.3. Mode 2: 8-bit Counter/Timer with Auto-Reload 262

25.1.4. Mode 3: Two 8-bit Counter/Timers (Timer 0 Only) 263
25.2. Timer 2 269
25.2.1. 16-bit Timer with Auto-Reload 269
25.2.2. 8-bit Timers with Auto-Reload 269
25.2.3. External Oscillator Capture Mode 270
25.3. Timer 3 275
25.3.1. 16-Bit Timer with Auto-Reload 275
25.3.2. 8-Bit Timers with Auto-Reload 275
25.3.3. External Oscillator Capture Mode 276
26. Programmable Counter Array 281
26.1. PCA Counter/Timer 282
26.2. PCA0 Interrupt Sources 283
26.3. Capture/Compare Modules 283
26.3.1. Edge-triggered Capture Mode 284
26.3.2. Software Timer (Compare) Mode 285
26.3.3. High-Speed Output Mode 286
26.3.4. Frequency Output Mode 287
26.3.5. 8-bit, 9-bit, 10-bit and 11-bit Pulse Width Modulator Modes 288
26.3.6. 16-Bit Pulse Width Modulator Mode 290
26.4. Watchdog Timer Mode 291
26.4.1. Watchdog Timer Operation 291
26.4.2. Watchdog Timer Usage 292
26.5. Register Descriptions for PCA0 294
27. C2 Interface 300
27.1. C2 Interface Registers 300
27.2. C2 Pin Sharing 303

List of Figures

Figure 1.1. C8051F568-9 and ‘F570-5 (40-pin) Block Diagram 17
Figure 1.2. C8051F560-7 (32-pin) Block Diagram 18
Figure 1.3. C8051F550-7 (24-pin) Block Diagram 19
Figure 3.1. QFN-40 Pinout Diagram (Top View) 24
Figure 3.2. QFP-32 Pinout Diagram (Top View) 25
Figure 3.3. QFN-32 Pinout Diagram (Top View) 26
Figure 3.4. QFN-24 Pinout Diagram (Top View) 27
Figure 4.1. QFN-40 Package Drawing 28
Figure 4.2. QFN-40 Landing Diagram 29
Figure 4.3. QFP-32 Package Drawing 30
Figure 4.4. QFP-32 Landing Diagram 31
Figure 4.5. QFN-32 Package Drawing 32
Figure 4.6. QFN-32 Landing Diagram 33
Figure 4.7. QFN-24 Package Drawing 34
Figure 4.8. QFN-24 Landing Diagram 35
Figure 5.1. Minimum VDD Monitor Threshold vs. System Clock Frequency 39
Figure 6.1. ADC0 Functional Block Diagram 47
Figure 6.2. ADC0 Tracking Modes 49
Figure 6.3. 12-Bit ADC Tracking Mode Example 50
Figure 6.4. 12-Bit ADC Burst Mode Example With Repeat Count Set to 4 51
Figure 6.5. ADC0 Equivalent Input Circuit 53
Figure 6.6. ADC Window Compare Example: Right-Justified Data 64
Figure 6.7. ADC Window Compare Example: Left-Justified Data 64
Figure 6.8. ADC0 Multiplexer Block Diagram 65
Figure 6.9. Temperature Sensor Transfer Function 67
Figure 7.1. Voltage Reference Functional Block Diagram 68
Figure 8.1. Comparator Functional Block Diagram 70
Figure 8.2. Comparator Hysteresis Plot 71
Figure 8.3. Comparator Input Multiplexer Block Diagram 76
Figure 9.1. External Capacitors for Voltage Regulator Input/Output—Regulator Enabled 79
Figure 9.2. External Capacitors for Voltage Regulator Input/Output—Regulator Disabled 80
Figure 10.1. CIP-51 Block Diagram 82
Figure 11.1. C8051F55x/56x/57x Memory Map 92
Figure 11.2. Flash Program Memory Map 93
Figure 12.1. SFR Page Stack 96
Figure 12.2. SFR Page Stack While Using SFR Page 0x0 To Access SPI0DAT 97
Figure 12.3. SFR Page Stack After CAN0 Interrupt Occurs 98
Figure 12.4. SFR Page Stack Upon PCA Interrupt Occurring During a CAN0 ISR 99
Figure 12.5. SFR Page Stack Upon Return From PCA Interrupt 100
Figure 12.6. SFR Page Stack Upon Return From CAN0 Interrupt 101
Figure 14.1. Flash Program Memory Map 127

Figure 16.1. Reset Sources 138
Figure 16.2. Power-On and VDD Monitor Reset Timing 139
Figure 17.1. Multiplexed Configuration Example 149
Figure 17.2. EMIF Operating Modes 150
Figure 17.3. Multiplexed 16-bit MOVX Timing 153
Figure 17.4. Multiplexed 8-bit MOVX without Bank Select Timing 154
Figure 17.5. Multiplexed 8-bit MOVX with Bank Select Timing 155
Figure 18.1. Oscillator Options 157
Figure 18.2. Example Clock Multiplier Output 162
Figure 18.3. External 32.768 kHz Quartz Crystal Oscillator Connection Diagram 167
Figure 19.1. Port I/O Functional Block Diagram 169
Figure 19.2. Port I/O Cell Block Diagram 170
Figure 19.3. Peripheral Availability on Port I/O Pins 173
Figure 19.4. Crossbar Priority Decoder in Example Configuration 174
Figure 20.1. LIN Block Diagram 193
Figure 21.1. Typical CAN Bus Configuration 210
Figure 21.2. CAN Controller Diagram 211
Figure 21.3. Four segments of a CAN Bit 213
Figure 22.1. SMBus Block Diagram 218
Figure 22.2. Typical SMBus Configuration 219
Figure 22.3. SMBus Transaction 220
Figure 22.4. Typical SMBus SCL Generation 222
Figure 22.5. Typical Master Write Sequence 229
Figure 22.6. Typical Master Read Sequence 230
Figure 22.7. Typical Slave Write Sequence 231
Figure 22.8. Typical Slave Read Sequence 232
Figure 23.1. UART0 Block Diagram 235
Figure 23.2. UART0 Timing Without Parity or Extra Bit 237
Figure 23.3. UART0 Timing With Parity 237
Figure 23.4. UART0 Timing With Extra Bit 237
Figure 23.5. Typical UART Interconnect Diagram 238
Figure 23.6. UART Multi-Processor Mode Interconnect Diagram 240
Figure 24.1. SPI Block Diagram 246
Figure 24.2. Multiple-Master Mode Connection Diagram 249
Figure 24.3. 3-Wire Single Master and 3-Wire Single Slave Mode Connection Diagram 249
Figure 24.4. 4-Wire Single Master Mode and 4-Wire Slave Mode Connection Diagram 249
Figure 24.5. Master Mode Data/Clock Timing 251
Figure 24.6. Slave Mode Data/Clock Timing (CKPHA = 0) 252
Figure 24.7. Slave Mode Data/Clock Timing (CKPHA = 1) 252
Figure 24.8. SPI Master Timing (CKPHA = 0) 256
Figure 24.9. SPI Master Timing (CKPHA = 1) 256
Figure 24.10. SPI Slave Timing (CKPHA = 0) 257
Figure 24.11. SPI Slave Timing (CKPHA = 1) 257

Figure 25.1. T0 Mode 0 Block Diagram 262
Figure 25.2. T0 Mode 2 Block Diagram 263
Figure 25.3. T0 Mode 3 Block Diagram 264
Figure 25.4. Timer 2 16-Bit Mode Block Diagram 269
Figure 25.5. Timer 2 8-Bit Mode Block Diagram 270
Figure 25.6. Timer 2 External Oscillator Capture Mode Block Diagram 271
Figure 25.7. Timer 3 16-Bit Mode Block Diagram 275
Figure 25.8. Timer 3 8-Bit Mode Block Diagram 276
Figure 25.9. Timer 3 External Oscillator Capture Mode Block Diagram 277
Figure 26.1. PCA Block Diagram 281
Figure 26.2. PCA Counter/Timer Block Diagram 282
Figure 26.3. PCA Interrupt Block Diagram 283
Figure 26.4. PCA Capture Mode Diagram 285
Figure 26.5. PCA Software Timer Mode Diagram 286
Figure 26.6. PCA High-Speed Output Mode Diagram 287
Figure 26.7. PCA Frequency Output Mode 288
Figure 26.8. PCA 8-Bit PWM Mode Diagram 289
Figure 26.9. PCA 9, 10 and 11-Bit PWM Mode Diagram 290
Figure 26.10. PCA 16-Bit PWM Mode 291
Figure 26.11. PCA Module 2 with Watchdog Timer Enabled 292
Figure 27.1. Typical C2 Pin Sharing 303

List of Tables

Table 2.1. Product Selection Guide 21
Table 3.1. Pin Definitions for the C8051F55x/56x/57x 22
Table 4.1. QFN-40 Package Dimensions 28
Table 4.2. QFN-40 Landing Diagram Dimensions 29
Table 4.3. QFP-32 Package Dimensions 30
Table 4.4. QFP-32 Landing Diagram Dimensions 31
Table 4.5. QFN-32 Package Dimensions 32
Table 4.6. QFN-32 Landing Diagram Dimensions 33
Table 4.7. QFN-24 Package Dimensions 34
Table 4.8. QFN-24 Landing Diagram Dimensions 35
Table 5.1. Absolute Maximum Ratings 36
Table 5.2. Global Electrical Characteristics 37
Table 5.3. Port I/O DC Electrical Characteristics 40
Table 5.4. Reset Electrical Characteristics 41
Table 5.5. Flash Electrical Characteristics 41
Table 5.6. Internal High-Frequency Oscillator Electrical Characteristics 42
Table 5.7. Clock Multiplier Electrical Specifications 43
Table 5.8. Voltage Regulator Electrical Characteristics 43
Table 5.9. ADC0 Electrical Characteristics 44
Table 5.10. Temperature Sensor Electrical Characteristics 45
Table 5.11. Voltage Reference Electrical Characteristics 45
Table 5.12. Comparator 0 and Comparator 1 Electrical Characteristics 46
Table 10.1. CIP-51 Instruction Set Summary 84
Table 12.1. Special Function Register (SFR) Memory Map for Pages 0x00 and 0x0F 106
Table 12.2. Special Function Register (SFR) Memory Map for Page 0x0C 107
Table 12.3. Special Function Registers 108
Table 13.1. Interrupt Summary 114
Table 14.1. Flash Security Summary 128
Table 17.1. EMIF Pinout (C8051F568-9 and ‘F570-5) 146
Table 17.2. AC Parameters for External Memory Interface 156
Table 19.1. Port I/O Assignment for Analog Functions 171
Table 19.2. Port I/O Assignment for Digital Functions 172
Table 19.3. Port I/O Assignment for External Digital Event Capture Functions 172
Table 20.1. Baud Rate Calculation Variable Ranges 194
Table 20.2. Manual Baud Rate Parameters Examples 196
Table 20.3. Autobaud Parameters Examples 197
Table 20.4. LIN Registers* (Indirectly Addressable) 202
Table 21.1. Background System Information 212
Table 21.2. Standard CAN Registers and Reset Values 215
Table 22.1. SMBus Clock Source Selection 222
Table 22.2. Minimum SDA Setup and Hold Times 223

Table 22.3. Sources for Hardware Changes to SMB0CN 227
Table 22.4. SMBus Status Decoding 233
Table 23.1. Baud Rate Generator Settings for Standard Baud Rates 236
Table 24.1. SPI Slave Timing Parameters 258
Table 26.1. PCA Timebase Input Options 282
Table 26.2. PCA0CPM and PCA0PWM Bit Settings for PCA Capture/Compare Modules 284
Table 26.3. Watchdog Timer Timeout Intervals1 293

List of Registers

SFR Definition 6.4. ADC0CF: ADC0 Configuration 58
SFR Definition 6.5. ADC0H: ADC0 Data Word MSB 59
SFR Definition 6.6. ADC0L: ADC0 Data Word LSB 59
SFR Definition 6.7. ADC0CN: ADC0 Control 60
SFR Definition 6.8. ADC0TK: ADC0 Tracking Mode Select 61
SFR Definition 6.9. ADC0GTH: ADC0 Greater-Than Data High Byte 62
SFR Definition 6.10. ADC0GTL: ADC0 Greater-Than Data Low Byte 62
SFR Definition 6.11. ADC0LTH: ADC0 Less-Than Data High Byte 63
SFR Definition 6.12. ADC0LTL: ADC0 Less-Than Data Low Byte 63
SFR Definition 6.13. ADC0MX: ADC0 Channel Select 66
SFR Definition 7.1. REF0CN: Reference Control 69
SFR Definition 8.1. CPT0CN: Comparator0 Control 72
SFR Definition 8.2. CPT0MD: Comparator0 Mode Selection 73
SFR Definition 8.3. CPT1CN: Comparator1 Control 74
SFR Definition 8.4. CPT1MD: Comparator1 Mode Selection 75
SFR Definition 8.5. CPT0MX: Comparator0 MUX Selection 77
SFR Definition 8.6. CPT1MX: Comparator1 MUX Selection 78
SFR Definition 9.1. REG0CN: Regulator Control 80
SFR Definition 10.1. DPL: Data Pointer Low Byte 88
SFR Definition 10.2. DPH: Data Pointer High Byte 88
SFR Definition 10.3. SP: Stack Pointer 89
SFR Definition 10.4. ACC: Accumulator 89
SFR Definition 10.5. B: B Register 89
SFR Definition 10.6. PSW: Program Status Word 90
SFR Definition 10.7. SNn: Serial Number n 91
SFR Definition 12.1. SFR0CN: SFR Page Control 102
SFR Definition 12.2. SFRPAGE: SFR Page 103
SFR Definition 12.3. SFRNEXT: SFR Next 104
SFR Definition 12.4. SFRLAST: SFR Last 105
SFR Definition 13.1. IE: Interrupt Enable 116
SFR Definition 13.2. IP: Interrupt Priority 117
SFR Definition 13.3. EIE1: Extended Interrupt Enable 1 118
SFR Definition 13.4. EIP1: Extended Interrupt Priority 1 119
SFR Definition 13.5. EIE2: Extended Interrupt Enable 2 120
SFR Definition 13.6. EIP2: Extended Interrupt Priority Enabled 2 121
SFR Definition 13.7. IT01CF: INT0/INT1 Configuration 123
SFR Definition 14.1. PSCTL: Program Store R/W Control 131
SFR Definition 14.2. FLKEY: Flash Lock and Key 132
SFR Definition 14.3. FLSCL: Flash Scale 133
SFR Definition 14.4. CCH0CN: Cache Control 134
SFR Definition 14.5. ONESHOT: Flash Oneshot Period 134
SFR Definition 15.1. PCON: Power Control 137
SFR Definition 16.1. VDM0CN: VDD Monitor Control 141

SFR Definition 16.2. RSTSRC: Reset Source 143
SFR Definition 17.1. EMI0CN: External Memory Interface Control 147
SFR Definition 17.2. EMI0CF: External Memory Configuration 148
SFR Definition 17.3. EMI0TC: External Memory Timing Control 152
SFR Definition 18.1. CLKSEL: Clock Select 158
SFR Definition 18.2. OSCICN: Internal Oscillator Control 160
SFR Definition 18.3. OSCICRS: Internal Oscillator Coarse Calibration 161
SFR Definition 18.4. OSCIFIN: Internal Oscillator Fine Calibration 161
SFR Definition 18.5. CLKMUL: Clock Multiplier 163
SFR Definition 18.6. OSCXCN: External Oscillator Control 165
SFR Definition 19.1. XBR0: Port I/O Crossbar Register 0 176
SFR Definition 19.2. XBR1: Port I/O Crossbar Register 1 177
SFR Definition 19.3. XBR2: Port I/O Crossbar Register 1 178
SFR Definition 19.4. P0MASK: Port 0 Mask Register 179
SFR Definition 19.5. P0MAT: Port 0 Match Register 179
SFR Definition 19.6. P1MASK: Port 1 Mask Register 180
SFR Definition 19.7. P1MAT: Port 1 Match Register 180
SFR Definition 19.8. P2MASK: Port 2 Mask Register 181
SFR Definition 19.9. P2MAT: Port 2 Match Register 181
SFR Definition 19.10. P3MASK: Port 3 Mask Register 182
SFR Definition 19.11. P3MAT: Port 3 Match Register 182
SFR Definition 19.12. P0: Port 0 183
SFR Definition 19.13. P0MDIN: Port 0 Input Mode 184
SFR Definition 19.14. P0MDOUT: Port 0 Output Mode 184
SFR Definition 19.15. P0SKIP: Port 0 Skip 185
SFR Definition 19.16. P1: Port 1 185
SFR Definition 19.17. P1MDIN: Port 1 Input Mode 186
SFR Definition 19.18. P1MDOUT: Port 1 Output Mode 186
SFR Definition 19.19. P1SKIP: Port 1 Skip 187
SFR Definition 19.20. P2: Port 2 187
SFR Definition 19.21. P2MDIN: Port 2 Input Mode 188
SFR Definition 19.22. P2MDOUT: Port 2 Output Mode 188
SFR Definition 19.23. P2SKIP: Port 2 Skip 189
SFR Definition 19.24. P3: Port 3 189
SFR Definition 19.25. P3MDIN: Port 3 Input Mode 190
SFR Definition 19.26. P3MDOUT: Port 3 Output Mode 190
SFR Definition 19.27. P3SKIP: Port 3Skip 191
SFR Definition 19.28. P4: Port 4 191
SFR Definition 19.29. P4MDOUT: Port 4 Output Mode 192
SFR Definition 20.1. LIN0ADR: LIN0 Indirect Address Register 200
SFR Definition 20.2. LIN0DAT: LIN0 Indirect Data Register 200
SFR Definition 20.3. LIN0CF: LIN0 Control Mode Register 201
SFR Definition 21.1. CAN0CFG: CAN Clock Configuration 217
SFR Definition 22.1. SMB0CF: SMBus Clock/Configuration 224
SFR Definition 22.2. SMB0CN: SMBus Control 226

SFR Definition 22.3. SMB0DAT: SMBus Data 228
SFR Definition 23.1. SCON0: Serial Port 0 Control 241
SFR Definition 23.2. SMOD0: Serial Port 0 Control 243
SFR Definition 23.3. SBUF0: Serial (UART0) Port Data Buffer 244
SFR Definition 23.4. SBCON0: UART0 Baud Rate Generator Control 244
SFR Definition 23.6. SBRLL0: UART0 Baud Rate Generator Reload Low Byte 245
SFR Definition 23.5. SBRLH0: UART0 Baud Rate Generator Reload High Byte 245
SFR Definition 24.1. SPI0CFG: SPI0 Configuration 253
SFR Definition 24.2. SPI0CN: SPI0 Control 254
SFR Definition 24.3. SPI0CKR: SPI0 Clock Rate 255
SFR Definition 24.4. SPI0DAT: SPI0 Data 255
SFR Definition 25.1. CKCON: Clock Control 260
SFR Definition 25.2. TCON: Timer Control 265
SFR Definition 25.3. TMOD: Timer Mode 266
SFR Definition 25.4. TL0: Timer 0 Low Byte 267
SFR Definition 25.5. TL1: Timer 1 Low Byte 267
SFR Definition 25.6. TH0: Timer 0 High Byte 268
SFR Definition 25.7. TH1: Timer 1 High Byte 268
SFR Definition 25.8. TMR2CN: Timer 2 Control 272
SFR Definition 25.9. TMR2RLL: Timer 2 Reload Register Low Byte 273
SFR Definition 25.10. TMR2RLH: Timer 2 Reload Register High Byte 273
SFR Definition 25.11. TMR2L: Timer 2 Low Byte 274
SFR Definition 25.12. TMR2H Timer 2 High Byte 274
SFR Definition 25.13. TMR3CN: Timer 3 Control 278
SFR Definition 25.14. TMR3RLL: Timer 3 Reload Register Low Byte 279
SFR Definition 25.15. TMR3RLH: Timer 3 Reload Register High Byte 279
SFR Definition 25.16. TMR3L: Timer 3 Low Byte 280
SFR Definition 25.17. TMR3H Timer 3 High Byte 280
SFR Definition 26.1. PCA0CN: PCA Control 294
SFR Definition 26.2. PCA0MD: PCA Mode 295
SFR Definition 26.3. PCA0PWM: PCA PWM Configuration 296
SFR Definition 26.4. PCA0CPMn: PCA Capture/Compare Mode 297
SFR Definition 26.5. PCA0L: PCA Counter/Timer Low Byte 298
SFR Definition 26.6. PCA0H: PCA Counter/Timer High Byte 298
SFR Definition 26.7. PCA0CPLn: PCA Capture Module Low Byte 299
SFR Definition 26.8. PCA0CPHn: PCA Capture Module High Byte 299

1. System Overview

C8051F55x/56x/57x devices are fully integrated mixed-signal System-on-a-Chip MCUs. Highlighted features are listed below. Refer to Table 2.1 for specific product feature selection and part ordering numbers.

- High-speed pipelined 8051-compatible microcontroller core (up to 50 MIPS)
- In-system, full-speed, non-intrusive debug interface (on-chip)
- Controller Area Network (CAN 2.0B) Controller with 32 message objects, each with its own indentifier mask (C8051F550/1/4/5, ‘F560/1/4/5/8/9, and ‘F572/3)
- LIN 2.1 peripheral (fully backwards compatible, master and slave modes) (C8051F550/2/4/6, ‘F560/2/4/6/8, and ‘F570/2/4)
- True 12-bit 200 ksps 32-channel single-ended ADC with analog multiplexer
- Precision programmable 24 MHz internal oscillator that is within ±0.5% across the temperature range and for VDD voltages greater than or equal to the on-chip voltage regulator minimum output at the low setting. The oscillator is within ±1.0% for VDD voltages below this minimum output setting.
- On-chip Clock Multiplier to reach up to 50 MHz
- 32 kB (C8051F550-3, ‘F560-3, ‘F568-9, and ‘F570-1) or 16 kB (C8051F554-7, ‘F564-7, and ‘F572-5) of on-chip Flash memory
- 2304 bytes of on-chip RAM
- SMBus/I2C, Enhanced UART, and Enhanced SPI serial interfaces implemented in hardware
- Four general-purpose 16-bit timers
- External Data Memory Interface (C8051F568-9 and ‘F570-5) with 64 kB address space
- Programmable Counter/Timer Array (PCA) with six capture/compare modules and Watchdog Timer function
- On-chip Voltage Regulator
- On-chip Power-On Reset, V_{DD} Monitor, and Temperature Sensor
- On-chip Voltage Comparator
- 33, 25, or 18 Port I/O (5 V push-pull)

With on-chip Voltage Regulator, Power-On Reset, V_{DD} monitor, Watchdog Timer, and clock oscillator, the C8051F55x/56x/57x devices are truly stand-alone System-on-a-Chip solutions. The Flash memory can be reprogrammed even in-circuit, providing non-volatile data storage, and also allowing field upgrades of the 8051 firmware. User software has complete control of all peripherals, and may individually shut down any or all peripherals for power savings.

The on-chip Silicon Labs 2-Wire (C2) Development Interface allows non-intrusive (uses no on-chip resources), full speed, in-circuit debugging using the production MCU installed in the final application. This debug logic supports inspection and modification of memory and registers, setting breakpoints, single stepping, run and halt commands. All analog and digital peripherals are fully functional while debugging using C2. The two C2 interface pins can be shared with user functions, allowing in-system debugging without occupying package pins.

The devices are specified for 1.8 V to 5.25 V operation over the automotive temperature range (–40 to +125 °C). The C8051F568-9 and ‘F570-5 are available in 40-pin QFN packages, the C8051F560-7 devices are available in 32-pin QFP and QFN packages, and the C8051F550-7 are available in 24-pin QFN packages. All package options are lead-free and RoHS compliant. See Table 2.1 for ordering information. Block diagrams are included in Figure 1.1, Figure 1.2, and Figure 1.3.

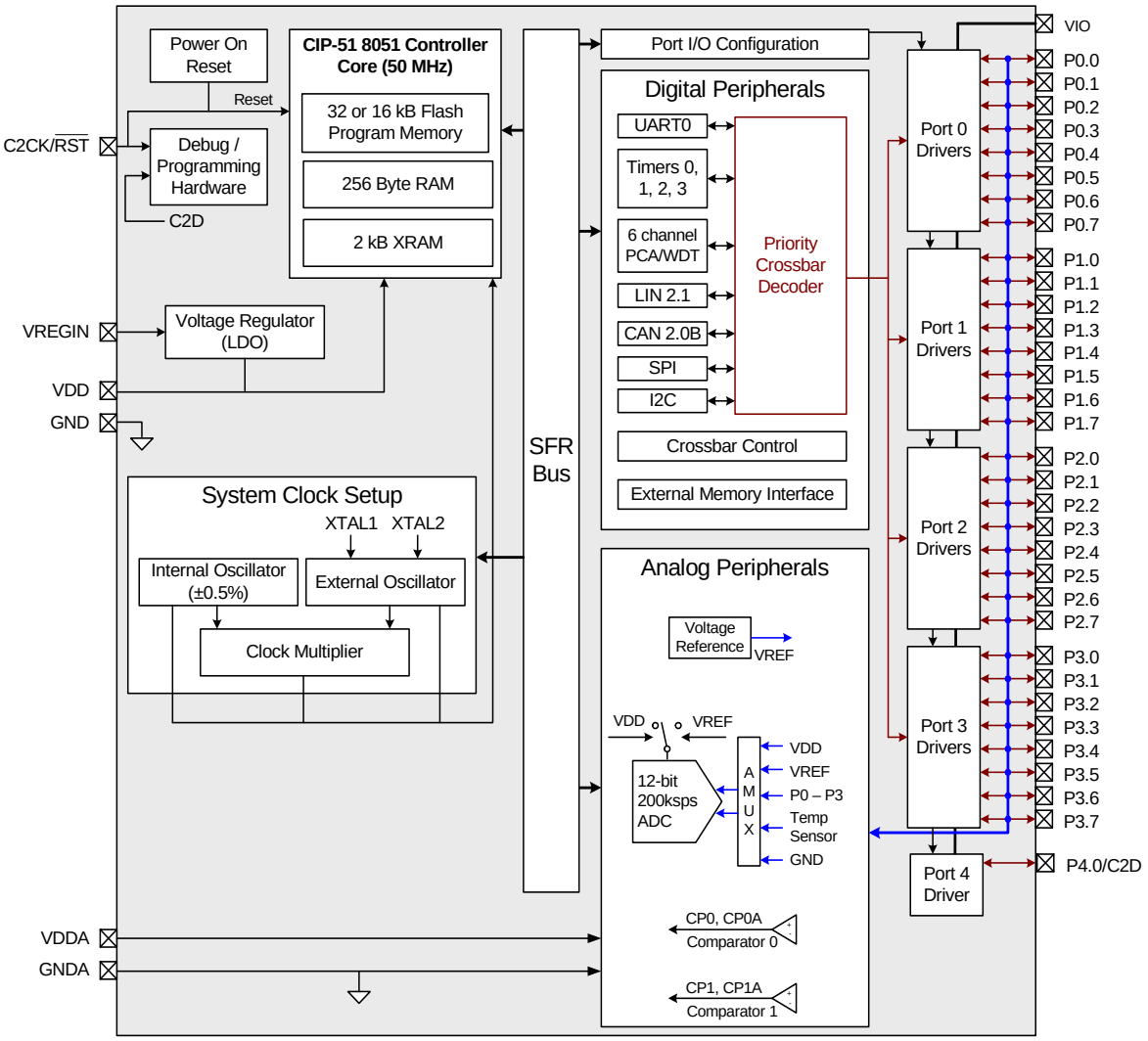


Figure 1.1. C8051F568-9 and 'F570-5 (40-pin) Block Diagram

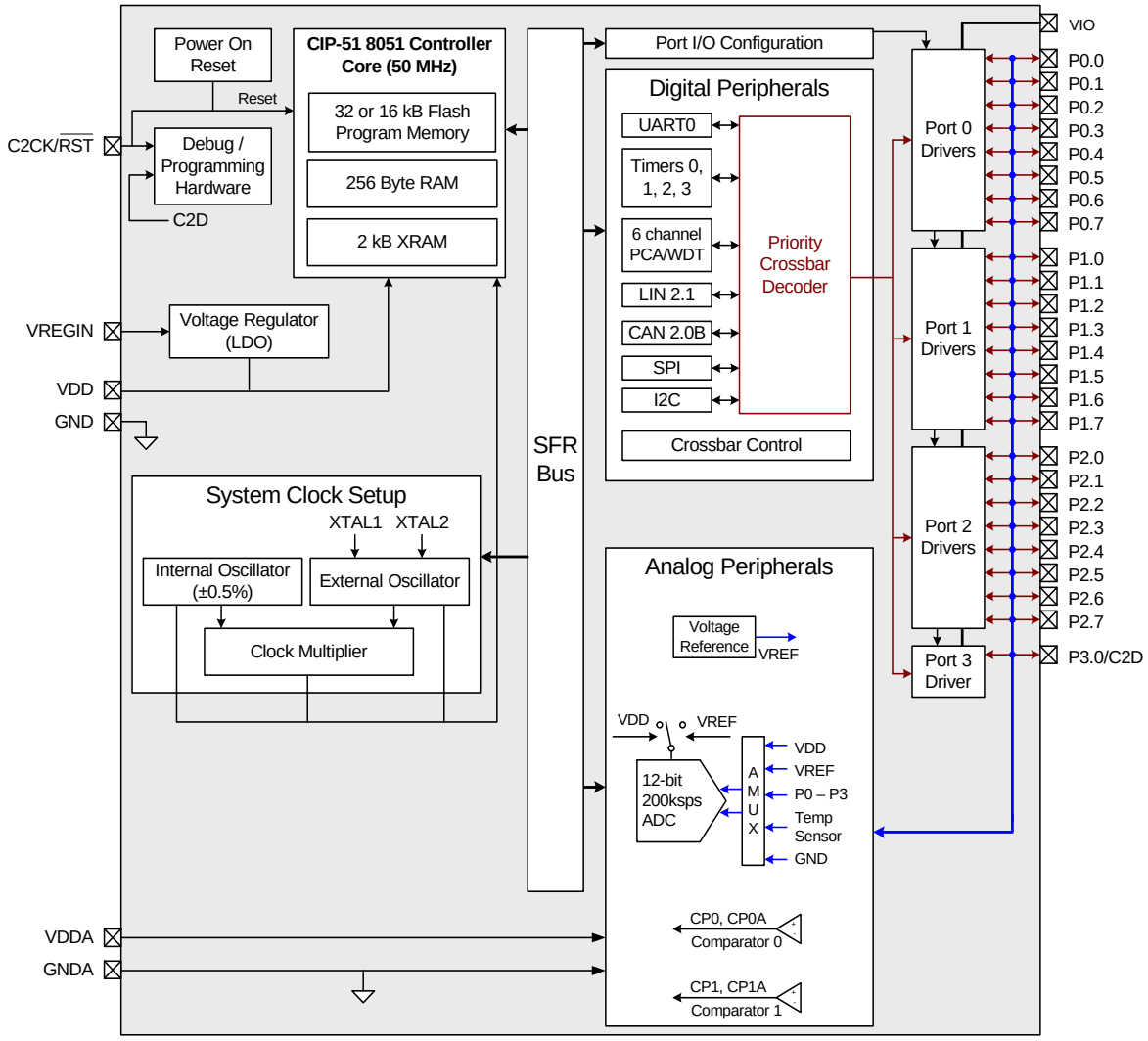


Figure 1.2. C8051F560-7 (32-pin) Block Diagram

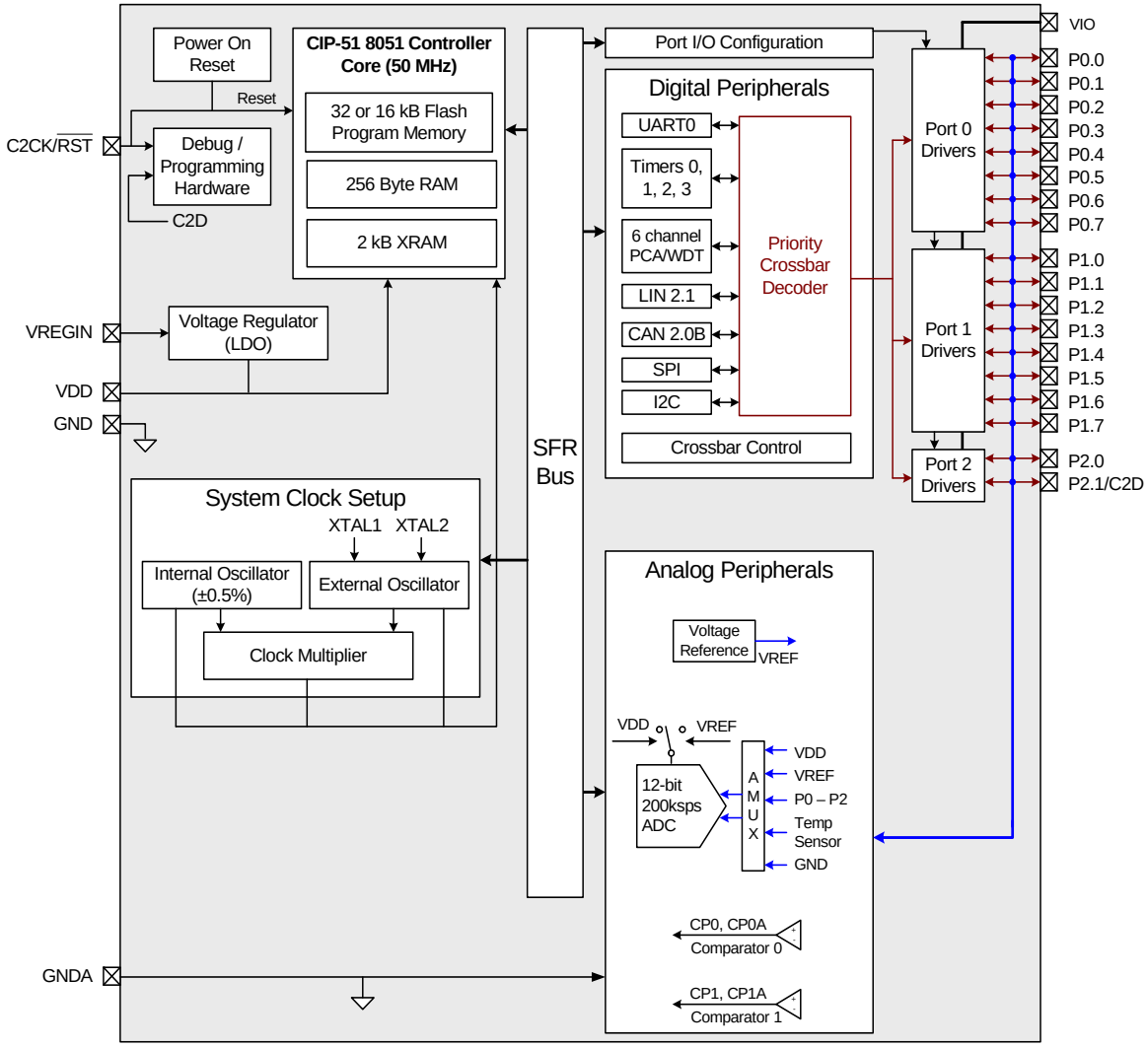


Figure 1.3. C8051F550-7 (24-pin) Block Diagram

2. Ordering Information

The following features are common to all devices in this family:

- 50 MHz system clock and 50 MIPS throughput (peak)
- 2304 bytes of RAM (256 internal bytes and 2048 XRAM bytes)
- SMBus/I^2C, Enhanced SPI, Enhanced UART
- Four Timers
- Six Programmable Counter Array channels
- Internal 24 MHz oscillator
- Internal Voltage Regulator
- 12-bit, 200 ksps ADC
- Internal Voltage Reference and Temperature Sensor
- Two Analog Comparators

Table 2.1 shows the feature that differentiate the devices in this family.

Table 2.1. Product Selection Guide

Ordering Part Number	Flash Memory (kB)	CAN2.0B	LIN2.1	Digital Port I/Os	External Mem. Interface	Package
C8051F550-IM	32	✓	✓	18	—	QFN-24
C8051F551-IM	32	✓	—	18	—	QFN-24
C8051F552-IM	32	—	✓	18	—	QFN-24
C8051F553-IM	32	—	—	18	—	QFN-24
C8051F554-IM	16	✓	✓	18	—	QFN-24
C8051F555-IM	16	✓	—	18	—	QFN-24
C8051F556-IM	16	—	✓	18	—	QFN-24
C8051F557-IM	16	—	—	18	—	QFN-24
C8051F560-IM	32	✓	✓	25	—	QFN-32
C8051F560-IQ	32	✓	✓	25	—	QFP-32
C8051F561-IM	32	✓	—	25	—	QFN-32
C8051F561-IQ	32	✓	—	25	—	QFP-32
C8051F562-IM	32	—	✓	25	—	QFN-32
C8051F562-IQ	32	—	✓	25	—	QFP-32
C8051F563-IM	32	—	—	25	—	QFN-32
C8051F563-IQ	32	—	—	25	—	QFP-32

Ordering Part Number	Flash Memory (kB)	CAN2.0B	LIN2.1	Digital Port I/Os	External Mem. Interface	Package
C8051F564-IM	16	✓	✓	25	—	QFN-32
C8051F564-IQ	16	✓	✓	25	—	QFP-32
C8051F565-IM	16	✓	—	25	—	QFN-32
C8051F565-IQ	16	✓	—	25	—	QFP-32
C8051F566-IM	16	—	✓	25	—	QFN-32
C8051F566-IQ	16	—	✓	25	—	QFP-32
C8051F567-IM	16	—	—	25	—	QFN-32
C8051F567-IQ	16	—	—	25	—	QFP-32
C8051F568-IM	32	✓	✓	33	✓	QFN-40
C8051F569-IM	32	✓	—	33	✓	QFN-40
C8051F570-IM	32	—	✓	33	✓	QFN-40
C8051F571-IM	32	—	—	33	✓	QFN-40
C8051F572-IM	16	✓	✓	33	✓	QFN-40
C8051F573-IM	16	✓	—	33	✓	QFN-40
C8051F574-IM	16	—	✓	33	✓	QFN-40
C8051F575-IM	16	—	—	33	✓	QFN-40

Note: The suffix of the part number indicates the device rating and the package. All devices are RoHS compliant.

All devices in Table 2.1 are also available in an automotive version. For the automotive version, the -I in the ordering part number is replaced with -A. For example, the automotive version of the C8051F550-IM is the C8051F550-AM.

The -AM and -AQ devices receive full automotive quality production status, including AEC-Q100 qualification, registration with International Material Data System (IMDS) and Part Production Approval Process (PPAP) documentation. PPAP documentation is available at www.silabs.com with a registered and NDA approved user account. The -AM and -AQ devices enable high volume automotive OEM applications with their enhanced testing and processing. Please contact Silicon Labs sales for more information regarding –AM and -AQ devices for your automotive project.

3. Pin Definitions

Table 3.1. Pin Definitions for the C8051F55x/56x/57x

Name	Pin 40-pin packages	Pin 32-pin packages	Pin 24-pin packages	Type	Description
VDD	4	4	3		Digital Supply Voltage. Must be connected.
GND	6	6	4		Digital Ground. Must be connected.
VDDA	5	5	—		Analog Supply Voltage. Must be connected.
GNDA	7	7	5		Analog Ground. Must be connected.
VREGIN	3	3	2		Voltage Regulator Input
VIO	2	2	1		Port I/O Supply Voltage. Must be connected.
$\overline{\text{RST}}$/ C2CK	10	10	8	D I/O D I/O	Device Reset. Open-drain output of internal POR or V_{DD} Monitor. Clock signal for the C2 Debug Interface.
P4.0/ C2D	9	—	—	D I/O or A In D I/O	Port 4.0. See SFR Definition 19.28. Bi-directional data signal for the C2 Debug Interface.
P3.0/ C2D		9	—	D I/O or A In D I/O	Port 3.0. See SFR Definition 19.24. Bi-directional data signal for the C2 Debug Interface.
P2.1/ C2D		—	7	D I/O or A In D I/O	Port 2.1. See SFR Definition 19.20. Bi-directional data signal for the C2 Debug Interface.
P0.0	8	8	6	D I/O or A In	Port 0.0. See SFR Definition 19.12.
P0.1	1	1	24	D I/O or A In	Port 0.1
P0.2	40	32	23	D I/O or A In	Port 0.2
P0.3	39	31	22	D I/O or A In	Port 0.3
P0.4	38	30	21	D I/O or A In	Port 0.4
P0.5	37	29	20	D I/O or A In	Port 0.5
P0.6	36	28	19	D I/O or A In	Port 0.6
P0.7	35	27	18	D I/O or A In	Port 0.7

Table 3.1. Pin Definitions for the C8051F55x/56x/57x (Continued)

Name	Pin 40-pin packages	Pin 32-pin packages	Pin 24-pin packages	Type	Description
P1.0	34	26	17	D I/O or A In	Port 1.0. See SFR Definition 19.16.
P1.1	33	25	16	D I/O or A In	Port 1.1.
P1.2	32	24	15	D I/O or A In	Port 1.2.
P1.3	31	23	14	D I/O or A In	Port 1.3.
P1.4	30	22	13	D I/O or A In	Port 1.4.
P1.5	29	21	12	D I/O or A In	Port 1.5.
P1.6	28	20	11	D I/O or A In	Port 1.6.
P1.7	27	19	10	D I/O or A In	Port 1.7.
P2.0	26	18	9	D I/O or A In	Port 2.0. See SFR Definition 19.20.
P2.1	25	17	—	D I/O or A In	Port 2.1.
P2.2	24	16	—	D I/O or A In	Port 2.2.
P2.3	23	15	—	D I/O or A In	Port 2.3.
P2.4	22	14	—	D I/O or A In	Port 2.4.
P2.5	21	13	—	D I/O or A In	Port 2.5.
P2.6	20	12	—	D I/O or A In	Port 2.6.
P2.7	19	11	—	D I/O or A In	Port 2.7.
P3.0	18	—	—	D I/O or A In	Port 3.0. See SFR Definition 19.24.
P3.1	17	—	—	D I/O or A In	Port 3.1.
P3.2	16	—	—	D I/O or A In	Port 3.2.
P3.3	15	—	—	D I/O or A In	Port 3.3.
P3.4	14	—	—	D I/O or A In	Port 3.4.
P3.5	13	—	—	D I/O or A In	Port 3.5.
P3.6	12	—	—	D I/O or A In	Port 3.6.
P3.7	11	—	—	D I/O or A In	Port 3.7.

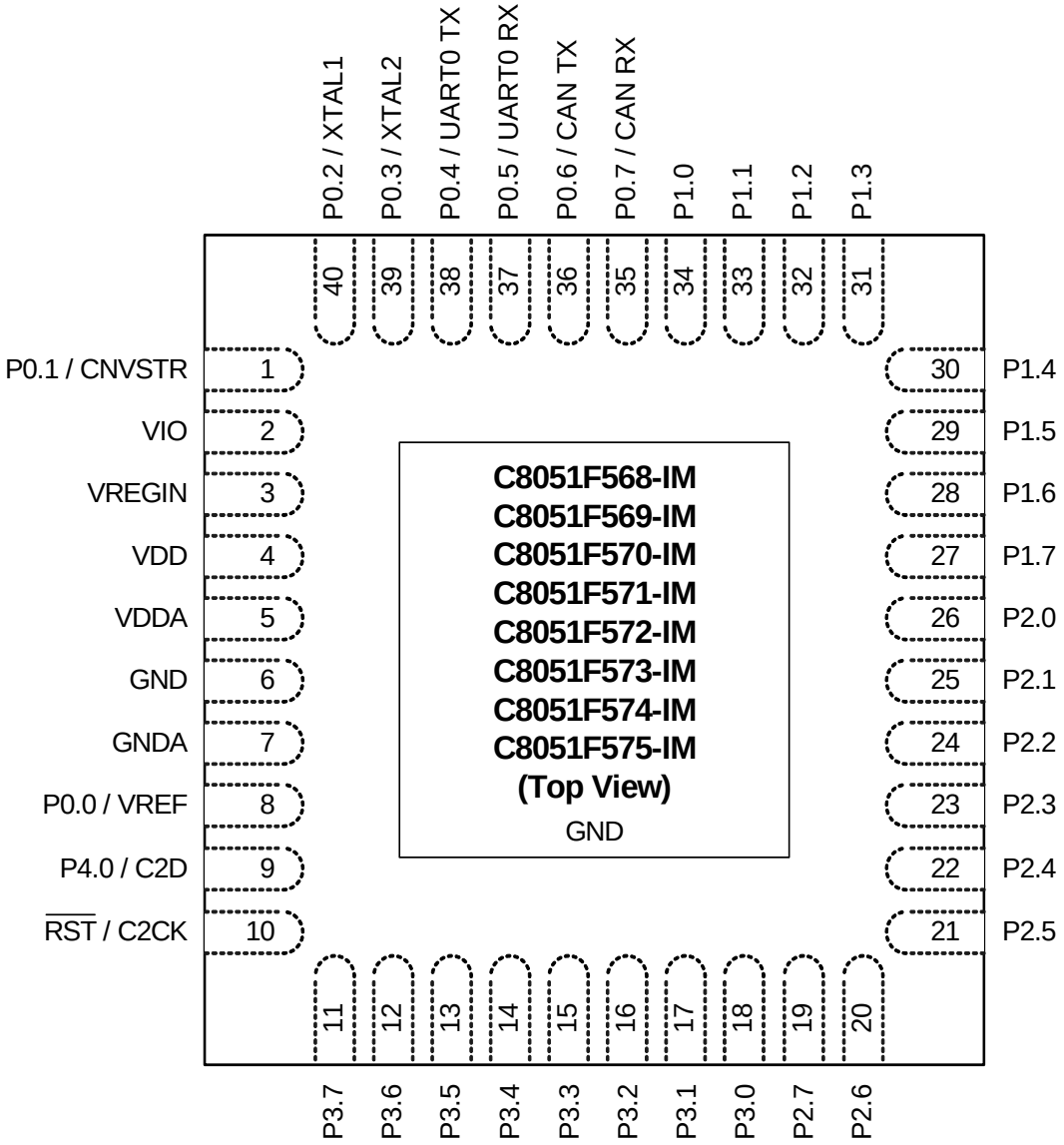


Figure 3.1. QFN-40 Pinout Diagram (Top View)

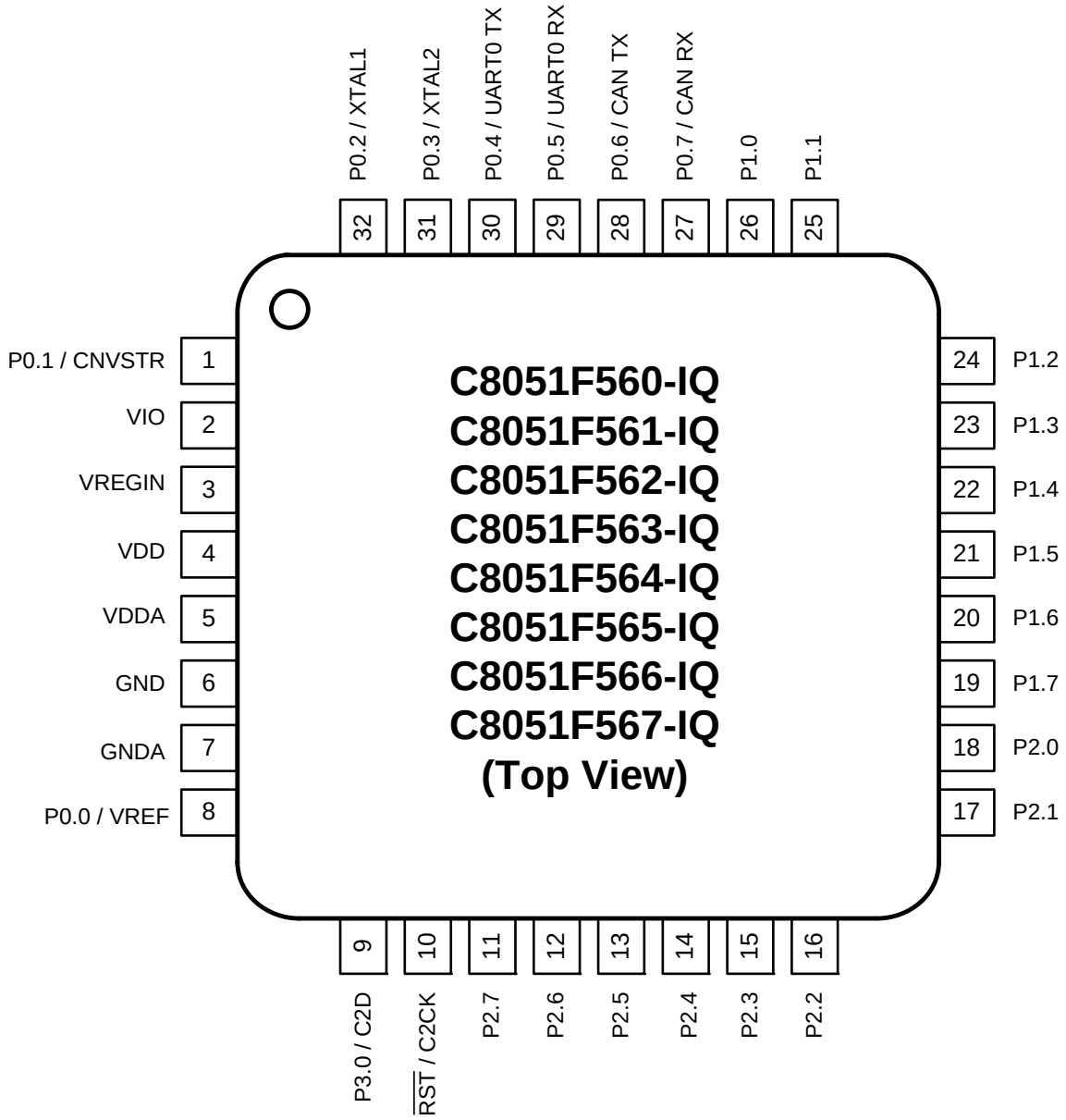


Figure 3.2. QFP-32 Pinout Diagram (Top View)

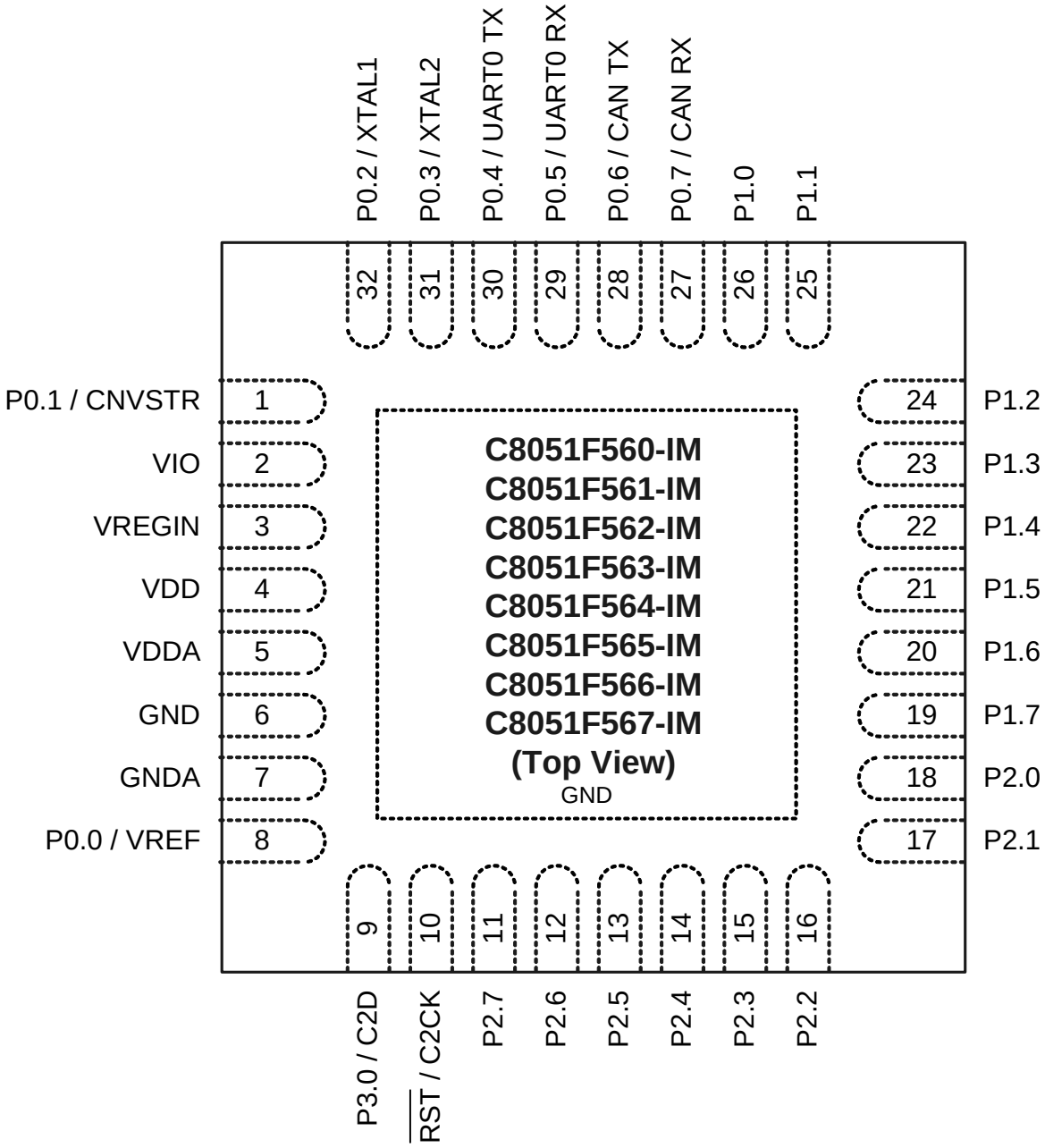


Figure 3.3. QFN-32 Pinout Diagram (Top View)

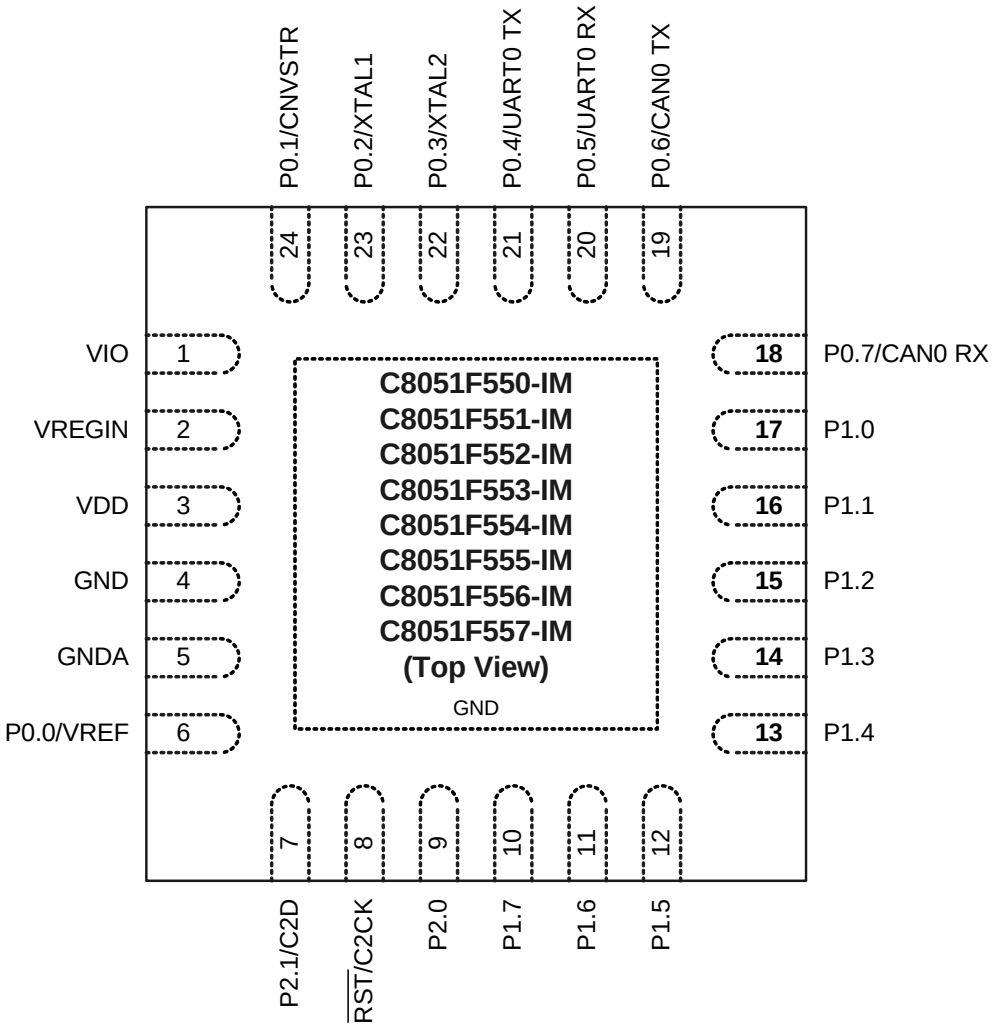


Figure 3.4. QFN-24 Pinout Diagram (Top View)

4. Package Specifications

4.1. QFN-40 Package Specifications

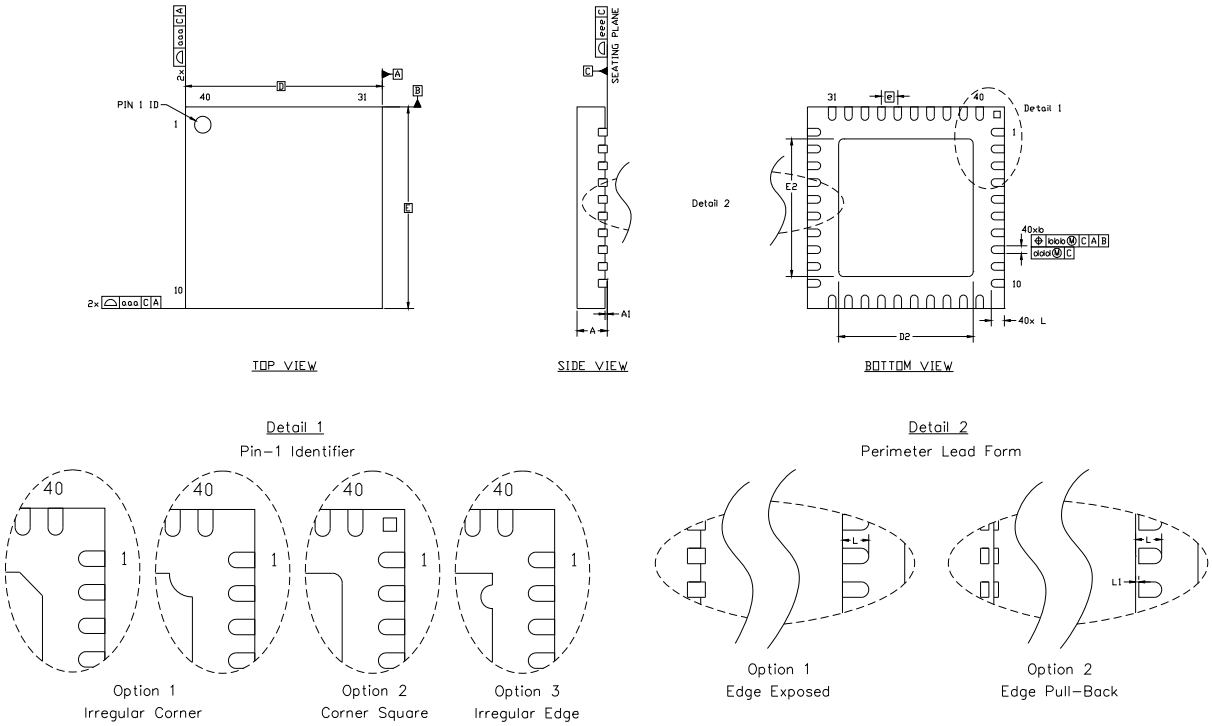


Figure 4.1. QFN-40 Package Drawing

Table 4.1. QFN-40 Package Dimensions

Dimension	Min	Typ	Max
A	0.80	0.85	0.90
A1	0.00		0.05
b	0.18	0.23	0.28
D		6.00 BSC	
D2	4.00	4.10	4.20
e		0.50 BSC	
E		6.00 BSC	

Dimension	Min	Typ	Max
E2	4.00	4.10	4.20
L	0.35	0.40	0.45
L1			0.10
aaa			0.10
bbb			0.10
ddd			0.05
eee			0.08

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to JEDEC Solid State Outline MO-220, variation VJJD-5, except for features A, D2, and E2 which are toleranced per supplier designation.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

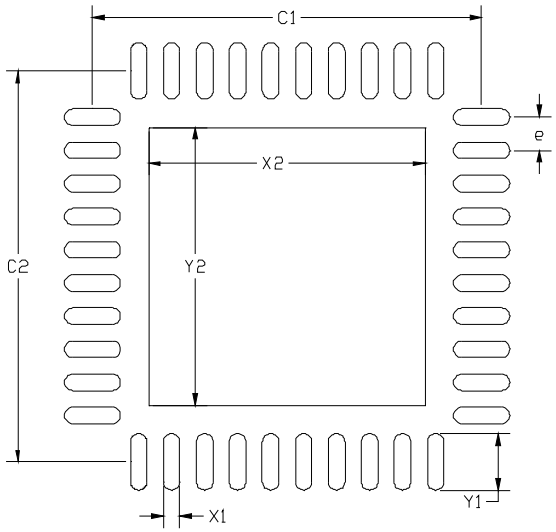


Figure 4.2. QFN-40 Landing Diagram

Table 4.2. QFN-40 Landing Diagram Dimensions

Dimension	Min	Max	Dimension	Min	Max
C1	5.80	5.90	X2	4.10	4.20
C2	5.80	5.90	Y1	0.75	0.85
e	0.50 BSC		Y2	4.10	4.20
X1	0.15	0.25			

Notes:

General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimension and Tolerancing is per the ANSI Y14.5M-1994 specification.
3. This Land Pattern Design is based on the IPC-SM-7351 guidelines.
4. All dimensions shown are at Maximum Material Condition (MMC). Least Material Condition (LMC) is calculated based on a Fabrication Allowance of 0.05 mm.

Solder Mask Design

5. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.

Stencil Design

6. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
7. The stencil thickness should be 0.125 mm (5 mils).
8. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.
9. A 4x4 array of 0.80 mm square openings on a 1.05 mm pitch should be used for the center ground pad.

Card Assembly

10. A No-Clean, Type-3 solder paste is recommended.
11. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

4.2. QFP-32 Package Specifications

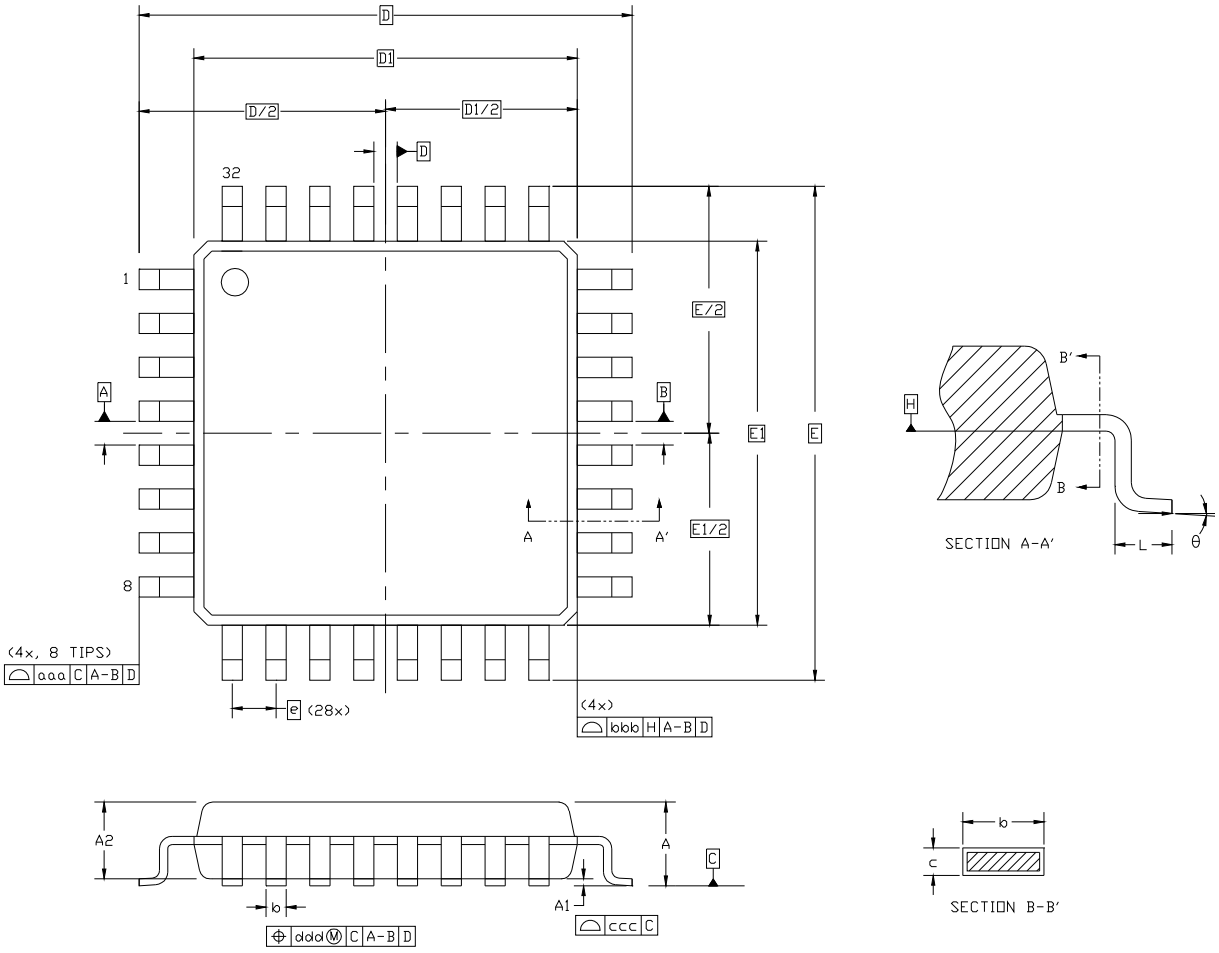


Figure 4.3. QFP-32 Package Drawing

Table 4.3. QFP-32 Package Dimensions

Dimension	Min	Typ	Max
A	—	—	1.60
A1	0.05	—	0.15
A2	1.35	1.40	1.45
b	0.30	0.37	0.45
c	0.09	—	0.20
D	9.00 BSC.		
D1	7.00 BSC.		
e	0.80 BSC.		

Dimension	Min	Typ	Max
E	9.00 BSC.		
E1	7.00 BSC.		
L	0.45	0.60	0.75
aaa	0.20		
bbb	0.20		
ccc	0.10		
ddd	0.20		
θ	0°	3.5°	7°

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to the JEDEC outline MS-026, variation BBA.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

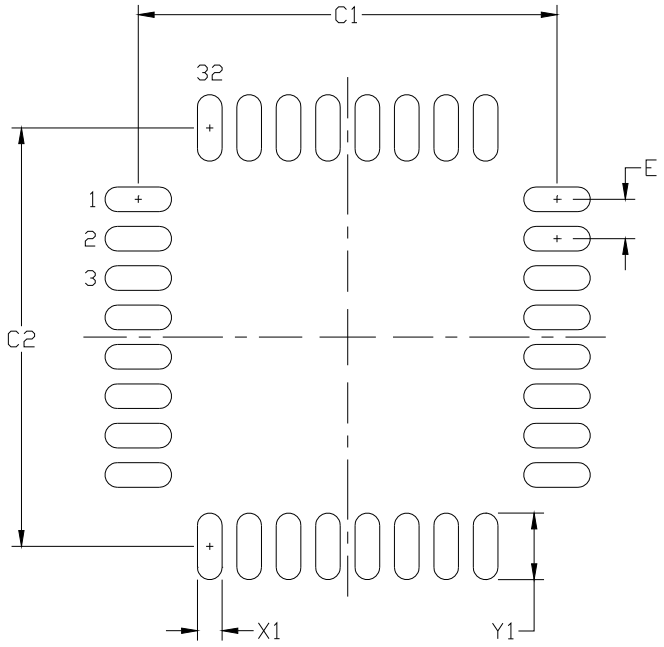


Figure 4.4. QFP-32 Landing Diagram

Table 4.4. QFP-32 Landing Diagram Dimensions

Dimension	Min	Max	Dimension	Min	Max
C1	8.40	8.50	X1	0.40	0.50
C2	8.40	8.50	Y1	1.25	1.35
E	0.80 BSC				

Notes:

General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. This Land Pattern Design is based on the IPC-7351 guidelines.

Solder Mask Design

3. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.

Stencil Design

4. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
5. The stencil thickness should be 0.125 mm (5 mils).
6. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.

Card Assembly

7. A No-Clean, Type-3 solder paste is recommended.
8. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

4.3. QFN-32 Package Specifications

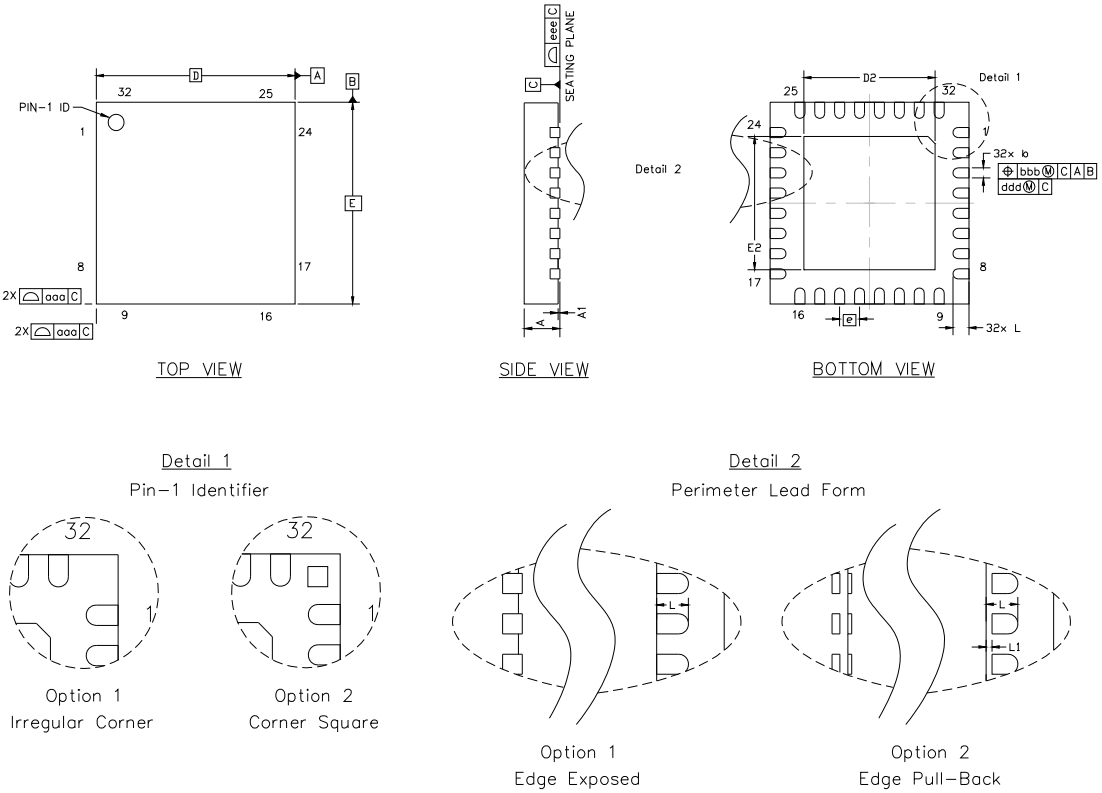


Figure 4.5. QFN-32 Package Drawing

Table 4.5. QFN-32 Package Dimensions

Dimension	Min	Typ	Max
A	0.80	0.9	1.00
A1	0.00	0.02	0.05
b	0.18	0.25	0.30
D		5.00 BSC.	
D2	3.20	3.30	3.40
e		0.50 BSC.	
E		5.00 BSC.	

Dimension	Min	Typ	Max
E2	3.20	3.30	3.40
L	0.30	0.40	0.50
L1	0.00	—	0.15
aaa	—	—	0.15
bbb	—	—	0.15
ddd	—	—	0.05
eee	—	—	0.08

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to the JEDEC Solid State Outline MO-220, variation VHHD except for custom features D2, E2, and L which are toleranced per supplier designation.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

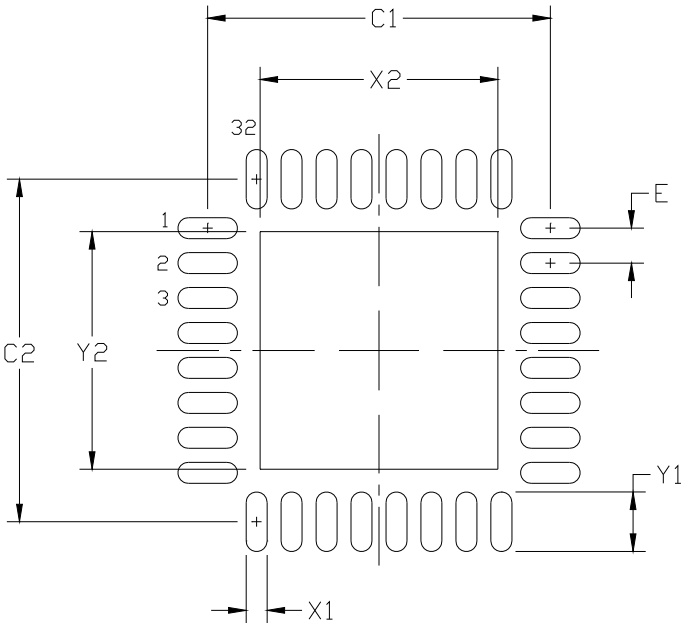


Figure 4.6. QFN-32 Landing Diagram

Table 4.6. QFN-32 Landing Diagram Dimensions

Dimension	Min	Max		Dimension	Min	Max
C1	4.80	4.90		X2	3.20	3.40
C2	4.80	4.90		Y1	0.75	0.85
e	0.50 BSC			Y2	3.20	3.40
X1	0.20	0.30				

Notes:

General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. This Land Pattern Design is based on the IPC-7351 guidelines.

Solder Mask Design

3. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.

Stencil Design

4. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
5. The stencil thickness should be 0.125 mm (5 mils).
6. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.
7. A 3x3 array of 1.0 mm openings on a 1.20 mm pitch should be used for the center ground pad.

Card Assembly

8. A No-Clean, Type-3 solder paste is recommended.
9. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

4.4. QFN-24 Package Specifications

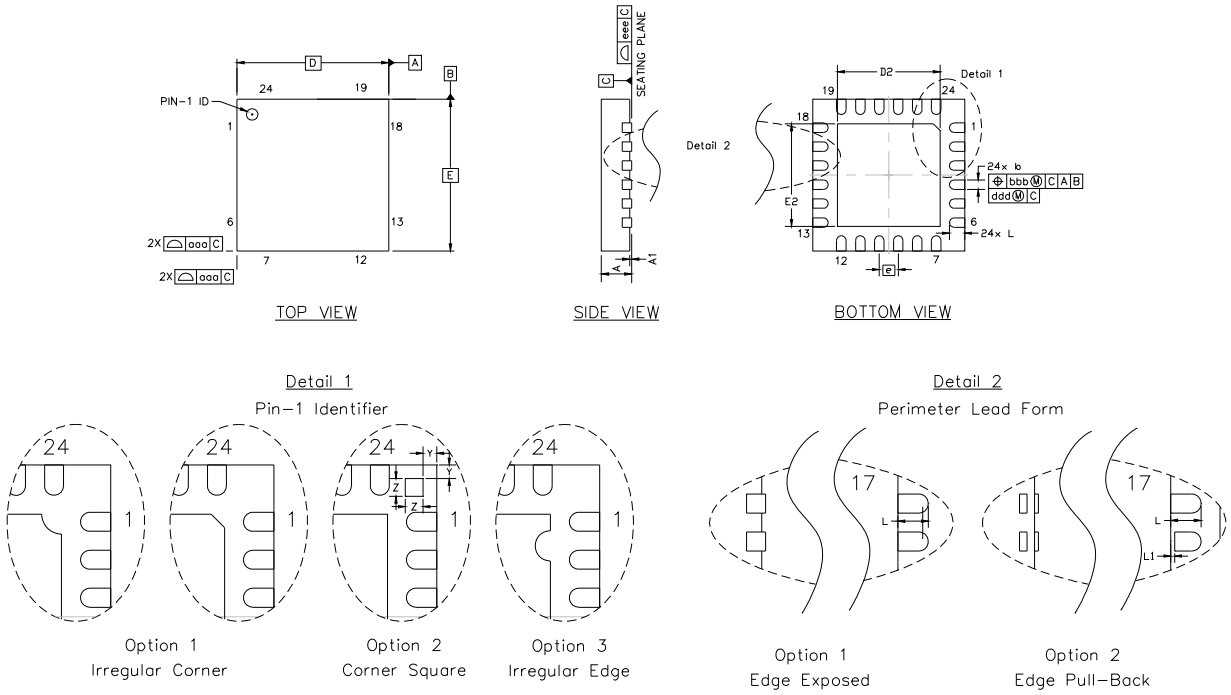


Figure 4.7. QFN-24 Package Drawing

Table 4.7. QFN-24 Package Dimensions

Dimension	Min	Typ	Max	Dimension	Min	Typ	Max
A	0.70	0.75	0.80	L	0.30	0.40	0.50
A1	0.00	0.02	0.05	L1	0.00		0.15
b	0.18	0.25	0.30	aaa			0.15
D	4.00 BSC			bbb			0.10
D2	2.55	2.70	2.80	ddd			0.05
e	0.50 BSC			eee			0.08
E	4.00 BSC			Z		0.24	
E2	2.55	2.70	2.80	Y		0.18	

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to JEDEC Solid State Outline MO-220, variation WGGD, except for custom features D2, E2, Z, Y, and L which are toleranced per supplier designation.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

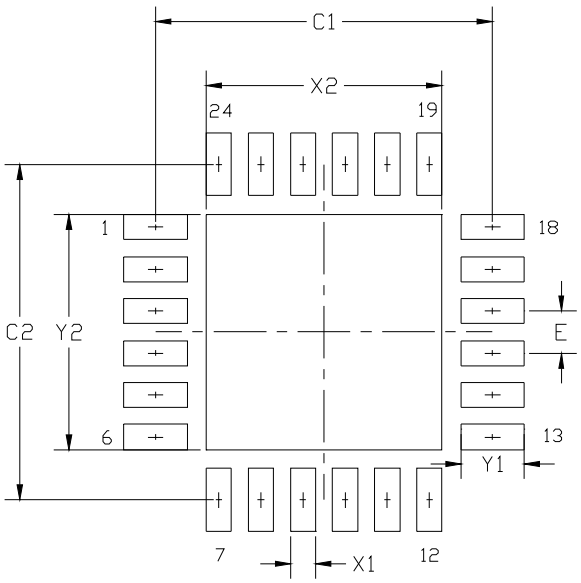


Figure 4.8. QFN-24 Landing Diagram

Table 4.8. QFN-24 Landing Diagram Dimensions

Dimension	Min	Max	Dimension	Min	Max
C1	3.90	4.00	X2	2.70	2.80
C2	3.90	4.00	Y1	0.65	0.75
E	0.50 BSC		Y2	2.70	2.80
X1	0.20	0.30			

Notes:
General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. This Land Pattern Design is based on the IPC-7351 guidelines.

Solder Mask Design

3. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.

Stencil Design

4. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
5. The stencil thickness should be 0.125 mm (5 mils).
6. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.
7. A 2x2 array of 1.10 mm x 1.10 mm openings on a 1.30 mm pitch should be used for the center ground pad.

Card Assembly

8. A No-Clean, Type-3 solder paste is recommended.
9. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

5. Electrical Characteristics

5.1. Absolute Maximum Specifications

Table 5.1. Absolute Maximum Ratings

Parameter	Conditions	Min	Typ	Max	Units
Ambient Temperature under Bias		–55	—	135	°C
Storage Temperature		–65	—	150	°C
Voltage on V_{REGIN} with Respect to GND		–0.3	—	5.5	V
Voltage on V_{DD} with Respect to GND		–0.3	—	2.8	V
Voltage on VDDA with Respect to GND		–0.3	—	2.8	V
Voltage on V_{IO} with Respect to GND		–0.3	—	5.5	V
Voltage on any Port I/O Pin or $\overline{RST}$ with Respect to GND		–0.3	—	V_{IO} + 0.3	V
Maximum Total Current through V_{REGIN} or GND		—	—	500	mA
Maximum Output Current Sunk by $\overline{RST}$ or any Port Pin		—	—	100	mA
Maximum Output Current Sourced by any Port Pin		—	—	100	mA

Note: Stresses outside of the range of the "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the devices at those or any other conditions outside of those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

5.2. Electrical Characteristics

Table 5.2. Global Electrical Characteristics

–40 to +125 °C, 24 MHz system clock unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Supply Input Voltage (V_{REGIN})		1.8	—	5.25	V
Digital Supply Voltage (V_{DD})	System Clock ≤ 25 MHz	V_{RST}[1]	—	2.75	V
	System Clock > 25 MHz	2	—	2.75	
Analog Supply Voltage (VDDA)	System Clock ≤ 25 MHz	V_{RST}[1]	—	2.75	V
(Must be connected to V_{DD})	System Clock > 25 MHz	2	—	2.75	
Port I/O Supply Voltage (V_{IO})	Normal Operation	1.8[2]	—	5.25	V
Digital Supply RAM Data Retention Voltage		—	1.5	—	V
SYSCLK (System Clock)[3]		0	—	50	MHz
T_{SYSH} (SYSCLK High Time)		9	—	—	ns
T_{SYSL} (SYSCLK Low Time)		9	—	—	ns
Specified Operating Temperature Range		–40	—	+125	°C
Digital Supply Current—CPU Active (Normal Mode, fetching instructions from Flash)					
I_{DD}[4]	V_{DD} = 2.1 V, F = 200 kHz	—	85	—	µA
	V_{DD} = 2.1 V, F = 1.5 MHz	—	660	—	µA
	V_{DD} = 2.1 V, F = 25 MHz	—	9.2	11	mA
	V_{DD} = 2.1 V, F = 50 MHz	—	17	21	mA
I_{DD}[4]	V_{DD} = 2.6 V, F = 200 kHz	—	120	—	µA
	V_{DD} = 2.6 V, F = 1.5 MHz	—	920	—	µA
	V_{DD} = 2.6 V, F = 25 MHz	—	13	21	mA
	V_{DD} = 2.6 V, F = 50 MHz	—	22	33	mA
I_{DD} Supply Sensitivity[4]	F = 25 MHz	—	68	—	%/V
	F = 1 MHz	—	77	—	%/V

Notes:

1. Given in Table 5.4 on page 41.
2. V_{IO} should not be lower than the V_{DD} voltage.
3. SYSCLK must be at least 32 kHz to enable debugging.
4. Guaranteed by characterization. Does not include oscillator supply current.
5. IDD estimation for different frequencies.
6. Idle IDD estimation for different frequencies.

Table 5.2. Global Electrical Characteristics (Continued)
–40 to +125 °C, 24 MHz system clock unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
I_{DD} Frequency Sensitivity [4,5]	V_{DD} = 2.1 V, F ≤ 12.5 MHz, T = 25 °C	—	0.43	—	mA/MHz
	V_{DD} = 2.1 V, F > 12.5 MHz, T = 25 °C	—	0.33	—	mA/MHz
	V_{DD} = 2.6 V, F ≤ 12.5 MHz, T = 25 °C	—	0.60	—	mA/MHz
	V_{DD} = 2.6 V, F > 12.5 MHz, T = 25 °C	—	0.42	—	mA/MHz
Digital Supply Current—CPU Inactive (Idle Mode, not fetching instructions from Flash)					
I_{DD} [4]	V_{DD} = 2.1 V, F = 200 kHz	—	50	—	µA
	V_{DD} = 2.1 V, F = 1.5 MHz	—	410	—	µA
	V_{DD} = 2.1 V, F = 25 MHz	—	6.5	8.0	mA
	V_{DD} = 2.1 V, F = 50 MHz	—	13	16	mA
I_{DD} [4]	V_{DD} = 2.6 V, F = 200 kHz	—	67	—	µA
	V_{DD} = 2.6 V, F = 1.5 MHz	—	530	—	µA
	V_{DD} = 2.6 V, F = 25 MHz	—	8.0	15	mA
	V_{DD} = 2.6 V, F = 50 MHz	—	16	25	mA
I_{DD} Supply Sensitivity [4]	F = 25 MHz	—	55	—	%/V
	F = 1 MHz	—	58	—	
I_{DD} Frequency Sensitivity [4.6]	V_{DD} = 2.1V, F ≤ 12.5 MHz, T = 25 °C	—	0.26	—	mA/MHz
	V_{DD} = 2.1V, F > 12.5 MHz, T = 25 °C	—	0.26	—	
	V_{DD} = 2.6V, F ≤ 12.5 MHz, T = 25 °C	—	0.34	—	
	V_{DD} = 2.6V, F > 12.5 MHz, T = 25 °C	—	0.34	—	
Digital Supply Current [4] (Stop or Suspend Mode)	Oscillator not running, V_{DD} Monitor Disabled				µA
	Temp = 25 °C	—	1	—	
	Temp = 60 °C	—	6	—	
	Temp= 125 °C	—	70	—	

Notes:
1. Given in Table 5.4 on page 41.
2. V_{IO} should not be lower than the V_{DD} voltage.
3. SYSCLK must be at least 32 kHz to enable debugging.
4. Guaranteed by characterization. Does not include oscillator supply current.
5. IDD estimation for different frequencies.
6. Idle IDD estimation for different frequencies.

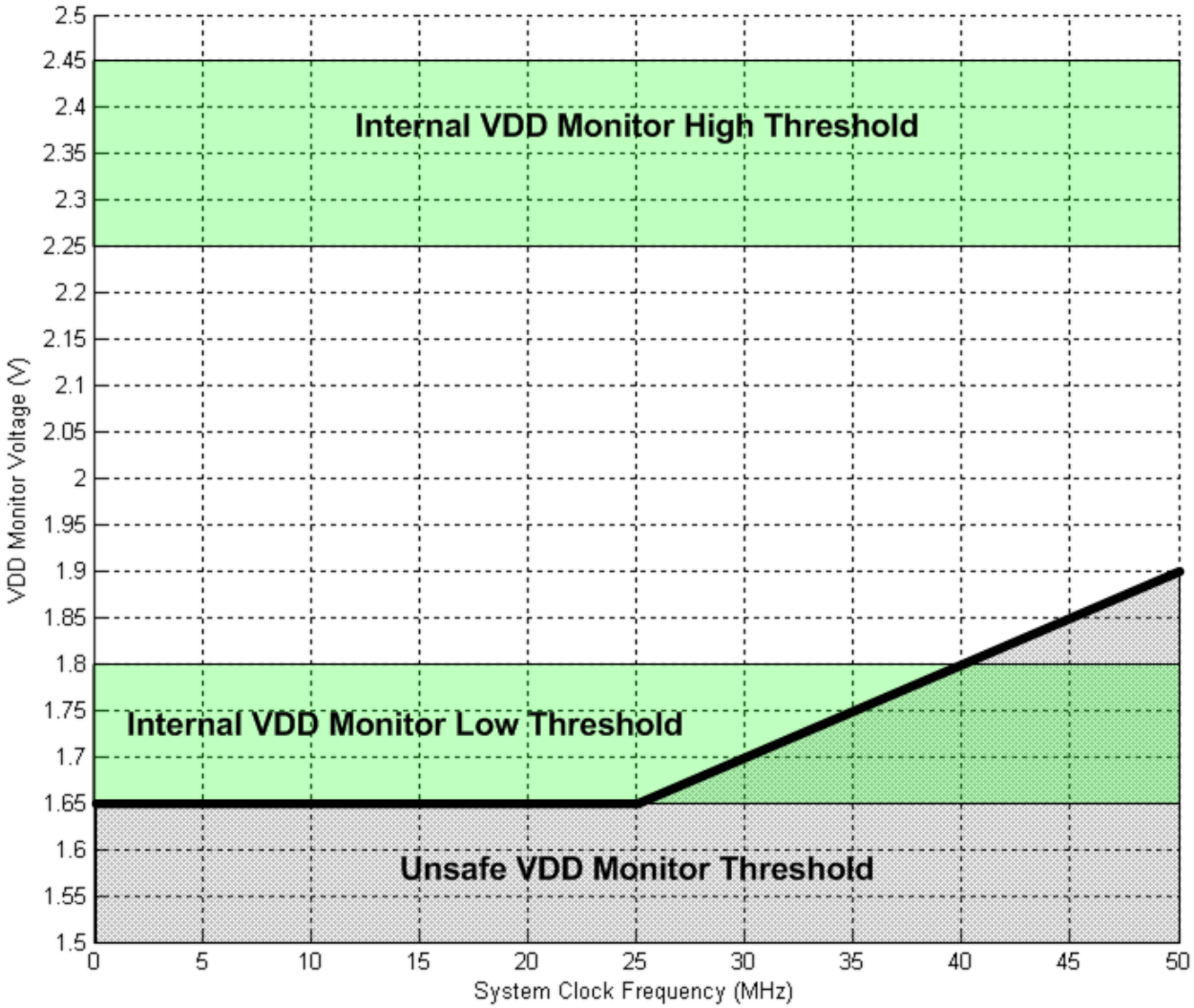


Figure 5.1. Minimum VDD Monitor Threshold vs. System Clock Frequency

Note: With system clock frequencies greater than 25 MHz, the V_{DD} monitor level should be set to the high threshold (VDMLVL = 1b in SFR VDM0CN) to prevent undefined CPU operation. The high threshold should only be used with an external regulator powering V_{DD} directly. See Figure 9.2 on page 80 for the recommended power supply connections.

Table 5.3. Port I/O DC Electrical Characteristics

V_{DD} = 1.8 to 2.75 V, –40 to +125 °C unless otherwise specified.

Parameters	Conditions	Min	Typ	Max	Units
Output High Voltage	I_{OH} = –3 mA, Port I/O push-pull	V_{IO} – 0.4	—	—	V
	I_{OH} = –10 µA, Port I/O push-pull	V_{IO} – 0.02	—	—	
	I_{OH} = –10 mA, Port I/O push-pull	—	V_{IO} – 0.7	—	
Output Low Voltage	**V_{IO} = 1.8 V:**				
	I_{OL} = 70 µA	—	—	50	
	I_{OL} = 8.5 mA	—	—	750	
	V_{IO} = 2.7 V:				
	I_{OL} = 70 µA	—	—	45	mV
	I_{OL} = 8.5 mA	—	—	550	
	V_{IO} = 5.25 V:				
	I_{OL} = 70 µA	—	—	40	
	I_{OL} = 8.5 mA	—	—	400	
Input High Voltage	V_{REGIN} = 5.25 V	0.7 x VIO	—		V
Input Low Voltage	V_{REGIN} = 2.7 V	—	—	0.3 x VIO	V
Input Leakage Current	Weak Pullup Off	—	—	±2	µA
	Weak Pullup On, V_{IO} = 2.1 V, V_{IN} = 0 V, V_{DD} = 1.8 V	—	7	9	
	Weak Pullup On, V_{IO} = 2.6 V, V_{IN} = 0 V, V_{DD} = 2.6 V	—	17	22	
	Weak Pullup On, V_{IO} = 5.0 V, V_{IN} = 0 V, V_{DD} = 2.6 V	—	49	115	

Table 5.4. Reset Electrical Characteristics

–40 to +125 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
$\overline{\text{RST}}$ Output Low Voltage	VIO = 5 V; IOL = 70 µA	—	—	40	mV
$\overline{\text{RST}}$ Input High Voltage		0.7 x V_{IO}	—	—	
$\overline{\text{RST}}$ Input Low Voltage		—	—	0.3 x V_{IO}	
$\overline{\text{RST}}$ Input Pullup Current	$\overline{\text{RST}}$ = 0.0 V, VIO = 5 V	—	49	115	µA
V_{DD} RST Threshold ($V_{RST-LOW}$)		1.65	1.75	1.80	V
V_{DD} RST Threshold ($V_{RST-HIGH}$)		2.25	2.30	2.45	V
V_{REGIN} Ramp Time for Power On	V_{REGIN} Ramp 0–1.8 V	—	—	1	ms
Missing Clock Detector Timeout	Time from last system clock rising edge to reset initiation V_{DD} = 2.1 V V_{DD} = 2.5 V	 200 200	 340 250	 600 600	µs
Reset Time Delay	Delay between release of any reset source and code execution at location 0x0000	—	155	175	µs
Minimum $\overline{\text{RST}}$ Low Time to Generate a System Reset		6	—	—	µs
V_{DD} Monitor Turn-on Time		—	60	100	µs
V_{DD} Monitor Supply Current		—	1	2	µA

Table 5.5. Flash Electrical Characteristics

V_{DD} = 1.8 to 2.75 V, –40 to +125 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Flash Size	C8051F550-3, ‘F560-3, ‘F568-9, and ‘F570-1	32768[1]			Bytes
	C8051F554-7, ‘F564-7, and ‘F572-5	16384			
Endurance		20 k	150 k	—	Erase/Write
Retention	125 °C	10	—	—	Years
Erase Cycle Time	25 MHz System Clock	28	30	45	ms
Write Cycle Time	25 MHz System Clock	79	84	125	µs
V_{DD}	Write/Erase operations	$V_{RST-HIGH}$[2]	—	—	V
Temperature during Programming Operations	–I Devices –A Devices	0 –40	— —	+125 +125	°C

1. On the 32 kB Flash devices, 1024 bytes at addresses 0x7C00 to 0x7FFF are reserved.
2. See Table 5.4 for the $V_{RST-HIGH}$ specification.

Table 5.6. Internal High-Frequency Oscillator Electrical Characteristics

V_{DD} = 1.8 to 2.75 V, –40 to +125 °C unless otherwise specified; Using factory-calibrated settings.

Parameter	Conditions	Min	Typ	Max	Units
Oscillator Frequency	IFCN = 111b; VDD ≥ VREGMIN[1] IFCN = 111b; VDD < VREGMIN[1]	24 – 0.5% 24 – 1.0%	24[2] 24[2]	24 + 0.5% 24 + 1.0%	MHz
Oscillator Supply Current (from V_{DD})	Internal Oscillator On OSCICN[7:6] = 11b	—	880	1300	µA
Internal Oscillator Suspend OSCICN[7:6] = 00b ZTCEN = 1	Temp = 25 °C Temp = 85 °C Temp = 125 °C	—	67 90 130	—	
Wake-up Time From Suspend	OSCICN[7:6] = 00b	—	1	—	µs
Power Supply Sensitivity	Constant Temperature	—	0.11	—	%/V
Temperature Sensitivity[3]	Constant Supply TC_1 TC_2	 — —	 5.0 –0.65	 — —	 ppm/°C ppm/°C[2]

1. VREGMIN is the minimum output of the voltage regulator for its low setting (REG0CN: REG0MD = 0b). See Table 5.8, “Voltage Regulator Electrical Characteristics,” on page 43.
2. This is the average frequency across the operating temperature range
3. Use temperature coefficients TC_1 and TC_2 to calculate the new internal oscillator frequency using the following equation:

$$f(T) = f0 \times (1 + TC_1 \times (T - T0) + TC_2 \times (T - T0)^2)$$

where f0 is the internal oscillator frequency at 25 °C and T0 is 25 °C.

Table 5.7. Clock Multiplier Electrical Specifications

V_{DD} = 1.8 to 2.75 V, –40 to +125 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Input Frequency (Fcm_{in})		2	—	—	MHz
Output Frequency		—	—	50	MHz
Power Supply Current		—	0.9	1.9	mA

Table 5.8. Voltage Regulator Electrical Characteristics

V_{DD} = 1.8 to 2.75 V, –40 to +125 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Input Voltage Range (V_{REGIN})		1.8*	—	5.25	V
Dropout Voltage (V_{DO})	Maximum Current = 50 mA	—	10	—	mV/mA
Output Voltage (V_{DD})	2.1 V operation (REG0MD = 0) 2.6 V operation (REG0MD = 1)	2.0 2.5	2.1 2.6	2.25 2.75	V
Bias Current		—	1	9	µA
Dropout Indicator Detection Threshold	With respect to VDD	–0.21	—	–0.02	V
Output Voltage Temperature Coefficient		—	0.29	—	mV/°C
VREG Settling Time	50 mA load with V_{REGIN} = 2.4 V and V_{DD} load capacitor of 4.8 µF	—	450	—	µs
***Note:** The minimum input voltage is 1.8 V or V_{DD} + V_{DO}(max load), whichever is greater					

Table 5.9. ADC0 Electrical Characteristics

VDDA = 1.8 to 2.75 V, –40 to +125 °C, VREF = 1.5 V (REFSL=0) unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
DC Accuracy					
Resolution			12		bits
Integral Nonlinearity		—	±0.5	±3	LSB
Differential Nonlinearity	Guaranteed Monotonic	—	±0.5	±1	LSB
Offset Error[1]		–10	3.0	10	LSB
Full Scale Error		–20	5.7	20	LSB
Offset Temperature Coefficient		—	7.7	—	ppm/°C
Dynamic performance (10 kHz sine-wave single-ended input, 1 dB below Full Scale, 200 ksps)					
Signal-to-Noise Plus Distortion		63	65	—	dB
Total Harmonic Distortion	Up to the 5th harmonic;	—	80	—	dB
Spurious-Free Dynamic Range		—	-82	—	dB
Conversion Rate					
SAR Conversion Clock		—	—	3.6	MHz
Conversion Time in SAR Clocks[2]		13	—	—	clocks
Track/Hold Acquisition Time[3]	VDDA ≥ 2.0 V VDDA < 2.0 V	1.5 3.5	— —	— —	µs
Throughput Rate[4]	VDDA ≥ 2.0 V	—	—	200	ksps
Analog Inputs					
ADC Input Voltage Range[5]	gain = 1.0 (default) gain = n	0 0	—	VREF VREF / n	V
Absolute Pin Voltage with respect to GND		0	—	V_{IO}	V
Sampling Capacitance		—	31	—	pF
Input Multiplexer Impedance		—	3	—	kΩ
Power Specifications					
Power Supply Current (VDDA supplied to ADC0)	Operating Mode, 200 ksps	—	1100	1500	µA
Burst Mode (Idle)		—	1100	1500	µA
Power-On Time		5	—	—	µs
Power Supply Rejection		—	–60	—	mV/V

Notes:

1. Represents one standard deviation from the mean. Offset and full-scale error can be removed through calibration.
2. An additional 2 FCLK cycles are required to start and complete a conversion
3. Additional tracking time may be required depending on the output impedance connected to the ADC input. See Section "6.2.1. Settling Time Requirements" on page 52.
4. An increase in tracking time will decrease the ADC throughput.
5. See Section "6.3. Selectable Gain" on page 53 for more information about the setting the gain.

Table 5.10. Temperature Sensor Electrical Characteristics

VDDA = 1.8 to 2.75 V, –40 to +125 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Linearity		—	±0.1	—	°C
Slope		—	3.33	—	mV/°C
Slope Error*		—	88	—	µV/°C
Offset	Temp = 0 °C	—	856	—	mV
Offset Error*	Temp = 0 °C	—	±14	—	mV
Power Supply Current		—	18	—	µA
Tracking Time		12	—	—	µs
***Note:** Represents one standard deviation from the mean.					

Table 5.11. Voltage Reference Electrical Characteristics

VDDA = 1.8 to 2.75 V, –40 to +125 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Internal Reference (REFBE = 1)					
Output Voltage	25 °C ambient (REFLV = 0)	1.45	1.50	1.55	V
	25 °C ambient (REFLV = 1), V_{DD} = 2.6 V	2.15	2.20	2.25	
VREF Short-Circuit Current		—	5	10	mA
VREF Temperature Coefficient		—	38	—	ppm/°C
Power Consumption	Internal	—	30	50	µA
Load Regulation	Load = 0 to 200 µA to AGND	—	3	—	µV/µA
VREF Turn-on Time 1	4.7 µF tantalum and 0.1 µF bypass	—	1.5	—	ms
VREF Turn-on Time 2	0.1 µF bypass	—	46	—	µs
Power Supply Rejection		—	1.2	—	mV/V
External Reference (REFBE = 0)					
Input Voltage Range		1.5	—	V_{DDA}	V
Input Current	Sample Rate = 200 ksps; VREF = 1.5 V	—	2.1	—	µA
Power Specifications					
Reference Bias Generator	REFBE = 1 or TEMPE = 1	—	21	40	µA

Table 5.12. Comparator 0 and Comparator 1 Electrical Characteristics

VIO = 1.8 to 5.25 V, –40 to +125 °C unless otherwise noted.

Parameter	Conditions	Min	Typ	Max	Units
Response Time: Mode 0, Vcm* = 1.5 V	CPn+ – CPn– = 100 mV	—	330	—	ns
	CPn+ – CPn– = –100 mV	—	390	—	ns
Response Time: Mode 1, Vcm* = 1.5 V	CPn+ – CPn– = 100 mV	—	490	—	ns
	CPn+ – CPn– = –100 mV	—	610	—	ns
Response Time: Mode 2, Vcm* = 1.5 V	CPn+ – CPn– = 100 mV	—	590	—	ns
	CP0+ – CP0– = –100 mV	—	750	—	ns
Response Time: Mode 3, Vcm* = 1.5 V	CPn+ – CPn– = 100 mV	—	2300	—	ns
	CPn+ – CPn– = –100 mV	—	3100	—	ns
Common-Mode Rejection Ratio		—	2.1	13	mV/V
Positive Hysteresis 1	CPnHYP1–0 = 00	-2	0	2	mV
Positive Hysteresis 2	CPnHYP1–0 = 01	2	6	10	mV
Positive Hysteresis 3	CPnHYP1–0 = 10	5	11	20	mV
Positive Hysteresis 4	CPnHYP1–0 = 11	13	21	40	mV
Negative Hysteresis 1	CPnHYN1–0 = 00	-2	0	2	mV
Negative Hysteresis 2	CPnHYN1–0 = 01	2	5	10	mV
Negative Hysteresis 3	CPnHYN1–0 = 10	5	11	20	mV
Negative Hysteresis 4	CPnHYN1–0 = 11	13	21	40	mV
Inverting or Non-Inverting Input Voltage Range		–0.25	—	V_{IO} + 0.25	V
Input Capacitance		—	8	—	pF
Input Offset Voltage		–10	—	+10	mV
Power Supply					
Power Supply Rejection		—	0.18	—	mV/V
Power-up Time		—	3	—	µs
Supply Current at DC	Mode 0	—	6.3	20	µA
	Mode 1	—	3.4	10	µA
	Mode 2	—	2.6	7.5	µA
	Mode 3	—	0.6	3	µA

***Note:** Vcm is the common-mode voltage on CP0+ and CP0–.

6. 12-Bit ADC (ADC0)

The ADC0 on the C8051F55x/56x/57x consists of an analog multiplexer (AMUX0) with 33, 25, or 18 total input selections and a 200 ksps, 12-bit successive-approximation-register (SAR) ADC with integrated track-and-hold, programmable window detector, programmable attenuation (1:2), and hardware accumulator. The ADC0 subsystem has a special Burst Mode which can automatically enable ADC0, capture and accumulate samples, then place ADC0 in a low power shutdown mode without CPU intervention. The AMUX0, data conversion modes, and window detector are all configurable under software control via the Special Function Registers shows in Figure 6.1. ADC0 inputs are single-ended and may be configured to measure P0.0-P3.7, the Temperature Sensor output, V_{DD}, or GND with respect to GND. The voltage reference for ADC0 is selected as described in Section "6.6. Temperature Sensor" on page 67. ADC0 is enabled when the AD0EN bit in the ADC0 Control register (ADC0CN) is set to logic 1, or when performing conversions in Burst Mode. ADC0 is in low power shutdown when AD0EN is logic 0 and no Burst Mode conversions are taking place.

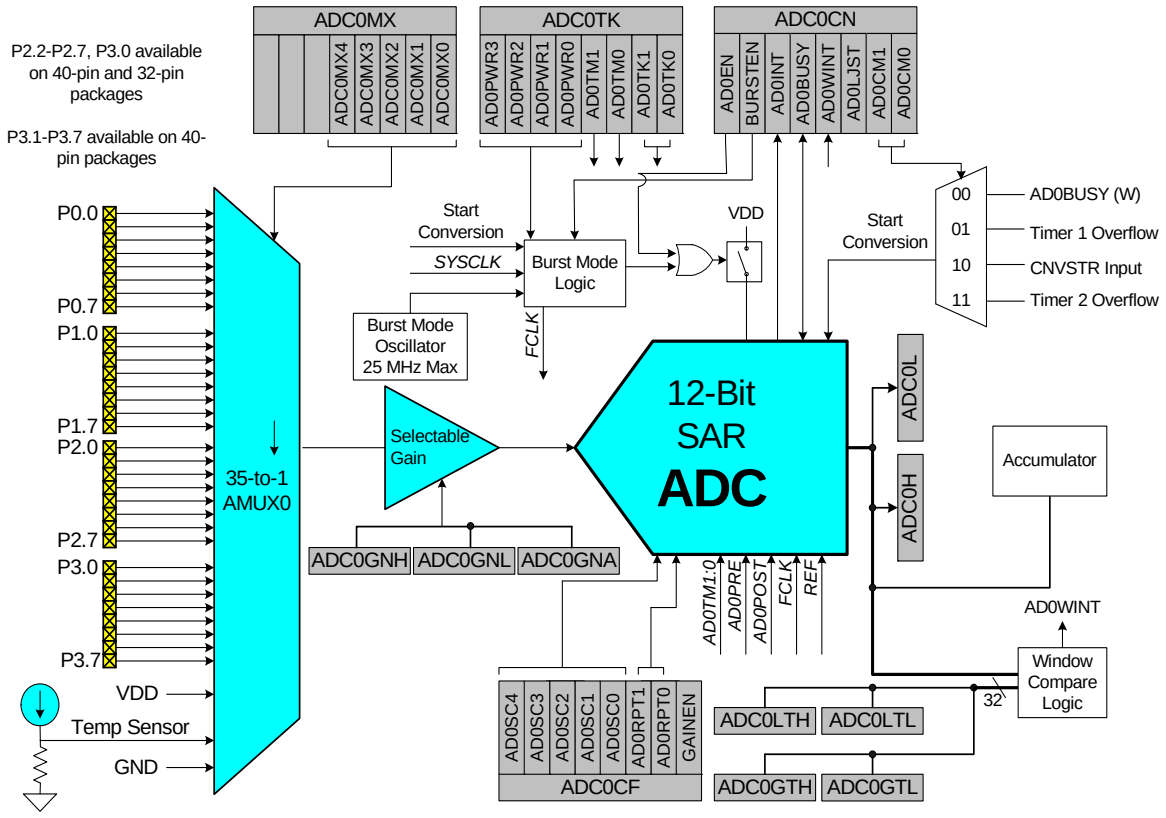


Figure 6.1. ADC0 Functional Block Diagram

6.1. Modes of Operation

In a typical system, ADC0 is configured using the following steps:

1. If a gain adjustment is required, refer to Section “6.3. Selectable Gain” on page 53.
2. Choose the start of conversion source.
3. Choose Normal Mode or Burst Mode operation.
4. If Burst Mode, choose the ADC0 Idle Power State and set the Power-up Time.
5. Choose the tracking mode. Note that Pre-Tracking Mode can only be used with Normal Mode.
6. Calculate the required settling time and set the post convert-start tracking time using the AD0TK bits.
7. Choose the repeat count.
8. Choose the output word justification (Right-Justified or Left-Justified).
9. Enable or disable the End of Conversion and Window Comparator Interrupts.

6.1.1. Starting a Conversion

A conversion can be initiated in one of four ways, depending on the programmed states of the ADC0 Start of Conversion Mode bits (AD0CM1–0) in register ADC0CN. Conversions may be initiated by one of the following:

- Writing a 1 to the AD0BUSY bit of register ADC0CN
- A rising edge on the CNVSTR input signal (pin P0.1)
- A Timer 1 overflow (i.e., timed continuous conversions)
- A Timer 2 overflow (i.e., timed continuous conversions)

Writing a 1 to AD0BUSY provides software control of ADC0 whereby conversions are performed "on-demand.” During conversion, the AD0BUSY bit is set to logic 1 and reset to logic 0 when the conversion is complete. The falling edge of AD0BUSY triggers an interrupt (when enabled) and sets the ADC0 interrupt flag (AD0INT). Note: When polling for ADC conversion completions, the ADC0 interrupt flag (AD0INT) should be used. Converted data is available in the ADC0 data registers, ADC0H:ADC0L, when bit AD0INT is logic 1. Note that when Timer 2 overflows are used as the conversion source, Low Byte overflows are used if Timer2 is in 8-bit mode; High byte overflows are used if Timer 2 is in 16-bit mode. See Section “25. Timers” on page 259 for timer configuration.

Important Note About Using CNVSTR: The CNVSTR input pin also functions as Port pin P0.1. When the CNVSTR input is used as the ADC0 conversion source, Port pin P0.1 should be skipped by the Digital Crossbar. To configure the Crossbar to skip P0.1, set to 1 Bit1 in register P0SKIP. See Section “19. Port Input/Output” on page 169 for details on Port I/O configuration.

6.1.2. Tracking Modes

Each ADC0 conversion must be preceded by a minimum tracking time for the converted result to be accurate. ADC0 has three tracking modes: Pre-Tracking, Post-Tracking, and Dual-Tracking. Pre-Tracking Mode provides the minimum delay between the convert start signal and end of conversion by tracking continuously before the convert start signal. This mode requires software management in order to meet minimum tracking requirements. In Post-Tracking Mode, a programmable tracking time starts after the convert start signal and is managed by hardware. Dual-Tracking Mode maximizes tracking time by tracking before and after the convert start signal. Figure 6.2 shows examples of the three tracking modes.

Pre-Tracking Mode is selected when AD0TM is set to 10b. Conversions are started immediately following the convert start signal. ADC0 is tracking continuously when not performing a conversion. Software must allow at least the minimum tracking time between each end of conversion and the next convert start signal. The minimum tracking time must also be met prior to the first convert start signal after ADC0 is enabled.

Post-Tracking Mode is selected when AD0TM is set to 01b. A programmable tracking time based on AD0TK is started immediately following the convert start signal. Conversions are started after the programmed tracking time ends. After a conversion is complete, ADC0 does not track the input. Rather, the sampling capacitor remains disconnected from the input making the input pin high-impedance until the next convert start signal.

Dual-Tracking Mode is selected when AD0TM is set to 11b. A programmable tracking time based on AD0TK is started immediately following the convert start signal. Conversions are started after the programmed tracking time ends. After a conversion is complete, ADC0 tracks continuously until the next conversion is started.

Depending on the output connected to the ADC input, additional tracking time, more than is specified in Table 5.9, may be required after changing MUX settings. See the settling time requirements described in Section “6.2.1. Settling Time Requirements” on page 52.

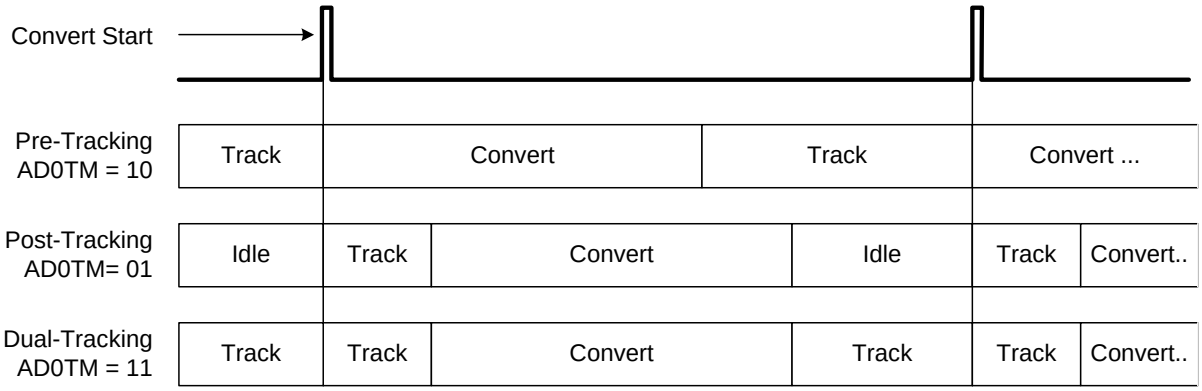


Figure 6.2. ADC0 Tracking Modes

6.1.3. Timing

ADC0 has a maximum conversion speed specified in Table 5.9. ADC0 is clocked from the ADC0 Subsystem Clock (FCLK). The source of FCLK is selected based on the BURSTEN bit. When BURSTEN is logic 0, FCLK is derived from the current system clock. When BURSTEN is logic 1, FCLK is derived from the Burst Mode Oscillator, an independent clock source with a maximum frequency of 25 MHz.

When ADC0 is performing a conversion, it requires a clock source that is typically slower than FCLK. The ADC0 SAR conversion clock (SAR clock) is a divided version of FCLK. The divide ratio can be configured using the AD0SC bits in the ADC0CF register. The maximum SAR clock frequency is listed in Table 5.9.

ADC0 can be in one of three states at any given time: tracking, converting, or idle. Tracking time depends on the tracking mode selected. For Pre-Tracking Mode, tracking is managed by software and ADC0 starts conversions immediately following the convert start signal. For Post-Tracking and Dual-Tracking Modes, the tracking time after the convert start signal is equal to the value determined by the AD0TK bits plus 2 FCLK cycles. Tracking is immediately followed by a conversion. The ADC0 conversion time is always 13 SAR clock cycles plus an additional 2 FCLK cycles to start and complete a conversion. Figure 6.3 shows timing diagrams for a conversion in Pre-Tracking Mode and tracking plus conversion in Post-Tracking or Dual-Tracking Mode. In this example, repeat count is set to one.

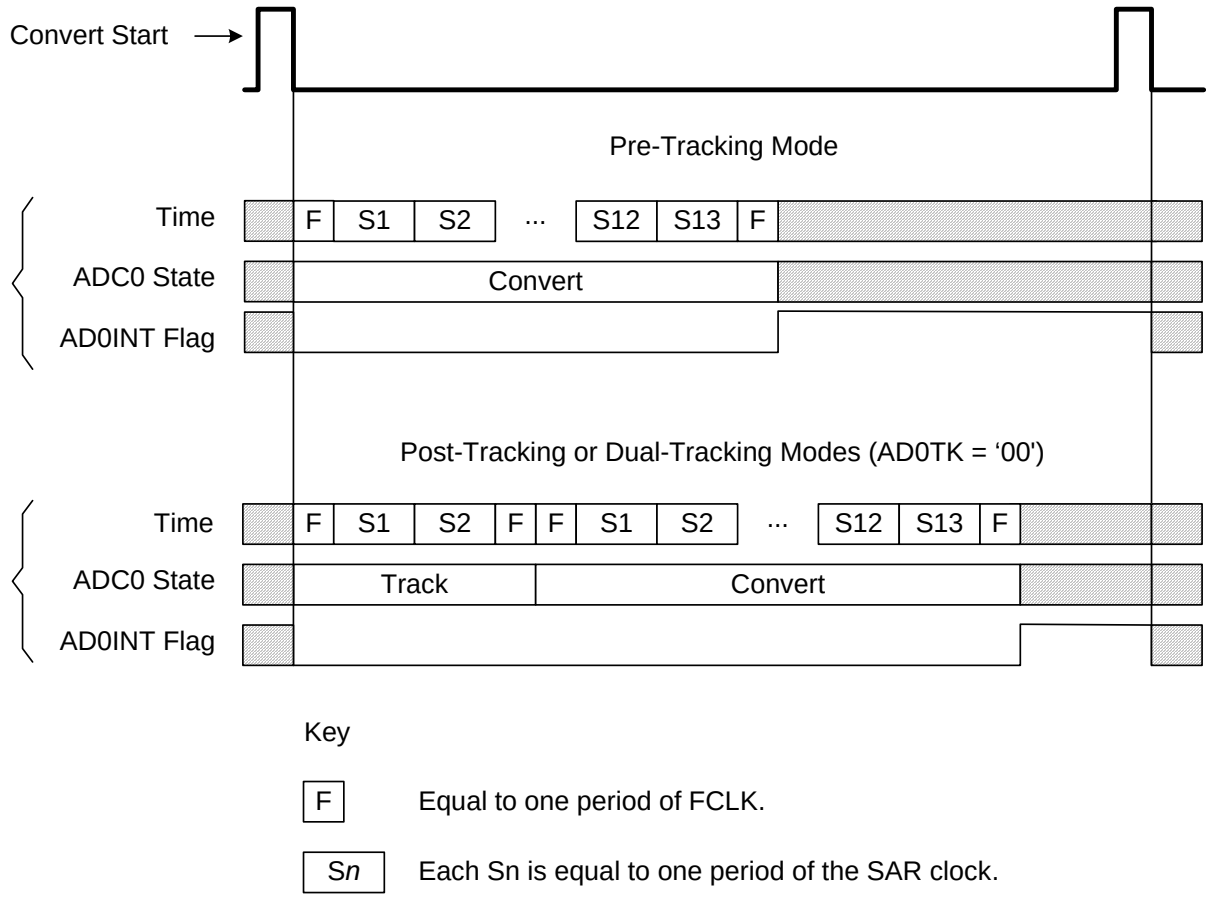


Figure 6.3. 12-Bit ADC Tracking Mode Example

6.1.4. Burst Mode

Burst Mode is a power saving feature that allows ADC0 to remain in a very low power state between conversions. When Burst Mode is enabled, ADC0 wakes from a very low power state, accumulates 1, 4, 8, or 16 samples using an internal Burst Mode clock (approximately 25 MHz), then re-enters a very low power state. Since the Burst Mode clock is independent of the system clock, ADC0 can perform multiple conversions then enter a very low power state within a single system clock cycle, even if the system clock is slow (e.g., 32.768 kHz), or suspended.

Burst Mode is enabled by setting BURSTEN to logic 1. When in Burst Mode, AD0EN controls the ADC0 idle power state (i.e. the state ADC0 enters when not tracking or performing conversions). If AD0EN is set to logic 0, ADC0 is powered down after each burst. If AD0EN is set to logic 1, ADC0 remains enabled after each burst. On each convert start signal, ADC0 is awakened from its Idle Power State. If ADC0 is powered down, it will automatically power up and wait the programmable Power-up Time controlled by the AD0PWR bits. Otherwise, ADC0 will start tracking and converting immediately. Figure 6.4 shows an example of Burst Mode Operation with a slow system clock and a repeat count of 4.

Important Note: When Burst Mode is enabled, only Post-Tracking and Dual-Tracking modes can be used.

When Burst Mode is enabled, a single convert start will initiate a number of conversions equal to the repeat count. When Burst Mode is disabled, a convert start is required to initiate each conversion. In both modes, the ADC0 End of Conversion Interrupt Flag (AD0INT) will be set after “repeat count” conversions have

been accumulated. Similarly, the Window Comparator will not compare the result to the greater-than and less-than registers until “repeat count” conversions have been accumulated.

Note: When using Burst Mode, care must be taken to issue a convert start signal no faster than once every four SYSCLK periods. This includes external convert start signals.

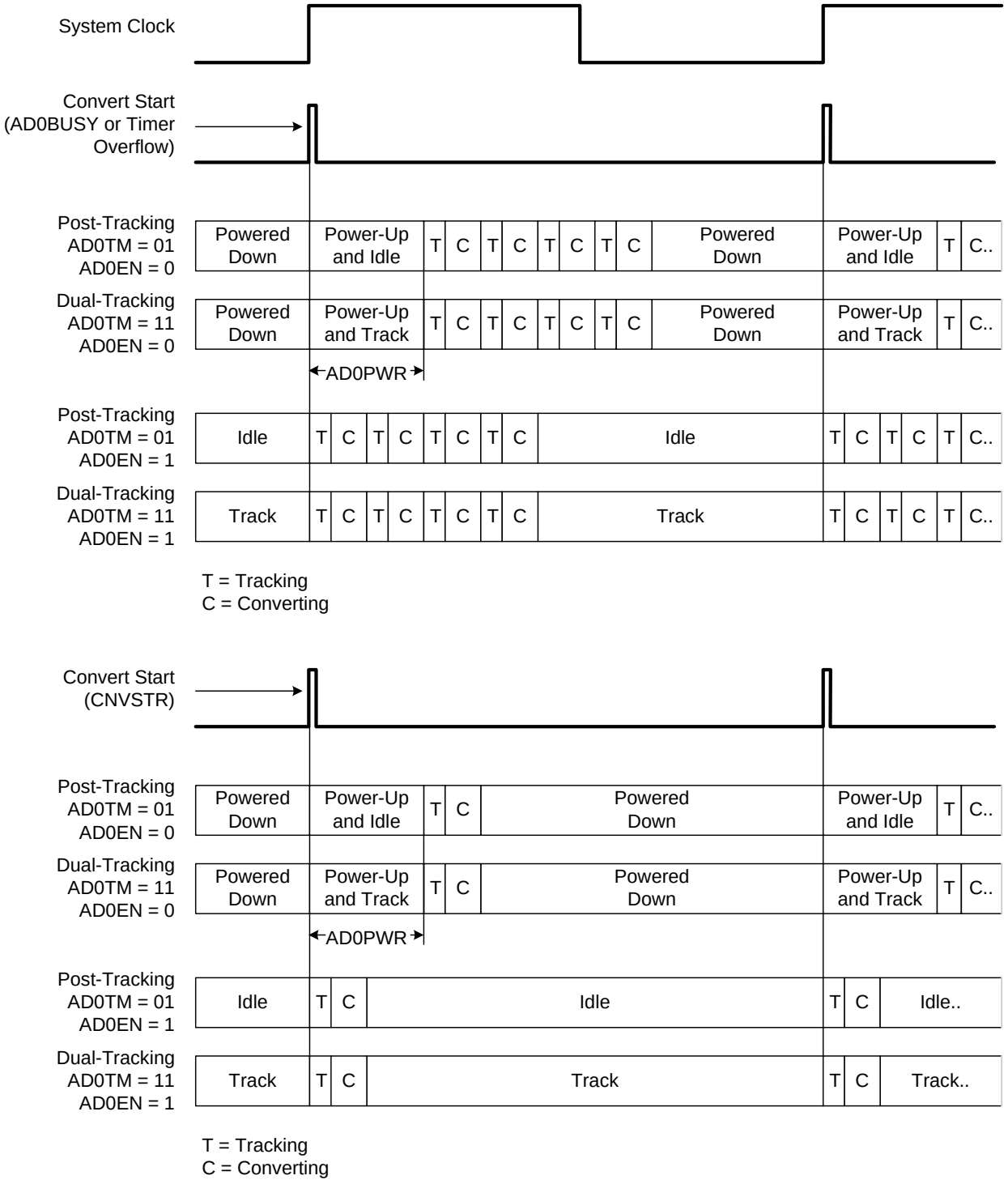


Figure 6.4. 12-Bit ADC Burst Mode Example With Repeat Count Set to 4

6.2. Output Code Formatting

The registers ADC0H and ADC0L contain the high and low bytes of the output conversion code. When the repeat count is set to 1, conversion codes are represented in 12-bit unsigned integer format and the output conversion code is updated after each conversion. Inputs are measured from 0 to V_{REF} x 4095/4096. Data can be right-justified or left-justified, depending on the setting of the AD0LJST bit (ADC0CN.2). Unused bits in the ADC0H and ADC0L registers are set to 0. Example codes are shown below for both right-justified and left-justified data.

Input Voltage	Right-Justified ADC0H:ADC0L (AD0LJST = 0)	Left-Justified ADC0H:ADC0L (AD0LJST = 1)
VREF x 4095/4096	0x0FFF	0xFFF0
VREF x 2048/4096	0x0800	0x8000
VREF x 2047/4096	0x07FF	0x7FF0
0	0x0000	0x0000

When the ADC0 Repeat Count is greater than 1, the output conversion code represents the accumulated result of the conversions performed and is updated after the last conversion in the series is finished. Sets of 4, 8, or 16 consecutive samples can be accumulated and represented in unsigned integer format. The repeat count can be selected using the AD0RPT bits in the ADC0CF register. The value must be right-justified (AD0LJST = 0), and unused bits in the ADC0H and ADC0L registers are set to 0. The following example shows right-justified codes for repeat counts greater than 1. Notice that accumulating 2^n samples is equivalent to left-shifting by *n* bit positions when all samples returned from the ADC have the same value.

Input Voltage	Repeat Count = 4	Repeat Count = 8	Repeat Count = 16
V_{REF} x 4095/4096	0x3FFC	0x7FF8	0xFFF0
V_{REF} x 2048/4096	0x2000	0x4000	0x8000
V_{REF} x 2047/4096	0x1FFC	0x3FF8	0x7FF0
0	0x0000	0x0000	0x0000

6.2.1. Settling Time Requirements

A minimum tracking time is required before an accurate conversion is performed. This tracking time is determined by any series impedance, including the AMUX0 resistance, the ADC0 sampling capacitance, and the accuracy required for the conversion.

Figure 6.5 shows the equivalent ADC0 input circuit. The required ADC0 settling time for a given settling accuracy (SA) may be approximated by Equation 6.1. When measuring the Temperature Sensor output, use the settling time specified in Table 5.10. When measuring V_{DD} with respect to GND, R_{TOTAL} reduces to R_{MUX}. See Table 5.9 for ADC0 minimum settling time requirements as well as the mux impedance and sampling capacitor values.

$$t = \ln\left(\frac{2^n}{SA}\right) \times R_{TOTAL} C_{SAMPLE}$$

Equation 6.1. ADC0 Settling Time Requirements

Where:
SA is the settling accuracy, given as a fraction of an LSB (for example, 0.25 to settle within 1/4 LSB).
t is the required settling time in seconds. R_{TOTAL} is the sum of the AMUX0 resistance and any external source resistance. *n* is the ADC resolution in bits (10).

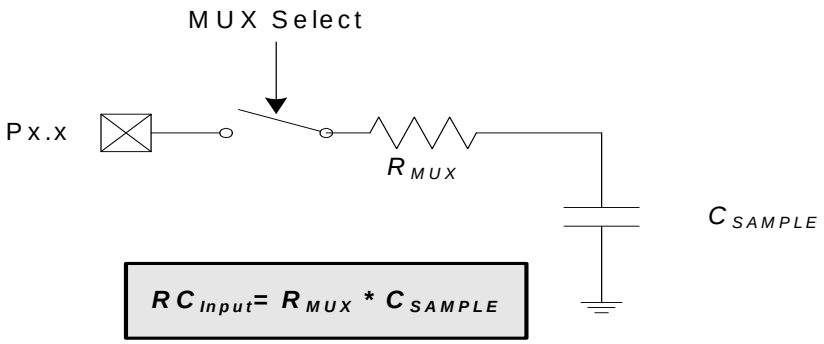


Figure 6.5. ADC0 Equivalent Input Circuit

6.3. Selectable Gain

ADC0 on the C8051F55x/56x/57x family of devices implements a selectable gain adjustment option. By writing a value to the gain adjust address range, the user can select gain values between 0 and 1.016.

For example, three analog sources to be measured have full-scale outputs of 5.0 V, 4.0 V, and 3.0 V, respectively. Each ADC measurement would ideally use the full dynamic range of the ADC with an internal voltage reference of 1.5 V or 2.2 V (set to 2.2 V for this example). When selecting the first source (5.0 V full-scale), a gain value of 0.44 (5 V full scale x 0.44 = 2.2 V full scale) provides a full-scale signal of 2.2 V when the input signal is 5.0 V. Likewise, a gain value of 0.55 (4 V full scale x 0.55 = 2.2 V full scale) for the second source and 0.73 (3 V full scale x 0.73 = 2.2 V full scale) for the third source provide full-scale ADC0 measurements when the input signal is full-scale.

Additionally, some sensors or other input sources have small part-to-part variations that must be accounted for to achieve accurate results. In this case, the programmable gain value could be used as a calibration value to eliminate these part-to-part variations.

6.3.1. Calculating the Gain Value

The ADC0 selectable gain feature is controlled by 13 bits in three registers. ADC0GNH contains the 8 upper bits of the gain value and ADC0GNL contains the 4 lower bits of the gain value. The final GAINADD bit (ADC0GNA.0) controls an optional extra 1/64 (0.016) of gain that can be added in addition to the ADC0GNH and ADC0GNL gain. The ADC0GNA.0 bit is set to 1 after a power-on reset.

The equivalent gain for the ADC0GNH, ADC0GNL and ADC0GNA registers is as follows:

$$gain = \left(\frac{GAIN}{4096}\right) + GAINADD \times \left(\frac{1}{64}\right)$$

Equation 6.2. Equivalent Gain from the ADC0GNH and ADC0GNL Registers

Where:
GAIN is the 12-bit word of ADC0GNH[7:0] and ADC0GNL[7:4]
GAINADD is the value of the GAINADD bit (ADC0GNA.0)
gain is the equivalent gain value from 0 to 1.016

For example, if ADC0GNH = 0xFC, ADC0GNL = 0x00, and GAINADD = 1, GAIN = 0xFC0 = 4032, and the resulting equation is as follows:

$$GAIN = \left(\frac{4032}{4096}\right) + 1 \times \left(\frac{1}{64}\right) = 0.984 + 0.016 = 1.0$$

The table below equates values in the ADC0GNH, ADC0GNL, and ADC0GNA registers to the equivalent gain using this equation.

ADC0GNH Value	ADC0GNL Value	GAINADD Value	GAIN Value	Equivalent Gain
0xFC (default)	0x00 (default)	1 (default)	4032 + 64	1.0 (default)
0x7C	0x00	1	1984 + 64	0.5
0xBC	0x00	1	3008 + 64	0.75
0x3C	0x00	1	960 + 64	0.25
0xFF	0xF0	0	4095 + 0	~1.0
0xFF	0xF0	1	4096 + 64	1.016

For any desired gain value, the GAIN registers can be calculated by the following:

$$GAIN = \left(gain - GAINADD \times \left(\frac{1}{64}\right)\right) \times 4096$$

Equation 6.3. Calculating the ADC0GNH and ADC0GNL Values from the Desired Gain

Where:
GAIN is the 12-bit word of ADC0GNH[7:0] and ADC0GNL[7:4]
GAINADD is the value of the GAINADD bit (ADC0GNA.0)
gain is the equivalent gain value from 0 to 1.016

When calculating the value of GAIN to load into the ADC0GNH and ADC0GNL registers, the GAINADD bit can be turned on or off to reach a value closer to the desired gain value.

For example, the initial example in this section requires a gain of 0.44 to convert 5 V full scale to 2.2 V full scale. Using Equation 6.3:

$$GAIN = \left(0.44 - GAINADD \times \left(\frac{1}{64}\right)\right) \times 4096$$

If GAINADD is set to 1, this makes the equation:

$$GAIN = \left(0.44 - 1 \times \left(\frac{1}{64}\right)\right) \times 4096 = 0.424 \times 4096 = 1738 = 0x06CA$$

The actual gain from setting GAINADD to 1 and ADC0GNH and ADC0GNL to 0x6CA is 0.4399. A similar gain can be achieved if GAINADD is set to 0 with a different value for ADC0GNH and ADC0GNL.

6.3.2. Setting the Gain Value

The three programmable gain registers are accessed indirectly using the ADC0H and ADC0L registers when the GAINEN bit (ADC0CF.0) bit is set. ADC0H acts as the address register, and ADC0L is the data register. The programmable gain registers can only be written to and cannot be read. See Gain Register Definition 6.1, Gain Register Definition 6.2, and Gain Register Definition 6.3 for more information.

The gain is programmed using the following steps:

1. Set the GAINEN bit (ADC0CF.0)
2. Load the ADC0H with the ADC0GNH, ADC0GNL, or ADC0GNA address.
3. Load ADC0L with the desired value for the selected gain register.
4. Reset the GAINEN bit (ADC0CF.0)

Notes:

1. An ADC conversion should not be performed while the GAINEN bit is set.
2. Even with gain enabled, the maximum input voltage must be less than V_{REGIN} and the maximum voltage of the signal after gain must be less than or equal to V_{REF}.

In code, changing the value to 0.44 gain from the previous example looks like:

```
// in 'C':
ADC0CF |= 0x01;          // GAINEN = 1
ADC0H = 0x04;            // Load the ADC0GNH address
ADC0L = 0x6C;            // Load the upper byte of 0x6CA to ADC0GNH
ADC0H = 0x07;            // Load the ADC0GNL address
ADC0L = 0xA0;            // Load the lower nibble of 0x6CA to ADC0GNL
ADC0H = 0x08;            // Load the ADC0GNA address
ADC0L = 0x01;            // Set the GAINADD bit
ADC0CF &= ~0x01;         // GAINEN = 0

; in assembly
ORL ADC0CF,#01H          ; GAINEN = 1
MOV ADC0H,#04H           ; Load the ADC0GNH address
MOV ADC0L,#06CH          ; Load the upper byte of 0x6CA to ADC0GNH
MOV ADC0H,#07H           ; Load the ADC0GNL address
MOV ADC0L,#0A0H          ; Load the lower nibble of 0x6CA to ADC0GNL
MOV ADC0H,#08H           ; Load the ADC0GNA address
MOV ADC0L,#01H           ; Set the GAINADD bit
ANL ADC0CF,#0FEH         ; GAINEN = 0
```

Gain Register Definition 6.1. ADC0GNH: ADC0 Selectable Gain High Byte

Bit	7	6	5	4	3	2	1	0
Name	GAINH[7:0]							
Type	W							
Reset	1	1	1	1	1	1	0	0

Indirect Address = 0x04;

Bit	Name	Function
7:0	GAINH[7:0]	**ADC0 Gain High Byte.** See Section 6.3.1 for details on calculating the value for this register.
Note: This register is accessed indirectly; See Section 6.3.2 for details for writing this register.		

Gain Register Definition 6.2. ADC0GNL: ADC0 Selectable Gain Low Byte

Bit	7	6	5	4	3	2	1	0
Name	GAINL[3:0]				Reserved	Reserved	Reserved	Reserved
Type	W				W	W	W	W
Reset	0	0	0	0	0	0	0	0

Indirect Address = 0x07;

Bit	Name	Function
7:4	GAINL[3:0]	**ADC0 Gain Lower 4 Bits.** See Figure 6.3.1 for details for setting this register. This register is only accessed indirectly through the ADC0H and ADC0L register.
3:0	Reserved	Must Write 0000b
Note: This register is accessed indirectly; See Section 6.3.2 for details for writing this register.		

Gain Register Definition 6.3. ADC0GNA: ADC0 Additional Selectable Gain

Bit	7	6	5	4	3	2	1	0
Name	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	GAINADD
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	1

Indirect Address = 0x08;

Bit	Name	Function
7:1	Reserved	Must Write 0000000b.
0	GAINADD	**ADC0 Additional Gain Bit.** Setting this bit add 1/64 (0.016) gain to the gain value in the ADC0GNH and ADC0GNL registers.
Note: This register is accessed indirectly; See Section 6.3.2 for details for writing this register.		

SFR Definition 6.4. ADC0CF: ADC0 Configuration

Bit	7	6	5	4	3	2	1	0
Name	AD0SC[4:0]					AD0RPT[1:0]		GAINEN
Type	R/W					R/W	R/W	R/W
Reset	1	1	1	1	1	0	0	0

SFR Address = 0xBC; SFR Page = 0x00

Bit	Name	Function
7:3	AD0SC[4:0]	**ADC0 SAR Conversion Clock Period Bits.** SAR Conversion clock is derived from system clock by the following equation, where *AD0SC* refers to the 5-bit value held in bits AD0SC4–0. SAR Conversion clock requirements are given in the ADC specification table BURSTEN = 0: FCLK is the current system clock BURSTEN = 1: FCLK is a maximum of 30 MHz, independent of the current system clock.. $AD0SC = \frac{FCLK}{CLK_{SAR}} - 1$ **Note:** Round up the result of the calculation for AD0SC
2:1	A0RPT[1:0]	**ADC0 Repeat Count.** Controls the number of conversions taken and accumulated between ADC0 End of Conversion (ADCINT) and ADC0 Window Comparator (ADCWINT) interrupts. A convert start is required for each conversion unless Burst Mode is enabled. In Burst Mode, a single convert start can initiate multiple self-timed conversions. Results in both modes are accumulated in the ADC0H:ADC0L register. **When AD0RPT1–0 are set to a value other than '00', the AD0LJST bit in the ADC0CN register must be set to '0' (right justified).** 00: 1 conversion is performed. 01: 4 conversions are performed and accumulated. 10: 8 conversions are performed and accumulated. 11: 16 conversions are performed and accumulated.
0	GAINEN	**Gain Enable Bit.** Controls the gain programming. Refer to Section “6.3. Selectable Gain” on page 53 for information about using this bit.

SFR Definition 6.5. ADC0H: ADC0 Data Word MSB

Bit	7	6	5	4	3	2	1	0
Name	ADC0H[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xBE; SFR Page = 0x00

Bit	Name	Function
7:0	ADC0H[7:0]	**ADC0 Data Word High-Order Bits.** For AD0LJST = 0 and AD0RPT as follows: 00: Bits 3–0 are the upper 4 bits of the 12-bit result. Bits 7–4 are 0000b. 01: Bits 4–0 are the upper 5 bits of the 14-bit result. Bits 7–5 are 000b. 10: Bits 5–0 are the upper 6 bits of the 15-bit result. Bits 7–6 are 00b. 11: Bits 7–0 are the upper 8 bits of the 16-bit result. For AD0LJST = 1 (AD0RPT must be 00): Bits 7–0 are the most-significant bits of the ADC0 12-bit result.

SFR Definition 6.6. ADC0L: ADC0 Data Word LSB

Bit	7	6	5	4	3	2	1	0
Name	ADC0L[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xBD; SFR Page = 0x00

Bit	Name	Function
7:0	ADC0L[7:0]	**ADC0 Data Word Low-Order Bits.** For AD0LJST = 0: Bits 7–0 are the lower 8 bits of the ADC0 Accumulated Result. For AD0LJST = 1 (AD0RPT must be '00'): Bits 7–4 are the lower 4 bits of the 12-bit result. Bits 3–0 are 0000b.

SFR Definition 6.7. ADC0CN: ADC0 Control

Bit	7	6	5	4	3	2	1	0
Name	AD0EN	BURSTEN	AD0INT	AD0BUSY	AD0WINT	AD0LJST	AD0CM[1:0]	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE8; SFR Page = 0x00; Bit-Addressable

Bit	Name	Function		
7	AD0EN	**ADC0 Enable Bit.** 0: ADC0 Disabled. ADC0 is in low-power shutdown. 1: ADC0 Enabled. ADC0 is active and ready for data conversions.		
6	BURSTEN	**ADC0 Burst Mode Enable Bit.** 0: Burst Mode Disabled. 1: Burst Mode Enabled.		
5	AD0INT	**ADC0 Conversion Complete Interrupt Flag.** 0: ADC0 has not completed a data conversion since AD0INT was last cleared. 1: ADC0 has completed a data conversion.		
4	AD0BUSY	**ADC0 Busy Bit.**	**Read:** 0: ADC0 conversion is not in progress. 1: ADC0 conversion is in progress.	**Write:** 0: No Effect. 1: Initiates ADC0 Conversion if AD0CM[1:0] = 00b
3	AD0WINT	**ADC0 Window Compare Interrupt Flag.** This bit must be cleared by software 0: ADC0 Window Comparison Data match has not occurred since this flag was last cleared. 1: ADC0 Window Comparison Data match has occurred.		
2	AD0LJST	**ADC0 Left Justify Select Bit.** 0: Data in ADC0H:ADC0L registers is right-justified 1: Data in ADC0H:ADC0L registers is left-justified. This option should not be used with a repeat count greater than 1 (when AD0RPT[1:0] is 01b, 10b, or 11b).		
1:0	AD0CM[1:0]	**ADC0 Start of Conversion Mode Select.** 00: ADC0 start-of-conversion source is write of 1 to AD0BUSY. 01: ADC0 start-of-conversion source is overflow of Timer 1. 10: ADC0 start-of-conversion source is rising edge of external CNVSTR. 11: ADC0 start-of-conversion source is overflow of Timer 2.		

SFR Definition 6.8. ADC0TK: ADC0 Tracking Mode Select

Bit	7	6	5	4	3	2	1	0
Name	AD0PWR[3:0]				AD0TM[1:0]		AD0TK[1:0]	
Type	R/W				R/W		R/W	
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xBA; SFR Page = 0x00

Bit	Name	Function
7:4	AD0PWR[3:0]	**ADC0 Burst Power-up Time.** For BURSTEN = 0: ADC0 Power state controlled by AD0EN For BURSTEN = 1, AD0EN = 1: ADC0 remains enabled and does not enter the very low power state For BURSTEN = 1, AD0EN = 0: ADC0 enters the very low power state and is enabled after each convert start signal. The Power-up time is programmed according the following equation: $AD0PWR = \frac{Tstartup}{200ns} - 1$ or $Tstartup = (AD0PWR + 1)200ns$
3:2	AD0TM[1:0]	**ADC0 Tracking Mode Enable Select Bits.** 00: Reserved. 01: ADC0 is configured to Post-Tracking Mode. 10: ADC0 is configured to Pre-Tracking Mode. 11: ADC0 is configured to Dual Tracking Mode.
1:0	AD0TK[1:0]	**ADC0 Post-Track Time.** 00: Post-Tracking time is equal to 2 SAR clock cycles + 2 FCLK cycles. 01: Post-Tracking time is equal to 4 SAR clock cycles + 2 FCLK cycles. 10: Post-Tracking time is equal to 8 SAR clock cycles + 2 FCLK cycles. 11: Post-Tracking time is equal to 16 SAR clock cycles + 2 FCLK cycles.

6.4. Programmable Window Detector

The ADC Programmable Window Detector continuously compares the ADC0 output registers to user-programmed limits, and notifies the system when a desired condition is detected. This is especially effective in an interrupt-driven system, saving code space and CPU bandwidth while delivering faster system response times. The window detector interrupt flag (AD0WINT in register ADC0CN) can also be used in polled mode. The ADC0 Greater-Than (ADC0GTH, ADC0GTL) and Less-Than (ADC0LTH, ADC0LTL) registers hold the comparison values. The window detector flag can be programmed to indicate when measured data is inside or outside of the user-programmed limits, depending on the contents of the ADC0 Less-Than and ADC0 Greater-Than registers.

SFR Definition 6.9. ADC0GTH: ADC0 Greater-Than Data High Byte

Bit	7	6	5	4	3	2	1	0
Name	ADC0GTH[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xC4; SFR Page = 0x00

Bit	Name	Function
7:0	ADC0GTH[7:0]	**ADC0 Greater-Than Data Word High-Order Bits.**

SFR Definition 6.10. ADC0GTL: ADC0 Greater-Than Data Low Byte

Bit	7	6	5	4	3	2	1	0
Name	ADC0GTL[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xC3; SFR Page = 0x00

Bit	Name	Function
7:0	ADC0GTL[7:0]	**ADC0 Greater-Than Data Word Low-Order Bits.**

SFR Definition 6.11. ADC0LTH: ADC0 Less-Than Data High Byte

Bit	7	6	5	4	3	2	1	0
Name	ADC0LTH[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xC6; SFR Page = 0x00

Bit	Name	Function
7:0	ADC0LTH[7:0]	**ADC0 Less-Than Data Word High-Order Bits.**

SFR Definition 6.12. ADC0LTL: ADC0 Less-Than Data Low Byte

Bit	7	6	5	4	3	2	1	0
Name	ADC0LTL[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xC5; SFR Page = 0x00

Bit	Name	Function
7:0	ADC0LTL[7:0]	**ADC0 Less-Than Data Word Low-Order Bits.**

6.4.1. Window Detector In Single-Ended Mode

Figure 6.6 shows two example window comparisons for right-justified data with ADC0LTH:ADC0LTL = 0x0200 (512d) and ADC0GTH:ADC0GTL = 0x0100 (256d). The input voltage can range from 0 to V_{REF} x (4095/4096) with respect to GND, and is represented by a 12-bit unsigned integer value. The repeat count is set to one. In the left example, an AD0WINT interrupt will be generated if the ADC0 conversion word (ADC0H:ADC0L) is within the range defined by ADC0GTH:ADC0GTL and ADC0LTH:ADC0LTL (if 0x0100 < ADC0H:ADC0L < 0x0200). In the right example, and AD0WINT interrupt will be generated if the ADC0 conversion word is outside of the range defined by the ADC0GT and ADC0LT registers (if ADC0H:ADC0L < 0x0100 or ADC0H:ADC0L > 0x0200). Figure 6.7 shows an example using left-justified data with the same comparison values.

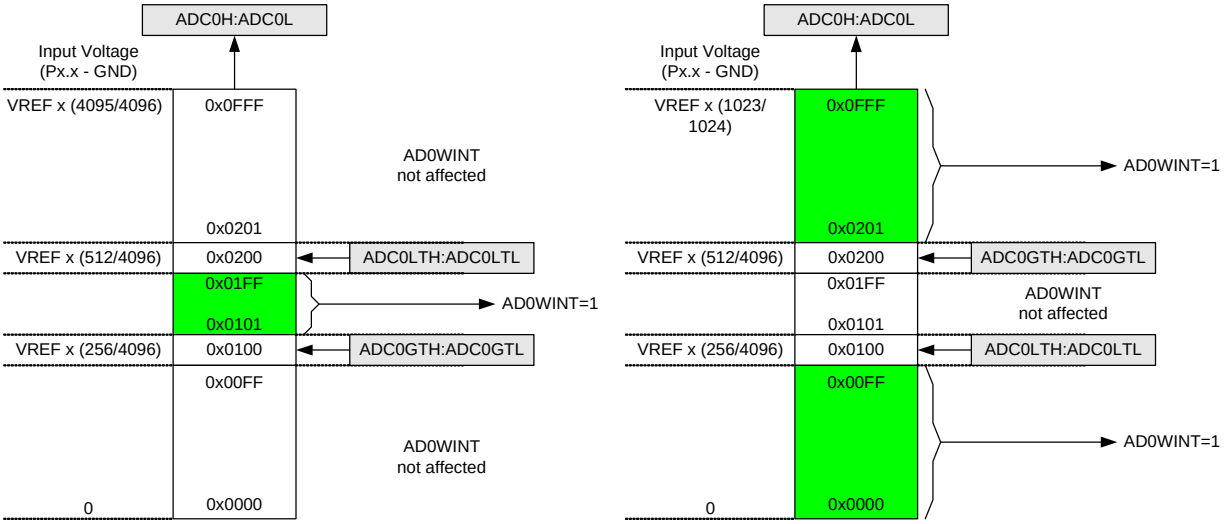


Figure 6.6. ADC Window Compare Example: Right-Justified Data

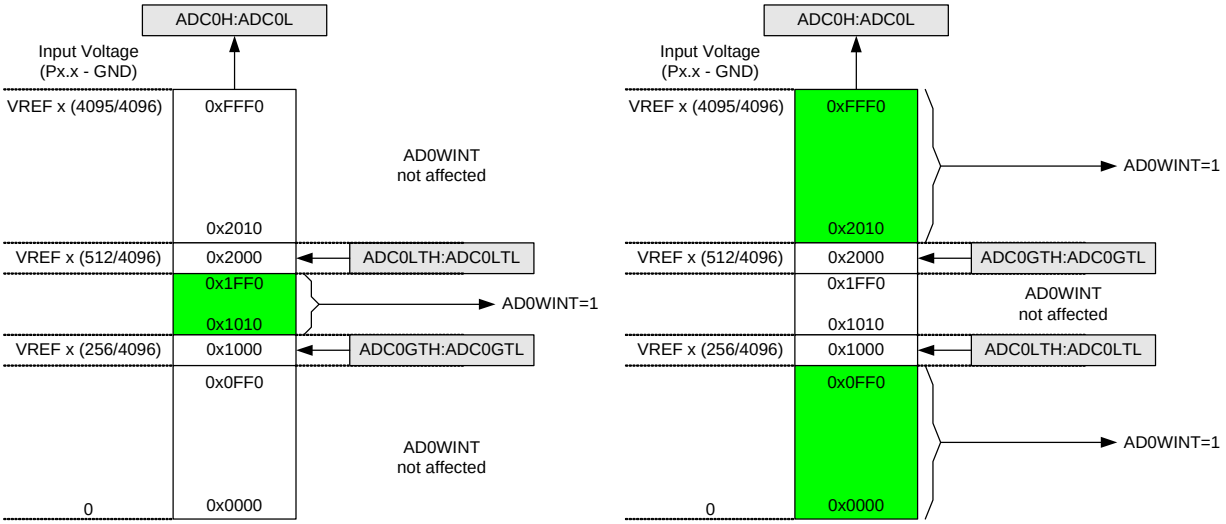


Figure 6.7. ADC Window Compare Example: Left-Justified Data

6.5. ADC0 Analog Multiplexer

ADC0 includes an analog multiplexer to enable multiple analog input sources. Any of the following may be selected as an input: P0.0–P3.7, the on-chip temperature sensor, the core power supply (V_{DD}), or ground (GND). **ADC0 is single-ended and all signals measured are with respect to GND.** The ADC0 input channels are selected using the ADC0MX register as described in SFR Definition 6.13.

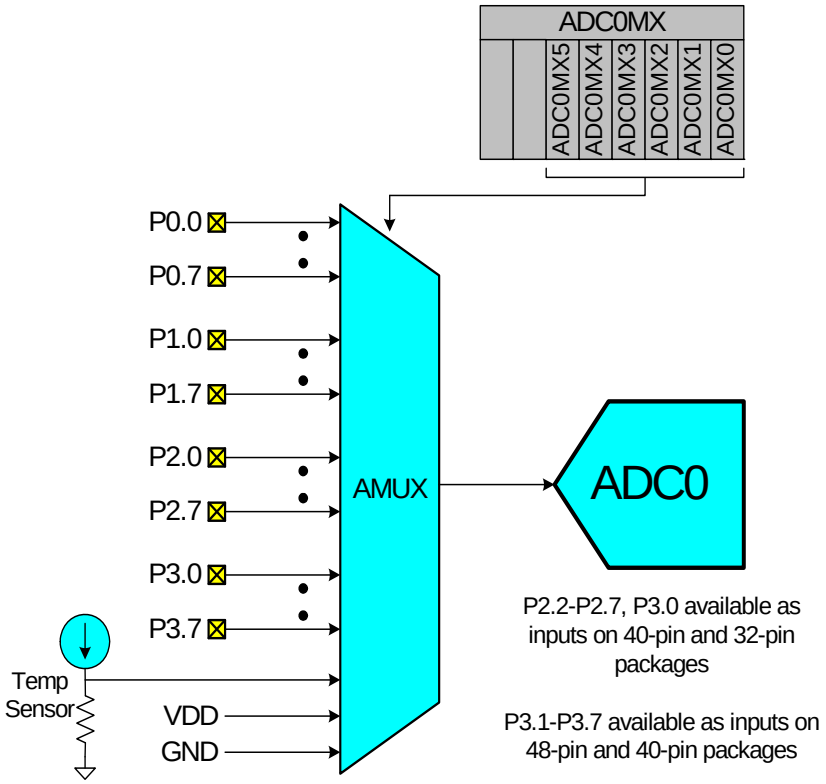


Figure 6.8. ADC0 Multiplexer Block Diagram

Important Note About ADC0 Input Configuration: Port pins selected as ADC0 inputs should be configured as analog inputs, and should be skipped by the Digital Crossbar. To configure a Port pin for analog input, set to 0 the corresponding bit in register PnMDIN. To force the Crossbar to skip a Port pin, set to 1 the corresponding bit in register PnSKIP. See Section “19. Port Input/Output” on page 169 for more Port I/O configuration details.

SFR Definition 6.13. ADC0MX: ADC0 Channel Select

Bit	7	6	5	4	3	2	1	0
Name			ADC0MX[5:0]					
Type	R	R	R/W					
Reset	0	0	1	1	1	1	1	1

SFR Address = 0xBB; SFR Page = 0x00;

Bit	Name	Function
7:6	Unused	Read = 00b; Write = Don't Care.
5:0	AMX0P[5:0]	**AMUX0 Positive Input Selection.** 000000: P0.0 000001: P0.1 000010: P0.2 000011: P0.3 000100: P0.4 000101: P0.5 000110: P0.6 000111: P0.7 001000: P1.0 001001: P1.1 001010: P1.2 001011: P1.3 001100: P1.4 001101: P1.5 001110: P1.6 001111: P1.7 010000: P2.0 010001: P2.1 010010: P2.2 (Only available on 40-pin and 32-pin package devices) 010011: P2.3 (Only available on 40-pin and 32-pin package devices) 010100: P2.4 (Only available on 40-pin and 32-pin package devices) 010101: P2.5 (Only available on 40-pin and 32-pin package devices) 010110: P2.6 (Only available on 40-pin and 32-pin package devices) 010111: P2.7 (Only available on 40-pin and 32-pin package devices) 011000: P3.0 (Only available on 40-pin and 32-pin package devices) 011001: P3.1 (Only available on 40-pin package devices) 011010: P3.2 (Only available on 40-pin package devices) 011011: P3.3 (Only available on 40-pin package devices) 011100: P3.4 (Only available on 40-pin package devices) 011101: P3.5 (Only available on 40-pin package devices) 011110: P3.6 (Only available on 40-pin package devices) 011111: P3.7 (Only available on 40-pin package devices) 100000–101111: Reserved 110000: Temp Sensor 110001: V_{DD} 110010–111111: GND

6.6. Temperature Sensor

An on-chip temperature sensor is included on the C8051F55x/56x/57x devices which can be directly accessed via the ADC multiplexer in single-ended configuration. To use the ADC to measure the temperature sensor, the ADC multiplexer channel should be configured to connect to the temperature sensor. The temperature sensor transfer function is shown in Figure 6.9. The output voltage (V_{TEMP}) is the positive ADC input is selected by bits AD0MX[4:0] in register ADC0MX. The TEMPE bit in register REF0CN enables/disables the temperature sensor, as described in SFR Definition 7.1. While disabled, the temperature sensor defaults to a high impedance state and any ADC measurements performed on the sensor will result in meaningless data. Refer to Table 5.10 for the slope and offset parameters of the temperature sensor.

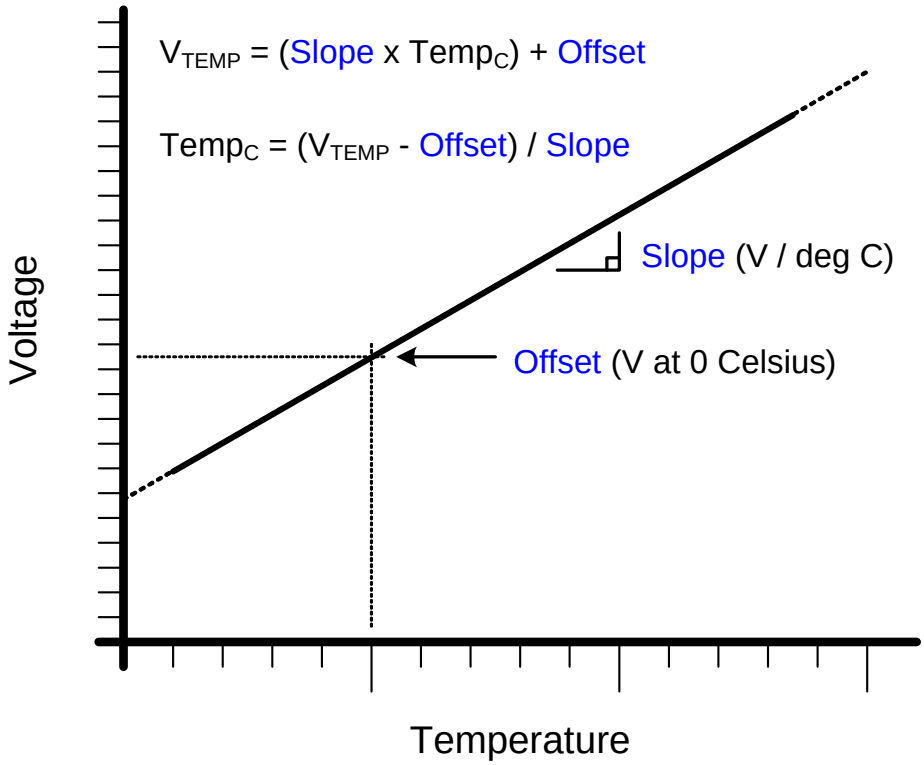


Figure 6.9. Temperature Sensor Transfer Function

7. Voltage Reference

The Voltage reference multiplexer on the C8051F55x/56x/57x devices is configurable to use an externally connected voltage reference, the on-chip reference voltage generator routed to the VREF pin, or the V_{DD} power supply voltage (see Figure 7.1). The REFSL bit in the Reference Control register (REF0CN, SFR Definition 7.1) selects the reference source for the ADC. For an external source or the on-chip reference, REFSL should be set to 0 to select the VREF pin. To use V_{DD} as the reference source, REFSL should be set to 1.

The BIASE bit enables the internal voltage bias generator, which is used by the ADC, Temperature Sensor, and internal oscillator. This bias is automatically enabled when any peripheral which requires it is enabled, and it does not need to be enabled manually. The bias generator may be enabled manually by writing a 1 to the BIASE bit in register REF0CN. The electrical specifications for the voltage reference circuit are given in Table 5.11.

The on-chip voltage reference circuit consists of a temperature stable bandgap voltage reference generator and a gain-of-two output buffer amplifier. The output voltage is selectable between 1.5 V and 2.25 V. The on-chip voltage reference can be driven on the VREF pin by setting the REFBE bit in register REF0CN to a 1. The maximum load seen by the VREF pin must be less than 200 µA to GND. Bypass capacitors of 0.1 µF and 4.7 µF are recommended from the VREF pin to GND. If the on-chip reference is not used, the REFBE bit should be cleared to 0. Electrical specifications for the on-chip voltage reference are given in Table 5.11.

Important Note about the VREF Pin: When using either an external voltage reference or the on-chip reference circuitry, the VREF pin should be configured as an analog pin and skipped by the Digital Crossbar. Refer to Section “19. Port Input/Output” on page 169 for the location of the VREF pin, as well as details of how to configure the pin in analog mode and to be skipped by the crossbar. If VDD is selected as the voltage reference in the REF0CN register and the ADC is enabled in the ADC0CN register, the P0.0/VREF pin cannot operate as a general purpose I/O pin in open-drain mode. With the above settings, this pin can operate in push-pull output mode or as an analog input.

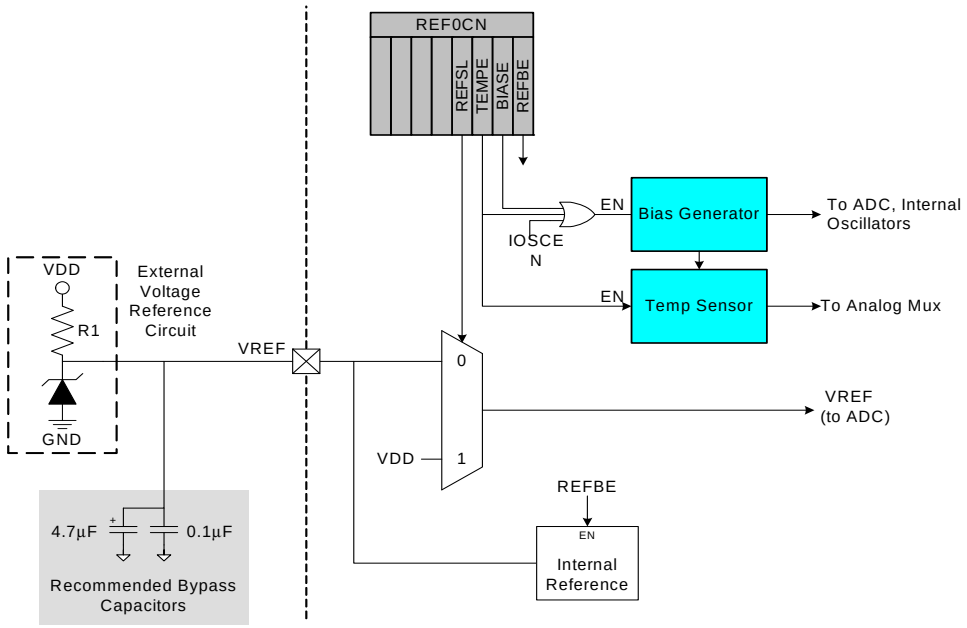


Figure 7.1. Voltage Reference Functional Block Diagram

SFR Definition 7.1. REF0CN: Reference Control

Bit	7	6	5	4	3	2	1	0
Name			ZTCEN	REFLV	REFSL	TEMPE	BIASE	REFBE
Type	R	R	R	R	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD1; SFR Page = 0x00

Bit	Name	Function
7:6	Unused	Read = 00b; Write = don't care.
5	ZTCEN	**Zero Temperature Coefficient Bias Enable Bit.** This bit must be set to 1b before entering oscillator suspend mode. 0: ZeroTC Bias Generator automatically enabled when required. 1: ZeroTC Bias Generator forced on.
4	REFLV	**Voltage Reference Output Level Select.** This bit selects the output voltage level for the internal voltage reference 0: Internal voltage reference set to 1.5 V. 1: Internal voltage reference set to 2.20 V.
3	REFSL	**Voltage Reference Select.** This bit selects the ADCs voltage reference. 0: V_{REF} pin used as voltage reference. 1: V_{DD} used as voltage reference. If V_{DD} is selected as the voltage reference and the ADC is enabled in the ADC0CN register, the P0.0/VREF pin cannot operate as a general purpose I/O pin in open-drain mode. With the above settings, this pin can operate in push-pull output mode or as an analog input.
2	TEMPE	**Temperature Sensor Enable Bit.** 0: Internal Temperature Sensor off. 1: Internal Temperature Sensor on.
1	BIASE	**Internal Analog Bias Generator Enable Bit.** 0: Internal Bias Generator off. 1: Internal Bias Generator on.
0	REFBE	**On-chip Reference Buffer Enable Bit.** 0: On-chip Reference Buffer off. 1: On-chip Reference Buffer on. Internal voltage reference driven on the V_{REF} pin.

8. Comparators

The C8051F55x/56x/57x devices include two on-chip programmable voltage Comparators. A block diagram of the comparators is shown in Figure 8.1, where “n” is the comparator number (0 or 1). The two Comparators operate identically except that Comparator0 can also be used a reset source. For input selection details, refer to SFR Definition 8.5 and SFR Definition 8.6.

Each Comparator offers programmable response time and hysteresis, an analog input multiplexer, and two outputs that are optionally available at the Port pins: a synchronous “latched” output (CP0, CP1), or an asynchronous “raw” output (CP0A, CP1A). The asynchronous signal is available even when the system clock is not active. This allows the Comparators to operate and generate an output with the device in STOP mode. When assigned to a Port pin, the Comparator outputs may be configured as open drain or push-pull (see Section “19.4. Port I/O Initialization” on page 174). Comparator0 may also be used as a reset source (see Section “16.5. Comparator0 Reset” on page 142).

The Comparator0 inputs are selected in the CPT0MX register (SFR Definition 8.5). The CMX0P1-CMX0P0 bits select the Comparator0 positive input; the CMX0N1-CMX0N0 bits select the Comparator0 negative input. The Comparator1 inputs are selected in the CPT1MX register (SFR Definition 8.6). The CMX1P1-CMX1P0 bits select the Comparator1 positive input; the CMX1N1-CMX1N0 bits select the Comparator1 negative input.

Important Note About Comparator Inputs: The Port pins selected as Comparator inputs should be configured as analog inputs in their associated Port configuration register, and configured to be skipped by the Crossbar (for details on Port configuration, see Section “19.1. Port I/O Modes of Operation” on page 170).

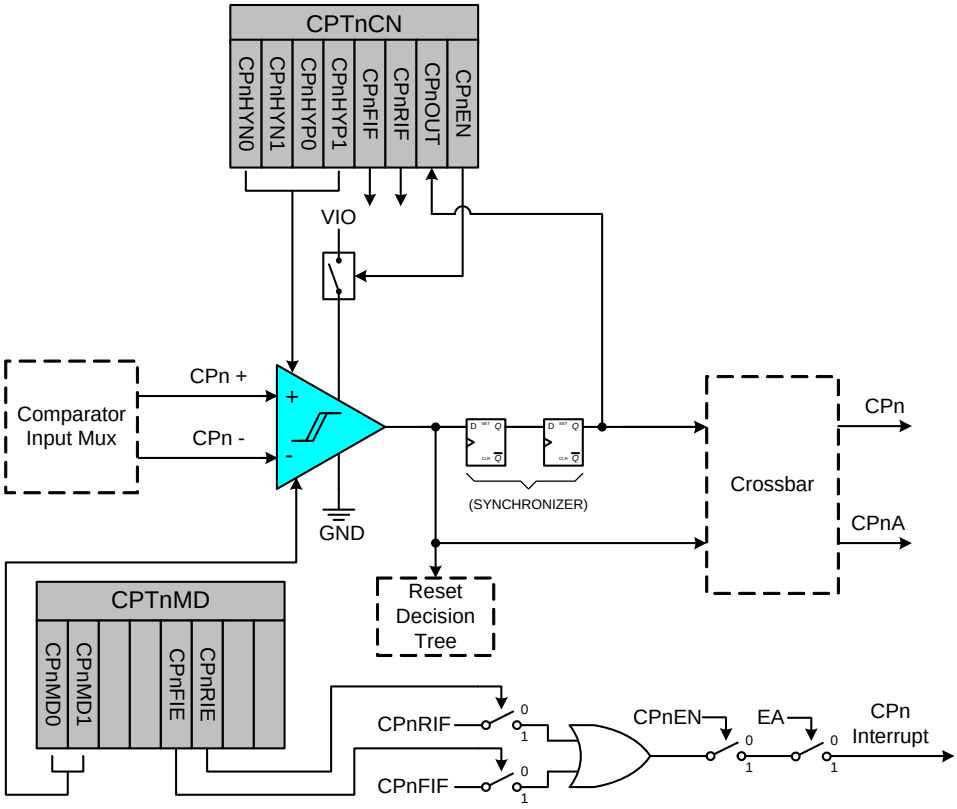


Figure 8.1. Comparator Functional Block Diagram

Comparator outputs can be polled in software, used as an interrupt source, and/or routed to a Port pin. When routed to a Port pin, Comparator outputs are available asynchronous or synchronous to the system clock; the asynchronous output is available even in STOP mode (with no system clock active). When disabled, the Comparator output (if assigned to a Port I/O pin via the Crossbar) defaults to the logic low state, and the power supply to the comparator is turned off. See Section “19.3. Priority Crossbar Decoder” on page 172 for details on configuring Comparator outputs via the digital Crossbar. Comparator inputs can be externally driven from –0.25 V to (V_{DD}) + 0.25 V without damage or upset. The complete Comparator electrical specifications are given in Table 5.12.

The Comparator response time may be configured in software via the CPTnMD registers (see SFR Definition 8.2). Selecting a longer response time reduces the Comparator supply current. See Table 5.12 for complete timing and supply current requirements.

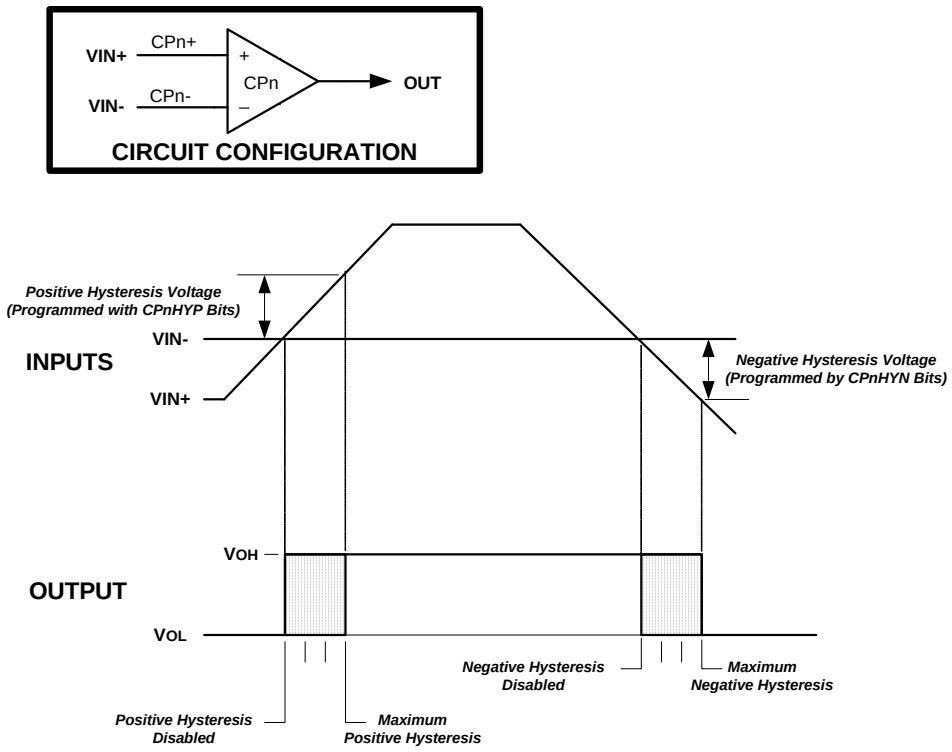


Figure 8.2. Comparator Hysteresis Plot

Comparator hysteresis is software-programmable via its Comparator Control register CPTnCN.

The amount of negative hysteresis voltage is determined by the settings of the CPnHYN bits. As shown in Figure 8.2, various levels of negative hysteresis can be programmed, or negative hysteresis can be disabled. In a similar way, the amount of positive hysteresis is determined by the setting the CPnHYP bits.

Comparator interrupts can be generated on both rising-edge and falling-edge output transitions. (For Interrupt enable and priority control, see “13. Interrupts” .) The CPnFIF flag is set to 1 upon a Comparator falling-edge, and the CPnRIF flag is set to 1 upon the Comparator rising-edge. Once set, these bits remain set until cleared by software. The output state of the Comparator can be obtained at any time by reading the CPnOUT bit. The Comparator is enabled by setting the CPnEN bit to 1, and is disabled by clearing this bit to 0.

Note that false rising edges and falling edges can be detected when the comparator is first powered on or if changes are made to the hysteresis or response time control bits. Therefore, it is recommended that the rising-edge and falling-edge flags be explicitly cleared to logic 0 a short time after the comparator is enabled or its mode bits have been changed.

SFR Definition 8.1. CPT0CN: Comparator0 Control

Bit	7	6	5	4	3	2	1	0
Name	CP0EN	CP0OUT	CP0RIF	CP0FIF	CP0HYP[1:0]		CP0HYN[1:0]	
Type	R/W	R	R/W	R/W	R/W		R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x9A; SFR Page = 0x00

Bit	Name	Function
7	CP0EN	**Comparator0 Enable Bit.** 0: Comparator0 Disabled. 1: Comparator0 Enabled.
6	CP0OUT	**Comparator0 Output State Flag.** 0: Voltage on CP0+ < CP0–. 1: Voltage on CP0+ > CP0–.
5	CP0RIF	**Comparator0 Rising-Edge Flag. Must be cleared by software.** 0: No Comparator0 Rising Edge has occurred since this flag was last cleared. 1: Comparator0 Rising Edge has occurred.
4	CP0FIF	**Comparator0 Falling-Edge Flag. Must be cleared by software.** 0: No Comparator0 Falling-Edge has occurred since this flag was last cleared. 1: Comparator0 Falling-Edge has occurred.
3:2	CP0HYP[1:0]	**Comparator0 Positive Hysteresis Control Bits.** 00: Positive Hysteresis Disabled. 01: Positive Hysteresis = 5 mV. 10: Positive Hysteresis = 10 mV. 11: Positive Hysteresis = 20 mV.
1:0	CP0HYN[1:0]	**Comparator0 Negative Hysteresis Control Bits.** 00: Negative Hysteresis Disabled. 01: Negative Hysteresis = 5 mV. 10: Negative Hysteresis = 10 mV. 11: Negative Hysteresis = 20 mV.

SFR Definition 8.2. CPT0MD: Comparator0 Mode Selection

Bit	7	6	5	4	3	2	1	0
Name			CP0RIE	CP0FIE			CP0MD[1:0]	
Type	R	R	R/W	R/W	R	R	R/W	
Reset	0	0	0	0	0	0	1	0

SFR Address = 0x9B; SFR Page = 0x00

Bit	Name	Function
7:6	Unused	Read = 00b, Write = Don't Care.
5	CP0RIE	**Comparator0 Rising-Edge Interrupt Enable.** 0: Comparator0 Rising-edge interrupt disabled. 1: Comparator0 Rising-edge interrupt enabled.
4	CP0FIE	**Comparator0 Falling-Edge Interrupt Enable.** 0: Comparator0 Falling-edge interrupt disabled. 1: Comparator0 Falling-edge interrupt enabled.
3:2	Unused	Read = 00b, Write = don't care.
1:0	CP0MD[1:0]	**Comparator0 Mode Select.** These bits affect the response time and power consumption for Comparator0. 00: Mode 0 (Fastest Response Time, Highest Power Consumption) 01: Mode 1 10: Mode 2 11: Mode 3 (Slowest Response Time, Lowest Power Consumption)

SFR Definition 8.3. CPT1CN: Comparator1 Control

Bit	7	6	5	4	3	2	1	0
Name	CP1EN	CP1OUT	CP1RIF	CP1FIF	CP1HYP[1:0]		CP1HYN[1:0]	
Type	R/W	R	R/W	R/W	R/W		R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x9D; SFR Page = 0x00

Bit	Name	Function
7	CP1EN	**Comparator1 Enable Bit.** 0: Comparator1 Disabled. 1: Comparator1 Enabled.
6	CP1OUT	**Comparator1 Output State Flag.** 0: Voltage on CP1+ < CP1–. 1: Voltage on CP1+ > CP1–.
5	CP1RIF	**Comparator1 Rising-Edge Flag. Must be cleared by software.** 0: No Comparator1 Rising Edge has occurred since this flag was last cleared. 1: Comparator1 Rising Edge has occurred.
4	CP1FIF	**Comparator1 Falling-Edge Flag. Must be cleared by software.** 0: No Comparator1 Falling-Edge has occurred since this flag was last cleared. 1: Comparator1 Falling-Edge has occurred.
3:2	CP1HYP[1:0]	**Comparator1 Positive Hysteresis Control Bits.** 00: Positive Hysteresis Disabled. 01: Positive Hysteresis = 5 mV. 10: Positive Hysteresis = 10 mV. 11: Positive Hysteresis = 20 mV.
1:0	CP1HYN[1:0]	**Comparator1 Negative Hysteresis Control Bits.** 00: Negative Hysteresis Disabled. 01: Negative Hysteresis = 5 mV. 10: Negative Hysteresis = 10 mV. 11: Negative Hysteresis = 20 mV.

SFR Definition 8.4. CPT1MD: Comparator1 Mode Selection

Bit	7	6	5	4	3	2	1	0
Name			CP1RIE	CP1FIE			CP1MD[1:0]	
Type	R	R	R/W	R/W	R	R	R/W	
Reset	0	0	0	0	0	0	1	0

SFR Address = 0x9E; SFR Page = 0x00

Bit	Name	Function
7:6	Unused	Read = 00b, Write = Don't Care.
5	CP1RIE	**Comparator1 Rising-Edge Interrupt Enable.** 0: Comparator1 Rising-edge interrupt disabled. 1: Comparator1 Rising-edge interrupt enabled.
4	CP1FIE	**Comparator1 Falling-Edge Interrupt Enable.** 0: Comparator1 Falling-edge interrupt disabled. 1: Comparator1 Falling-edge interrupt enabled.
3:2	Unused	Read = 00b, Write = don't care.
1:0	CP1MD[1:0]	**Comparator1 Mode Select.** These bits affect the response time and power consumption for Comparator1. 00: Mode 0 (Fastest Response Time, Highest Power Consumption) 01: Mode 1 10: Mode 2 11: Mode 3 (Slowest Response Time, Lowest Power Consumption)

8.1. Comparator Multiplexer

C8051F55x/56x/57x devices include an analog input multiplexer for each of the comparators to connect Port I/O pins to the comparator inputs. The Comparator0 inputs are selected in the CPT0MX register (SFR Definition 8.5). The CMX0P3–CMX0P0 bits select the Comparator0 positive input; the CMX0N3–CMX0N0 bits select the Comparator0 negative input. Similarly, the Comparator1 inputs are selected in the CPT1MX register using the CMX1P3-CMX1P0 bits and CMX1N3–CMX1N0 bits. The same pins are available to both multiplexers at the same time and can be used by both comparators simultaneously.

Important Note About Comparator Inputs: The Port pins selected as comparator inputs should be configured as analog inputs in their associated Port configuration register, and configured to be skipped by the Crossbar (for details on Port configuration, see Section “19.6. Special Function Registers for Accessing and Configuring Port I/O” on page 183).

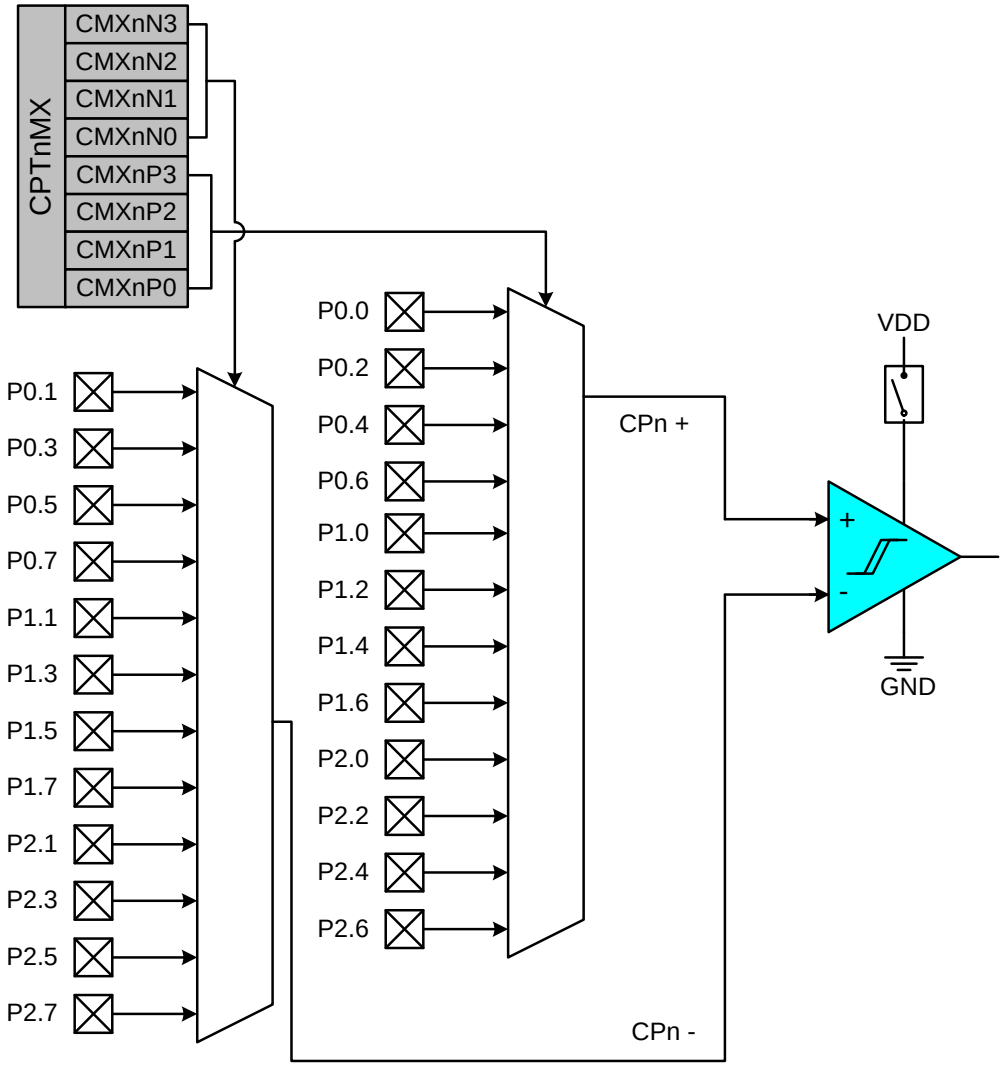


Figure 8.3. Comparator Input Multiplexer Block Diagram

SFR Definition 8.5. CPT0MX: Comparator0 MUX Selection

Bit	7	6	5	4	3	2	1	0
Name	CMX0N[3:0]				CMX0P[3:0]			
Type	R/W				R/W			
Reset	0	1	1	1	0	1	1	1

SFR Address = 0x9C; SFR Page = 0x00

Bit	Name	Function
7:4	CMX0N[3:0]	**Comparator0 Negative Input MUX Selection.** 0000: P0.1 0001: P0.3 0010: P0.5 0011: P0.7 0100: P1.1 0101: P1.3 0110: P1.5 0111: P1.7 1000: P2.1 1001: P2.3 (only available on 40-pin and 32-pin devices) 1010: P2.5 (only available on 40-pin and 32-pin devices) 1011: P2.7 (only available on 40-pin and 32-pin devices) 1100–1111: None
3:0	CMX0P[3:0]	**Comparator0 Positive Input MUX Selection.** 0000: P0.0 0001: P0.2 0010: P0.4 0011: P0.6 0100: P1.0 0101: P1.2 0110: P1.4 0111: P1.6 1000: P2.0 1001: P2.2 (only available on 40-pin and 32-pin devices) 1010: P2.4 (only available on 40-pin and 32-pin devices) 1011: P2.6 (only available on 40-pin and 32-pin devices) 1100–1111: None

SFR Definition 8.6. CPT1MX: Comparator1 MUX Selection

Bit	7	6	5	4	3	2	1	0
Name	CMX1N[3:0]				CMX1P[3:0]			
Type	R/W				R/W			
Reset	0	1	1	1	0	1	1	1

SFR Address = 0x9F; SFR Page = 0x00

Bit	Name	Function
7:4	CMX1N[3:0]	**Comparator1 Negative Input MUX Selection.** 0000: P0.1 0001: P0.3 0010: P0.5 0011: P0.7 0100: P1.1 0101: P1.3 0110: P1.5 0111: P1.7 1000: P2.1 1001: P2.3 (only available on 40-pin and 32-pin devices) 1010: P2.5 (only available on 40-pin and 32-pin devices) 1011: P2.7 (only available on 40-pin and 32-pin devices) 1100–1111: None
3:0	CMX1P[3:0]	**Comparator1 Positive Input MUX Selection.** 0000: P0.0 0001: P0.2 0010: P0.4 0011: P0.6 0100: P1.0 0101: P1.2 0110: P1.4 0111: P1.6 1000: P2.0 1001: P2.2 (only available on 40-pin and 32-pin devices) 1010: P2.4 (only available on 40-pin and 32-pin devices) 1011: P2.6 (only available on 40-pin and 32-pin devices) 1100–1111: None

9. Voltage Regulator (REG0)

C8051F55x/56x/57x devices include an on-chip low dropout voltage regulator (REG0). The input to REG0 at the V_{REGIN} pin can be as high as 5.25 V. The output can be selected by software to 2.1 V or 2.6 V. When enabled, the output of REG0 appears on the V_{DD} pin, powers the microcontroller core, and can be used to power external devices. On reset, REG0 is enabled and can be disabled by software.

The Voltage regulator can generate an interrupt (if enabled by EREG0, EIE2.0) that is triggered whenever the V_{REGIN} input voltage drops below the dropout threshold voltage. This dropout interrupt has no pending flag and the recommended procedure to use it is as follows:

1. Wait enough time to ensure the V_{REGIN} input voltage is stable
2. Enable the dropout interrupt (EREG0, EIE2.0) and select the proper priority (PREG0, EIP2.0)
3. If triggered, inside the interrupt disable it (clear EREG0, EIE2.0), execute all procedures necessary to protect your application (put it in a safe mode and leave the interrupt now disabled.
4. In the main application, now running in the safe mode, regularly checks the DROPOUT bit (REG0CN.0). Once it is cleared by the regulator hardware the application can enable the interrupt again (EREG0, EIE1.6) and return to the normal mode operation.

The input (V_{REGIN}) and output (V_{DD}) of the voltage regulator should both be bypassed with a large capacitor (4.7 µF + 0.1 µF) to ground as shown in Figure 9.1. This capacitor will eliminate power spikes and provide any immediate power required by the microcontroller. The settling time associated with the voltage regulator is shown in Table 5.8 on page 43.

Note: The output of the internal voltage regulator is calibrated by the MCU immediately after any reset event. The output of the un-calibrated internal regulator could be below the high threshold setting of the V_{DD} Monitor. If this is the case *and* the V_{DD} Monitor is set to the high threshold setting *and* if the MCU receives a non-power on reset (POR), the MCU will remain in reset until a POR occurs (i.e., V_{DD} Monitor will keep the device in reset). A POR will force the V_{DD} Monitor to the low threshold setting which is guaranteed to be below the un-calibrated output of the internal regulator. The device will then exit reset and resume normal operation. It is for this reason Silicon Labs strongly recommends that the V_{DD} Monitor is always left in the low threshold setting (i.e. default value upon POR).

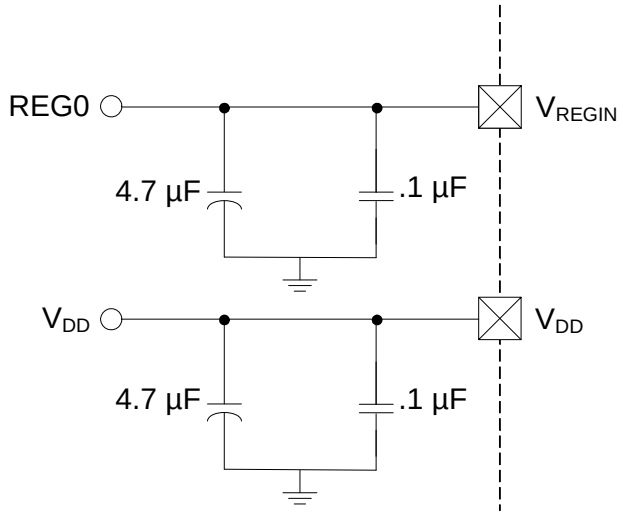


Figure 9.1. External Capacitors for Voltage Regulator Input/Output—Regulator Enabled

If the internal voltage regulator is not used, the VREGIN input should be tied to VDD, as shown in Figure 9.2.

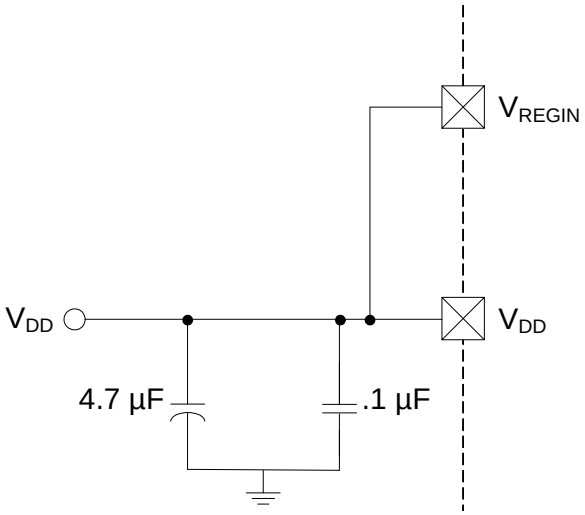


Figure 9.2. External Capacitors for Voltage Regulator Input/Output—Regulator Disabled

SFR Definition 9.1. REG0CN: Regulator Control

Bit	7	6	5	4	3	2	1	0
Name	REGDIS	Reserved		REG0MD				DROPOUT
Type	R/W	R/W	R	R/W	R	R	R	R
Reset	0	1	0	1	0	0	0	0

SFR Address = 0xC9; SFR Page = 0x00

Bit	Name	Function
7	REGDIS	**Voltage Regulator Disable Bit.** 0: Voltage Regulator Enabled 1: Voltage Regulator Disabled
6	Reserved	Read = 1b; Must Write 1b.
5	Unused	Read = 0b; Write = Don't Care.
4	REG0MD	**Voltage Regulator Mode Select Bit.** 0: Voltage Regulator Output is 2.1 V. 1: Voltage Regulator Output is 2.6 V.
3:1	Unused	Read = 000b. Write = Don't Care.
0	DROPOUT	**Voltage Regulator Dropout Indicator.** 0: Voltage Regulator is not in dropout. 1: Voltage Regulator is in or near dropout.

10. CIP-51 Microcontroller

The MCU system controller core is the CIP-51 microcontroller. The CIP-51 is fully compatible with the MCS-51™ instruction set; standard 803x/805x assemblers and compilers can be used to develop software. The MCU family has a superset of all the peripherals included with a standard 8051. The CIP-51 also includes on-chip debug hardware (see description in Section 27), and interfaces directly with the analog and digital subsystems providing a complete data acquisition or control-system solution in a single integrated circuit.

The CIP-51 Microcontroller core implements the standard 8051 organization and peripherals as well as additional custom peripherals and functions to extend its capability (see Figure 10.1 for a block diagram). The CIP-51 includes the following features:

- Fully Compatible with MCS-51 Instruction Set
- 50 MIPS Peak Throughput with 50 MHz Clock
- 0 to 50 MHz Clock Frequency
- Extended Interrupt Handler
- Reset Input
- Power Management Modes
- On-chip Debug Logic
- Program and Data Memory Security

10.1. Performance

The CIP-51 employs a pipelined architecture that greatly increases its instruction throughput over the standard 8051 architecture. In a standard 8051, all instructions except for MUL and DIV take 12 or 24 system clock cycles to execute, and usually have a maximum system clock of 12 MHz. By contrast, the CIP-51 core executes 70% of its instructions in one or two system clock cycles, with no instructions taking more than eight system clock cycles.

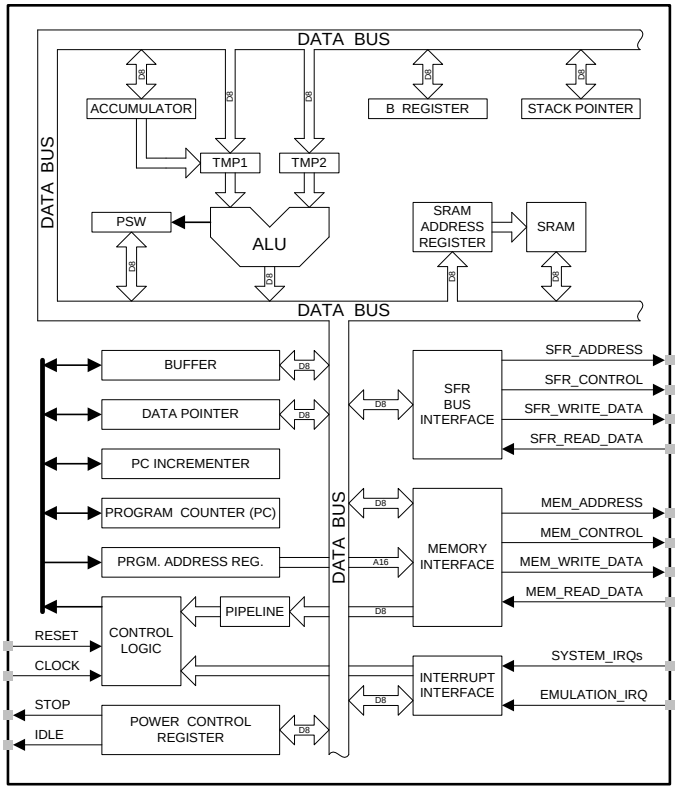


Figure 10.1. CIP-51 Block Diagram

With the CIP-51's maximum system clock at 50 MHz, it has a peak throughput of 50 MIPS. The CIP-51 has a total of 109 instructions. The table below shows the total number of instructions that require each execution time.

Clocks to Execute	1	2	2/3	3	3/4	4	4/5	5	8
Number of Instructions	26	50	5	14	7	3	1	2	1

Programming and Debugging Support

In-system programming of the Flash program memory and communication with on-chip debug support logic is accomplished via the Silicon Labs 2-Wire Development Interface (C2).

The on-chip debug support logic facilitates full speed in-circuit debugging, allowing the setting of hardware breakpoints, starting, stopping and single stepping through program execution (including interrupt service routines), examination of the program's call stack, and reading/writing the contents of registers and memory. This method of on-chip debugging is completely non-intrusive, requiring no RAM, Stack, timers, or other on-chip resources. C2 details can be found in Section “27. C2 Interface” on page 300.

The CIP-51 is supported by development tools from Silicon Labs and third party vendors. Silicon Labs provides an integrated development environment (IDE) including editor, debugger and programmer. The IDE's debugger and programmer interface to the CIP-51 via the C2 interface to provide fast and efficient in-system device programming and debugging. Third party macro assemblers and C compilers are also available.

10.2. Instruction Set

The instruction set of the CIP-51 System Controller is fully compatible with the standard MCS-51™ instruction set. Standard 8051 development tools can be used to develop software for the CIP-51. All CIP-51 instructions are the binary and functional equivalent of their MCS-51™ counterparts, including opcodes, addressing modes and effect on PSW flags. However, instruction timing is different than that of the standard 8051.

10.2.1. Instruction and CPU Timing

In many 8051 implementations, a distinction is made between machine cycles and clock cycles, with machine cycles varying from 2 to 12 clock cycles in length. However, the CIP-51 implementation is based solely on clock cycle timing. All instruction timings are specified in terms of clock cycles.

Due to the pipelined architecture of the CIP-51, most instructions execute in the same number of clock cycles as there are program bytes in the instruction. Conditional branch instructions take one less clock cycle to complete when the branch is not taken as opposed to when the branch is taken. Table 10.1 is the CIP-51 Instruction Set Summary, which includes the mnemonic, number of bytes, and number of clock cycles for each instruction.

Table 10.1. CIP-51 Instruction Set Summary

Mnemonic	Description	Bytes	Clock Cycles
Arithmetic Operations			
ADD A, Rn	Add register to A	1	1
ADD A, direct	Add direct byte to A	2	2
ADD A, @Ri	Add indirect RAM to A	1	2
ADD A, #data	Add immediate to A	2	2
ADDC A, Rn	Add register to A with carry	1	1
ADDC A, direct	Add direct byte to A with carry	2	2
ADDC A, @Ri	Add indirect RAM to A with carry	1	2
ADDC A, #data	Add immediate to A with carry	2	2
SUBB A, Rn	Subtract register from A with borrow	1	1
SUBB A, direct	Subtract direct byte from A with borrow	2	2
SUBB A, @Ri	Subtract indirect RAM from A with borrow	1	2
SUBB A, #data	Subtract immediate from A with borrow	2	2
INC A	Increment A	1	1
INC Rn	Increment register	1	1
INC direct	Increment direct byte	2	2
INC @Ri	Increment indirect RAM	1	2
DEC A	Decrement A	1	1
DEC Rn	Decrement register	1	1
DEC direct	Decrement direct byte	2	2
DEC @Ri	Decrement indirect RAM	1	2
INC DPTR	Increment Data Pointer	1	1
MUL AB	Multiply A and B	1	4
DIV AB	Divide A by B	1	8
DA A	Decimal adjust A	1	1
Logical Operations			
ANL A, Rn	AND Register to A	1	1
ANL A, direct	AND direct byte to A	2	2
ANL A, @Ri	AND indirect RAM to A	1	2
ANL A, #data	AND immediate to A	2	2
ANL direct, A	AND A to direct byte	2	2
ANL direct, #data	AND immediate to direct byte	3	3
ORL A, Rn	OR Register to A	1	1
ORL A, direct	OR direct byte to A	2	2
ORL A, @Ri	OR indirect RAM to A	1	2
ORL A, #data	OR immediate to A	2	2
ORL direct, A	OR A to direct byte	2	2
ORL direct, #data	OR immediate to direct byte	3	3
XRL A, Rn	Exclusive-OR Register to A	1	1
XRL A, direct	Exclusive-OR direct byte to A	2	2
XRL A, @Ri	Exclusive-OR indirect RAM to A	1	2
Note: Certain instructions take a variable number of clock cycles to execute depending on instruction alignment and the FLRT setting (SFR Definition 14.3).			

Table 10.1. CIP-51 Instruction Set Summary (Continued)

Mnemonic	Description	Bytes	Clock Cycles
XRL A, #data	Exclusive-OR immediate to A	2	2
XRL direct, A	Exclusive-OR A to direct byte	2	2
XRL direct, #data	Exclusive-OR immediate to direct byte	3	3
CLR A	Clear A	1	1
CPL A	Complement A	1	2
RL A	Rotate A left	1	1
RLC A	Rotate A left through Carry	1	1
RR A	Rotate A right	1	1
RRC A	Rotate A right through Carry	1	1
SWAP A	Swap nibbles of A	1	1
Data Transfer			
MOV A, Rn	Move Register to A	1	1
MOV A, direct	Move direct byte to A	2	2
MOV A, @Ri	Move indirect RAM to A	1	2
MOV A, #data	Move immediate to A	2	2
MOV Rn, A	Move A to Register	1	1
MOV Rn, direct	Move direct byte to Register	2	2
MOV Rn, #data	Move immediate to Register	2	2
MOV direct, A	Move A to direct byte	2	2
MOV direct, Rn	Move Register to direct byte	2	2
MOV direct, direct	Move direct byte to direct byte	3	3
MOV direct, @Ri	Move indirect RAM to direct byte	2	2
MOV direct, #data	Move immediate to direct byte	3	3
MOV @Ri, A	Move A to indirect RAM	1	2
MOV @Ri, direct	Move direct byte to indirect RAM	2	2
MOV @Ri, #data	Move immediate to indirect RAM	2	2
MOV DPTR, #data16	Load DPTR with 16-bit constant	3	3
MOVC A, @A+DPTR	Move code byte relative DPTR to A	1	4-7*
MOVC A, @A+PC	Move code byte relative PC to A	1	3
MOVX A, @Ri	Move external data (8-bit address) to A	1	3
MOVX @Ri, A	Move A to external data (8-bit address)	1	3
MOVX A, @DPTR	Move external data (16-bit address) to A	1	3
MOVX @DPTR, A	Move A to external data (16-bit address)	1	3
PUSH direct	Push direct byte onto stack	2	2
POP direct	Pop direct byte from stack	2	2
XCH A, Rn	Exchange Register with A	1	1
XCH A, direct	Exchange direct byte with A	2	2
XCH A, @Ri	Exchange indirect RAM with A	1	2
XCHD A, @Ri	Exchange low nibble of indirect RAM with A	1	2
Boolean Manipulation			
CLR C	Clear Carry	1	1
CLR bit	Clear direct bit	2	2

Note: Certain instructions take a variable number of clock cycles to execute depending on instruction alignment and the FLRT setting (SFR Definition 14.3).

Table 10.1. CIP-51 Instruction Set Summary (Continued)

Mnemonic	Description	Bytes	Clock Cycles
SETB C	Set Carry	1	1
SETB bit	Set direct bit	2	2
CPL C	Complement Carry	1	1
CPL bit	Complement direct bit	2	2
ANL C, bit	AND direct bit to Carry	2	2
ANL C, /bit	AND complement of direct bit to Carry	2	2
ORL C, bit	OR direct bit to carry	2	2
ORL C, /bit	OR complement of direct bit to Carry	2	2
MOV C, bit	Move direct bit to Carry	2	2
MOV bit, C	Move Carry to direct bit	2	2
JC rel	Jump if Carry is set	2	2/(4-6)*
JNC rel	Jump if Carry is not set	2	2/(4-6)*
JB bit, rel	Jump if direct bit is set	3	3/(5-7)*
JNB bit, rel	Jump if direct bit is not set	3	3/(5-7)*
JBC bit, rel	Jump if direct bit is set and clear bit	3	3/(5-7)*
Program Branching			
ACALL addr11	Absolute subroutine call	2	4-6*
LCALL addr16	Long subroutine call	3	5-7*
RET	Return from subroutine	1	6-8*
RETI	Return from interrupt	1	6-8*
AJMP addr11	Absolute jump	2	4-6*
LJMP addr16	Long jump	3	5-7*
SJMP rel	Short jump (relative address)	2	4-6*
JMP @A+DPTR	Jump indirect relative to DPTR	1	3-5*
JZ rel	Jump if A equals zero	2	2/(4-6)*
JNZ rel	Jump if A does not equal zero	2	2/(4-6)*
CJNE A, direct, rel	Compare direct byte to A and jump if not equal	3	4/(6-8)*
CJNE A, #data, rel	Compare immediate to A and jump if not equal	3	3/(6-8)*
CJNE Rn, #data, rel	Compare immediate to Register and jump if not equal	3	3/(5-7)*
CJNE @Ri, #data, rel	Compare immediate to indirect and jump if not equal	3	4/(6-8)*
DJNZ Rn, rel	Decrement Register and jump if not zero	2	2/(4-6)*
DJNZ direct, rel	Decrement direct byte and jump if not zero	3	3/(5-7)*
NOP	No operation	1	1

Note: Certain instructions take a variable number of clock cycles to execute depending on instruction alignment and the FLRT setting (SFR Definition 14.3).

Notes on Registers, Operands and Addressing Modes:
Rn—Register R0–R7 of the currently selected register bank. **@Ri**—Data RAM location addressed indirectly through R0 or R1. **rel**—8-bit, signed (two's complement) offset relative to the first byte of the following instruction. Used by SJMP and all conditional jumps. **direct**—8-bit internal data location's address. This could be a direct-access Data RAM location (0x00–0x7F) or an SFR (0x80–0xFF). **#data**—8-bit constant **#data16**—16-bit constant **bit**—Direct-accessed bit in Data RAM or SFR **addr11**—11-bit destination address used by ACALL and AJMP. The destination must be within the same 2 kB page of program memory as the first byte of the following instruction. **addr16**—16-bit destination address used by LCALL and LJMP. The destination may be anywhere within the 64 kB program memory space. There is one unused opcode (0xA5) that performs the same function as NOP. All mnemonics copyrighted © Intel Corporation 1980.

10.3. CIP-51 Register Descriptions

Following are descriptions of SFRs related to the operation of the CIP-51 System Controller. Reserved bits should not be set to logic l. Future product versions may use these bits to implement new features in which case the reset value of the bit will be logic 0, selecting the feature's default state. Detailed descriptions of the remaining SFRs are included in the sections of the datasheet associated with their corresponding system function.

SFR Definition 10.1. DPL: Data Pointer Low Byte

Bit	7	6	5	4	3	2	1	0
Name	DPL[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x82; SFR Page = All Pages

Bit	Name	Function
7:0	DPL[7:0]	**Data Pointer Low.** The DPL register is the low byte of the 16-bit DPTR. DPTR is used to access indirectly addressed Flash memory or XRAM.

SFR Definition 10.2. DPH: Data Pointer High Byte

Bit	7	6	5	4	3	2	1	0
Name	DPH[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x83; SFR Page = All Pages

Bit	Name	Function
7:0	DPH[7:0]	**Data Pointer High.** The DPH register is the high byte of the 16-bit DPTR. DPTR is used to access indirectly addressed Flash memory or XRAM.

SFR Definition 10.3. SP: Stack Pointer

Bit	7	6	5	4	3	2	1	0
Name	SP[7:0]							
Type	R/W							
Reset	0	0	0	0	0	1	1	1

SFR Address = 0x81; SFR Page = All Pages

Bit	Name	Function
7:0	SP[7:0]	**Stack Pointer.** The Stack Pointer holds the location of the top of the stack. The stack pointer is incremented before every PUSH operation. The SP register defaults to 0x07 after reset.

SFR Definition 10.4. ACC: Accumulator

Bit	7	6	5	4	3	2	1	0
Name	ACC[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE0; SFR Page = All Pages; Bit-Addressable

Bit	Name	Function
7:0	ACC[7:0]	**Accumulator.** This register is the accumulator for arithmetic operations.

SFR Definition 10.5. B: B Register

Bit	7	6	5	4	3	2	1	0
Name	B[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xF0; SFR Page = All Pages; Bit-Addressable

Bit	Name	Function
7:0	B[7:0]	**B Register.** This register serves as a second accumulator for certain arithmetic operations.

SFR Definition 10.6. PSW: Program Status Word

Bit	7	6	5	4	3	2	1	0
Name	CY	AC	F0	RS[1:0]		OV	F1	PARITY
Type	R/W	R/W	R/W	R/W		R/W	R/W	R
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD0; SFR Page = All Pages; Bit-Addressable

Bit	Name	Function
7	CY	**Carry Flag.** This bit is set when the last arithmetic operation resulted in a carry (addition) or a borrow (subtraction). It is cleared to logic 0 by all other arithmetic operations.
6	AC	**Auxiliary Carry Flag.** This bit is set when the last arithmetic operation resulted in a carry into (addition) or a borrow from (subtraction) the high order nibble. It is cleared to logic 0 by all other arithmetic operations.
5	F0	**User Flag 0.** This is a bit-addressable, general purpose flag for use under software control.
4:3	RS[1:0]	**Register Bank Select.** These bits select which register bank is used during register accesses. 00: Bank 0, Addresses 0x00-0x07 01: Bank 1, Addresses 0x08-0x0F 10: Bank 2, Addresses 0x10-0x17 11: Bank 3, Addresses 0x18-0x1F
2	OV	**Overflow Flag.** This bit is set to 1 under the following circumstances: ■ An ADD, ADDC, or SUBB instruction causes a sign-change overflow. ■ A MUL instruction results in an overflow (result is greater than 255). ■ A DIV instruction causes a divide-by-zero condition. The OV bit is cleared to 0 by the ADD, ADDC, SUBB, MUL, and DIV instructions in all other cases.
1	F1	**User Flag 1.** This is a bit-addressable, general purpose flag for use under software control.
0	PARITY	**Parity Flag.** This bit is set to logic 1 if the sum of the eight bits in the accumulator is odd and cleared if the sum is even.

10.4. Serial Number Special Function Registers (SFRs)

The C8051F55x/56x/57x devices include four SFRs, SN0 through SN3, that are pre-programmed during production with a unique, 32-bit serial number. The serial number provides a unique identification number for each device and can be read from the application firmware. If the serial number is not used in the application, these four registers can be used as general purpose SFRs.

SFR Definition 10.7. SNn: Serial Number n

Bit	7	6	5	4	3	2	1	0
Name	SERNUMn[7:0]							
Type	R/W							
Reset	Varies—Unique 32-bit value							

SFR Addresses: SN0 = 0xF9; SN1 = 0xFA; SN2 = 0xFB; SN3 = 0xFC; SFR Page = 0x0F;

Bit	Name	Function
7:0	SERNUMn[7:0]	**Serial Number Bits.** The four serial number registers form a 32-bit serial number, with SN3 as the most significant byte and SN0 as the least significant byte.

11. Memory Organization

The memory organization of the CIP-51 System Controller is similar to that of a standard 8051. There are two separate memory spaces: program memory and data memory. Program and data memory share the same address space but are accessed via different instruction types. The memory organization is shown in Figure 11.1

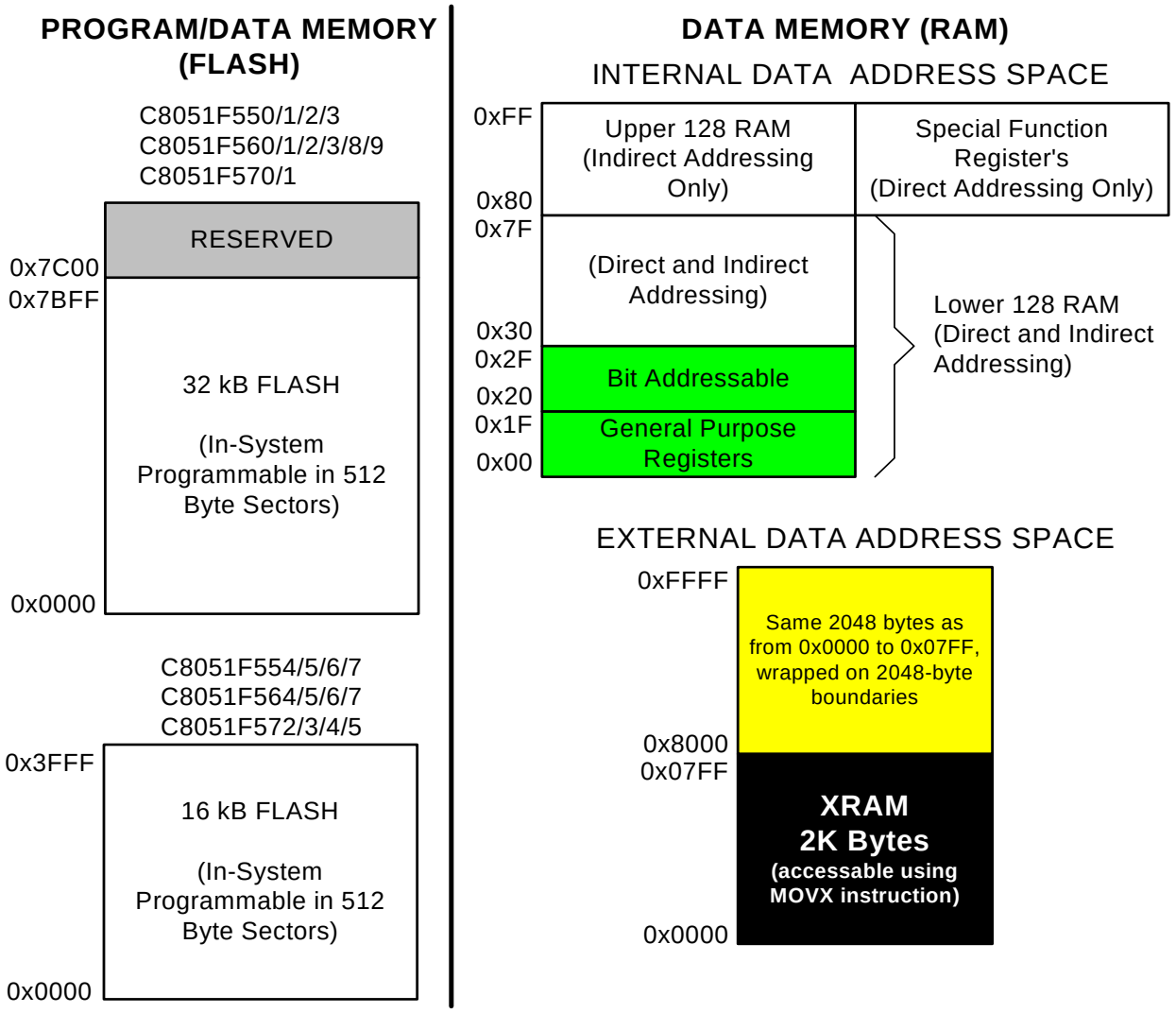


Figure 11.1. C8051F55x/56x/57x Memory Map

11.1. Program Memory

The CIP-51 core has a 64 kB program memory space. The C8051F55x/56x/57x devices implement 32 kB or 16 kB of this program memory space as in-system, re-programmable Flash memory, organized in a contiguous block from addresses 0x0000 to 0x7FFF in 32 kB devices and addresses 0x0000 to 0x3FFF in 16 kB devices. The address 0x7BFF in 32 kB devices and 0x3FFF in 16 kB devices serves as the security lock byte for the device. Addresses above 0x7BFF are reserved in the 32 kB devices.

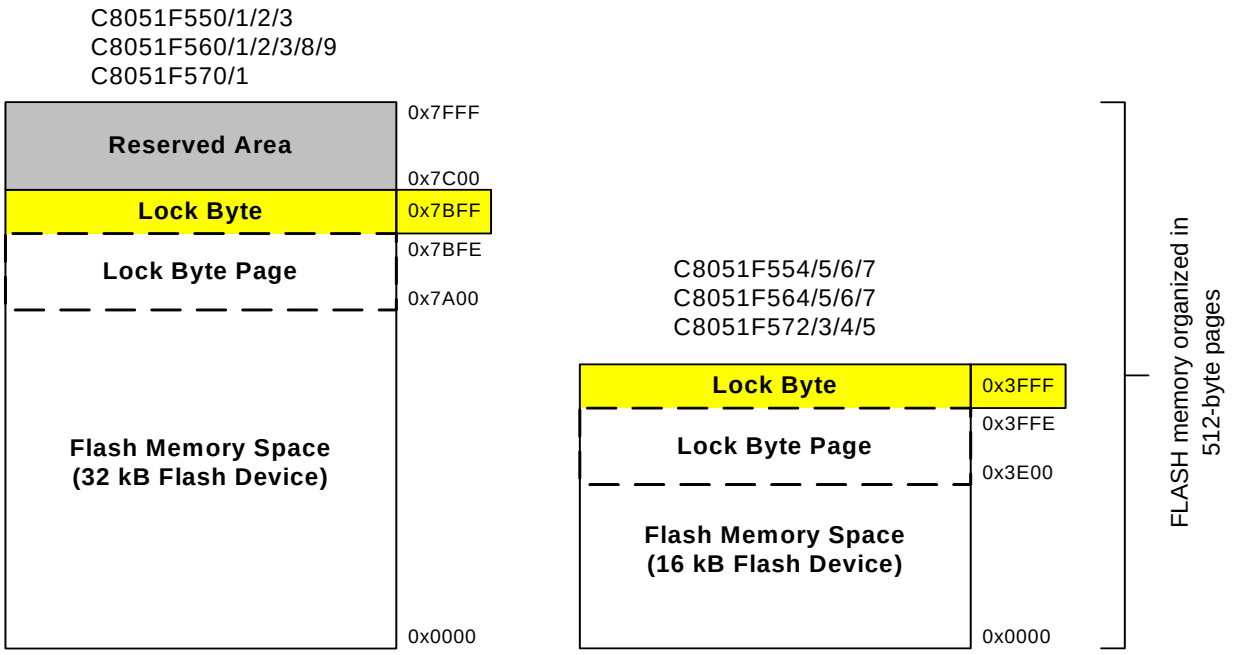


Figure 11.2. Flash Program Memory Map

11.1.1. MOVX Instruction and Program Memory

The MOVX instruction in an 8051 device is typically used to access external data memory. On the C8051F55x/56x/57x devices, the MOVX instruction is normally used to read and write on-chip XRAM, but can be re-configured to write and erase on-chip Flash memory space. MOVC instructions are always used to read Flash memory, while MOVX write instructions are used to erase and write Flash. This Flash access feature provides a mechanism for the C8051F55x/56x/57x to update program code and use the program memory space for non-volatile data storage. Refer to Section “14. Flash Memory” on page 124 for further details.

11.2. Data Memory

The C8051F55x/56x/57x devices include 2304 bytes of RAM data memory. 256 bytes of this memory is mapped into the internal RAM space of the 8051. The other 2048 bytes of this memory is on-chip “external” memory. The data memory map is shown in Figure 11.1 for reference.

11.2.1. Internal RAM

There are 256 bytes of internal RAM mapped into the data memory space from 0x00 through 0xFF. The lower 128 bytes of data memory are used for general purpose registers and scratch pad memory. Either direct or indirect addressing may be used to access the lower 128 bytes of data memory. Locations 0x00 through 0x1F are addressable as four banks of general purpose registers, each bank consisting of eight byte-wide registers. The next 16 bytes, locations 0x20 through 0x2F, may either be addressed as bytes or as 128 bit locations accessible with the direct addressing mode.

The upper 128 bytes of data memory are accessible only by indirect addressing. This region occupies the same address space as the Special Function Registers (SFR) but is physically separate from the SFR space. The addressing mode used by an instruction when accessing locations above 0x7F determines whether the CPU accesses the upper 128 bytes of data memory space or the SFRs. Instructions that use direct addressing will access the SFR space. Instructions using indirect addressing above 0x7F access the upper 128 bytes of data memory. Figure 11.1 illustrates the data memory organization of the

C8051F55x/56x/57x.

11.2.1.1. General Purpose Registers

The lower 32 bytes of data memory, locations 0x00 through 0x1F, may be addressed as four banks of general-purpose registers. Each bank consists of eight byte-wide registers designated R0 through R7. Only one of these banks may be enabled at a time. Two bits in the program status word, RS0 (PSW.3) and RS1 (PSW.4), select the active register bank (see description of the PSW in SFR Definition 10.6). This allows fast context switching when entering subroutines and interrupt service routines. Indirect addressing modes use registers R0 and R1 as index registers.

11.2.1.2. Bit Addressable Locations

In addition to direct access to data memory organized as bytes, the sixteen data memory locations at 0x20 through 0x2F are also accessible as 128 individually addressable bits. Each bit has a bit address from 0x00 to 0x7F. Bit 0 of the byte at 0x20 has bit address 0x00 while bit7 of the byte at 0x20 has bit address 0x07. Bit 7 of the byte at 0x2F has bit address 0x7F. A bit access is distinguished from a full byte access by the type of instruction used (bit source or destination operands as opposed to a byte source or destination).

The MCS-51™ assembly language allows an alternate notation for bit addressing of the form XX.B where XX is the byte address and B is the bit position within the byte. For example, the instruction:

```
MOV    C, 22.3h
```

moves the Boolean value at 0x13 (bit 3 of the byte at location 0x22) into the Carry flag.

11.2.1.3. Stack

A programmer's stack can be located anywhere in the 256-byte data memory. The stack area is designated using the Stack Pointer (SP) SFR. The SP will point to the last location used. The next value pushed on the stack is placed at SP+1 and then SP is incremented. A reset initializes the stack pointer to location 0x07. Therefore, the first value pushed on the stack is placed at location 0x08, which is also the first register (R0) of register bank 1. Thus, if more than one register bank is to be used, the SP should be initialized to a location in the data memory not being used for data storage. The stack depth can extend up to 256 bytes.

12. Special Function Registers

The direct-access data memory locations from 0x80 to 0xFF constitute the special function registers (SFRs). The SFRs provide control and data exchange with the C8051F55x/56x/57x's resources and peripherals. The CIP-51 controller core duplicates the SFRs found in a typical 8051 implementation as well as implementing additional SFRs used to configure and access the sub-systems unique to the C8051F55x/56x/57x. This allows the addition of new functionality while retaining compatibility with the MCS-51™ instruction set. Table 12.3 lists the SFRs implemented in the C8051F55x/56x/57x device family.

The SFR registers are accessed anytime the direct addressing mode is used to access memory locations from 0x80 to 0xFF. SFRs with addresses ending in 0x0 or 0x8 (e.g., P0, TCON, SCON0, IE, etc.) are bit-addressable as well as byte-addressable. All other SFRs are byte-addressable only. Unoccupied addresses in the SFR space are reserved for future use. Accessing unoccupied addresses in the SFR space will have an indeterminate effect and should be avoided. Refer to the corresponding pages of the data sheet, as indicated in Table 12.3, for a detailed description of each register.

12.1. SFR Paging

The CIP-51 features SFR paging, allowing the device to map many SFRs into the 0x80 to 0xFF memory address space. The SFR memory space has 256 *pages*. In this way, each memory location from 0x80 to 0xFF can access up to 256 SFRs. The C8051F55x/56x/57x family of devices utilizes three SFR pages: 0x00, 0x0C, and 0x0F. SFR pages are selected using the Special Function Register Page Selection register, SFRPAGE (see SFR Definition 11.3). The procedure for reading and writing an SFR is as follows:

1. Select the appropriate SFR page number using the SFRPAGE register.
2. Use direct accessing mode to read or write the special function register (MOV instruction).

12.2. Interrupts and SFR Paging

When an interrupt occurs, the SFR Page Register will automatically switch to the SFR page containing the flag bit that caused the interrupt. The automatic SFR Page switch function conveniently removes the burden of switching SFR pages from the interrupt service routine. Upon execution of the RETI instruction, the SFR page is automatically restored to the SFR Page in use prior to the interrupt. This is accomplished via a three-byte *SFR Page Stack*. The top byte of the stack is SFRPAGE, the current SFR Page. The second byte of the SFR Page Stack is SFRNEXT. The third, or bottom byte of the SFR Page Stack is SFRLAST. Upon an interrupt, the current SFRPAGE value is pushed to the SFRNEXT byte, and the value of SFRNEXT is pushed to SFRLAST. Hardware then loads SFRPAGE with the SFR Page containing the flag bit associated with the interrupt. On a return from interrupt, the SFR Page Stack is popped resulting in the value of SFRNEXT returning to the SFRPAGE register, thereby restoring the SFR page context without software intervention. The value in SFRLAST (0x00 if there is no SFR Page value in the bottom of the stack) of the stack is placed in SFRNEXT register. If desired, the values stored in SFRNEXT and SFRLAST may be modified during an interrupt, enabling the CPU to return to a different SFR Page upon execution of the RETI instruction (on interrupt exit). Modifying registers in the SFR Page Stack does not cause a push or pop of the stack. Only interrupt calls and returns will cause push/pop operations on the SFR Page Stack.

On the C8051F55x/56x/57x devices, vectoring to an interrupt will switch SFRPAGE to page 0x00, except for the CAN0 interrupt which will switch SFRPAGE to page 0x0C.

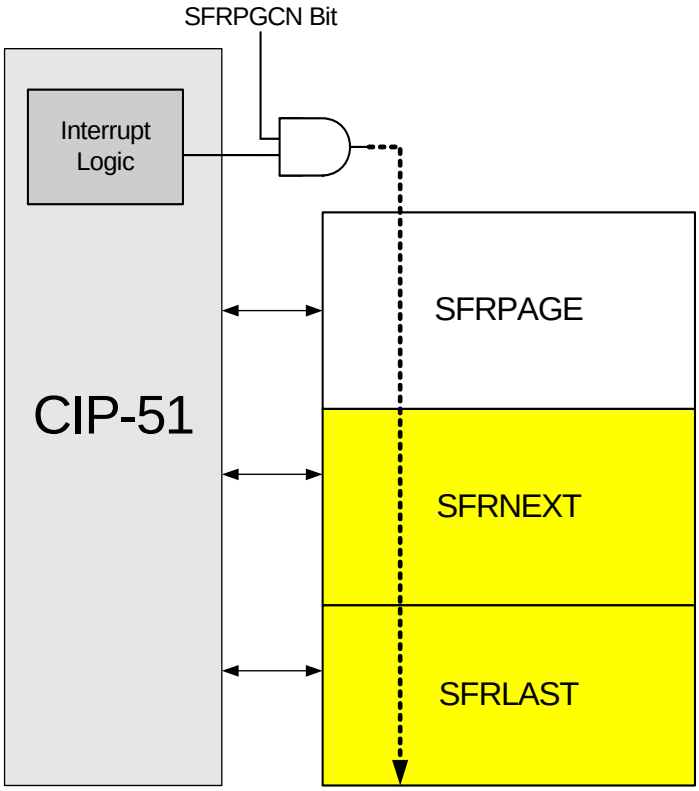


Figure 12.1. SFR Page Stack

Automatic hardware switching of the SFR Page on interrupts may be enabled or disabled as desired using the SFR Automatic Page Control Enable Bit located in the SFR Page Control Register (SFR0CN). This function defaults to “enabled” upon reset. In this way, the autoswitching function will be enabled unless disabled in software.

A summary of the SFR locations (address and SFR page) are provided in Table 12.3 in the form of an SFR memory map. Each memory location in the map has an SFR page row, denoting the page in which that SFR resides. Certain SFRs are accessible from ALL SFR pages, and are denoted by the “(ALL PAGES)” designation. For example, the Port I/O registers P0, P1, P2, and P3 all have the “(ALL PAGES)” designation, indicating these SFRs are accessible from all SFR pages regardless of the SFRPAGE register value.

12.3. SFR Page Stack Example

The following is an example that shows the operation of the SFR Page Stack during interrupts. In this example, the SFR Control register is left in the default enabled state (i.e., SFRPGEN = 1), and the CIP-51 is executing in-line code that is writing values to SPI Data Register (SFR “SPI0DAT”, located at address 0xA3 on SFR Page 0x00). The device is also using the CAN peripheral (CAN0) and the Programmable Counter Array (PCA0) peripheral to generate a PWM output. The PCA is timing a critical control function in its interrupt service and so its associated ISR that is set to high priority. At this point, the SFR page is set to access the SPI0DAT SFR (SFRPAGE = 0x00). See Figure 12.2.

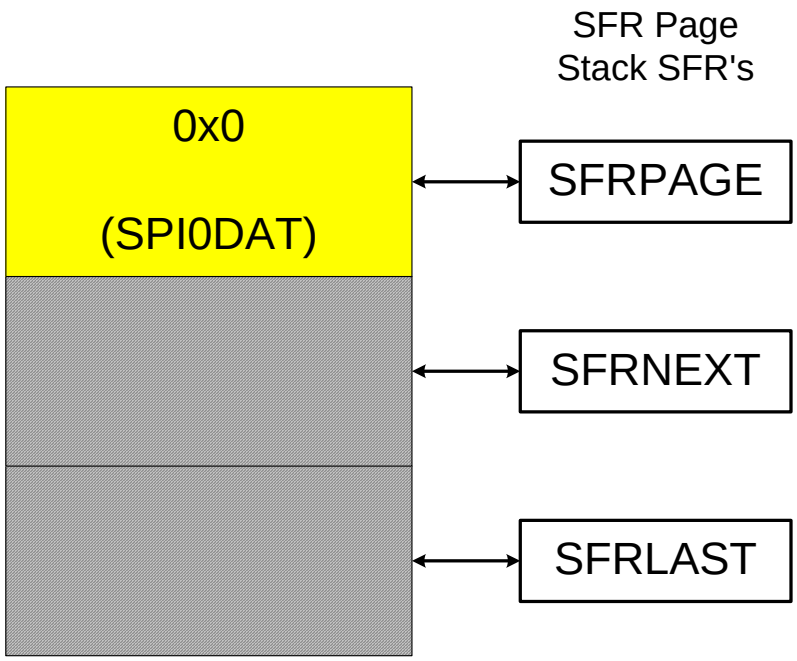


Figure 12.2. SFR Page Stack While Using SFR Page 0x0 To Access SPI0DAT

While CIP-51 executes in-line code (writing values to SPI0DAT in this example), the CAN0 Interrupt occurs. The CIP-51 vectors to the CAN0 ISR and pushes the current SFR Page value (SFR Page 0x00) into SFRNEXT in the SFR Page Stack. The SFR page needed to access CAN's SFRs is then automatically placed in the SFRPAGE register (SFR Page 0x0C). SFRPAGE is considered the "top" of the SFR Page Stack. Software can now access the CAN0 SFRs. Software may switch to any SFR Page by writing a new value to the SFRPAGE register at any time during the CAN0 ISR to access SFRs that are not on SFR Page 0x0C. See Figure 12.3.

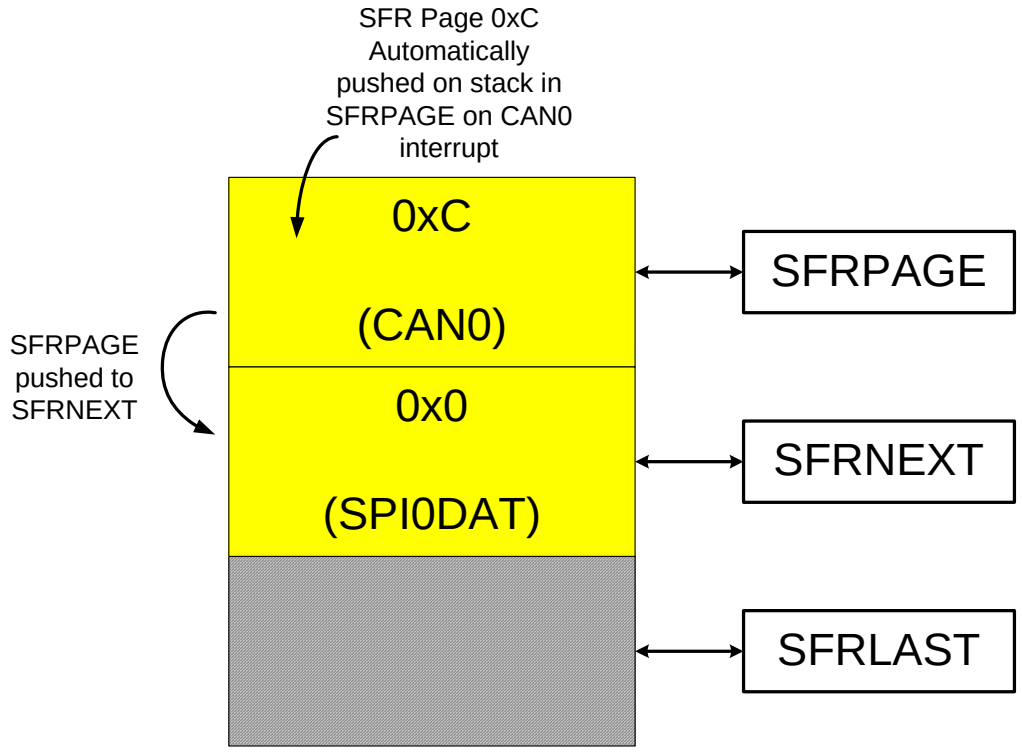


Figure 12.3. SFR Page Stack After CAN0 Interrupt Occurs

While in the CAN0 ISR, a PCA interrupt occurs. Recall the PCA interrupt is configured as a high priority interrupt, while the CAN0 interrupt is configured as a *low* priority interrupt. Thus, the CIP-51 will now vector to the high priority PCA ISR. Upon doing so, the CIP-51 will automatically place the SFR page needed to access the PCA's special function registers into the SFRPAGE register, SFR Page 0x00. The value that was in the SFRPAGE register before the PCA interrupt (SFR Page 0x0C for CAN0) is pushed down the stack into SFRNEXT. Likewise, the value that was in the SFRNEXT register before the PCA interrupt (in this case SFR Page 0x00 for SPI0DAT) is pushed down to the SFRLAST register, the "bottom" of the stack. Note that a value stored in SFRLAST (via a previous software write to the SFRLAST register) will be overwritten. See Figure 12.4.

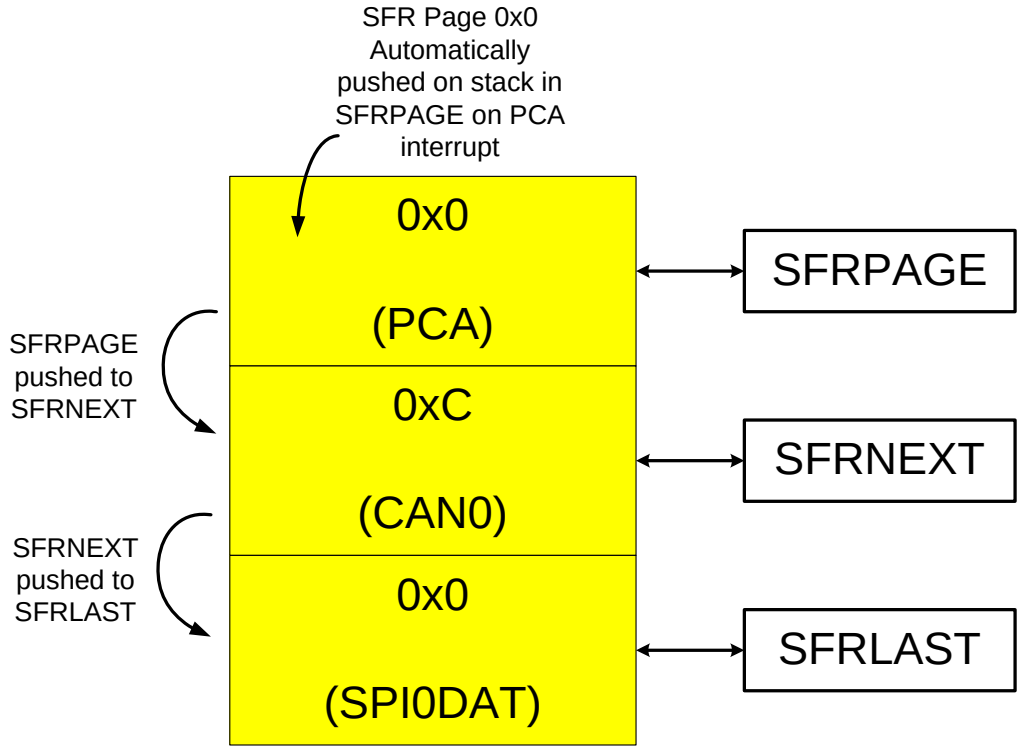


Figure 12.4. SFR Page Stack Upon PCA Interrupt Occurring During a CAN0 ISR

On exit from the PCA interrupt service routine, the CIP-51 will return to the CAN0 ISR. On execution of the RETI instruction, SFR Page 0x00 used to access the PCA registers will be automatically popped off of the SFR Page Stack, and the contents of the SFRNEXT register will be moved to the SFRPAGE register. Software in the CAN0 ISR can continue to access SFRs as it did prior to the PCA interrupt. Likewise, the contents of SFRLAST are moved to the SFRNEXT register. Recall this was the SFR Page value 0x00 being used to access SPI0DAT before the CAN0 interrupt occurred. See Figure 12.5.

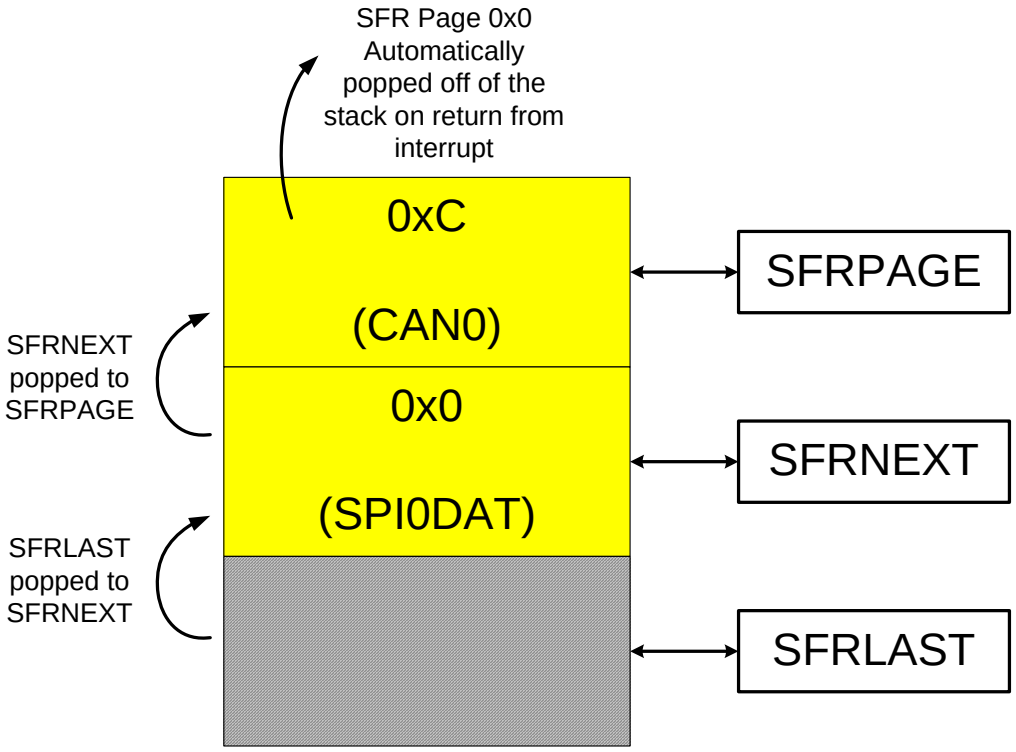


Figure 12.5. SFR Page Stack Upon Return From PCA Interrupt

On the execution of the RETI instruction in the CAN0 ISR, the value in SFRPAGE register is overwritten with the contents of SFRNEXT. The CIP-51 may now access the SPI0DAT register as it did prior to the interrupts occurring. See Figure 12.6.

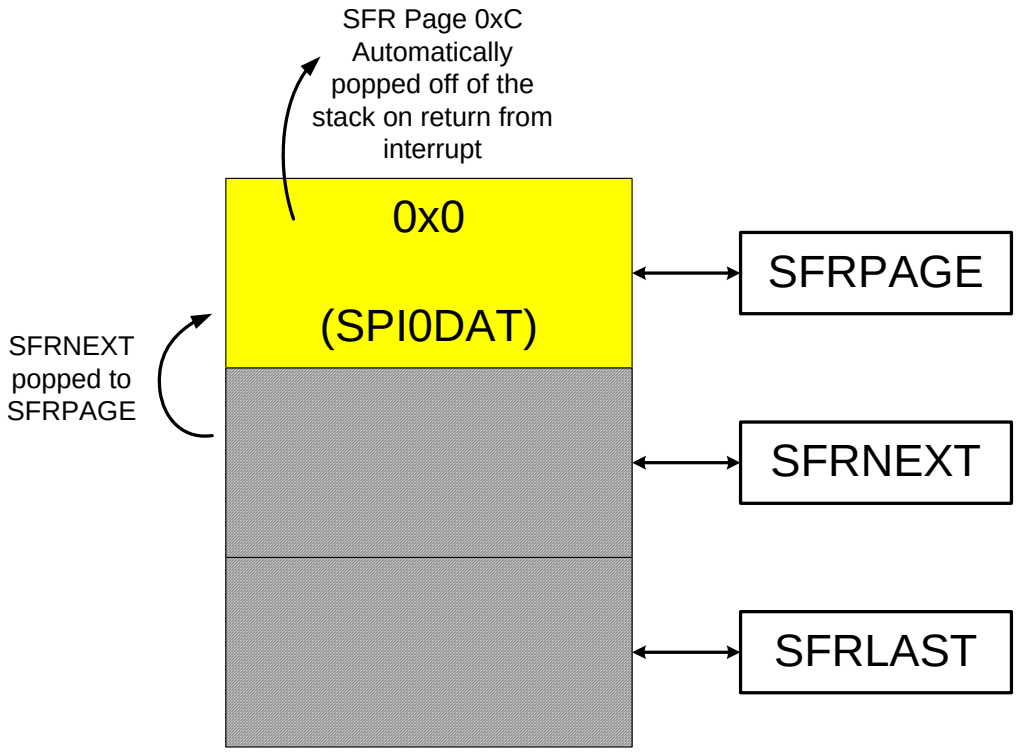


Figure 12.6. SFR Page Stack Upon Return From CAN0 Interrupt

In the example above, all three bytes in the SFR Page Stack are accessible via the SFRPAGE, SFRNEXT, and SFRLAST special function registers. If the stack is altered while servicing an interrupt, it is possible to return to a different SFR Page upon interrupt exit than selected prior to the interrupt call. Direct access to the SFR Page stack can be useful to enable real-time operating systems to control and manage context switching between multiple tasks.

Push operations on the SFR Page Stack only occur on interrupt service, and pop operations only occur on interrupt exit (execution on the RETI instruction). The automatic switching of the SFRPAGE and operation of the SFR Page Stack as described above can be disabled in software by clearing the SFR Automatic Page Enable Bit (SFRPGEN) in the SFR Page Control Register (SFR0CN). See SFR Definition 12.1.

SFR Definition 12.1. SFR0CN: SFR Page Control

Bit	7	6	5	4	3	2	1	0
Name								SFRPGEN
Type	R	R	R	R	R	R	R	R/W
Reset	0	0	0	0	0	0	0	1

SFR Address = 0x84; SFR Page = 0x0F

Bit	Name	Function
7:1	Unused	Read = 0000000b; Write = Don't Care
0	SFRPGEN	**SFR Automatic Page Control Enable.** Upon interrupt, the C8051 Core will vector to the specified interrupt service routine and automatically switch the SFR page to the corresponding peripheral or function's SFR page. This bit is used to control this autopaging function. 0: SFR Automatic Paging disabled. The C8051 core will not automatically change to the appropriate SFR page (i.e., the SFR page that contains the SFRs for the peripheral/function that was the source of the interrupt). 1: SFR Automatic Paging enabled. Upon interrupt, the C8051 will switch the SFR page to the page that contains the SFRs for the peripheral or function that is the source of the interrupt.

SFR Definition 12.2. SFRPAGE: SFR Page

Bit	7	6	5	4	3	2	1	0
Name	SFRPAGE[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA7; SFR Page = All Pages

Bit	Name	Function
7:0	SFRPAGE[7:0]	**SFR Page Bits.** Represents the SFR Page the C8051 core uses when reading or modifying SFRs. Write: Sets the SFR Page. Read: Byte is the SFR page the C8051 core is using. When enabled in the SFR Page Control Register (SFR0CN), the C8051 core will automatically switch to the SFR Page that contains the SFRs of the corresponding peripheral/function that caused the interrupt, and return to the previous SFR page upon return from interrupt (unless SFR Stack was altered before a returning from the interrupt). SFRPAGE is the top byte of the SFR Page Stack, and push/pop events of this stack are caused by interrupts (and not by reading/writing to the SFRPAGE register)

SFR Definition 12.3. SFRNEXT: SFR Next

Bit	7	6	5	4	3	2	1	0
Name	SFRNEXT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x85; SFR Page = All Pages

Bit	Name	Function
7:0	SFRNEXT[7:0]	**SFR Page Bits.** This is the value that will go to the SFR Page register upon a return from interrupt. Write: Sets the SFR Page contained in the second byte of the SFR Stack. This will cause the SFRPAGE SFR to have this SFR page value upon a return from interrupt. Read: Returns the value of the SFR page contained in the second byte of the SFR stack. SFR page context is retained upon interrupts/return from interrupts in a 3 byte SFR Page Stack: SFRPAGE is the first entry, SFRNEXT is the second, and SFRLAST is the third entry. The SFR stack bytes may be used alter the context in the SFR Page Stack, and will not cause the stack to “push” or “pop”. Only interrupts and return from interrupts cause pushes and pops of the SFR Page Stack.

SFR Definition 12.4. SFRLAST: SFR Last

Bit	7	6	5	4	3	2	1	0
Name	SFRLAST[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA7; SFR Page = All Pages

Bit	Name	Function
7:0	SFRLAST[7:0]	**SFR Page Stack Bits.** This is the value that will go to the SFRNEXT register upon a return from interrupt. Write: Sets the SFR Page in the last entry of the SFR Stack. This will cause the SFRNEXT SFR to have this SFR page value upon a return from interrupt. Read: Returns the value of the SFR page contained in the last entry of the SFR stack. SFR page context is retained upon interrupts/return from interrupts in a 3 byte SFR Page Stack: SFRPAGE is the first entry, SFRNEXT is the second, and SFRLAST is the third entry. The SFR stack bytes may be used alter the context in the SFR Page Stack, and will not cause the stack to “push” or “pop”. Only interrupts and return from interrupts cause pushes and pops of the SFR Page Stack.

Table 12.1. Special Function Register (SFR) Memory Map for Pages 0x00 and 0x0F

Address	Page	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)
F8	0F	SPI0CN	PCA0L SN0	PCA0H SN1	PCA0CPL0 SN2	PCA0CPH0 SN3	PCACPL4	PCACPH4	VDM0CN
F0	0F	B (All Pages)	P0MAT P0MDIN	P0MASK P1MDIN	P1MAT P2MDIN	P1MASK P3MDIN		EIP1 EIP1	EIP2 EIP2
E8	0F	ADC0CN	PCA0CPL1	PCA0CPH1	PCA0CPL2	PCA0CPH2	PCA0CPL3	PCA0CPL3	RSTSRC
E0	0F	ACC (All Pages)	XBR0	XBR1	CCH0CN	IT01CF		EIE1 (All Pages)	EIE2 (All Pages)
D8	0F	PCA0CN	PCA0MD PCA0PWM	PCA0CPM0	PCA0CPM1	PCA0CPM2	PCA0CPM3	PCA0CPM4	PCA0CPM5
D0	0F	PSW (All Pages)	REF0CN	LIN0DATA	LIN0ADDR	P0SKIP	P1SKIP	P2SKIP	P3SKIP
C8	0F	TMR2CN	REG0CN LIN0CF	TMR2RLL	TMR2RLH	TMR2L	TMR2H	PCA0CPL5	PCA0CPH5
C0	0F	SMB0CN	SMB0CF	SMB0DAT	ADC0GTL	ADC0GTH	ADC0LTL	ADC0LTH	XBR2
B8	0F	IP (All Pages)		ADC0TK	ADC0MX	ADC0CF	ADC0L	ADC0H	
B0	0F	P3 (All Pages)	P2MAT	P2MASK EMI0CF			P4 (All Pages)	FLSCL (All Pages)	FLKEY (All Pages)
A8	0F	IE (All Pages)	SMOD0	EMI0CN EMI0TC	SBCON0	SBRLL0	SBRLH0	P3MAT P3MDOUT	P3MASK P4MDOUT
A0	0F	P2 (All Pages)	SPI0CFG OSCICN	SPI0CKR OSCICRS	SPI0DAT	P0MDOUT	P1MDOUT	P2MDOUT	SFRPAGE (All Pages)
98	0F	SCON0	SBUF0	CPT0CN	CPT0MD	CPT0MX	CPT1CN	CPT1MD OSCIFIN	CPT1MX OSCXCN
90	0F	P1 (All Pages)	TMR3CN	TMR3RLL	TMR3RLH	TMR3L	TMR3H		CLKMUL
88	0F	TCON (All Pages)	TMOD (All Pages)	TL0 (All Pages)	TL1 (All Pages)	TH0 (All Pages)	TH1 (All Pages)	CKCON (All Pages)	PSCTL CLKSEL
80	0F	P0 (All Pages)	SP (All Pages)	DPL (All Pages)	DPH (All Pages)	SFR0CN	SFRNEXT (All Pages)	SFRLAST (All Pages)	PCON (All Pages)
		0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)

(bit addressable)

Table 12.2. Special Function Register (SFR) Memory Map for Page 0x0C

	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)
F8			CAN0IF2DA2L	CAN0IF2DA2H	CAN0IF2DB1L	CAN0IF2DB1H	CAN0IF2DB2L	CAN0IF2DB2H
F0	B (All Pages)		CAN0IF2A2L	CAN0IF2A2H			CAN0IF2DA1L	CAN0IF2DA1H
E8			CAN0IF2M1L	CAN0IF2M1H	CAN0IF2M2L	CAN0IF2M2H	CAN0IF2A1L	CAN0IF2A1H
E0	ACC (All Pages)		CAN0IF2CML	CAN0IF2CMH			EIE1 (All Pages)	EIE2 (All Pages)
D8			CAN0IF1DB1L	CAN0IF1DB1H	CAN0IF1DB2L	CAN0IF1DB2H	CAN0IF2CRL	CAN0IF2CRH
D0	PSW (All Pages)		CAN0IF1MCL	CAN0IF1MCH	CAN0IF1DA1L	CAN0IF1DA1H	CAN0IF1DA2L	CAN0IF1DA2H
C8			CAN0IF1A1L	CAN0IF1A1H	CAN0IF1A2L	CAN0IF1A2H	CAN0IF2MCL	CAN0IF2MCH
C0	CAN0CN		CAN0IF1CML	CAN0IF1CMH	CAN0IF1M1L	CAN0IF1M1H	CAN0IF1M2L	CAN0IF1M2H
B8	IP (All Pages)		CAN0MV1L	CAN0MV1H	CAN0MV2L	CAN0MV2H	CAN0IF1CRL	CAN0IF1CRH
B0	P3 (All Pages)		CAN0IP2L	CAN0IP2H		P4 (All Pages)	FLSCL (All Pages)	FLKEY (All Pages)
A8	IE (All Pages)		CAN0ND1L	CAN0ND1H	CAN0ND2L	CAN0ND2H	CAN0IP1L	CAN0IP1H
A0	P2 (All Pages)	CAN0BRPE	CAN0TR1L	CAN0TR1H	CAN0TR2L	CAN0TR2H		SFRPAGE (All Pages)
98	SCON0 (All Pages)		CAN0BTL	CAN0BTH	CAN0IIDL	CAN0IIDH	CAN0TST	
90	P1 (All Pages)		CAN0CFG		CAN0STAT		CAN0ERRL	CAN0ERRH
88	TCON (All Pages)	TMOD (All Pages)	TL0 (All Pages)	TL1 (All Pages)	TH0 (All Pages)	TH1 (All Pages)	CKCON (All Pages)	
80	P0 (All Pages)	SP (All Pages)	DPL (All Pages)	DPH (All Pages)		SFRNEXT (All Pages)	SFRLAST (All Pages)	PCON (All Pages)
	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)

(bit addressable)

Table 12.3. Special Function Registers

SFRs are listed in alphabetical order. All undefined SFR locations are reserved

Register	Address	Description	Page
ACC	0xE0	Accumulator	89
ADC0CF	0xBC	ADC0 Configuration	58
ADC0CN	0xE8	ADC0 Control	60
ADC0GTH	0xC4	ADC0 Greater-Than Compare High	62
ADC0GTL	0xC3	ADC0 Greater-Than Compare Low	62
ADC0H	0xBE	ADC0 High	59
ADC0L	0xBD	ADC0 Low	59
ADC0LTH	0xC6	ADC0 Less-Than Compare Word High	63
ADC0LTL	0xC5	ADC0 Less-Than Compare Word Low	63
ADC0MX	0xBB	ADC0 Mux Configuration	66
ADC0TK	0xBA	ADC0 Tracking Mode Select	61
B	0xF0	B Register	89
CCH0CN	0xE3	Cache Control	134
CKCON	0x8E	Clock Control	260
CLKMUL	0x97	Clock Multiplier	163
CLKSEL	0x8F	Clock Select	158
CPT0CN	0x9A	Comparator0 Control	72
CPT0MD	0x9B	Comparator0 Mode Selection	73
CPT0MX	0x9C	Comparator0 MUX Selection	77
CPT1CN	0x9D	Comparator1 Control	72
CPT1MD	0x9E	Comparator1 Mode Selection	73
CPT1MX	0x9F	Comparator1 MUX Selection	77
DPH	0x83	Data Pointer High	88
DPL	0x82	Data Pointer Low	88
EIE1	0xE6	Extended Interrupt Enable 1	118
EIE2	0xE7	Extended Interrupt Enable 2	118
EIP1	0xF6	Extended Interrupt Priority 1	119
EIP2	0xF7	Extended Interrupt Priority 2	120
EMI0CF	0xB2	External Memory Interface Configuration	148
EMI0CN	0xAA	External Memory Interface Control	147
EMI0TC	0xAA	External Memory Interface Timing Control	152
FLKEY	0xB7	Flash Lock and Key	132
FLSCL	0xB6	Flash Scale	133
IE	0xA8	Interrupt Enable	116
IP	0xB8	Interrupt Priority	117

Table 12.3. Special Function Registers (Continued)

SFRs are listed in alphabetical order. All undefined SFR locations are reserved

Register	Address	Description	Page
IT01CF	0xE4	INT0/INT1 Configuration	123
LIN0ADR	0xD3	LIN0 Address	200
LIN0CF	0xC9	LIN0 Configuration	200
LIN0DAT	0xD2	LIN0 Data	201
OSCICN	0xA1	Internal Oscillator Control	160
OSCICRS	0xA2	Internal Oscillator Coarse Control	161
OSCIFIN	0x9E	Internal Oscillator Fine Calibration	161
OSCXCN	0x9F	External Oscillator Control	165
P0	0x80	Port 0 Latch	183
P0MASK	0xF2	Port 0 Mask Configuration	179
P0MAT	0xF1	Port 0 Match Configuration	179
P0MDIN	0xF1	Port 0 Input Mode Configuration	184
P0MDOUT	0xA4	Port 0 Output Mode Configuration	184
P0SKIP	0xD4	Port 0 Skip	185
P1	0x90	Port 1 Latch	185
P1MASK	0xF4	Port 1 Mask Configuration	180
P1MAT	0xF3	Port 1 Match Configuration	180
P1MDIN	0xF2	Port 1 Input Mode Configuration	186
P1MDOUT	0xA5	Port 1 Output Mode Configuration	186
P1SKIP	0xD5	Port 1 Skip	187
P2	0xA0	Port 2 Latch	187
P2MASK	0xB2	Port 2 Mask Configuration	181
P2MAT	0xB1	Port 2 Match Configuration	181
P2MDIN	0xF3	Port 2 Input Mode Configuration	188
P2MDOUT	0xA6	Port 2 Output Mode Configuration	188
P2SKIP	0xD6	Port 2 Skip	189
P3	0xB0	Port 3 Latch	189
P3MASK	0xAF	Port 3 Mask Configuration	182
P3MAT	0xAE	Port 3 Match Configuration	182
P3MDIN	0xF4	Port 3 Input Mode Configuration	190
P3MDOUT	0xAE	Port 3 Output Mode Configuration	190
P3SKIP	0xD7	Port 3 Skip	191
P4	0xB5	Port 4 Latch	191
P4MDOUT	0xAF	Port 4 Output Mode Configuration	192
PCA0CN	0xD8	PCA Control	294
PCA0CPH0	0xFC	PCA Capture 0 High	299

Table 12.3. Special Function Registers (Continued)

SFRs are listed in alphabetical order. All undefined SFR locations are reserved

Register	Address	Description	Page
PCA0CPH1	0xEA	PCA Capture 1 High	299
PCA0CPH2	0xEC	PCA Capture 2 High	299
PCA0CPH3	0xEE	PCA Capture 3 High	299
PCA0CPH4	0xFE	PCA Capture 4 High	299
PCA0CPH5	0xCF	PCA Capture 5 High	299
PCA0CPL0	0xFB	PCA Capture 0 Low	299
PCA0CPL1	0xE9	PCA Capture 1 Low	299
PCA0CPL2	0xEB	PCA Capture 2 Low	299
PCA0CPL3	0xED	PCA Capture 3 Low	299
PCA0CPL4	0xFD	PCA Capture 4 Low	299
PCA0CPL5	0xCE	PCA Capture 5 Low	299
PCA0CPM0	0xDA	PCA Module 0 Mode Register	297
PCA0CPM1	0xDB	PCA Module 1 Mode Register	297
PCA0CPM2	0xDC	PCA Module 2 Mode Register	297
PCA0CPM3	0xDD	PCA Module 3 Mode Register	297
PCA0CPM4	0xDE	PCA Module 4 Mode Register	297
PCA0CPM5	0xDF	PCA Module 5 Mode Register	297
PCA0H	0xFA	PCA Counter High	298
PCA0L	0xF9	PCA Counter Low	298
PCA0MD	0xD9	PCA Mode	295
PCA0PWM	0xD9	PCA PWM Configuration	296
PCON	0x87	Power Control	137
PSCTL	0x8F	Program Store R/W Control	131
PSW	0xD0	Program Status Word	90
REF0CN	0xD1	Voltage Reference Control	69
REG0CN	0xC9	Voltage Regulator Control	80
RSTSRC	0xEF	Reset Source Configuration/Status	143
SBCON0	0xAB	UART0 Baud Rate Generator Control	244
SBRLH0	0xAD	UART0 Baud Rate Reload High Byte	245
SBRLL0	0xAC	UART0 Baud Rate Reload Low Byte	245
SBUF0	0x99	UART0 Data Buffer	244
SCON0	0x98	UART0 Control	241
SFR0CN	0x84	SFR Page Control	102
SFRLAST	0x86	SFR Stack Last Page	105
SFRNEXT	0x85	SFR Stack Next Page	104
SFRPAGE	0xA7	SFR Page Select	103

Table 12.3. Special Function Registers (Continued)

SFRs are listed in alphabetical order. All undefined SFR locations are reserved

Register	Address	Description	Page
SMB0CF	0xC1	SMBus0 Configuration	224
SMB0CN	0xC0	SMBus0 Control	226
SMB0DAT	0xC2	SMBus0 Data	228
SMOD0	0xA9	UART0 Mode	243
SN0	0xF9	Serial Number 0	91
SN1	0xFA	Serial Number 1	91
SN2	0xFB	Serial Number 2	91
SN3	0xFC	Serial Number 3	91
SP	0x81	Stack Pointer	89
SPI0CFG	0xA1	SPI0 Configuration	253
SPI0CKR	0xA2	SPI0 Clock Rate Control	255
SPI0CN	0xF8	SPI0 Control	254
SPI0DAT	0xA3	SPI0 Data	255
TCON	0x88	Timer/Counter Control	265
TH0	0x8C	Timer/Counter 0 High	268
TH1	0x8D	Timer/Counter 1 High	268
TL0	0x8A	Timer/Counter 0 Low	267
TL1	0x8B	Timer/Counter 1 Low	267
TMOD	0x89	Timer/Counter Mode	266
TMR2CN	0xC8	Timer/Counter 2 Control	272
TMR2H	0xCD	Timer/Counter 2 High	274
TMR2L	0xCC	Timer/Counter 2 Low	274
TMR2RLH	0xCB	Timer/Counter 2 Reload High	273
TMR2RLL	0xCA	Timer/Counter 2 Reload Low	273
TMR3CN	0x91	Timer/Counter 3 Control	278
TMR3H	0x95	Timer/Counter 3 High	280
TMR3L	0x94	Timer/Counter 3 Low	280
TMR3RLH	0x93	Timer/Counter 3 Reload High	279
TMR3RLL	0x92	Timer/Counter 3 Reload Low	279
VDM0CN	0xFF	V_{DD} Monitor Control	141
XBR0	0xE1	Port I/O Crossbar Control 0	176
XBR1	0xE2	Port I/O Crossbar Control 1	177
XBR2	0xC7	Port I/O Crossbar Control 2	178

13. Interrupts

The C8051F55x/56x/57x devices include an extended interrupt system supporting a total of 18 interrupt sources with two priority levels. The allocation of interrupt sources between on-chip peripherals and external inputs pins varies according to the specific version of the device. Each interrupt source has one or more associated interrupt-pending flag(s) located in an SFR. When a peripheral or external source meets a valid interrupt condition, the associated interrupt-pending flag is set to logic 1.

If interrupts are enabled for the source, an interrupt request is generated when the interrupt-pending flag is set. As soon as execution of the current instruction is complete, the CPU generates an LCALL to a predetermined address to begin execution of an interrupt service routine (ISR). Each ISR must end with an RETI instruction, which returns program execution to the next instruction that would have been executed if the interrupt request had not occurred. If interrupts are not enabled, the interrupt-pending flag is ignored by the hardware and program execution continues as normal. (The interrupt-pending flag is set to logic 1 regardless of the interrupt's enable/disable state.)

Each interrupt source can be individually enabled or disabled through the use of an associated interrupt enable bit in an SFR (IE, EIE1, or EIE2). However, interrupts must first be globally enabled by setting the EA bit (IE.7) to logic 1 before the individual interrupt enables are recognized. Setting the EA bit to logic 0 disables all interrupt sources regardless of the individual interrupt-enable settings.

Note: Any instruction that clears a bit to disable an interrupt should be immediately followed by an instruction that has two or more opcode bytes. Using EA (global interrupt enable) as an example:

```
// in 'C':
EA = 0; // clear EA bit.
EA = 0; // this is a dummy instruction with two-byte opcode.

; in assembly:
CLR EA ; clear EA bit.
CLR EA ; this is a dummy instruction with two-byte opcode.
```

For example, if an interrupt is posted during the execution phase of a "CLR EA" opcode (or any instruction which clears a bit to disable an interrupt source), and the instruction is followed by a single-cycle instruction, the interrupt may be taken. However, a read of the enable bit will return a 0 inside the interrupt service routine. When the bit-clearing opcode is followed by a multi-cycle instruction, the interrupt will not be taken.

Some interrupt-pending flags are automatically cleared by the hardware when the CPU vectors to the ISR. However, most are not cleared by the hardware and must be cleared by software before returning from the ISR. If an interrupt-pending flag remains set after the CPU completes the return-from-interrupt (RETI) instruction, a new interrupt request will be generated immediately and the CPU will re-enter the ISR after the completion of the next instruction.

13.1. MCU Interrupt Sources and Vectors

The C8051F55x/56x/57x MCUs support 18 interrupt sources. Software can simulate an interrupt by setting any interrupt-pending flag to logic 1. If interrupts are enabled for the flag, an interrupt request will be generated and the CPU will vector to the ISR address associated with the interrupt-pending flag. MCU interrupt sources, associated vector addresses, priority order and control bits are summarized in Table 13.1. Refer to the datasheet section associated with a particular on-chip peripheral for information regarding valid interrupt conditions for the peripheral and the behavior of its interrupt-pending flag(s).

13.1.1. Interrupt Priorities

Each interrupt source can be individually programmed to one of two priority levels: low or high. A low priority interrupt service routine can be preempted by a high priority interrupt. A high priority interrupt cannot be preempted. Each interrupt has an associated interrupt priority bit in an SFR (IE, EIP1, or EIP2) used to configure its priority level. Low priority is the default. If two interrupts are recognized simultaneously, the interrupt with the higher priority is serviced first. If both interrupts have the same priority level, a fixed priority order is used to arbitrate, given in Table 13.1.

13.1.2. Interrupt Latency

Interrupt response time depends on the state of the CPU when the interrupt occurs. Pending interrupts are sampled and priority decoded each system clock cycle. Therefore, the fastest possible response time is 5 system clock cycles: 1 clock cycle to detect the interrupt and 4 clock cycles to complete the LCALL to the ISR. If an interrupt is pending when a RETI is executed, a single instruction is executed before an LCALL is made to service the pending interrupt. Therefore, the maximum response time for an interrupt (when no other interrupt is currently being serviced or the new interrupt is of greater priority) occurs when the CPU is performing an RETI instruction followed by a DIV as the next instruction. In this case, the response time is 18 system clock cycles: 1 clock cycle to detect the interrupt, 5 clock cycles to execute the RETI, 8 clock cycles to complete the DIV instruction and 4 clock cycles to execute the LCALL to the ISR. If the CPU is executing an ISR for an interrupt with equal or higher priority, the new interrupt will not be serviced until the current ISR completes, including the RETI and following instruction.

Table 13.1. Interrupt Summary

Interrupt Source	Interrupt Vector	Priority Order	Pending Flag	Bit addressable?	Cleared by HW?	Enable Flag	Priority Control
Reset	0x0000	Top	None	N/A	N/A	Always Enabled	Always Highest
External Interrupt 0 (INT0)	0x0003	0	IE0 (TCON.1)	Y	Y	EX0 (IE.0)	PX0 (IP.0)
Timer 0 Overflow	0x000B	1	TF0 (TCON.5)	Y	Y	ET0 (IE.1)	PT0 (IP.1)
External Interrupt 1 (INT1)	0x0013	2	IE1 (TCON.3)	Y	Y	EX1 (IE.2)	PX1 (IP.2)
Timer 1 Overflow	0x001B	3	TF1 (TCON.7)	Y	Y	ET1 (IE.3)	PT1 (IP.3)
UART0	0x0023	4	RI0 (SCON0.0) TI0 (SCON0.1)	Y	N	ES0 (IE.4)	PS0 (IP.4)
Timer 2 Overflow	0x002B	5	TF2H (TMR2CN.7) TF2L (TMR2CN.6)	Y	N	ET2 (IE.5)	PT2 (IP.5)
SPI0	0x0033	6	SPIF (SPI0CN.7) WCOL (SPI0CN.6) MODF (SPI0CN.5) RXOVRN (SPI0CN.4)	Y	N	ESPI0 (IE.6)	PSPI0 (IP.6)
SMB0	0x003B	7	SI (SMB0CN.0)	Y	N	ESMB0 (EIE1.0)	PSMB0 (EIP1.0)
ADC0 Window Compare	0x0043	8	AD0WINT (ADC0CN.3)	Y	N	EWADC0 (EIE1.1)	PWADC0 (EIP1.1)
ADC0 Conversion Complete	0x004B	9	AD0INT (ADC0CN.5)	Y	N	EADC0 (EIE1.2)	PADC0 (EIP1.2)
Programmable Counter Array	0x0053	10	CF (PCA0CN.7) CCFn (PCA0CN.n) COVF (PCA0PWM.6)	Y	N	EPCA0 (EIE1.3)	PPCA0 (EIP1.3)
Comparator0	0x005B	11	CP0FIF (CPT0CN.4) CP0RIF (CPT0CN.5)	N	N	ECP0 (EIE1.4)	PCP0 (EIP1.4)
Comparator1	0x0063	12	CP1FIF (CPT1CN.4) CP1RIF (CPT1CN.5)	N	N	ECP1 (EIE1.5)	PCP1 (EIP1.5)
Timer 3 Overflow	0x006B	13	TF3H (TMR3CN.7) TF3L (TMR3CN.6)	N	N	ET3 (EIE1.6)	PT3 (EIP1.6)
LIN0	0x0073	14	LIN0INT (LINST.3)	N	N*	ELIN0 (EIE1.7)	PLIN0 (EIP1.7)
Voltage Regulator Dropout	0x007B	15	N/A	N/A	N/A	EREG0 (EIE2.0)	PREG0 (EIP2.0)
CAN0	0x0083	16	CAN0INT (CAN0CN.7)	N	Y	ECAN0 (EIE2.1)	PCAN0 (EIP2.1)
Port Match	0x008B	17	None	N/A	N/A	EMAT (EIE2.2)	PMAT (EIP2.2)
***Note:** The LIN0INT bit is cleared by setting RSTINT (LINCTRL.3)							

13.2. Interrupt Register Descriptions

The SFRs used to enable the interrupt sources and set their priority level are described in this section. Refer to the data sheet section associated with a particular on-chip peripheral for information regarding valid interrupt conditions for the peripheral and the behavior of its interrupt-pending flag(s).

SFR Definition 13.1. IE: Interrupt Enable

Bit	7	6	5	4	3	2	1	0
Name	EA	ESPI0	ET2	ES0	ET1	EX1	ET0	EX0
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA8; Bit-Addressable; SFR Page = All Pages

Bit	Name	Function
7	EA	**Enable All Interrupts.** Globally enables/disables all interrupts. It overrides individual interrupt mask settings. 0: Disable all interrupt sources. 1: Enable each interrupt according to its individual mask setting.
6	ESPI0	**Enable Serial Peripheral Interface (SPI0) Interrupt.** This bit sets the masking of the SPI0 interrupts. 0: Disable all SPI0 interrupts. 1: Enable interrupt requests generated by SPI0.
5	ET2	**Enable Timer 2 Interrupt.** This bit sets the masking of the Timer 2 interrupt. 0: Disable Timer 2 interrupt. 1: Enable interrupt requests generated by the TF2L or TF2H flags.
4	ES0	**Enable UART0 Interrupt.** This bit sets the masking of the UART0 interrupt. 0: Disable UART0 interrupt. 1: Enable UART0 interrupt.
3	ET1	**Enable Timer 1 Interrupt.** This bit sets the masking of the Timer 1 interrupt. 0: Disable all Timer 1 interrupt. 1: Enable interrupt requests generated by the TF1 flag.
2	EX1	**Enable External Interrupt 1.** This bit sets the masking of External Interrupt 1. 0: Disable external interrupt 1. 1: Enable interrupt requests generated by the $\overline{\text{INT1}}$ input.
1	ET0	**Enable Timer 0 Interrupt.** This bit sets the masking of the Timer 0 interrupt. 0: Disable all Timer 0 interrupt. 1: Enable interrupt requests generated by the TF0 flag.
0	EX0	**Enable External Interrupt 0.** This bit sets the masking of External Interrupt 0. 0: Disable external interrupt 0. 1: Enable interrupt requests generated by the $\overline{\text{INT0}}$ input.

SFR Definition 13.2. IP: Interrupt Priority

Bit	7	6	5	4	3	2	1	0
Name		PSPI0	PT2	PS0	PT1	PX1	PT0	PX0
Type	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	0	0	0	0	0	0	0

SFR Address = 0xB8; Bit-Addressable; SFR Page = All Pages

Bit	Name	Function
7	Unused	Read = 1b, Write = Don't Care.
6	PSPI0	**Serial Peripheral Interface (SPI0) Interrupt Priority Control.** This bit sets the priority of the SPI0 interrupt. 0: SPI0 interrupt set to low priority level. 1: SPI0 interrupt set to high priority level.
5	PT2	**Timer 2 Interrupt Priority Control.** This bit sets the priority of the Timer 2 interrupt. 0: Timer 2 interrupt set to low priority level. 1: Timer 2 interrupt set to high priority level.
4	PS0	**UART0 Interrupt Priority Control.** This bit sets the priority of the UART0 interrupt. 0: UART0 interrupt set to low priority level. 1: UART0 interrupt set to high priority level.
3	PT1	**Timer 1 Interrupt Priority Control.** This bit sets the priority of the Timer 1 interrupt. 0: Timer 1 interrupt set to low priority level. 1: Timer 1 interrupt set to high priority level.
2	PX1	**External Interrupt 1 Priority Control.** This bit sets the priority of the External Interrupt 1 interrupt. 0: External Interrupt 1 set to low priority level. 1: External Interrupt 1 set to high priority level.
1	PT0	**Timer 0 Interrupt Priority Control.** This bit sets the priority of the Timer 0 interrupt. 0: Timer 0 interrupt set to low priority level. 1: Timer 0 interrupt set to high priority level.
0	PX0	**External Interrupt 0 Priority Control.** This bit sets the priority of the External Interrupt 0 interrupt. 0: External Interrupt 0 set to low priority level. 1: External Interrupt 0 set to high priority level.

SFR Definition 13.3. EIE1: Extended Interrupt Enable 1

Bit	7	6	5	4	3	2	1	0
Name	ELIN0	ET3	ECP1	ECP0	EPCA0	EADC0	EWADC0	ESMB0
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE6; SFR Page = All Pages

Bit	Name	Function
7	ELIN0	**Enable LIN0 Interrupt.** This bit sets the masking of the LIN0 interrupt. 0: Disable LIN0 interrupts. 1: Enable interrupt requests generated by the LIN0INT flag.
6	ET3	**Enable Timer 3 Interrupt.** This bit sets the masking of the Timer 3 interrupt. 0: Disable Timer 3 interrupts. 1: Enable interrupt requests generated by the TF3L or TF3H flags.
5	ECP1	**Enable Comparator1 (CP1) Interrupt.** This bit sets the masking of the CP1 interrupt. 0: Disable CP1 interrupts. 1: Enable interrupt requests generated by the CP1RIF or CP1FIF flags.
4	ECP0	**Enable Comparator0 (CP0) Interrupt.** This bit sets the masking of the CP0 interrupt. 0: Disable CP0 interrupts. 1: Enable interrupt requests generated by the CP0RIF or CP0FIF flags.
3	EPCA0	**Enable Programmable Counter Array (PCA0) Interrupt.** This bit sets the masking of the PCA0 interrupts. 0: Disable all PCA0 interrupts. 1: Enable interrupt requests generated by PCA0.
2	EADC0	**Enable ADC0 Conversion Complete Interrupt.** This bit sets the masking of the ADC0 Conversion Complete interrupt. 0: Disable ADC0 Conversion Complete interrupt. 1: Enable interrupt requests generated by the AD0INT flag.
1	EWADC0	**Enable Window Comparison ADC0 Interrupt.** This bit sets the masking of ADC0 Window Comparison interrupt. 0: Disable ADC0 Window Comparison interrupt. 1: Enable interrupt requests generated by ADC0 Window Compare flag (AD0WINT).
0	ESMB0	**Enable SMBus (SMB0) Interrupt.** This bit sets the masking of the SMB0 interrupt. 0: Disable all SMB0 interrupts. 1: Enable interrupt requests generated by SMB0.

SFR Definition 13.4. EIP1: Extended Interrupt Priority 1

Bit	7	6	5	4	3	2	1	0
Name	PLIN0	PT3	PCP1	PCP0	PPCA0	PADC0	PWADC0	PSMB0
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xF6; SFR Page = 0x00 and 0x0F

Bit	Name	Function
7	PLIN0	**LIN0 Interrupt Priority Control.** This bit sets the priority of the LIN0 interrupt. 0: LIN0 interrupts set to low priority level. 1: LIN0 interrupts set to high priority level.
6	PT3	**Timer 3 Interrupt Priority Control.** This bit sets the priority of the Timer 3 interrupt. 0: Timer 3 interrupts set to low priority level. 1: Timer 3 interrupts set to high priority level.
5	PCP1	**Comparator0 (CP1) Interrupt Priority Control.** This bit sets the priority of the CP1 interrupt. 0: CP1 interrupt set to low priority level. 1: CP1 interrupt set to high priority level.
4	PCP0	**Comparator0 (CP0) Interrupt Priority Control.** This bit sets the priority of the CP0 interrupt. 0: CP0 interrupt set to low priority level. 1: CP0 interrupt set to high priority level.
3	PPCA0	**Programmable Counter Array (PCA0) Interrupt Priority Control.** This bit sets the priority of the PCA0 interrupt. 0: PCA0 interrupt set to low priority level. 1: PCA0 interrupt set to high priority level.
2	PADC0	**ADC0 Conversion Complete Interrupt Priority Control.** This bit sets the priority of the ADC0 Conversion Complete interrupt. 0: ADC0 Conversion Complete interrupt set to low priority level. 1: ADC0 Conversion Complete interrupt set to high priority level.
1	PWADC0	**ADC0 Window Comparator Interrupt Priority Control.** This bit sets the priority of the ADC0 Window interrupt. 0: ADC0 Window interrupt set to low priority level. 1: ADC0 Window interrupt set to high priority level.
0	PSMB0	**SMBus (SMB0) Interrupt Priority Control.** This bit sets the priority of the SMB0 interrupt. 0: SMB0 interrupt set to low priority level. 1: SMB0 interrupt set to high priority level.

SFR Definition 13.5. EIE2: Extended Interrupt Enable 2

Bit	7	6	5	4	3	2	1	0
Name						EMAT	ECAN0	EREG0
Type	R	R	R	R	R	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE7; SFR Page = All Pages

Bit	Name	Function
7:3	Unused	Read = 00000b; Write = Don't Care.
2	EMAT	**Enable Port Match Interrupt.** This bit sets the masking of the Port Match interrupt. 0: Disable all Port Match interrupts. 1: Enable interrupt requests generated by a Port Match
1	ECAN0	**Enable CAN0 Interrupts.** This bit sets the masking of the CAN0 interrupt. 0: Disable all CAN0 interrupts. 1: Enable interrupt requests generated by CAN0.
0	EREG0	**Enable Voltage Regulator Dropout Interrupt.** This bit sets the masking of the Voltage Regulator Dropout interrupt. 0: Disable the Voltage Regulator Dropout interrupt. 1: Enable the Voltage Regulator Dropout interrupt.

SFR Definition 13.6. EIP2: Extended Interrupt Priority Enabled 2

Bit	7	6	5	4	3	2	1	0
Name						PMAT	PCAN0	PREG0
Type	R	R	R	R	R	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xF7; SFR Page = 0x00 and 0x0F

Bit	Name	Function
7:3	Unused	Read = 00000b; Write = Don't Care.
2	PMAT	**Port Match Interrupt Priority Control.** This bit sets the priority of the Port Match interrupt. 0: Port Match interrupt set to low priority level. 1: Port Match interrupt set to high priority level.
1	PCAN0	**CAN0 Interrupt Priority Control.** This bit sets the priority of the CAN0 interrupt. 0: CAN0 interrupt set to low priority level. 1: CAN0 interrupt set to high priority level.
0	PREG0	**Voltage Regulator Dropout Interrupt Priority Control.** This bit sets the priority of the Voltage Regulator Dropout interrupt. 0: Voltage Regulator Dropout interrupt set to low priority level. 1: Voltage Regulator Dropout interrupt set to high priority level.

13.3. External Interrupts $\overline{\text{INT0}}$ and $\overline{\text{INT1}}$

The $\overline{\text{INT0}}$ and $\overline{\text{INT1}}$ external interrupt sources are configurable as active high or low, edge or level sensitive. The IN0PL ($\overline{\text{INT0}}$ Polarity) and IN1PL ($\overline{\text{INT1}}$ Polarity) bits in the IT01CF register select active high or active low; the IT0 and IT1 bits in TCON (Section “25.1. Timer 0 and Timer 1” on page 261) select level or edge sensitive. The table below lists the possible configurations.

IT0	IN0PL	$\overline{\text{INT0}}$ Interrupt
1	0	Active low, edge sensitive
1	1	Active high, edge sensitive
0	0	Active low, level sensitive
0	1	Active high, level sensitive

IT1	IN1PL	$\overline{\text{INT1}}$ Interrupt
1	0	Active low, edge sensitive
1	1	Active high, edge sensitive
0	0	Active low, level sensitive
0	1	Active high, level sensitive

$\overline{\text{INT0}}$ and $\overline{\text{INT1}}$ are assigned to Port pins as defined in the IT01CF register (see SFR Definition 13.7). Note that $\overline{\text{INT0}}$ and $\overline{\text{INT0}}$ Port pin assignments are independent of any Crossbar assignments. $\overline{\text{INT0}}$ and $\overline{\text{INT1}}$ will monitor their assigned Port pins without disturbing the peripheral that was assigned the Port pin via the Crossbar. To assign a Port pin only to $\overline{\text{INT0}}$ and/or $\overline{\text{INT1}}$, configure the Crossbar to skip the selected pin(s). This is accomplished by setting the associated bit in register XBR0 (see Section “19.3. Priority Crossbar Decoder” on page 172 for complete details on configuring the Crossbar).

IE0 (TCON.1) and IE1 (TCON.3) serve as the interrupt-pending flags for the $\overline{\text{INT0}}$ and $\overline{\text{INT1}}$ external interrupts, respectively. If an $\overline{\text{INT0}}$ or $\overline{\text{INT1}}$ external interrupt is configured as edge-sensitive, the corresponding interrupt-pending flag is automatically cleared by the hardware when the CPU vectors to the ISR. When configured as level sensitive, the interrupt-pending flag remains logic 1 while the input is active as defined by the corresponding polarity bit (IN0PL or IN1PL); the flag remains logic 0 while the input is inactive. The external interrupt source must hold the input active until the interrupt request is recognized. It must then deactivate the interrupt request before execution of the ISR completes or another interrupt request will be generated.

SFR Definition 13.7. IT01CF: INT0/INT1 Configuration

Bit	7	6	5	4	3	2	1	0
Name	IN1PL	IN1SL[2:0]			IN0PL	IN0SL[2:0]		
Type	R/W	R/W			R/W	R/W		
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE4; SFR Page = 0x0F

Bit	Name	Function
7	IN1PL	**$\overline{\text{INT1}}$ Polarity.** 0: $\overline{\text{INT1}}$ input is active low. 1: $\overline{\text{INT1}}$ input is active high.
6:4	IN1SL[2:0]	**$\overline{\text{INT1}}$ Port Pin Selection Bits.** These bits select which Port pin is assigned to $\overline{\text{INT1}}$. Note that this pin assignment is independent of the Crossbar; $\overline{\text{INT1}}$ will monitor the assigned Port pin without disturbing the peripheral that has been assigned the Port pin via the Crossbar. The Crossbar will not assign the Port pin to a peripheral if it is configured to skip the selected pin. 000: Select P1.0 001: Select P1.1 010: Select P1.2 011: Select P1.3 100: Select P1.4 101: Select P1.5 110: Select P1.6 111: Select P1.7
3	IN0PL	**$\overline{\text{INT0}}$ Polarity.** 0: $\overline{\text{INT0}}$ input is active low. 1: $\overline{\text{INT0}}$ input is active high.
2:0	IN0SL[2:0]	**$\overline{\text{INT0}}$ Port Pin Selection Bits.** These bits select which Port pin is assigned to $\overline{\text{INT0}}$. Note that this pin assignment is independent of the Crossbar; $\overline{\text{INT0}}$ will monitor the assigned Port pin without disturbing the peripheral that has been assigned the Port pin via the Crossbar. The Crossbar will not assign the Port pin to a peripheral if it is configured to skip the selected pin. 000: Select P1.0 001: Select P1.1 010: Select P1.2 011: Select P1.3 100: Select P1.4 101: Select P1.5 110: Select P1.6 111: Select P1.7

14. Flash Memory

On-chip, re-programmable Flash memory is included for program code and non-volatile data storage. The Flash memory can be programmed in-system, a single byte at a time, through the C2 interface or by software using the MOVX instruction. Once cleared to logic 0, a Flash bit must be erased to set it back to logic 1. Flash bytes would typically be erased (set to 0xFF) before being reprogrammed. The write and erase operations are automatically timed by hardware for proper execution; data polling to determine the end of the write/erase operation is not required. Code execution is stalled during a Flash write/erase operation. Refer to Table 5.5 for complete Flash memory electrical characteristics.

14.1. Programming The Flash Memory

The simplest means of programming the Flash memory is through the C2 interface using programming tools provided by Silicon Labs or a third party vendor. This is the only means for programming a non-initialized device. For details on the C2 commands to program Flash memory, see Section “27. C2 Interface” on page 300.

To ensure the integrity of Flash contents, it is strongly recommended that the on-chip V_{DD} Monitor be enabled in any system that includes code that writes and/or erases Flash memory from software. See Section 14.4 for more details. Before performing any Flash write or erase procedure, set the FLEWT bit in Flash Scale register (FLSCL) to 1. Also, note that 8-bit MOVX instructions cannot be used to erase or write to Flash memory at addresses higher than 0x00FF.

For –I (Industrial Grade) parts, parts programmed at a cold temperature below 0 °C may exhibit weakly programmed flash memory bits. If programmed at 0 °C or higher, there is no problem reading Flash across the entire temperature range of -40 °C to 125 °C. This temperature restriction does not apply to –A (Automotive Grade) devices.

14.1.1. Flash Lock and Key Functions

Flash writes and erases by user software are protected with a lock and key function. The Flash Lock and Key Register (FLKEY) must be written with the correct key codes, in sequence, before Flash operations may be performed. The key codes are: 0xA5, 0xF1. The timing does not matter, but the codes must be written in order. If the key codes are written out of order, or the wrong codes are written, Flash writes and erases will be disabled until the next system reset. Flash writes and erases will also be disabled if a Flash write or erase is attempted before the key codes have been written properly. The Flash lock resets after each write or erase; the key codes must be written again before a following Flash operation can be performed. The FLKEY register is detailed in SFR Definition 14.2.

14.1.2. Flash Erase Procedure

The Flash memory can be programmed by software using the MOVX write instruction with the address and data byte to be programmed provided as normal operands. Before writing to Flash memory using MOVX, Flash write operations must be enabled by doing the following: (1) setting the PSWE Program Store Write Enable bit (PSCTL.0) to logic 1 (this directs the MOVX writes to target Flash memory); and (2) Writing the Flash key codes in sequence to the Flash Lock register (FLKEY). The PSWE bit remains set until cleared by software.

A write to Flash memory can clear bits to logic 0 but cannot set them; only an erase operation can set bits to logic 1 in Flash. **A byte location to be programmed should be erased before a new value is written.** The Flash memory is organized in 512-byte pages. The erase operation applies to an entire page (setting all bytes in the page to 0xFF). To erase an entire 512-byte page, perform the following steps:

1. Disable interrupts (recommended).
2. Set the FLEWT bit (register FLSCL).
3. Set the PSEE bit (register PSCTL).
4. Set the PSWE bit (register PSCTL).
5. Write the first key code to FLKEY: 0xA5.
6. Write the second key code to FLKEY: 0xF1.
7. Using the MOVX instruction, write a data byte to any location within the 512-byte page to be erased.
8. Clear the PSWE and PSEE bits.

14.1.3. Flash Write Procedure

Flash bytes are programmed by software with the following sequence:

1. Disable interrupts (recommended).
2. Erase the 512-byte Flash page containing the target location, as described in Section 14.1.2.
3. Set the FLEWT bit (register FLSCL).
4. Set the PSWE bit (register PSCTL).
5. Clear the PSEE bit (register PSCTL).
6. Write the first key code to FLKEY: 0xA5.
7. Write the second key code to FLKEY: 0xF1.
8. Using the MOVX instruction, write a single data byte to the desired location within the 512-byte sector.
9. Clear the PSWE bit.

Steps 5–7 must be repeated for each byte to be written. After Flash writes are complete, PSWE should be cleared so that MOVX instructions do not target program memory.

14.1.4. Flash Write Optimization

The Flash write procedure includes a block write option to optimize the time to perform consecutive byte writes. When block write is enabled by setting the CHBLKW bit (CCH0CN.0), writes to two consecutive bytes in Flash require the same amount of time as a single byte write. This is performed by caching the first byte that is written to Flash and then committing both bytes to Flash when the second byte is written. When block writes are enabled, if the second write does not occur, the first data byte written is not actually written to Flash. Flash bytes with block write enabled are programmed by software with the following sequence:

1. Disable interrupts (recommended).
2. Erase the 512-byte Flash page containing the target location, as described in Section 14.1.2.
3. Set the FLEWT bit (register FLSCL).
4. Set the CHBLKW bit (register CCH0CN).
5. Set the PSWE bit (register PSCTL).
6. Clear the PSEE bit (register PSCTL).
7. Write the first key code to FLKEY: 0xA5.
8. Write the second key code to FLKEY: 0xF1.
9. Using the MOVX instruction, write the first data byte to the desired location within the 512-byte sector.
10. Write the first key code to FLKEY: 0xA5.
11. Write the second key code to FLKEY: 0xF1.
12. Using the MOVX instruction, write the second data byte to the desired location within the 512-byte sector. The location of the second byte must be the next higher address from the first data byte.
13. Clear the PSWE bit.
14. Clear the CHBLKW bit.

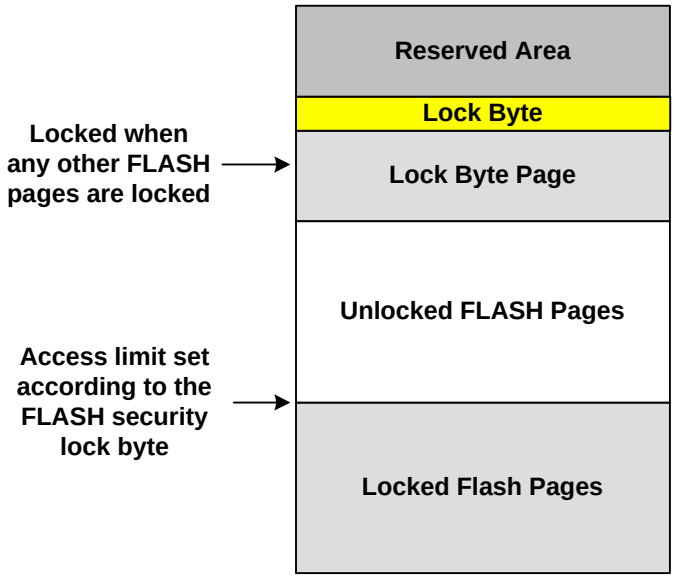
14.2. Non-volatile Data Storage

The Flash memory can be used for non-volatile data storage as well as program code. This allows data such as calibration coefficients to be calculated and stored at run time. Data is written using the MOVX write instruction and read using the MOVC instruction. Note: MOVX read instructions always target XRAM.

14.3. Security Options

The CIP-51 provides security options to protect the Flash memory from inadvertent modification by software as well as to prevent the viewing of proprietary program code and constants. The Program Store Write Enable (bit PSWE in register PSCTL) and the Program Store Erase Enable (bit PSEE in register PSCTL) bits protect the Flash memory from accidental modification by software. PSWE must be explicitly set to 1 before software can modify the Flash memory; both PSWE and PSEE must be set to 1 before software can erase Flash memory. Additional security features prevent proprietary program code and data constants from being read or altered across the C2 interface.

A Security Lock Byte located at the last byte of Flash user space offers protection of the Flash program memory from access (reads, writes, or erases) by unprotected code or the C2 interface. The Flash security mechanism allows the user to lock *n* 512-byte Flash pages, starting at page 0 (addresses 0x0000 to 0x01FF), where *n* is the ones complement number represented by the Security Lock Byte. **Note that the page containing the Flash Security Lock Byte is unlocked when no other Flash pages are locked (all bits of the Lock Byte are 1) and locked when any other Flash pages are locked (any bit of the Lock Byte is 0).** See example in Figure 14.1.



Security Lock Byte:	11111101b
1s Complement:	00000010b
Flash pages locked:	3 (First two Flash pages + Lock Byte Page)

Figure 14.1. Flash Program Memory Map

The level of Flash security depends on the Flash access method. The three Flash access methods that can be restricted are reads, writes, and erases from the C2 debug interface, user firmware executing on unlocked pages, and user firmware executing on locked pages. Table 14.1 summarizes the Flash security features of the C8051F55x/56x/57x devices.

Table 14.1. Flash Security Summary

Action	C2 Debug Interface	User Firmware executing from:	
		an unlocked page	a locked page
Read, Write or Erase unlocked pages (except page with Lock Byte)	Permitted	Permitted	Permitted
Read, Write or Erase locked pages (except page with Lock Byte)	Not Permitted	Flash Error Reset	Permitted
Read or Write page containing Lock Byte (if no pages are locked)	Permitted	Permitted	Permitted
Read or Write page containing Lock Byte (if any page is locked)	Not Permitted	Flash Error Reset	Permitted
Read contents of Lock Byte (if no pages are locked)	Permitted	Permitted	Permitted
Read contents of Lock Byte (if any page is locked)	Not Permitted	Flash Error Reset	Permitted
Erase page containing Lock Byte (if no pages are locked)	Permitted	Flash Error Reset	Flash Error Reset
Erase page containing Lock Byte—Unlock all pages (if any page is locked)	C2 Device Erase Only	Flash Error Reset	Flash Error Reset
Lock additional pages (change '1's to '0's in the Lock Byte)	Not Permitted	Flash Error Reset	Flash Error Reset
Unlock individual pages (change '0's to '1's in the Lock Byte)	Not Permitted	Flash Error Reset	Flash Error Reset
Read, Write or Erase Reserved Area	Not Permitted	Flash Error Reset	Flash Error Reset

C2 Device Erase—Erases all Flash pages including the page containing the Lock Byte.

Flash Error Reset—Not permitted; Causes Flash Error Device Reset (FERROR bit in RSTSRC is '1' after reset).

- All prohibited operations that are performed via the C2 interface are ignored (do not cause device reset).
- Locking any Flash page also locks the page containing the Lock Byte.
- Once written to, the Lock Byte cannot be modified except by performing a C2 Device Erase.
- If user code writes to the Lock Byte, the Lock does not take effect until the next device reset.

14.4. Flash Write and Erase Guidelines

Any system which contains routines which write or erase Flash memory from software involves some risk that the write or erase routines will execute unintentionally if the CPU is operating outside its specified operating range of V_{DD}, system clock frequency, or temperature. This accidental execution of Flash modifying code can result in alteration of Flash memory contents causing a system failure that is only recoverable by re-Flashing the code in the device.

The following guidelines are recommended for any system which contains routines which write or erase Flash from code.

14.4.1. V_{DD} Maintenance and the V_{DD} monitor

1. If the system power supply is subject to voltage or current "spikes," add sufficient transient protection devices to the power supply to ensure that the supply voltages listed in the Absolute Maximum Ratings table are not exceeded.
2. Make certain that the minimum VREGIN rise time specification of 1 ms is met. If the system cannot meet this rise time specification, then add an external V_{DD} brownout circuit to the RST pin of the device that holds the device in reset until V_{DD} reaches the minimum threshold and re-asserts RST if V_{DD} drops below the minimum threshold.
3. Enable the on-chip V_{DD} monitor in the high setting and enable the V_{DD} monitor as a reset source as early in code as possible. This should be the first set of instructions executed after the Reset Vector. For C-based systems, this will involve modifying the startup code added by the C compiler. See your compiler documentation for more details. Make certain that there are no delays in software between enabling the V_{DD} monitor in the high setting and enabling the V_{DD} monitor as a reset source. Code examples showing this can be found in “AN201: Writing to Flash from Firmware", available from the Silicon Laboratories web site.
4. As an added precaution, explicitly enable the V_{DD} monitor in the high setting and enable the V_{DD} monitor as a reset source inside the functions that write and erase Flash memory. The V_{DD} monitor enable instructions should be placed just after the instruction to set PSWE to a 1, but before the Flash write or erase operation instruction.

Note: The output of the internal voltage regulator is calibrated by the MCU immediately after any reset event. The output of the un-calibrated internal regulator could be below the high threshold setting of the V_{DD} Monitor. If this is the case *and* the V_{DD} Monitor is set to the high threshold setting *and* if the MCU receives a non-power on reset (POR), the MCU will remain in reset until a POR occurs (i.e., V_{DD} Monitor will keep the device in reset). A POR will force the V_{DD} Monitor to the low threshold setting which is guaranteed to be below the un-calibrated output of the internal regulator. The device will then exit reset and resume normal operation. It is for this reason Silicon Labs strongly recommends that the V_{DD} Monitor is always left in the low threshold setting (i.e. default value upon POR). When programming the Flash in-system, the V_{DD} Monitor must be set to the high threshold setting. For the highest system reliability, the time the V_{DD} Monitor is set to the high threshold setting should be minimized (e.g., setting the V_{DD} Monitor to the high threshold setting just before the Flash write operation and then changing it back to the low threshold setting immediately after the Flash write operation).

5. Make certain that all writes to the RSTSRC (Reset Sources) register use direct assignment operators and explicitly DO NOT use the bit-wise operators (such as AND or OR). For example, "RSTSRC = 0x02" is correct. "RSTSRC |= 0x02" is incorrect.
6. Make certain that all writes to the RSTSRC register explicitly set the PORSF bit to a 1. Areas to check are initialization code which enables other reset sources, such as the Missing Clock Detector or Comparator, for example, and instructions which force a Software Reset. A global search on "RSTSRC" can quickly verify this.

14.4.2. PSWE Maintenance

1. Reduce the number of places in code where the PSWE bit (b0 in PSCTL) is set to a 1. There should be exactly one routine in code that sets PSWE to a 1 to write Flash bytes and one routine in code that sets PSWE and PSEE both to a 1 to erase Flash pages.
2. Minimize the number of variable accesses while PSWE is set to a 1. Handle pointer address updates and loop variable maintenance outside the "PSWE = 1;... PSWE = 0;" area. Code examples showing this can be found in ”AN201: Writing to Flash from Firmware" available from the Silicon Laboratories web site.
3. Disable interrupts prior to setting PSWE to a 1 and leave them disabled until after PSWE has been reset to '0'. Any interrupts posted during the Flash write or erase operation will be serviced in priority order after the Flash operation has been completed and interrupts have been re-enabled by software.
4. Make certain that the Flash write and erase pointer variables are not located in XRAM. See your compiler documentation for instructions regarding how to explicitly locate variables in different memory areas.
5. Add address bounds checking to the routines that write or erase Flash memory to ensure that a routine called with an illegal address does not result in modification of the Flash.

14.4.3. System Clock

1. If operating from an external crystal, be advised that crystal performance is susceptible to electrical interference and is sensitive to layout and to changes in temperature. If the system is operating in an electrically noisy environment, use the internal oscillator or use an external CMOS clock.
2. If operating from the external oscillator, switch to the internal oscillator during Flash write or erase operations. The external oscillator can continue to run, and the CPU can switch back to the external oscillator after the Flash operation has completed.

Additional Flash recommendations and example code can be found in “AN201: Writing to Flash from Firmware" available from the Silicon Laboratories web site.

SFR Definition 14.1. PSCTL: Program Store R/W Control

Bit	7	6	5	4	3	2	1	0
Name							PSEE	PSWE
Type	R	R	R	R	R	R	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8F; SFR Page = 0x00

Bit	Name	Function
7:2	Unused	Read = 000000b, Write = don't care.
1	PSEE	**Program Store Erase Enable.** Setting this bit (in combination with PSWE) allows an entire page of Flash program memory to be erased. If this bit is logic 1 and Flash writes are enabled (PSWE is logic 1), a write to Flash memory using the MOVX instruction will erase the entire page that contains the location addressed by the MOVX instruction. The value of the data byte written does not matter. 0: Flash program memory erasure disabled. 1: Flash program memory erasure enabled.
0	PSWE	**Program Store Write Enable.** Setting this bit allows writing a byte of data to the Flash program memory using the MOVX write instruction. The Flash location should be erased before writing data. 0: Writes to Flash program memory disabled. 1: Writes to Flash program memory enabled; the MOVX write instruction targets Flash memory.

SFR Definition 14.2. FLKEY: Flash Lock and Key

Bit	7	6	5	4	3	2	1	0
Name	FLKEY[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xB7; SFR Page = All Pages

Bit	Name	Function
7:0	FLKEY[7:0]	**Flash Lock and Key Register.** Write: This register provides a lock and key function for Flash erasures and writes. Flash writes and erases are enabled by writing 0xA5 followed by 0xF1 to the FLKEY register. Flash writes and erases are automatically disabled after the next write or erase is complete. If any writes to FLKEY are performed incorrectly, or if a Flash write or erase operation is attempted while these operations are disabled, the Flash will be permanently locked from writes or erasures until the next device reset. If an application never writes to Flash, it can intentionally lock the Flash by writing a non-0xA5 value to FLKEY from software. Read: When read, bits 1–0 indicate the current Flash lock state. 00: Flash is write/erase locked. 01: The first key code has been written (0xA5). 10: Flash is unlocked (writes/erases allowed). 11: Flash writes/erases disabled until the next reset.

SFR Definition 14.3. FLSCL: Flash Scale

Bit	7	6	5	4	3	2	1	0
Name	Reserved	Reserved	Reserved	FLRT	Reserved	Reserved	FLEWT	Reserved
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xB6; SFR Page = All Pages

Bit	Name	Function
7:5	Reserved	Must Write 000b.
4	FLRT	**Flash Read Time Control.** This bit should be programmed to the smallest allowed value, according to the system clock speed. 0: SYSCLK ≤ 25 MHz (Flash read strobe is one system clock). 1: SYSCLK > 25 MHz (Flash read strobe is two system clocks).
3:2	Reserved	Must Write 00b.
1	FLEWT	**Flash Erase Write Time Control.** This bit should be set to 1b before Writing or Erasing Flash. 0: Short Flash Erase / Write Timing. 1: Extended Flash Erase / Write Timing.
0	Reserved	Must Write 0b.

SFR Definition 14.4. CCH0CN: Cache Control

Bit	7	6	5	4	3	2	1	0
Name	Reserved	Reserved	CHPFEN	Reserved	Reserved	Reserved	Reserved	CHBLKW
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	1	0	0	0	0	0

SFR Address = 0xE3; SFR Page = 0x0F

Bit	Name	Function
7:6	Reserved	Must Write 00b
5	CHPFEN	**Cache Prefect Enable Bit.** 0: Prefetch engine is disabled. 1: Prefetch engine is enabled.
4:1	Reserved	Must Write 0000b.
0	CHBLKW	**Block Write Enable Bit.** This bit allows block writes to Flash memory from firmware. 0: Each byte of a software Flash write is written individually. 1: Flash bytes are written in groups of two.

SFR Definition 14.5. ONESHOT: Flash Oneshot Period

Bit	7	6	5	4	3	2	1	0
Name					PERIOD[3:0]			
Type	R	R	R	R	R/W	R/W	R/W	R/W
Reset	0	0	0	0	1	1	1	1

SFR Address = 0xBE; SFR Page = 0x0F

Bit	Name	Function
7:4	Unused	Read = 0000b. Write = don't care.
3:0	PERIOD[3:0]	**Oneshot Period Control Bits.** These bits limit the internal Flash read strobe width as follows. When the Flash read strobe is de-asserted, the Flash memory enters a low-power state for the remainder of the system clock cycle. $FLASH_{RDMAX} = 5ns + (PERIOD \times 5ns)$

15. Power Management Modes

The C8051F55x/56x/57x devices have three software programmable power management modes: Idle, Stop, and Suspend. Idle mode and Stop mode are part of the standard 8051 architecture, while Suspend mode is an enhanced power-saving mode implemented by the high-speed oscillator peripheral.

Idle mode halts the CPU while leaving the peripherals and clocks active. In Stop mode, the CPU is halted, all interrupts and timers (except the Missing Clock Detector) are inactive, and the internal oscillator is stopped (analog peripherals remain in their selected states; the external oscillator is not affected). Suspend mode is similar to Stop mode in that the internal oscillator and CPU are halted, but the device can wake on events such as a Port Match or Comparator low output. Since clocks are running in Idle mode, power consumption is dependent upon the system clock frequency and the number of peripherals left in active mode before entering Idle. Stop mode and Suspend mode consume the least power because the majority of the device is shut down with no clocks active. SFR Definition 15.1 describes the Power Control Register (PCON) used to control the C8051F55x/56x/57x devices' Stop and Idle power management modes. Suspend mode is controlled by the SUSPEND bit in the OSCICN register (SFR Definition 18.2).

Although the C8051F55x/56x/57x has Idle, Stop, and Suspend modes available, more control over the device power can be achieved by enabling/disabling individual peripherals as needed. Each analog peripheral can be disabled when not in use and placed in low power mode. Digital peripherals, such as timers or serial buses, draw little power when they are not in use. Turning off oscillators lowers power consumption considerably, at the expense of reduced functionality.

15.1. Idle Mode

Setting the Idle Mode Select bit (PCON.0) causes the hardware to halt the CPU and enter Idle mode as soon as the instruction that sets the bit completes execution. All internal registers and memory maintain their original data. All analog and digital peripherals can remain active during Idle mode.

Idle mode is terminated when an enabled interrupt is asserted or a reset occurs. The assertion of an enabled interrupt will cause the Idle Mode Selection bit (PCON.0) to be cleared and the CPU to resume operation. The pending interrupt will be serviced and the next instruction to be executed after the return from interrupt (RETI) will be the instruction immediately following the one that set the Idle Mode Select bit. If Idle mode is terminated by an internal or external reset, the CIP-51 performs a normal reset sequence and begins program execution at address 0x0000.

Note: If the instruction following the write of the IDLE bit is a single-byte instruction and an interrupt occurs during the execution phase of the instruction that sets the IDLE bit, the CPU may not wake from Idle mode when a future interrupt occurs. Therefore, instructions that set the IDLE bit should be followed by an instruction that has two or more opcode bytes, for example:

```
// in 'C':
PCON |= 0x01;                  // set IDLE bit
PCON = PCON;                   // ... followed by a 3-cycle dummy instruction

; in assembly:
ORL PCON, #01h                 ; set IDLE bit
MOV PCON, PCON                 ; ... followed by a 3-cycle dummy instruction
```

If enabled, the Watchdog Timer (WDT) will eventually cause an internal watchdog reset and thereby terminate the Idle mode. This feature protects the system from an unintended permanent shutdown in the event of an inadvertent write to the PCON register. If this behavior is not desired, the WDT may be disabled by software prior to entering the Idle mode if the WDT was initially configured to allow this operation. This provides the opportunity for additional power savings, allowing the system to remain in the Idle mode indefinitely, waiting for an external stimulus to wake up the system. Refer to Section "16.6. PCA Watchdog Timer Reset" on page 142 for more information on the use and configuration of the WDT.

15.2. Stop Mode

Setting the Stop Mode Select bit (PCON.1) causes the controller core to enter Stop mode as soon as the instruction that sets the bit completes execution. In Stop mode the internal oscillator, CPU, and all digital peripherals are stopped; the state of the external oscillator circuit is not affected. Each analog peripheral (including the external oscillator circuit) may be shut down individually prior to entering Stop Mode. Stop mode can only be terminated by an internal or external reset. On reset, the device performs the normal reset sequence and begins program execution at address 0x0000.

If enabled, the Missing Clock Detector will cause an internal reset and thereby terminate the Stop mode. The Missing Clock Detector should be disabled if the CPU is to be put to in STOP mode for longer than the MCD timeout of 100 µs.

15.3. Suspend Mode

Setting the SUSPEND bit (OSCICN.5) causes the hardware to halt the CPU and the high-frequency internal oscillator, and go into Suspend mode as soon as the instruction that sets the bit completes execution. All internal registers and memory maintain their original data. Most digital peripherals are not active in Suspend mode. The exception to this is the Port Match feature.

Suspend mode can be terminated by three types of events, a port match (described in Section “19.5. Port Match” on page 179), a Comparator low output (if enabled), or a device reset event. When Suspend mode is terminated, the device will continue execution on the instruction following the one that set the SUSPEND bit. If the wake event was configured to generate an interrupt, the interrupt will be serviced upon waking the device. If Suspend mode is terminated by an internal or external reset, the CIP-51 performs a normal reset sequence and begins program execution at address 0x0000.

Note: Before entering suspend mode, firmware must set the ZTCEN bit in REF0CN (SFR Definition 7.1).

SFR Definition 15.1. PCON: Power Control

Bit	7	6	5	4	3	2	1	0
Name	GF[5:0]						STOP	IDLE
Type	R/W						R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x87; SFR Page = All Pages

Bit	Name	Function
7:2	GF[5:0]	**General Purpose Flags 5–0.** These are general purpose flags for use under software control.
1	STOP	**Stop Mode Select.** Setting this bit will place the CIP-51 in Stop mode. This bit will always be read as 0. 1: CPU goes into Stop mode (internal oscillator stopped).
0	IDLE	**IDLE: Idle Mode Select.** Setting this bit will place the CIP-51 in Idle mode. This bit will always be read as 0. 1: CPU goes into Idle mode. (Shuts off clock to CPU, but clock to Timers, Interrupts, Serial Ports, and Analog Peripherals are still active.)

16. Reset Sources

Reset circuitry allows the controller to be easily placed in a predefined default condition. On entry to this reset state, the following occur:

- CIP-51 halts program execution
- Special Function Registers (SFRs) are initialized to their defined reset values
- External Port pins are forced to a known state
- Interrupts and timers are disabled.

All SFRs are reset to the predefined values noted in the SFR detailed descriptions. The contents of internal data memory are unaffected during a reset; any previously stored data is preserved. However, since the stack pointer SFR is reset, the stack is effectively lost, even though the data on the stack is not altered.

The Port I/O latches are reset to 0xFF (all logic ones) in open-drain mode. Weak pullups are enabled during and after the reset. For V_{DD} Monitor and power-on resets, the $\overline{RST}$ pin is driven low until the device exits the reset state.

Note: When VIO rises faster than VDD, which can happen when VREGIN and VIO are tied together, a delay created between GPIO power (VIO) and the logic controlling GPIO (VDD) results in a temporary unknown state at the GPIO pins. When VIO rises faster than VDD, the GPIO may enter the following states: floating, glitch low, or glitch high. Cross coupling VIO and VDD with a 4.7 µF capacitor mitigates the root cause of the problem by allowing VIO and VDD to rise at the same rate.

On exit from the reset state, the program counter (PC) is reset, and the system clock defaults to the internal oscillator. The Watchdog Timer is enabled with the system clock divided by 12 as its clock source. Program execution begins at location 0x0000.

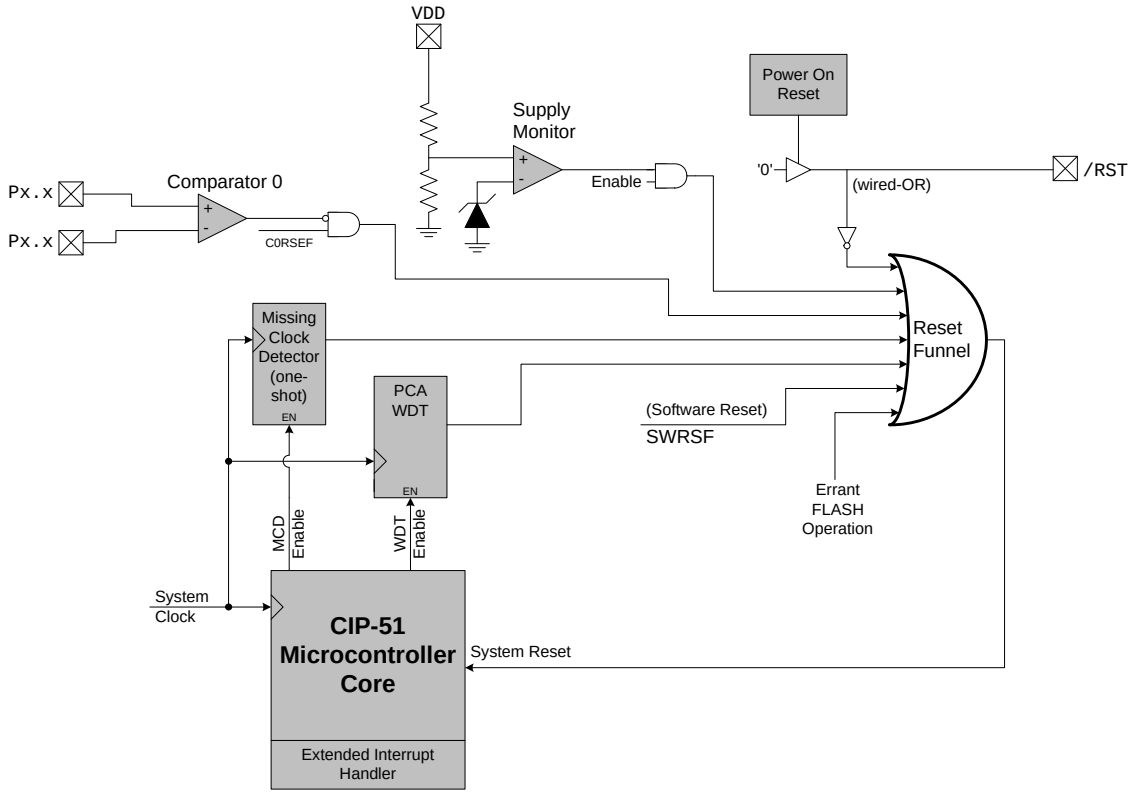


Figure 16.1. Reset Sources

16.1. Power-On Reset

During power-up, the device is held in a reset state and the $\overline{\text{RST}}$ pin is driven low until V_{DD} settles above V_{RST}. A delay occurs before the device is released from reset; the delay decreases as the V_{DD} ramp time increases (V_{DD} ramp time is defined as how fast V_{DD} ramps from 0 V to V_{RST}). Figure 16.2. plots the power-on and V_{DD} monitor reset timing.

On exit from a power-on reset, the PORSF flag (RSTSRC.1) is set by hardware to logic 1. When PORSF is set, all of the other reset flags in the RSTSRC Register are indeterminate (PORSF is cleared by all other resets). Since all resets cause program execution to begin at the same location (0x0000) software can read the PORSF flag to determine if a power-up was the cause of reset. The content of internal data memory should be assumed to be undefined after a power-on reset. The V_{DD} monitor is enabled following a power-on reset.

Note: For devices with a date code before year 2011, work week 24 (1124), if the /RST pin is held low for more than 1 second while power is applied to the device, and then /RST is released, a percentage of devices may lock up and fail to execute code. Toggling the /RST pin does not clear the condition. The condition is cleared by cycling power. Most devices that are affected will show the lock up behavior only within a narrow range of temperatures (a 5 to 10 °C window). Parts with a date code of year 2011, work week 24 (1124) or later do not have any restrictions on /RST low time. The date code of a device is a four-digit number on the bottom-most line of each device with the format YYWW, where YY is the two-digit calendar year and WW is the two digit work week.

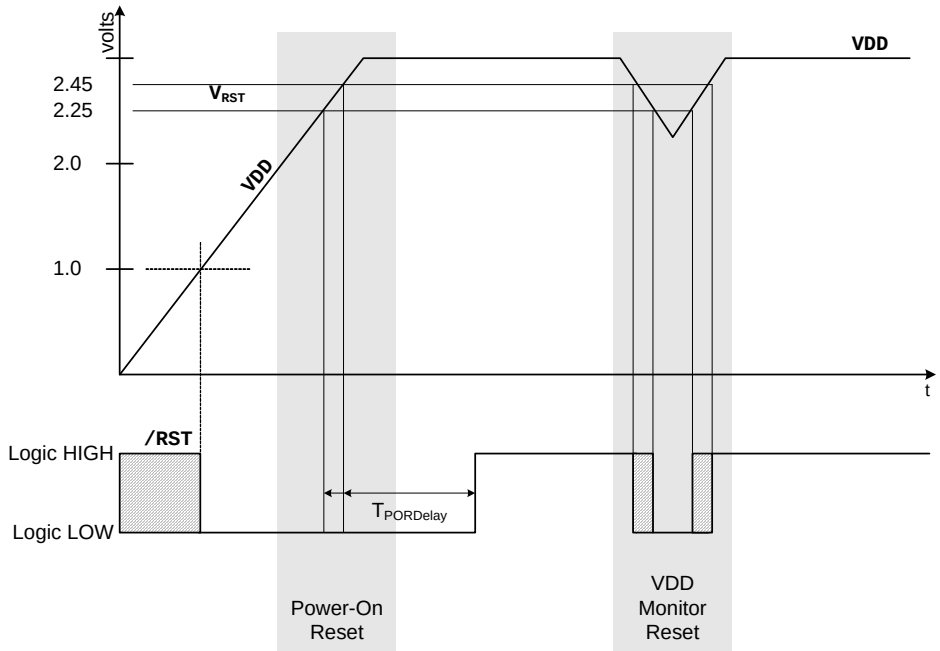


Figure 16.2. Power-On and V_{DD} Monitor Reset Timing

16.2. Power-Fail Reset/V_{DD} Monitor

When a power-down transition or power irregularity causes V_{DD} to drop below V_{RST}, the power supply monitor will drive the $\overline{RST}$ pin low and hold the CIP-51 in a reset state (see Figure 16.2). When V_{DD} returns to a level above V_{RST}, the CIP-51 will be released from the reset state. Note that even though internal data memory contents are not altered by the power-fail reset, it is impossible to determine if V_{DD} dropped below the level required for data retention. If the PORSF flag reads 1, the data may no longer be valid. The V_{DD} monitor is enabled after power-on resets. Its defined state (enabled/disabled) is not altered by any other reset source. For example, if the V_{DD} monitor is disabled by code and a software reset is performed, the V_{DD} monitor will still be disabled after the reset. **To protect the integrity of Flash contents, the V_{DD} monitor must be enabled to the higher setting (VDMLVL = 1) and selected as a reset source if software contains routines which erase or write Flash memory. If the V_{DD} monitor is not enabled and set to the high level, any erase or write performed on Flash memory will cause a Flash Error device reset.**

Important Note: If the V_{DD} monitor is being turned on from a disabled state, it should be enabled before it is selected as a reset source. Selecting the V_{DD} monitor as a reset source before it is enabled and stabilized may cause a system reset. In some applications, this reset may be undesirable. If this is not desirable in the application, a delay should be introduced between enabling the monitor and selecting it as a reset source. The procedure for enabling the V_{DD} monitor and configuring it as a reset source from a disabled state is as follows:

1. Enable the V_{DD} monitor (VDMEN bit in VDM0CN = 1).
2. If necessary, wait for the V_{DD} monitor to stabilize (see Table 5.4 for the V_{DD} Monitor turn-on time).
   Note: This delay should be omitted if software contains routines that erase or write Flash memory.
3. Select the V_{DD} monitor as a reset source (PORSF bit in RSTSRC = 1).

See Figure 16.2 for V_{DD} monitor timing; note that the power-on-reset delay is not incurred after a V_{DD} monitor reset. See Table 5.4 for complete electrical characteristics of the V_{DD} monitor.

Note: The output of the internal voltage regulator is calibrated by the MCU immediately after any reset event. The output of the un-calibrated internal regulator could be below the high threshold setting of the V_{DD} Monitor. If this is the case *and* the V_{DD} Monitor is set to the high threshold setting *and* if the MCU receives a non-power on reset (POR), the MCU will remain in reset until a POR occurs (i.e., V_{DD} Monitor will keep the device in reset). A POR will force the V_{DD} Monitor to the low threshold setting which is guaranteed to be below the un-calibrated output of the internal regulator. The device will then exit reset and resume normal operation. It is for this reason Silicon Labs strongly recommends that the V_{DD} Monitor is always left in the low threshold setting (i.e. default value upon POR).

When programming the Flash in-system, the V_{DD} Monitor must be set to the high threshold setting. For the highest system reliability, the time the V_{DD} Monitor is set to the high threshold setting should be minimized (e.g., setting the V_{DD} Monitor to the high threshold setting just before the Flash write operation and then changing it back to the low threshold setting immediately after the Flash write operation).

Note: The V_{DD} Monitor may trigger on fast changes in voltage on the VDD pin, regardless of whether the voltage increased or decreased.

SFR Definition 16.1. VDM0CN: V_{DD} Monitor Control

Bit	7	6	5	4	3	2	1	0
Name	VDMEN	VDDSTAT	VDMLVL					
Type	R/W	R	R/W	R	R	R	R	R
Reset	Varies	Varies	0	0	0	0	0	0

SFR Address = 0xFF; SFR Page = 0x00

Bit	Name	Function
7	VDMEN	**V_{DD} Monitor Enable.** This bit turns the V_{DD} monitor circuit on/off. The V_{DD} Monitor cannot generate system resets until it is also selected as a reset source in register RSTSRC (SFR Definition 16.2). Selecting the V_{DD} monitor as a reset source before it has stabilized may generate a system reset. In systems where this reset would be undesirable, a delay should be introduced between enabling the V_{DD} Monitor and selecting it as a reset source. See Table 5.4 for the minimum V_{DD} Monitor turn-on time. 0: V_{DD} Monitor Disabled. 1: V_{DD} Monitor Enabled.
6	VDDSTAT	**V_{DD} Status.** This bit indicates the current power supply status (V_{DD} Monitor output). 0: V_{DD} is at or below the V_{DD} monitor threshold. 1: V_{DD} is above the V_{DD} monitor threshold.
5	VDMLVL	**V_{DD} Monitor Level Select.** 0: V_{DD} Monitor Threshold is set to VRST-LOW 1: V_{DD} Monitor Threshold is set to VRST-HIGH. This setting is required for any system includes code that writes to and/or erases Flash.
4:0	Unused	Read = 00000b; Write = Don't care.

16.3. External Reset

The external $\overline{\text{RST}}$ pin provides a means for external circuitry to force the device into a reset state. Asserting an active-low signal on the $\overline{\text{RST}}$ pin generates a reset; an external pullup and/or decoupling of the $\overline{\text{RST}}$ pin may be necessary to avoid erroneous noise-induced resets. See Table 5.4 for complete $\overline{\text{RST}}$ pin specifications. The PINRSF flag (RSTSRC.0) is set on exit from an external reset.

16.4. Missing Clock Detector Reset

The Missing Clock Detector (MCD) is a one-shot circuit that is triggered by the system clock. If the system clock remains high or low for more than the value specified in Table 5.4, "Reset Electrical Characteristics," on page 41, the one-shot will time out and generate a reset. After a MCD reset, the MCDRSF flag (RSTSRC.2) will read 1, signifying the MCD as the reset source; otherwise, this bit reads 0. Writing a 1 to the MCDRSF bit enables the Missing Clock Detector; writing a 0 disables it. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

16.5. Comparator0 Reset

Comparator0 can be configured as a reset source by writing a 1 to the C0RSEF flag (RSTSRC.5). Comparator0 should be enabled and allowed to settle prior to writing to C0RSEF to prevent any turn-on chatter on the output from generating an unwanted reset. The Comparator0 reset is active-low: if the non-inverting input voltage (on CP0+) is less than the inverting input voltage (on CP0–), the device is put into the reset state. After a Comparator0 reset, the C0RSEF flag (RSTSRC.5) will read 1 signifying Comparator0 as the reset source; otherwise, this bit reads 0. The state of the RST pin is unaffected by this reset.

16.6. PCA Watchdog Timer Reset

The programmable Watchdog Timer (WDT) function of the Programmable Counter Array (PCA) can be used to prevent software from running out of control during a system malfunction. The PCA WDT function can be enabled or disabled by software as described in Section “26.4. Watchdog Timer Mode” on page 291; the WDT is enabled and clocked by SYSCLK/12 following any reset. If a system malfunction prevents user software from updating the WDT, a reset is generated and the WDTRSF bit (RSTSRC.5) is set to 1. The state of the RST pin is unaffected by this reset.

16.7. Flash Error Reset

If a Flash read/write/erase or program read targets an illegal address, a system reset is generated. This may occur due to any of the following:

- A Flash write or erase is attempted above user code space. This occurs when PSWE is set to 1 and a MOVX write operation targets an address in or above the reserved space.
- A Flash read is attempted above user code space. This occurs when a MOVC operation targets an address in or above the reserved space.
- A Program read is attempted above user code space. This occurs when user code attempts to branch to an address in or above the reserved space.
- A Flash read, write or erase attempt is restricted due to a Flash security setting (see Section “14.3. Security Options” on page 127).
- A Flash read, write, or erase is attempted when the VDD Monitor is not enabled to the high threshold and set as a reset source.

The FERROR bit (RSTSRC.6) is set following a Flash error reset. The state of the RST pin is unaffected by this reset.

16.8. Software Reset

Software may force a reset by writing a 1 to the SWRSF bit (RSTSRC.4). The SWRSF bit will read 1 following a software forced reset. The state of the RST pin is unaffected by this reset.

SFR Definition 16.2. RSTSRC: Reset Source

Bit	7	6	5	4	3	2	1	0
Name		FERROR	C0RSEF	SWRSF	WDTRSF	MCDRSF	PORSF	PINRSF
Type	R	R	R/W	R/W	R	R/W	R/W	R
Reset	0	Varies	Varies	Varies	Varies	Varies	Varies	Varies

SFR Address = 0xEF; SFR Page = 0x00

Bit	Name	Description	Write	Read
7	Unused	**Unused.**	Don't care.	0
6	FERROR	**Flash Error Reset Flag.**	N/A	Set to 1 if Flash read/write/erase error caused the last reset.
5	C0RSEF	**Comparator0 Reset Enable and Flag.**	Writing a 1 enables Comparator0 as a reset source (active-low).	Set to 1 if Comparator0 caused the last reset.
4	SWRSF	**Software Reset Force and Flag.**	Writing a 1 forces a system reset.	Set to 1 if last reset was caused by a write to SWRSF.
3	WDTRSF	**Watchdog Timer Reset Flag.**	N/A	Set to 1 if Watchdog Timer overflow caused the last reset.
2	MCDRSF	**Missing Clock Detector Enable and Flag.**	Writing a 1 enables the Missing Clock Detector. The MCD triggers a reset if a missing clock condition is detected.	Set to 1 if Missing Clock Detector timeout caused the last reset.
1	PORSF	**Power-On/V_{DD} Monitor Reset Flag, and V_{DD} monitor Reset Enable.**	Writing a 1 enables the V_{DD} monitor as a reset source. **Writing 1 to this bit before the V_{DD} monitor is enabled and stabilized may cause a system reset.**	Set to 1 anytime a power-on or V_{DD} monitor reset occurs. **When set to 1 all other RSTSRC flags are indeterminate.**
0	PINRSF	**HW Pin Reset Flag.**	N/A	Set to 1 if $\overline{\text{RST}}$ pin caused the last reset.

Note: Do not use read-modify-write operations on this register

17. External Data Memory Interface and On-Chip XRAM

For C8051F55x/56x/57x devices, 2 kB of RAM are included on-chip and mapped into the external data memory space (XRAM). Additionally, an External Memory Interface (EMIF) is available on the C8051F568-9 and ‘F570-5 devices, which can be used to access off-chip data memories and memory-mapped devices connected to the GPIO ports. The external memory space may be accessed using the external move instruction (MOVX) and the data pointer (DPTR), or using the MOVX indirect addressing mode using R0 or R1. If the MOVX instruction is used with an 8-bit address operand (such as @R1), then the high byte of the 16-bit address is provided by the External Memory Interface Control Register (EMI0CN, shown in SFR Definition 17.1).

Note: The MOVX instruction can also be used for writing to the Flash memory. See Section “14. Flash Memory” on page 124 for details. The MOVX instruction accesses XRAM by default.

17.1. Accessing XRAM

The XRAM memory space is accessed using the MOVX instruction. The MOVX instruction has two forms, both of which use an indirect addressing method. The first method uses the Data Pointer, DPTR, a 16-bit register which contains the effective address of the XRAM location to be read from or written to. The second method uses R0 or R1 in combination with the EMI0CN register to generate the effective XRAM address. Examples of both of these methods are given below.

17.1.1. 16-Bit MOVX Example

The 16-bit form of the MOVX instruction accesses the memory location pointed to by the contents of the DPTR register. The following series of instructions reads the value of the byte at address 0x1234 into the accumulator A:

```
MOV    DPTR, #1234h        ; load DPTR with 16-bit address to read (0x1234)
MOVX   A, @DPTR            ; load contents of 0x1234 into accumulator A
```

The above example uses the 16-bit immediate MOV instruction to set the contents of DPTR. Alternately, the DPTR can be accessed through the SFR registers DPH, which contains the upper 8-bits of DPTR, and DPL, which contains the lower 8-bits of DPTR.

17.1.2. 8-Bit MOVX Example

The 8-bit form of the MOVX instruction uses the contents of the EMI0CN SFR to determine the upper 8-bits of the effective address to be accessed and the contents of R0 or R1 to determine the lower 8-bits of the effective address to be accessed. The following series of instructions read the contents of the byte at address 0x1234 into the accumulator A.

```
MOV    EMI0CN, #12h        ; load high byte of address into EMI0CN
MOV    R0, #34h            ; load low byte of address into R0 (or R1)
MOVX   a, @R0              ; load contents of 0x1234 into accumulator A
```

17.2. Configuring the External Memory Interface

Configuring the External Memory Interface consists of four steps:

1. Configure the Output Modes of the associated port pins as either push-pull or open-drain (push-pull is most common), and skip the associated pins in the crossbar.
2. Configure Port latches to “park” the EMIF pins in a dormant state (usually by setting them to logic 1).
3. Select the memory mode (on-chip only, split mode without bank select, split mode with bank select, or off-chip only).
4. Set up timing to interface with off-chip memory or peripherals.

Each of these four steps is explained in detail in the following sections. The Port selection and Mode bits are located in the EMI0CF register shown in SFR Definition .

17.3. Port Configuration

The External Memory Interface appears on Ports 1, 2 and 3 when it is used for off-chip memory access. These ports are multiplexed so that low-order address lines are shared with the data lines. When the EMIF is used, the Crossbar should be configured to skip over the /RD control line (P1.6) and the /WR control line (P1.7) using the P1SKIP register and also skip over the ALE control line (P1.5). For more information about configuring the Crossbar, see Section “19.6. Special Function Registers for Accessing and Configuring Port I/O” on page 183. The EMIF pinout is shown inTable 17.1 on page 146.

The External Memory Interface claims the associated Port pins for memory operations ONLY during the execution of an off-chip MOVX instruction. Once the MOVX instruction has completed, control of the Port pins reverts to the Port latches or to the Crossbar settings for those pins. See Section “19. Port Input/Output” on page 169 for more information about the Crossbar and Port operation and configuration. **The Port latches should be explicitly configured to “park” the External Memory Interface pins in a dormant state, most commonly by setting them to a logic 1**.

During the execution of the MOVX instruction, the External Memory Interface will explicitly disable the drivers on all Port pins that are acting as Inputs (Data[7:0] during a READ operation, for example). The Output mode of the Port pins (whether the pin is configured as Open-Drain or Push-Pull) is unaffected by the External Memory Interface operation, and remains controlled by the PnMDOUT registers. In most cases, the output modes of all EMIF pins should be configured for push-pull mode.

Table 17.1. EMIF Pinout (C8051F568-9 and ‘F570-5)

Multiplexed Mode	
Signal Name	**Port Pin**
$\overline{RD}$	P1.6
$\overline{WR}$	P1.7
ALE	P1.5
D0/A0	P3.0
D1/A1	P3.1
D2/A2	P3.2
D3/A3	P3.3
D4/A4	P3.4
D5/A5	P3.5
D6/A6	P3.6
D7/A7	P3.7
A8	P2.0
A9	P2.1
A10	P2.2
A11	P2.3
A12	P2.4
A13	P2.5
A14	P2.6
A15	P2.7

SFR Definition 17.1. EMI0CN: External Memory Interface Control

Bit	7	6	5	4	3	2	1	0
Name	PGSEL[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xAA; SFR Page = 0x00

Bit	Name	Function
7:0	PGSEL[7:0]	**XRAM Page Select Bits.** The XRAM Page Select Bits provide the high byte of the 16-bit external data memory address when using an 8-bit MOVX command, effectively selecting a 256-byte page of RAM. 0x00: 0x0000 to 0x00FF 0x01: 0x0100 to 0x01FF ... 0xFE: 0xFE00 to 0xFEFF 0xFF: 0xFF00 to 0xFFFF

SFR Definition 17.2. EMI0CF: External Memory Configuration

Bit	7	6	5	4	3	2	1	0
Name				Reserved	EMD[1:0]		EALE[1:0]	
Type	R/W							
Reset	0	0	0	0	0	0	1	1

SFR Address = 0xB2; SFR Page = 0x0F

Bit	Name	Function
7:5	Unused	Read = 000b; Write = Don't Care.
4	Reserved	Read = 0b; Must Write 0b.
3:2	EMD[1:0]	**EMIF Operating Mode Select Bits.** 00: Internal Only: MOVX accesses on-chip XRAM only. All effective addresses alias to on-chip memory space 01: Split Mode without Bank Select: Accesses below the 2 kB boundary are directed on-chip. Accesses above the 2 kB boundary are directed off-chip. 8-bit off-chip MOVX operations use current contents of the Address high port latches to resolve the upper address byte. To access off chip space, EMI0CN must be set to a page that is not contained in the on-chip address space. 10: Split Mode with Bank Select: Accesses below the 2 kB boundary are directed on-chip. Accesses above the 2 kB boundary are directed off-chip. 8-bit off-chip MOVX operations uses the contents of EMI0CN to determine the high-byte of the address. 11: External Only: MOVX accesses off-chip XRAM only. On-chip XRAM is not visible to the CPU.
1:0	EALE[1:0]	**ALE Pulse-Width Select Bits.** These bits only have an effect when EMD2 = 0. 00: ALE high and ALE low pulse width = 1 SYSCLK cycle. 01: ALE high and ALE low pulse width = 2 SYSCLK cycles. 10: ALE high and ALE low pulse width = 3 SYSCLK cycles. 11: ALE high and ALE low pulse width = 4 SYSCLK cycles.

17.4. Multiplexed Mode

The External Memory Interface operates only in a Multiplexed mode. In Multiplexed mode, the Data Bus and the lower 8-bits of the Address Bus share the same Port pins: AD[7:0]. In this mode, an external latch (74HC373 or equivalent logic gate) is used to hold the lower 8-bits of the RAM address. The external latch is controlled by the ALE (Address Latch Enable) signal, which is driven by the External Memory Interface logic. An example of a Multiplexed Configuration is shown in Figure 17.1.

In Multiplexed mode, the external MOVX operation can be broken into two phases delineated by the state of the ALE signal. During the first phase, ALE is high and the lower 8-bits of the Address Bus are presented to AD[7:0]. During this phase, the address latch is configured such that the Q outputs reflect the states of the 'D' inputs. When ALE falls, signaling the beginning of the second phase, the address latch outputs remain fixed and are no longer dependent on the latch inputs. Later in the second phase, the Data Bus controls the state of the AD[7:0] port at the time $\overline{RD}$ or $\overline{WR}$ is asserted.

See Section "17.6.1. Multiplexed Mode" on page 153 for more information.

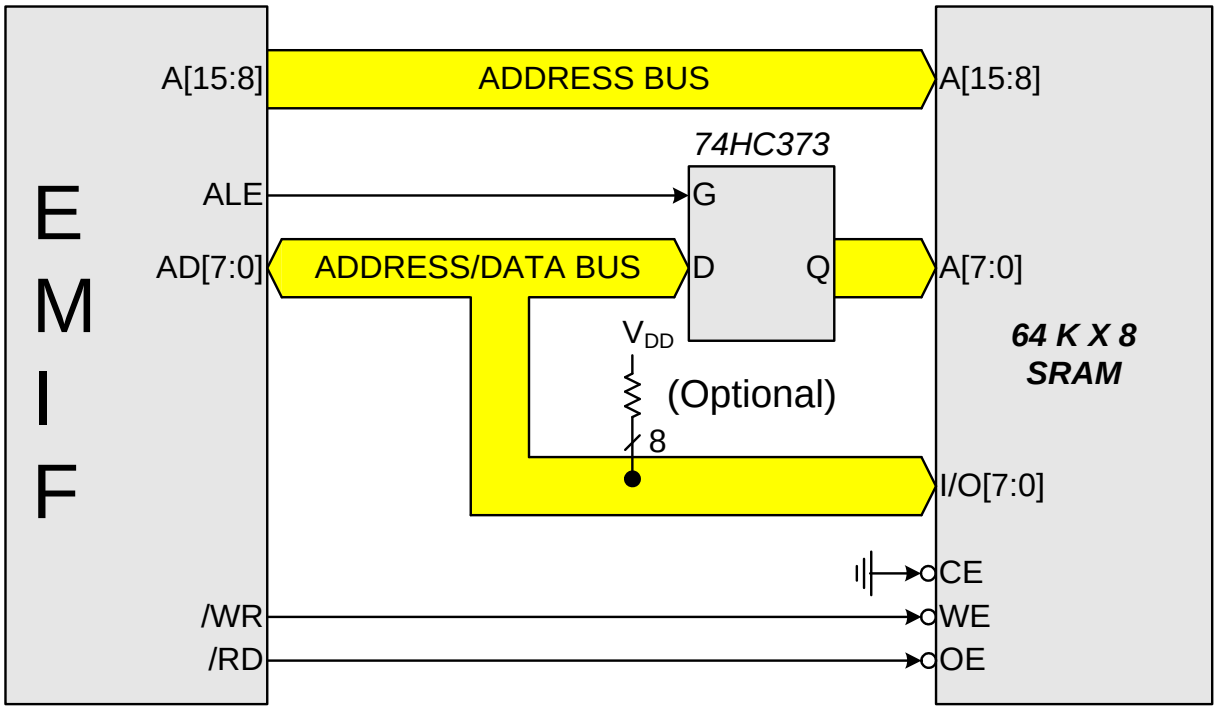


Figure 17.1. Multiplexed Configuration Example

17.5. Memory Mode Selection

The external data memory space can be configured in one of four modes, shown in Figure 17.2, based on the EMIF Mode bits in the EMI0CF register (SFR Definition 17.2). These modes are summarized below. More information about the different modes can be found in Section “17.6. Timing” on page 151.

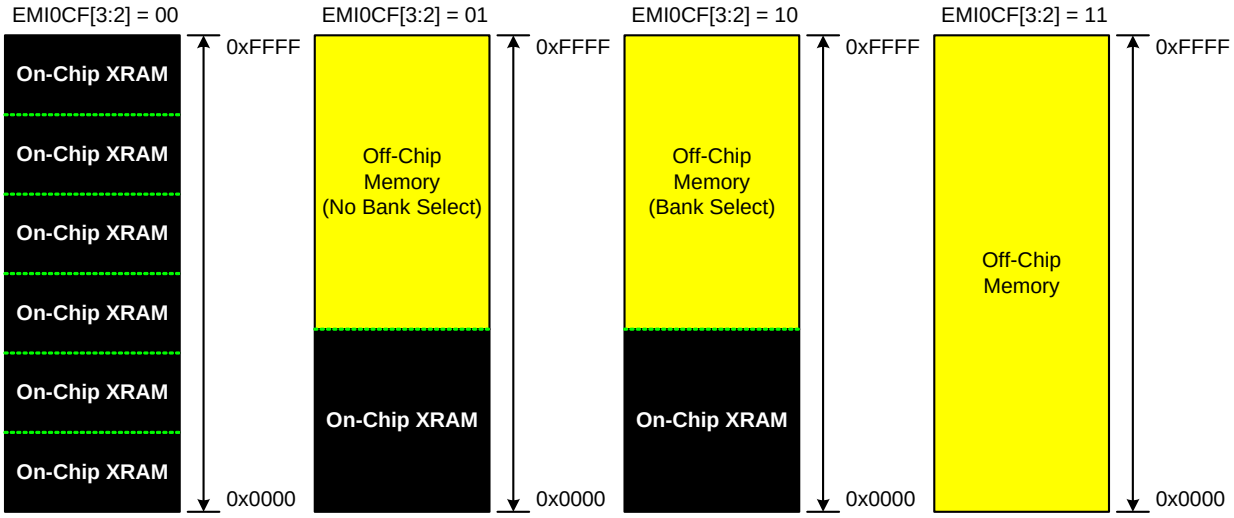


Figure 17.2. EMIF Operating Modes

17.5.1. Internal XRAM Only

When bits EMI0CF[3:2] are set to 00, all MOVX instructions will target the internal XRAM space on the device. Memory accesses to addresses beyond the populated space will wrap on 2 kB boundaries. As an example, the addresses 0x800 and 0x1000 both evaluate to address 0x0000 in on-chip XRAM space.

- 8-bit MOVX operations use the contents of EMI0CN to determine the high-byte of the effective address and R0 or R1 to determine the low-byte of the effective address.
- 16-bit MOVX operations use the contents of the 16-bit DPTR to determine the effective address.

17.5.2. Split Mode without Bank Select

When bit EMI0CF.[3:2] are set to 01, the XRAM memory map is split into two areas, on-chip space and off-chip space.

- Effective addresses below the internal XRAM size boundary will access on-chip XRAM space.
- Effective addresses above the internal XRAM size boundary will access off-chip space.
- 8-bit MOVX operations use the contents of EMI0CN to determine whether the memory access is on-chip or off-chip. However, in the “No Bank Select” mode, an 8-bit MOVX operation will not drive the upper 8-bits A[15:8] of the Address Bus during an off-chip access. This allows the user to manipulate the upper address bits at will by setting the Port state directly via the port latches. This behavior is in contrast with “Split Mode with Bank Select” described below. The lower 8-bits of the Address Bus A[7:0] are driven, determined by R0 or R1.
- 16-bit MOVX operations use the contents of DPTR to determine whether the memory access is on-chip or off-chip, and unlike 8-bit MOVX operations, the full 16-bits of the Address Bus A[15:0] are driven during the off-chip transaction.

17.5.3. Split Mode with Bank Select

When EMI0CF[3:2] are set to 10, the XRAM memory map is split into two areas, on-chip space and off-chip space.

- Effective addresses below the internal XRAM size boundary will access on-chip XRAM space.
- Effective addresses above the internal XRAM size boundary will access off-chip space.
- 8-bit MOVX operations use the contents of EMI0CN to determine whether the memory access is on-chip or off-chip. The upper 8-bits of the Address Bus A[15:8] are determined by EMI0CN, and the lower 8-bits of the Address Bus A[7:0] are determined by R0 or R1. All 16-bits of the Address Bus A[15:0] are driven in “Bank Select” mode.
- 16-bit MOVX operations use the contents of DPTR to determine whether the memory access is on-chip or off-chip, and the full 16-bits of the Address Bus A[15:0] are driven during the off-chip transaction.

17.5.4. External Only

When EMI0CF[3:2] are set to 11, all MOVX operations are directed to off-chip space. On-chip XRAM is not visible to the CPU. This mode is useful for accessing off-chip memory located between 0x0000 and the internal XRAM size boundary.

- 8-bit MOVX operations ignore the contents of EMI0CN. The upper Address bits A[15:8] are not driven (identical behavior to an off-chip access in “Split Mode without Bank Select” described above). This allows the user to manipulate the upper address bits at will by setting the Port state directly. The lower 8-bits of the effective address A[7:0] are determined by the contents of R0 or R1.
- 16-bit MOVX operations use the contents of DPTR to determine the effective address A[15:0]. The full 16-bits of the Address Bus A[15:0] are driven during the off-chip transaction.

17.6. Timing

The timing parameters of the External Memory Interface can be configured to enable connection to devices having different setup and hold time requirements. The Address Setup time, Address Hold time, RD and WR strobe widths, and in multiplexed mode, the width of the ALE pulse are all programmable in units of SYSCLK periods through EMI0TC, shown in SFR Definition 17.3, and EMI0CF[1:0].

The timing for an off-chip MOVX instruction can be calculated by adding 4 SYSCLK cycles to the timing parameters defined by the EMI0TC register. Assuming non-multiplexed operation, the minimum execution time for an off-chip XRAM operation is 5 SYSCLK cycles (1 SYSCLK for RD or WR pulse + 4 SYSCLKs). For multiplexed operations, the Address Latch Enable signal will require a minimum of 2 additional SYSCLK cycles. Therefore, the minimum execution time for an off-chip XRAM operation in multiplexed mode is 7 SYSCLK cycles (2 for /ALE + 1 for RD or WR + 4). The programmable setup and hold times default to the maximum delay settings after a reset. Table 17.2 lists the ac parameters for the External Memory Interface, and Figure 17.3 through Figure 17.5 show the timing diagrams for the different External Memory Interface modes and MOVX operations.

SFR Definition 17.3. EMI0TC: External Memory Timing Control

Bit	7	6	5	4	3	2	1	0
Name	EAS[1:0]		EWR[3:0]				EAH[1:0]	
Type	R/W		R/W				R/W	
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xAA; SFR Page = 0x0F

Bit	Name	Function
7:6	EAS[1:0]	**EMIF Address Setup Time Bits.** 00: Address setup time = 0 SYSCLK cycles. 01: Address setup time = 1 SYSCLK cycle. 10: Address setup time = 2 SYSCLK cycles. 11: Address setup time = 3 SYSCLK cycles.
5:2	EWR[3:0]	**EMIF $\overline{WR}$ and $\overline{RD}$ Pulse-Width Control Bits.** 0000: $\overline{WR}$ and $\overline{RD}$ pulse width = 1 SYSCLK cycle. 0001: $\overline{WR}$ and $\overline{RD}$ pulse width = 2 SYSCLK cycles. 0010: $\overline{WR}$ and $\overline{RD}$ pulse width = 3 SYSCLK cycles. 0011: $\overline{WR}$ and $\overline{RD}$ pulse width = 4 SYSCLK cycles. 0100: $\overline{WR}$ and $\overline{RD}$ pulse width = 5 SYSCLK cycles. 0101: $\overline{WR}$ and $\overline{RD}$ pulse width = 6 SYSCLK cycles. 0110: $\overline{WR}$ and $\overline{RD}$ pulse width = 7 SYSCLK cycles. 0111: $\overline{WR}$ and $\overline{RD}$ pulse width = 8 SYSCLK cycles. 1000: $\overline{WR}$ and $\overline{RD}$ pulse width = 9 SYSCLK cycles. 1001: $\overline{WR}$ and $\overline{RD}$ pulse width = 10 SYSCLK cycles. 1010: $\overline{WR}$ and $\overline{RD}$ pulse width = 11 SYSCLK cycles. 1011: $\overline{WR}$ and $\overline{RD}$ pulse width = 12 SYSCLK cycles. 1100: $\overline{WR}$ and $\overline{RD}$ pulse width = 13 SYSCLK cycles. 1101: $\overline{WR}$ and $\overline{RD}$ pulse width = 14 SYSCLK cycles. 1110: $\overline{WR}$ and $\overline{RD}$ pulse width = 15 SYSCLK cycles. 1111: $\overline{WR}$ and $\overline{RD}$ pulse width = 16 SYSCLK cycles.
1:0	EAH[1:0]	**EMIF Address Hold Time Bits.** 00: Address hold time = 0 SYSCLK cycles. 01: Address hold time = 1 SYSCLK cycle. 10: Address hold time = 2 SYSCLK cycles. 11: Address hold time = 3 SYSCLK cycles.

17.6.1. Multiplexed Mode

17.6.1.1. 16-bit MOVX: EMI0CF[4:2] = 001, 010, or 011

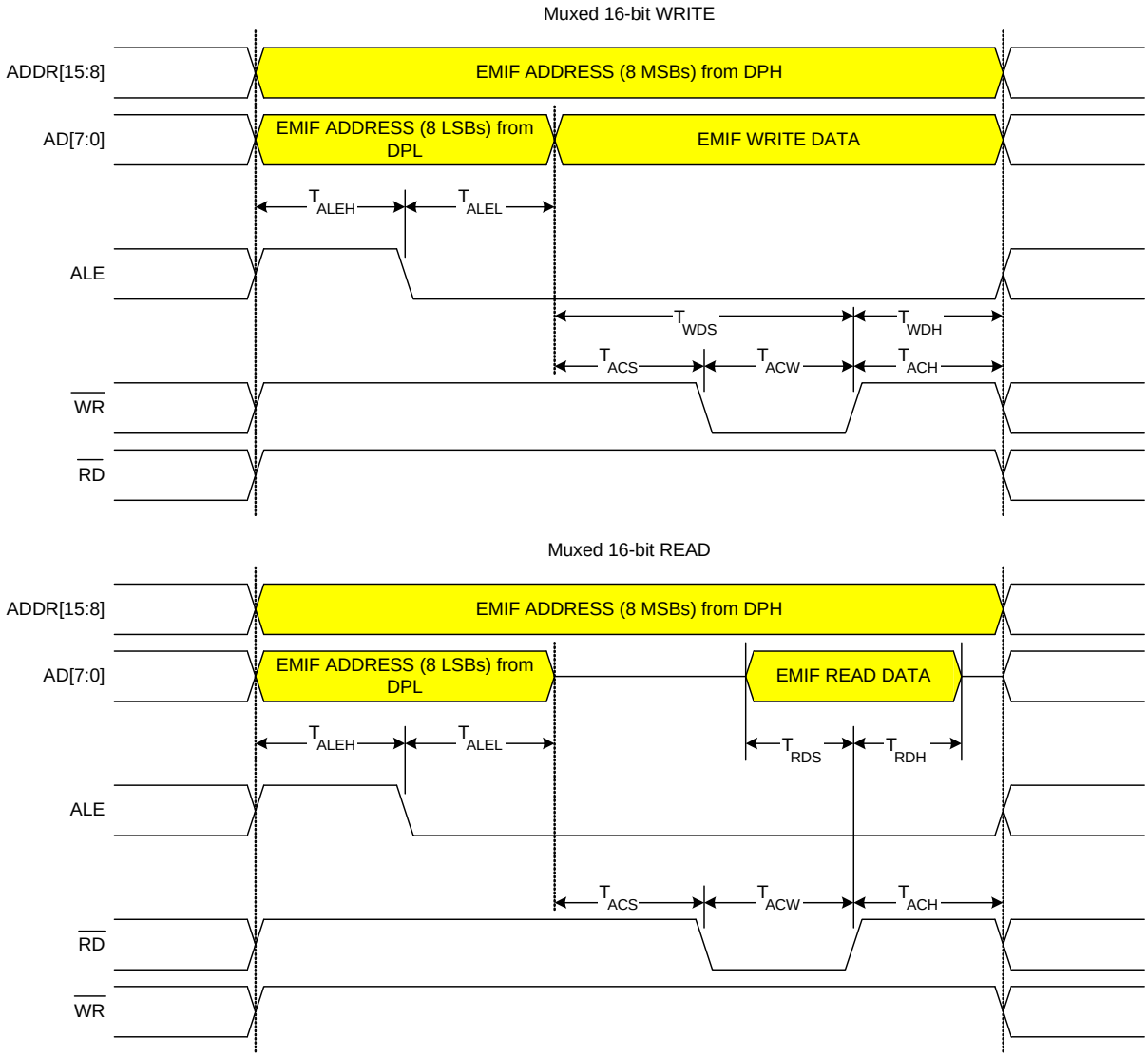


Figure 17.3. Multiplexed 16-bit MOVX Timing

17.6.1.2. 8-bit MOVX without Bank Select: EMI0CF[4:2] = 001 or 011

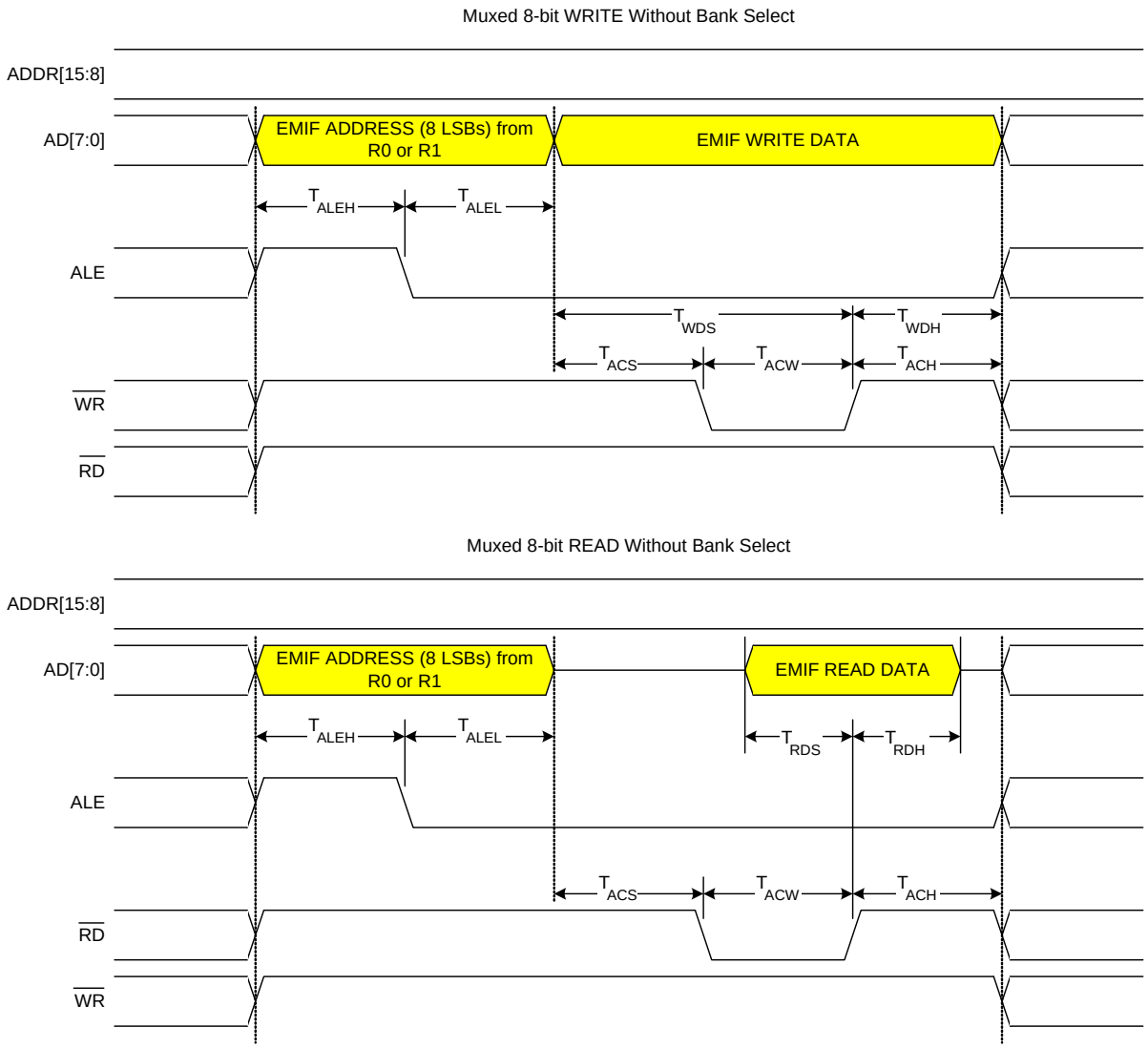


Figure 17.4. Multiplexed 8-bit MOVX without Bank Select Timing

17.6.1.3. 8-bit MOVX with Bank Select: EMI0CF[4:2] = 010

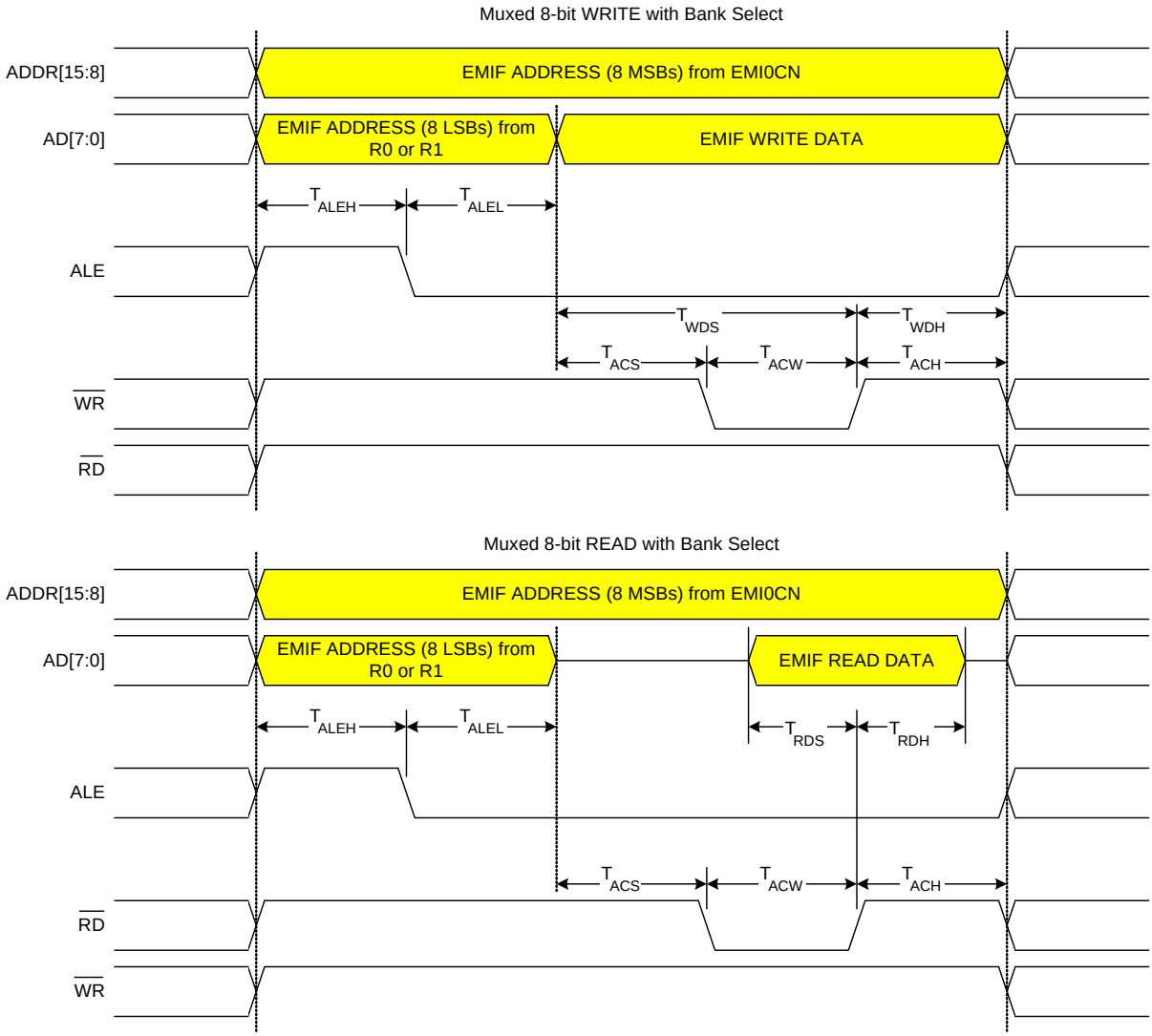


Figure 17.5. Multiplexed 8-bit MOVX with Bank Select Timing

Table 17.2. AC Parameters for External Memory Interface

Parameter	Description	Min*	Max*	Units
T_{ACS}	Address/Control Setup Time	0	3 x T_{SYSCLK}	ns
T_{ACW}	Address/Control Pulse Width	1 x T_{SYSCLK}	16 x T_{SYSCLK}	ns
T_{ACH}	Address/Control Hold Time	0	3 x T_{SYSCLK}	ns
T_{ALEH}	Address Latch Enable High Time	1 x T_{SYSCLK}	4 x T_{SYSCLK}	ns
T_{ALEL}	Address Latch Enable Low Time	1 x T_{SYSCLK}	4 x T_{SYSCLK}	ns
T_{WDS}	Write Data Setup Time	1 x T_{SYSCLK}	19 x T_{SYSCLK}	ns
T_{WDH}	Write Data Hold Time	0	3 x T_{SYSCLK}	ns
T_{RDS}	Read Data Setup Time	20		ns
T_{RDH}	Read Data Hold Time	0		ns
***Note:** T_{SYSCLK} is equal to one period of the device system clock (SYSCLK).				

18. Oscillators and Clock Selection

C8051F55x/56x/57x devices include a programmable internal high-frequency oscillator, an external oscillator drive circuit, and a clock multiplier. The internal oscillator can be enabled/disabled and calibrated using the OSCICN, OSCICRS, and OSCIFIN registers, as shown in Figure 18.1. The system clock can be sourced by the external oscillator circuit or the internal oscillator. The clock multiplier can produce three possible base outputs which can be scaled by a programmable factor of 1, 2/3, 2/4 (or 1/2), 2/5, 2/6 (or 1/3), or 2/7: Internal Oscillator x 2, Internal Oscillator x 4, External Oscillator x 2, or External Oscillator x 4.

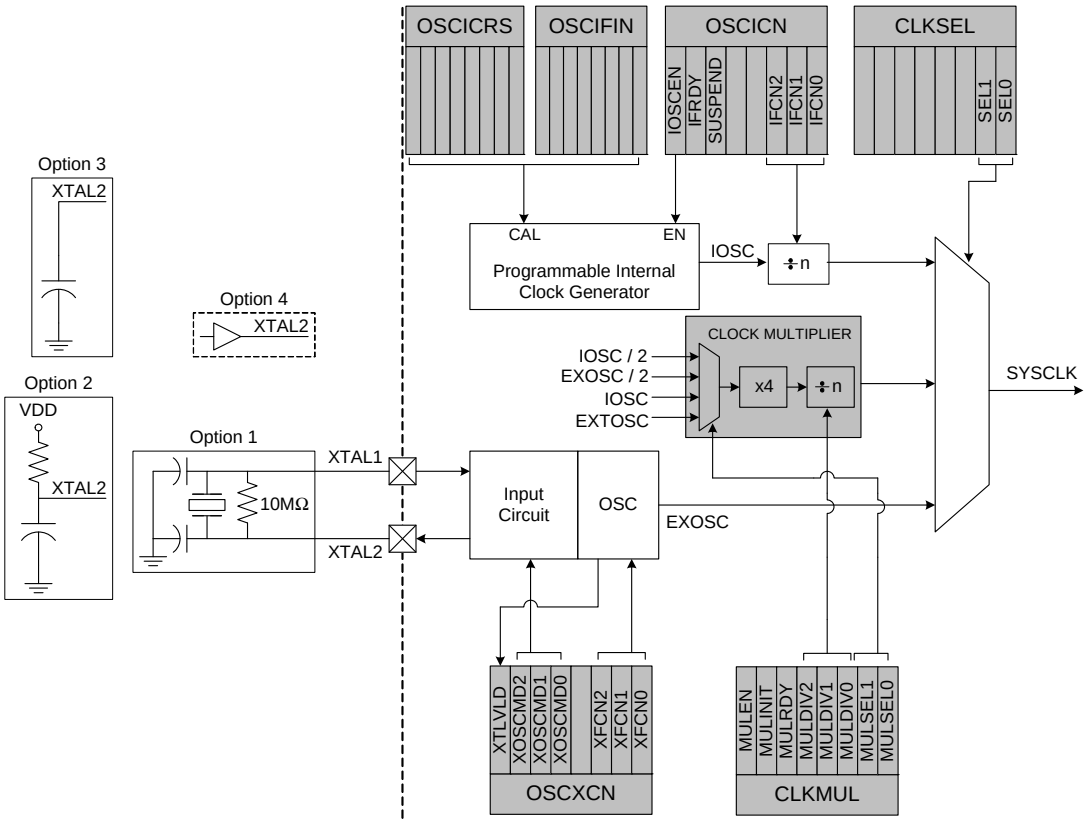


Figure 18.1. Oscillator Options

18.1. System Clock Selection

The CLKSL[1:0] bits in register CLKSEL select which oscillator source is used as the system clock. CLKSL[1:0] must be set to 01b for the system clock to run from the external oscillator; however the external oscillator may still clock certain peripherals (timers, PCA) when the internal oscillator is selected as the system clock. The system clock may be switched on-the-fly between the internal oscillator, external oscillator, and Clock Multiplier so long as the selected clock source is enabled and has settled.

The internal oscillator requires little start-up time and may be selected as the system clock immediately following the register write which enables the oscillator. The external RC and C modes also typically require no startup time.

External crystals and ceramic resonators however, typically require a start-up time before they are settled and ready for use. The Crystal Valid Flag (XTLVLD in register OSCXCN) is set to 1 by hardware when the external crystal or ceramic resonator is settled. **In crystal mode, to avoid reading a false XTLVLD, software should delay at least 1 ms between enabling the external oscillator and checking XTLVLD.**

SFR Definition 18.1. CLKSEL: Clock Select

Bit	7	6	5	4	3	2	1	0
Name							CLKSL[1:0]	
Type	R	R	R	R	R	R	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8F; SFR Page = 0x0F

Bit	Name	Function
7:2	Unused	Read = 000000b; Write = Don't Care
1:0	CLKSL[1:0]	**System Clock Source Select Bits.** 00: SYSCLK derived from the Internal Oscillator and scaled per the IFCN bits in register OSCICN. 01: SYSCLK derived from the External Oscillator circuit. 10: SYSCLK derived from the Clock Multiplier. 11: reserved.

18.2. Programmable Internal Oscillator

All C8051F55x/56x/57x devices include a programmable internal high-frequency oscillator that defaults as the system clock after a system reset. The internal oscillator period can be adjusted via the OSCICRS and OSCIFIN registers defined in SFR Definition 18.3 and SFR Definition 18.4. On C8051F55x/56x/57x devices, OSCICRS and OSCIFIN are factory calibrated to obtain a 24 MHz base frequency. Note that the system clock may be derived from the programmed internal oscillator divided by 1, 2, 4, 8, 16, 32, 64, or 128, as defined by the IFCN bits in register OSCICN. The divide value defaults to 128 following a reset.

18.2.1. Internal Oscillator Suspend Mode

When software writes a logic 1 to SUSPEND (OSCICN.5), the internal oscillator is suspended. If the system clock is derived from the internal oscillator, the input clock to the peripheral or CIP-51 will be stopped until one of the following events occur:

- Port 0 Match Event.
- Port 1 Match Event.
- Port 2 Match Event.
- Port 3 Match Event.
- Comparator 0 enabled and output is logic 0.

When one of the oscillator awakening events occur, the internal oscillator, CIP-51, and affected peripherals resume normal operation, regardless of whether the event also causes an interrupt. The CPU resumes execution at the instruction following the write to SUSPEND.

Note: Before entering suspend mode, firmware must set the ZTCEN bit in REF0CN (SFR Definition 7.1).

SFR Definition 18.2. OSCICN: Internal Oscillator Control

Bit	7	6	5	4	3	2	1	0
Name	IOSCEN[1:0]		SUSPEND	IFRDY	Reserved	IFCN[2:0]		
Type	R/W	R/W	R/W	R	R	R/W		
Reset	1	1	0	X	0	0	0	0

SFR Address = 0xA1; SFR Page = 0x0F

Bit	Name	Function
7:6	IOSCEN[1:0]	**Internal Oscillator Enable Bits.** 00: Oscillator Disabled. 01: Reserved. 10: Reserved. 11: Oscillator enabled in normal mode and disabled in suspend mode.
5	SUSPEND	**Internal Oscillator Suspend Enable Bit.** Setting this bit to logic 1 places the internal oscillator in SUSPEND mode. The internal oscillator resumes operation when one of the SUSPEND mode awakening events occurs. Before entering suspend mode, firmware must set the ZTCEN bit in REF0CN.
4	IFRDY	**Internal Oscillator Frequency Ready Flag.** Note: This flag may not accurately reflect the state of the oscillator. Firmware should not use this flag to determine if the oscillator is running. 0: Internal oscillator is not running at programmed frequency. 1: Internal oscillator is running at programmed frequency.
3	Reserved	Read = 0b; Must Write = 0b.
2:0	IFCN[2:0]	**Internal Oscillator Frequency Divider Control Bits.** 000: SYSCLK derived from Internal Oscillator divided by 128. 001: SYSCLK derived from Internal Oscillator divided by 64. 010: SYSCLK derived from Internal Oscillator divided by 32. 011: SYSCLK derived from Internal Oscillator divided by 16. 100: SYSCLK derived from Internal Oscillator divided by 8. 101: SYSCLK derived from Internal Oscillator divided by 4. 110: SYSCLK derived from Internal Oscillator divided by 2. 111: SYSCLK derived from Internal Oscillator divided by 1.

SFR Definition 18.3. OSCICRS: Internal Oscillator Coarse Calibration

Bit	7	6	5	4	3	2	1	0
Name		OSCICRS[6:0]						
Type	R	R/W						
Reset	0	Varies	Varies	Varies	Varies	Varies	Varies	Varies

SFR Address = 0xA2; SFR Page = 0x0F

Bit	Name	Function
7	Unused	Read = 0; Write = Don't Care
6:0	OSCICRS[6:0]	**Internal Oscillator Coarse Calibration Bits.** These bits determine the internal oscillator period. When set to 0000000b, the internal oscillator operates at its slowest setting. When set to 1111111b, the internal oscillator operates at its fastest setting. The reset value is factory calibrated to generate an internal oscillator frequency of 24 MHz.

SFR Definition 18.4. OSCIFIN: Internal Oscillator Fine Calibration

Bit	7	6	5	4	3	2	1	0
			OSCIFIN[5:0]					
Type	R	R	R/W					
Reset	0	0	Varies	Varies	Varies	Varies	Varies	Varies

SFR Address = 0x9E; SFR Page = 0x0F

Bit	Name	Function
7:6	Unused	Read = 00b; Write = Don't Care
5:0	OSCIFIN[5:0]	**Internal Oscillator Fine Calibration Bits.** These bits are fine adjustment for the internal oscillator period. The reset value is factory calibrated to generate an internal oscillator frequency of 24 MHz.

18.3. Clock Multiplier

The Clock Multiplier generates an output clock which is 4 times the input clock frequency scaled by a programmable factor of 1, 2/3, 2/4 (or 1/2), 2/5, 2/6 (or 1/3), or 2/7. The Clock Multiplier's input can be selected from the external oscillator, or the internal or external oscillators divided by 2. This produces three possible base outputs which can be scaled by a programmable factor: Internal Oscillator x 2, External Oscillator x 2, or External Oscillator x 4. See Section 18.1 on page 157 for details on system clock selection.

The Clock Multiplier is configured via the CLKMUL register (SFR Definition 18.5). The procedure for configuring and enabling the Clock Multiplier is as follows:

1. Reset the Multiplier by writing 0x00 to register CLKMUL.
2. Select the Multiplier input source via the MULSEL bits.
3. Select the Multiplier output scaling factor via the MULDIV bits
4. Enable the Multiplier with the MULEN bit (CLKMUL | = 0x80).
5. Delay for >5 µs.
6. Initialize the Multiplier with the MULINIT bit (CLKMUL | = 0xC0).
7. Poll for MULRDY $\geq$ 1.

Important Note: When using an external oscillator as the input to the Clock Multiplier, the external source must be enabled and stable before the Multiplier is initialized. See "18.4. External Oscillator Drive Circuit" on page 164 for details on selecting an external oscillator source.

The Clock Multiplier allows faster operation of the CIP-51 core and is intended to generate an output frequency between 25 and 50 MHz. The clock multiplier can also be used with slow input clocks. However, if the clock is below the minimum Clock Multiplier input frequency (FCM_{min}), the generated clock will consist of four fast pulses followed by a long delay until the next input clock rising edge. The average frequency of the output is equal to 4x the input, but the instantaneous frequency may be faster. See Figure 18.2 below for more information.

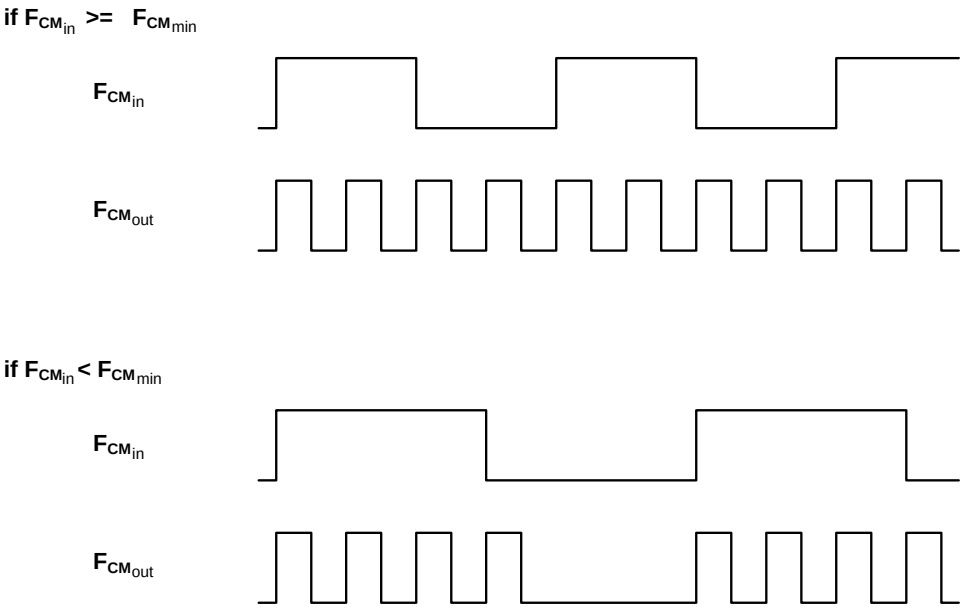


Figure 18.2. Example Clock Multiplier Output

SFR Definition 18.5. CLKMUL: Clock Multiplier

Bit	7	6	5	4	3	2	1	0
Name	MULEN	MULINIT	MULRDY	MULDIV[2:0]			MULSEL[1:0]	
Type	R/W	R/W	R	R/W			R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x97; SFR Page = 0x0F

Bit	Name	Function
7	MULEN	**Clock Multiplier Enable.** 0: Clock Multiplier disabled. 1: Clock Multiplier enabled.
6	MULINIT	**Clock Multiplier Initialize.** This bit is 0 when the Clock Multiplier is enabled. Once enabled, writing a 1 to this bit will initialize the Clock Multiplier. The MULRDY bit reads 1 when the Clock Multiplier is stabilized.
5	MULRDY	**Clock Multiplier Ready.** 0: Clock Multiplier is not ready. 1: Clock Multiplier is ready (PLL is locked).
4:2	MULDIV[2:0]	**Clock Multiplier Output Scaling Factor.** 000: Clock Multiplier Output scaled by a factor of 1. 001: Clock Multiplier Output scaled by a factor of 1. 010: Clock Multiplier Output scaled by a factor of 1. 011: Clock Multiplier Output scaled by a factor of 2/3*. 100: Clock Multiplier Output scaled by a factor of 2/4 (1/2). 101: Clock Multiplier Output scaled by a factor of 2/5*. 110: Clock Multiplier Output scaled by a factor of 2/6 (1/3). 111: Clock Multiplier Output scaled by a factor of 2/7*. ***Note:** The Clock Multiplier output duty cycle is not 50% for these settings.
1:0	MULSEL[1:0]	**Clock Multiplier Input Select.** These bits select the clock supplied to the Clock Multiplier

MULSEL[1:0]	Selected Input Clock	Clock Multiplier Output for MULDIV[2:0] = 000b
00	Internal Oscillator	Internal Oscillator x 2
01	External Oscillator	External Oscillator x 2
10	Internal Oscillator	Internal Oscillator x 4
11	External Oscillator	External Oscillator x 4

Notes: The maximum system clock is 50 MHz, and so the Clock Multiplier output should be scaled accordingly.
If Internal Oscillator x 2 or External Oscillator x 2 is selected using the MULSEL bits, MULDIV[2:0] is ignored.

18.4. External Oscillator Drive Circuit

The external oscillator circuit may drive an external crystal, ceramic resonator, capacitor, or RC network. A CMOS clock may also provide a clock input. For a crystal or ceramic resonator configuration, the crystal/resonator must be wired across the XTAL1 and XTAL2 pins as shown in Option 1 of Figure 18.1. A 10 MΩ resistor also must be wired across the XTAL2 and XTAL1 pins for the crystal/resonator configuration. In RC, capacitor, or CMOS clock configuration, the clock source should be wired to the XTAL2 pin as shown in Option 2, 3, or 4 of Figure 18.1. The type of external oscillator must be selected in the OSCXCN register, and the frequency control bits (XFCN) must be selected appropriately (see SFR Definition 18.6).

Important Note on External Oscillator Usage: Port pins must be configured when using the external oscillator circuit. When the external oscillator drive circuit is enabled in crystal/resonator mode, Port pins P0.2 and P0.3 are used as XTAL1 and XTAL2 respectively. When the external oscillator drive circuit is enabled in capacitor, RC, or CMOS clock mode, Port pin P0.3 is used as XTAL2. The Port I/O Crossbar should be configured to skip the Port pins used by the oscillator circuit; see Section “19.3. Priority Crossbar Decoder” on page 172 for Crossbar configuration. Additionally, when using the external oscillator circuit in crystal/resonator, capacitor, or RC mode, the associated Port pins should be configured as **analog inputs**. In CMOS clock mode, the associated pin should be configured as a **digital input**. See Section “19.4. Port I/O Initialization” on page 174 for details on Port input mode selection.

SFR Definition 18.6. OSCXCN: External Oscillator Control

Bit	7	6	5	4	3	2	1	0
Name	XTLVLD	XOSCMD[2:0]				XFCN[2:0]		
Type	R	R/W			R	R/W		
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x9F; SFR Page = 0x0F

Bit	Name	Function
7	XTLVLD	**Crystal Oscillator Valid Flag.** (Read only when XOSCMD = 11x.) 0: Crystal Oscillator is unused or not yet stable. 1: Crystal Oscillator is running and stable.
6:4	XOSCMD[2:0]	**External Oscillator Mode Select.** 00x: External Oscillator circuit off. 010: External CMOS Clock Mode. 011: External CMOS Clock Mode with divide by 2 stage. 100: RC Oscillator Mode. 101: Capacitor Oscillator Mode. 110: Crystal Oscillator Mode. 111: Crystal Oscillator Mode with divide by 2 stage.
3	Unused	Read = 0b; Write =0b
2:0	XFCN[2:0]	**External Oscillator Frequency Control Bits.** Set according to the desired frequency for Crystal or RC mode. Set according to the desired K Factor for C mode.

XFCN	Crystal Mode	RC Mode	C Mode
000	f ≤ 32 kHz	f ≤ 25 kHz	K Factor = 0.87
001	32 kHz < f ≤ 84 kHz	25 kHz < f ≤ 50 kHz	K Factor = 2.6
010	84 kHz < f ≤ 225 kHz	50 kHz < f ≤ 100 kHz	K Factor = 7.7
011	225 kHz < f ≤ 590 kHz	100 kHz < f ≤ 200 kHz	K Factor = 22
100	590 kHz < f ≤ 1.5 MHz	200 kHz < f ≤ 400 kHz	K Factor = 65
101	1.5 MHz < f ≤ 4 MHz	400 kHz < f ≤ 800 kHz	K Factor = 180
110	4 MHz < f ≤ 10 MHz	800 kHz < f ≤ 1.6 MHz	K Factor = 664
111	10 MHz < f ≤ 30 MHz	1.6 MHz < f ≤ 3.2 MHz	K Factor = 1590

18.4.1. External Crystal Example

If a crystal or ceramic resonator is used as an external oscillator source for the MCU, the circuit should be configured as shown in Figure 18.1, Option 1. The External Oscillator Frequency Control value (XFCN) should be chosen from the Crystal column of the table in SFR Definition 18.6 (OSCXCN register). For example, an 11.0592 MHz crystal requires an XFCN setting of 111b and a 32.768 kHz Watch Crystal requires an XFCN setting of 001b. After an external 32.768 kHz oscillator is stabilized, the XFCN setting can be switched to 000 to save power. It is recommended to enable the missing clock detector before switching the system clock to any external oscillator source.

When the crystal oscillator is first enabled, the oscillator amplitude detection circuit requires a settling time to achieve proper bias. Introducing a delay of 1 ms between enabling the oscillator and checking the XTLVLD bit will prevent a premature switch to the external oscillator as the system clock. Switching to the external oscillator before the crystal oscillator has stabilized can result in unpredictable behavior. The recommended procedure is:

1. Force XTAL1 and XTAL2 to a high state. This involves enabling the Crossbar and writing 1 to the port pins associated with XTAL1 and XTAL2.
2. Configure XTAL1 and XTAL2 as analog inputs using.
3. Enable the external oscillator.
4. Wait at least 1 ms.
5. Poll for XTLVLD => 1.
6. Enable the Missing Clock Detector.
7. Switch the system clock to the external oscillator.

Important Note on External Crystals: Crystal oscillator circuits are quite sensitive to PCB layout. The crystal should be placed as close as possible to the XTAL pins on the device. The traces should be as short as possible and shielded with ground plane from any other traces which could introduce noise or interference.

The capacitors shown in the external crystal configuration provide the load capacitance required by the crystal for correct oscillation. These capacitors are "in series" as seen by the crystal and "in parallel" with the stray capacitance of the XTAL1 and XTAL2 pins.

Note: The desired load capacitance depends upon the crystal and the manufacturer. Refer to the crystal data sheet when completing these calculations.

For example, a tuning-fork crystal of 32.768 kHz with a recommended load capacitance of 12.5 pF should use the configuration shown in Figure 18.1, Option 1. The total value of the capacitors and the stray capacitance of the XTAL pins should equal 25 pF. With a stray capacitance of 3 pF per pin, the 22 pF capacitors yield an equivalent capacitance of 12.5 pF across the crystal, as shown in Figure 18.3.

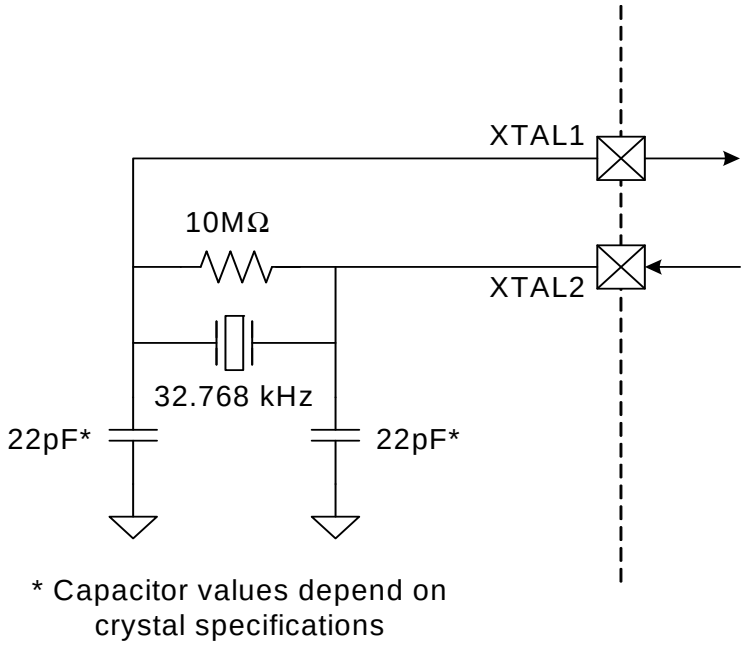


Figure 18.3. External 32.768 kHz Quartz Crystal Oscillator Connection Diagram

18.4.2. External RC Example

If an RC network is used as an external oscillator source for the MCU, the circuit should be configured as shown in Figure 18.1, Option 2. The capacitor should be no greater than 100 pF; however for very small capacitors, the total capacitance may be dominated by parasitic capacitance in the PCB layout. To determine the required External Oscillator Frequency Control value (XFCN) in the OSCXCN Register, first select the RC network value to produce the desired frequency of oscillation, according to Equation 18.1, where f = the frequency of oscillation in MHz, C = the capacitor value in pF, and R = the pull-up resistor value in kΩ.

$$f = 1.23 \times 10^3 / (R \times C)$$

Equation 18.1. RC Mode Oscillator Frequency

For example: If the frequency desired is 100 kHz, let R = 246 kΩ and C = 50 pF:

f = 1.23(10^3)/RC = 1.23(10^3)/[246 x 50] = 0.1 MHz = 100 kHz

Referring to the table in SFR Definition 18.6, the required XFCN setting is 010b.

18.4.3. External Capacitor Example

If a capacitor is used as an external oscillator for the MCU, the circuit should be configured as shown in Figure 18.1, Option 3. The capacitor should be no greater than 100 pF; however for very small capacitors, the total capacitance may be dominated by parasitic capacitance in the PCB layout. To determine the required External Oscillator Frequency Control value (XFCN) in the OSCXCN Register, select the capacitor to be used and find the frequency of oscillation according to Equation , where f = the frequency of oscillation in MHz, C = the capacitor value in pF, and V_{DD} = the MCU power supply in Volts.

$$f = (KF)/(R \times V_{DD})$$

Equation 18.2. C Mode Oscillator Frequency

For example: Assume V_{DD} = 2.1 V and f = 75 kHz:

f = KF / (C x VDD)

0.075 MHz = KF / (C x 2.1)

Since the frequency of roughly 75 kHz is desired, select the K Factor from the table in SFR Definition 18.6 (OSCXCN) as KF = 7.7:

0.075 MHz = 7.7 / (C x 2.1)

C x 2.1 = 7.7 / 0.075 MHz

C = 102.6 / 2.0 pF = 51.3 pF

Therefore, the XFCN value to use in this example is 010b.

19. Port Input/Output

Digital and analog resources are available through 33 (C8051F568-9 and ‘F570-5), 25 (C8051F550-7) or 18 (C8051F550-7) I/O pins. Port pins P0.0-P4.0 on the C8051F568-9 and ‘F570-5, port pins P0.0-P3.0 on theC8051F560-7, and port pins P0.0-P2.1 on the C8051F550-7 can be defined as general-purpose I/O (GPIO), assigned to one of the internal digital resources, or assigned to an analog function as shown in Figure 19.3. Port pin P4.0 on the C8051F568-9 and ‘F570-5 can be used as GPIO and is shared with the C2 Interface Data signal (C2D). Similarly, port pin P3.0 is shared with C2D on the C8051F560-7 and port pin P2.1 on the C8051F550-7. The designer has complete control over which functions are assigned, limited only by the number of physical I/O pins. This resource assignment flexibility is achieved through the use of a Priority Crossbar Decoder. Note that the state of a Port I/O pin can always be read in the corresponding Port latch, regardless of the Crossbar settings.

The Crossbar assigns the selected internal digital resources to the I/O pins based on the Priority Decoder (Figure 19.3 and Figure 19.4). The registers XBR0, XBR1, XBR2 are defined in SFR Definition 19.1 and SFR Definition 19.2 and are used to select internal digital functions.

The Port I/O cells are configured as either push-pull or open-drain in the Port Output Mode registers (PnMDOUT, where n = 0,1). Complete Electrical Specifications for Port I/O are given in Table 5.3 on page 40.

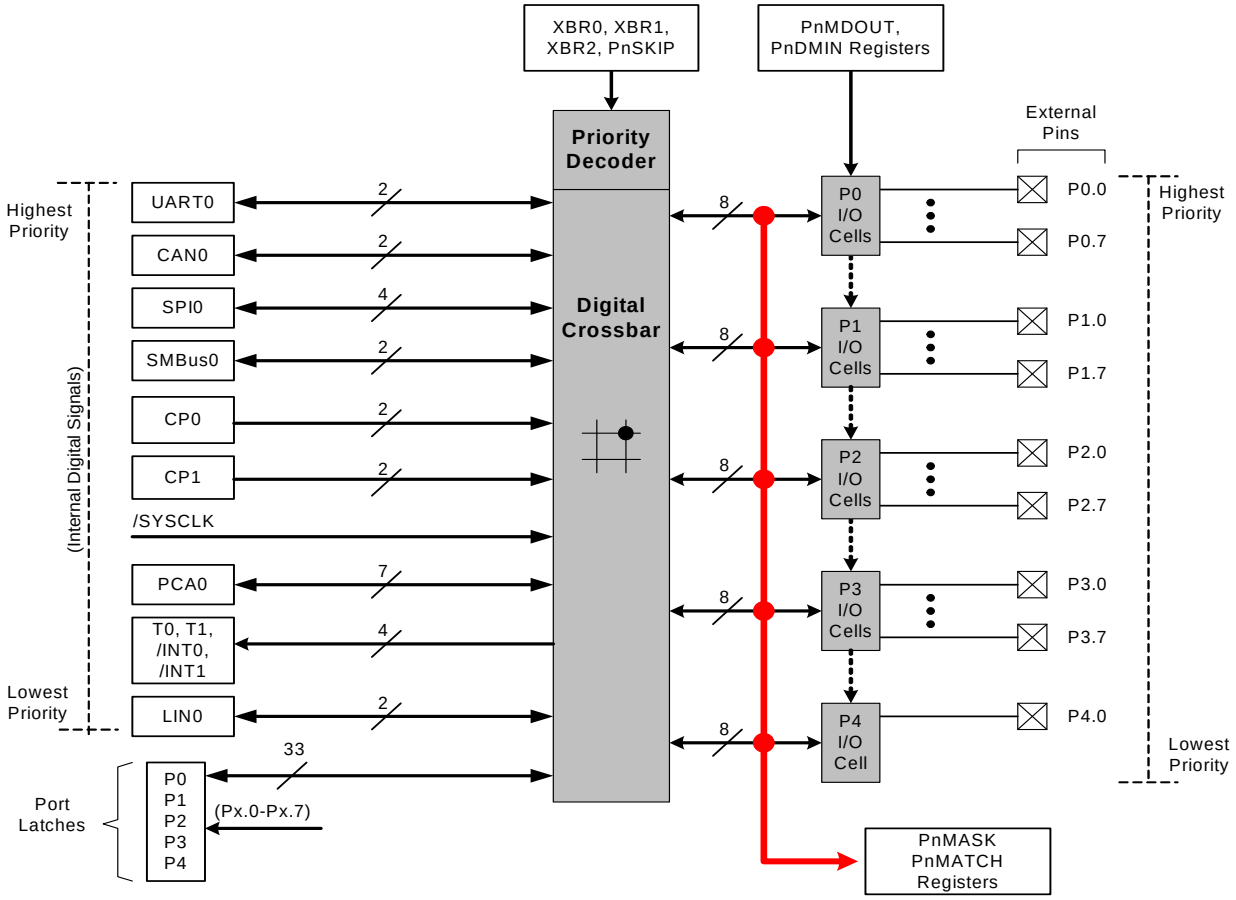


Figure 19.1. Port I/O Functional Block Diagram

Note: When VIO rises faster than VDD, which can happen when VREGIN and VIO are tied together, a delay created between GPIO power (VIO) and the logic controlling GPIO (VDD) results in a temporary unknown state at the GPIO pins. When VIO rises faster than VDD, the GPIO may enter the following states: floating, glitch low, or glitch high. Cross coupling VIO and VDD with a 4.7 µF capacitor mitigates the root cause of the problem by allowing VIO and VDD to rise at the same rate.

19.1. Port I/O Modes of Operation

Port pins P0.0–P4.0 use the Port I/O cell shown in Figure 19.2. Each Port I/O cell can be configured by software for analog I/O or digital I/O using the PnMDIN registers. On reset, all Port I/O cells default to a high impedance state with weak pull-ups enabled until the Crossbar is enabled (XBARE = 1).

19.1.1. Port Pins Configured for Analog I/O

Any pins to be used as Comparator or ADC inputs, external oscillator inputs, or VREF should be configured for analog I/O (PnMDIN.n = 0). When a pin is configured for analog I/O, its weak pullup, digital driver, and digital receiver are disabled. Port pins configured for analog I/O will always read back a value of 0.

Configuring pins as analog I/O saves power and isolates the Port pin from digital interference. Port pins configured as digital inputs may still be used by analog peripherals; however, this practice is not recommended and may result in measurement errors.

19.1.2. Port Pins Configured For Digital I/O

Any pins to be used by digital peripherals (UART, SPI, SMBus, etc.), external digital event capture functions, or as GPIO should be configured as digital I/O (PnMDIN.n = 1). For digital I/O pins, one of two output modes (push-pull or open-drain) must be selected using the PnMDOUT registers.

Push-pull outputs (PnMDOUT.n = 1) drive the Port pad to the VIO or GND supply rails based on the output logic value of the Port pin. Open-drain outputs have the high side driver disabled; therefore, they only drive the Port pad to GND when the output logic value is 0 and become high impedance inputs (both high low drivers turned off) when the output logic value is 1.

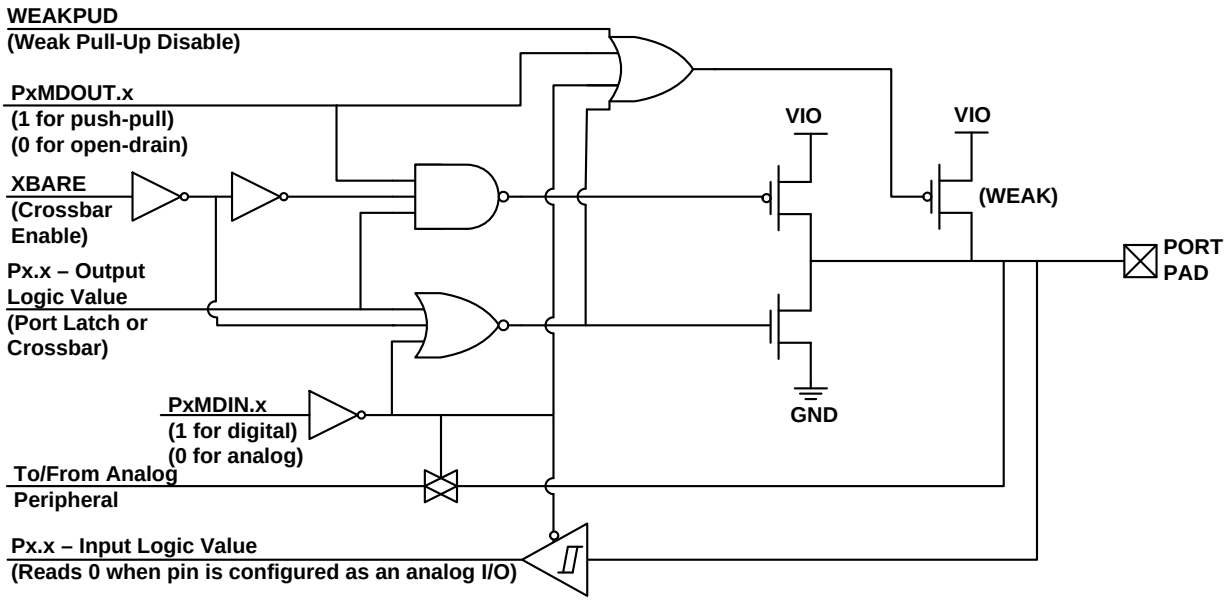


Figure 19.2. Port I/O Cell Block Diagram

When a digital I/O cell is placed in the high impedance state, a weak pull-up transistor pulls the Port pad to the VIO supply voltage to ensure the digital input is at a defined logic state. Weak pull-ups are disabled when the I/O cell is driven to GND to minimize power consumption and may be globally disabled by setting WEAKPUD to 1. The user should ensure that digital I/O are always internally or externally pulled or driven to a valid logic state to minimize power consumption. Port pins configured for digital I/O always read back the logic state of the Port pad, regardless of the output logic value of the Port pin.

19.1.3. Interfacing Port I/O in a Multi-Voltage System

All Port I/O are capable of interfacing to digital logic operating at a supply voltage higher than VDD and less than 5.25 V. Connect the VIO pin to the voltage source of the interface logic.

19.2. Assigning Port I/O Pins to Analog and Digital Functions

Port I/O pins P0.0–P3.7 can be assigned to various analog, digital, and external interrupt functions. P4.0 can be assigned to only digital functions. The Port pins assigned to analog functions should be configured for analog I/O, and Port pins assigned to digital or external interrupt functions should be configured for digital I/O.

19.2.1. Assigning Port I/O Pins to Analog Functions

Table 19.1 shows all available analog functions that require Port I/O assignments. **Port pins selected for these analog functions should have their corresponding bit in PnSKIP set to 1.** This reserves the pin for use by the analog function and does not allow it to be claimed by the Crossbar. Table 19.1 shows the potential mapping of Port I/O to each analog function.

Table 19.1. Port I/O Assignment for Analog Functions

Analog Function	Potentially Assignable Port Pins	SFR(s) used for Assignment
ADC Input	P0.0–P3.7[1]	ADC0MX, PnSKIP
Comparator0 or Compartor1 Input	P0.0–P2.7[1]	CPT0MX, CPT1MX, PnSKIP
Voltage Reference (VREF0)[2]	P0.0	REF0CN, PnSKIP
External Oscillator in Crystal Mode (XTAL1)	P0.2	OSCXCN, PnSKIP
External Oscillator in RC, C, or Crystal Mode (XTAL2)	P0.3	OSCXCN, PnSKIP

Notes:
1. P3.1–P3.7 are available on the 40-pin packages. P2.2-P3.0 are available 40-pin and 32-pin packages.
2. If VDD is selected as the voltage reference in the REF0CN register and the ADC is enabled in the ADC0CN register, the P0.0/VREF pin cannot operate as a general purpose I/O pin in open-drain mode. With the above settings, this pin can operate in push-pull output mode or as an analog input.

19.2.2. Assigning Port I/O Pins to Digital Functions

Any Port pins not assigned to analog functions may be assigned to digital functions or used as GPIO. Most digital functions rely on the Crossbar for pin assignment; however, some digital functions bypass the Crossbar in a manner similar to the analog functions listed above. **Port pins used by these digital functions and any Port pins selected for use as GPIO should have their corresponding bit in PnSKIP set to 1.** Table 19.2 shows all available digital functions and the potential mapping of Port I/O to each digital function.

Table 19.2. Port I/O Assignment for Digital Functions

Digital Function	Potentially Assignable Port Pins	SFR(s) used for Assignment
UART0, SPI0, SMBus, CAN0, LIN0, CP0, CP0A, CP1, CP1A, SYSCLK, PCA0 (CEX0-5 and ECI), T0 or T1.	Any Port pin available for assignment by the Crossbar. This includes P0.0–P4.0* pins which have their PnSKIP bit set to 0. **Note:** The Crossbar will always assign UART0 pins to P0.4 and P0.5 and always assign CAN0 to P0.6 and P0.7.	XBR0, XBR1, XBR2
Any pin used for GPIO	P0.0–P4.0*	P0SKIP, P1SKIP, P2SKIP, P3SKIP
***Note:** P3.1–P3.7 are available on the 40-pin packages. P2.2-P3.0 are available 40-pin and 32-pin packages.		

19.2.3. Assigning Port I/O Pins to External Digital Event Capture Functions

External digital event capture functions can be used to trigger an interrupt or wake the device from a low power mode when a transition occurs on a digital I/O pin. The digital event capture functions do not require dedicated pins and will function on both GPIO pins (PnSKIP = 1) and pins in use by the Crossbar (PnSKIP = 0). External digital event capture functions cannot be used on pins configured for analog I/O. Table 19.3 shows all available external digital event capture functions.

Table 19.3. Port I/O Assignment for External Digital Event Capture Functions

Digital Function	Potentially Assignable Port Pins	SFR(s) used for Assignment
External Interrupt 0	P1.0–P1.7	IT01CF
External Interrupt 1	P1.0–P1.7	IT01CF
Port Match	P0.0–P3.7*	P0MASK, P0MAT P1MASK, P1MAT P2MASK, P2MAT P3MASK, P3MAT
***Note:** P3.1–P3.7 are available on the 40-pin packages. P2.2-P3.0 are available 40-pin and 32-pin packages		

19.3. Priority Crossbar Decoder

The Priority Crossbar Decoder (Figure 19.3) assigns a priority to each I/O function, starting at the top with UART0. When a digital resource is selected, the least-significant unassigned Port pin is assigned to that resource excluding UART0, which is always assigned to pins P0.4 and P0.5, and excluding CAN0 which is always assigned to pins P0.6 and P0.7. If a Port pin is assigned, the Crossbar skips that pin when assigning the next selected resource. Additionally, the Crossbar will skip Port pins whose associated bits in the PnSKIP registers are set. The PnSKIP registers allow software to skip Port pins that are to be used for analog input, dedicated functions, or GPIO.

Because of the nature of Priority Crossbar Decoder, not all peripherals can be located on all port pins. Figure 19.3 maps peripherals to the potential port pins on which the peripheral I/O can appear.

Important Note on Crossbar Configuration: If a Port pin is claimed by a peripheral without use of the Crossbar, its corresponding PnSKIP bit should be set. This applies to P0.0 if VREF is used, P0.1 if the ADC is configured to use the external conversion start signal (CNVSTR), P0.3 and/or P0.2 if the external oscillator circuit is enabled, and any selected ADC or Comparator inputs. The Crossbar skips selected pins as if they were already assigned, and moves to the next unassigned pin.

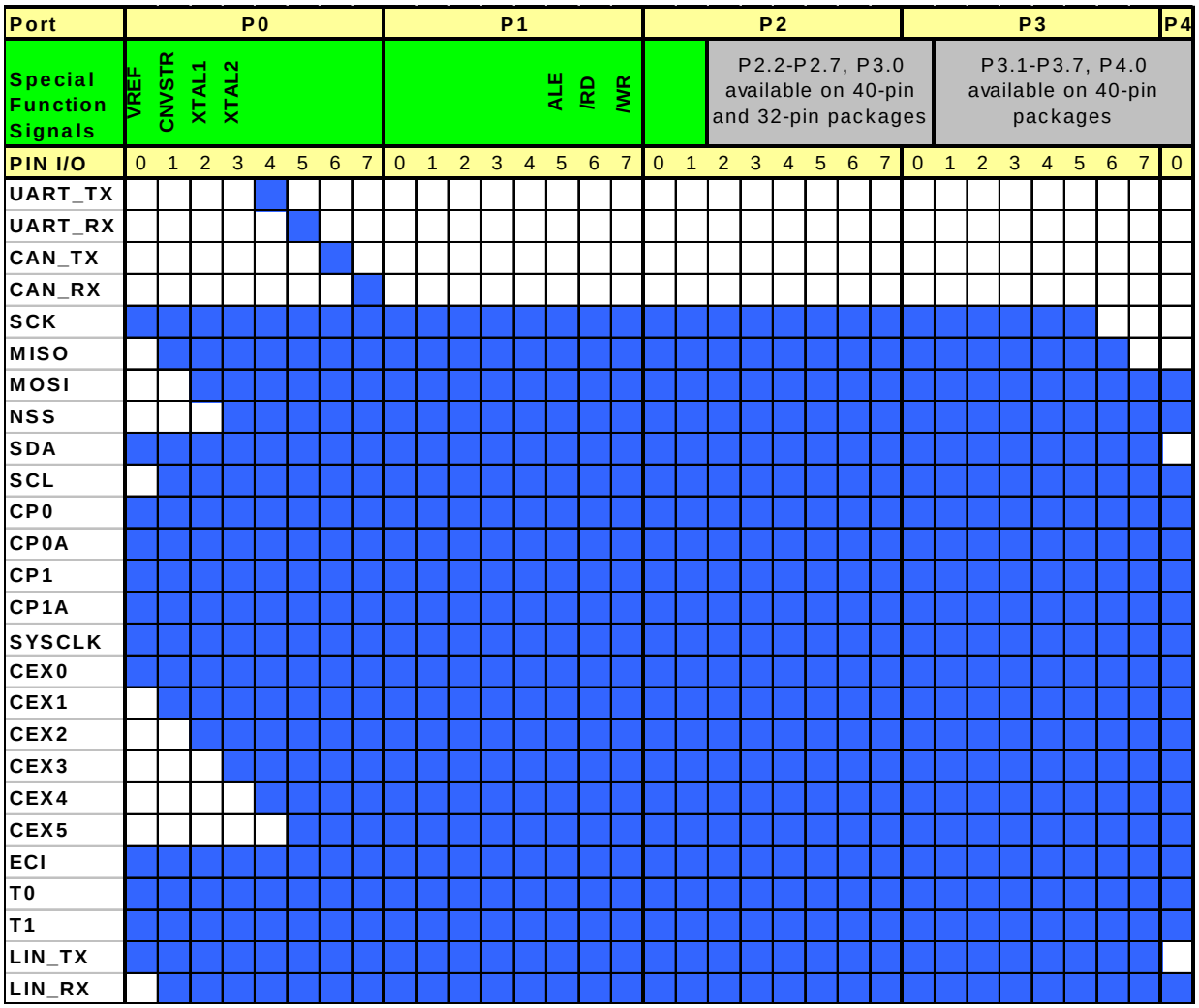


Figure 19.3. Peripheral Availability on Port I/O Pins

Registers XBR0, XBR1, and XBR2 are used to assign the digital I/O resources to the physical I/O Port pins. Note that when the SMBus is selected, the Crossbar assigns both pins associated with the SMBus (SDA and SCL); and similarly when the UART, CAN or LIN are selected, the Crossbar assigns both pins associated with the peripheral (TX and RX). UART0 pin assignments are fixed for bootloading purposes: UART TX0 is always assigned to P0.4; UART RX0 is always assigned to P0.5. CAN0 pin assignments are fixed to P0.6 for CAN_TX and P0.7 for CAN_RX. Standard Port I/Os appear contiguously after the prioritized functions have been assigned.

Important Note: The SPI can be operated in either 3-wire or 4-wire modes, pending the state of the NSSMD1–NSSMD0 bits in register SPI0CN. According to the SPI mode, the NSS signal may or may not be routed to a Port pin.

As an example configuration, if CAN0, SPI0 in 4-wire mode, and PCA0 Modules 0, 1, and 2 are enabled on the crossbar with P0.1, P0.2, and P0.5 skipped, the registers should be set as follows: XBR0 = 0x06 (CAN0 and SPI0 enabled), XBR1 = 0x0C (PCA0 modules 0, 1, and 2 enabled), XBR2 = 0x40 (Crossbar enabled), and P0SKIP = 0x26 (P0.1, P0.2, and P0.5 skipped). The resulting crossbar would look as shown in Figure 19.4.

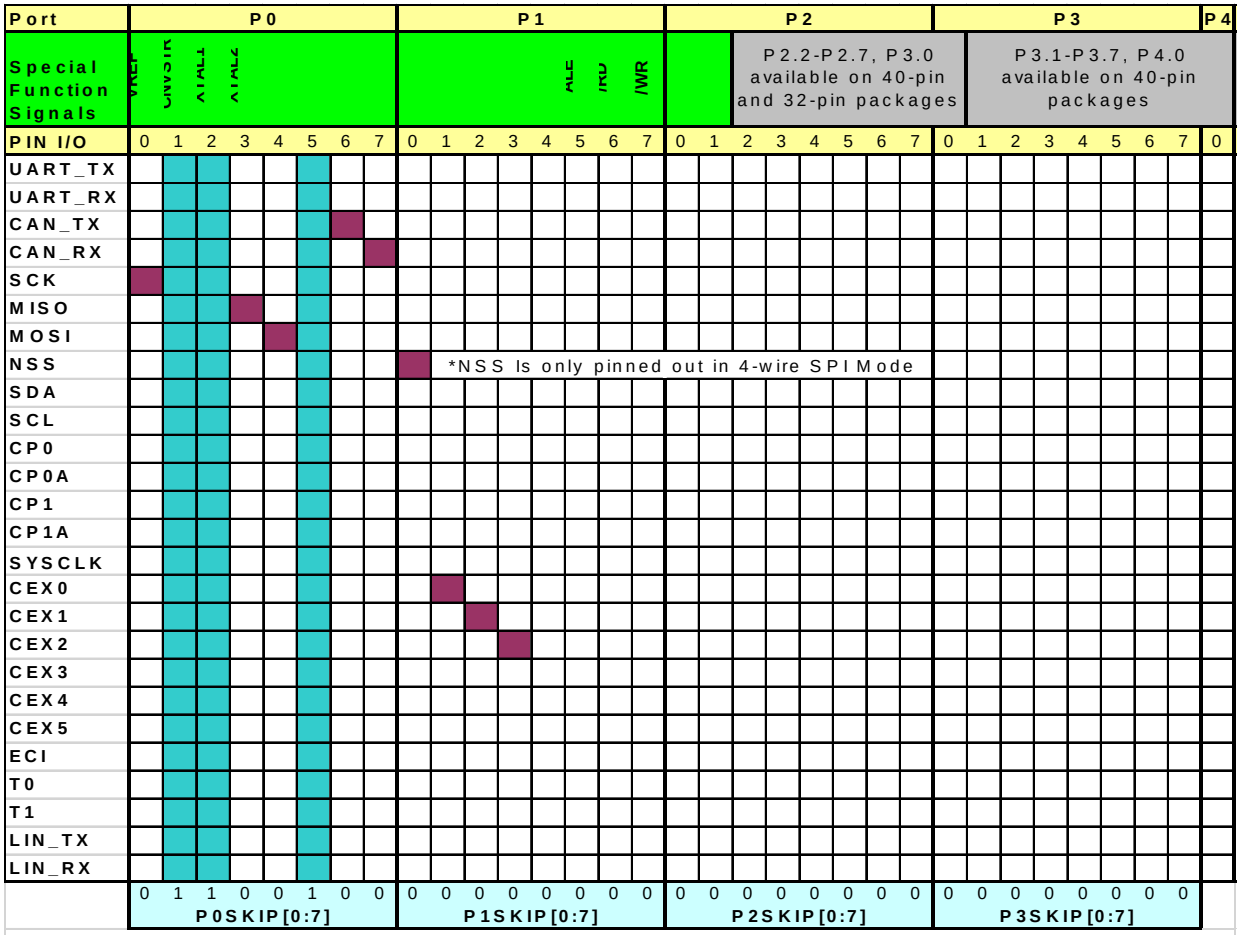


Figure 19.4. Crossbar Priority Decoder in Example Configuration

19.4. Port I/O Initialization

Port I/O initialization consists of the following steps:

1. Select the input mode (analog or digital) for all Port pins, using the Port Input Mode register (PnMDIN).
2. Select the output mode (open-drain or push-pull) for all Port pins, using the Port Output Mode register (PnMDOUT).
3. Select any pins to be skipped by the I/O Crossbar using the Port Skip registers (PnSKIP).
4. Assign Port pins to desired peripherals.
5. Enable the Crossbar (XBARE = 1).

All Port pins must be configured as either analog or digital inputs. Port 4 C8051F568-9 and ‘F570-5 is a digital-only Port. Any pins to be used as Comparator or ADC inputs should be configured as an analog inputs. When a pin is configured as an analog input, its weak pullup, digital driver, and digital receiver are disabled. This process saves power and reduces noise on the analog input. Pins configured as digital inputs may still be used by analog peripherals; however this practice is not recommended.

Additionally, all analog input pins should be configured to be skipped by the Crossbar (accomplished by setting the associated bits in PnSKIP). Port input mode is set in the PnMDIN register, where a 1 indicates a digital input, and a 0 indicates an analog input. All pins default to digital inputs on reset. See SFR Definition 19.13 for the PnMDIN register details.

The output driver characteristics of the I/O pins are defined using the Port Output Mode registers (PnMDOUT). Each Port Output driver can be configured as either open drain or push-pull. This selection is required even for the digital resources selected in the XBRn registers, and is not automatic. The only exception to this is the SMBus (SDA, SCL) pins, which are configured as open-drain regardless of the PnMDOUT settings. When the WEAKPUD bit in XBR2 is 0, a weak pullup is enabled for all Port I/O configured as open-drain. WEAKPUD does not affect the push-pull Port I/O. Furthermore, the weak pullup is turned off on an output that is driving a 0 to avoid unnecessary power dissipation.

Registers XBR0, XBR1, and XBR2 must be loaded with the appropriate values to select the digital I/O functions required by the design. Setting the XBARE bit in XBR2 to 1 enables the Crossbar. Until the Crossbar is enabled, the external pins remain as standard Port I/O (in input mode), regardless of the XBRn Register settings. For given XBRn Register settings, one can determine the I/O pin-out using the Priority Decode Table; as an alternative, the Configuration Wizard utility of the Silicon Labs IDE software will determine the Port I/O pin-assignments based on the XBRn Register settings.

The Crossbar must be enabled to use Port pins as standard Port I/O in output mode. Port output drivers are disabled while the Crossbar is disabled.

SFR Definition 19.1. XBR0: Port I/O Crossbar Register 0

Bit	7	6	5	4	3	2	1	0
Name	CP1AE	CP1E	CP0AE	CP0E	SMB0E	SPI0E	CAN0E	URT0E
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE1; SFR Page = 0x0F

Bit	Name	Function
7	CP1AE	**Comparator1 Asynchronous Output Enable.** 0: Asynchronous CP1 unavailable at Port pin. 1: Asynchronous CP1 routed to Port pin.
6	CP1E	**Comparator1 Output Enable.** 0: CP1 unavailable at Port pin. 1: CP1 routed to Port pin.
5	CP0AE	**Comparator0 Asynchronous Output Enable.** 0: Asynchronous CP0 unavailable at Port pin. 1: Asynchronous CP0 routed to Port pin.
4	CP0E	**Comparator0 Output Enable.** 0: CP0 unavailable at Port pin. 1: CP0 routed to Port pin.
3	SMB0E	**SMBus I/O Enable.** 0: SMBus I/O unavailable at Port pins. 1: SMBus I/O routed to Port pins.
2	SPI0E	**SPI I/O Enable.** 0: SPI I/O unavailable at Port pins. 1: SPI I/O routed to Port pins. Note that the SPI can be assigned either 3 or 4 GPIO pins.
1	CAN0E	**CAN I/O Output Enable.** 0: CAN I/O unavailable at Port pins. 1: CAN_TX, CAN_RX routed to Port pins P0.6 and P0.7.
0	URT0E	**UART I/O Output Enable.** 0: UART I/O unavailable at Port pin. 1: UART TX0, RX0 routed to Port pins P0.4 and P0.5.

SFR Definition 19.2. XBR1: Port I/O Crossbar Register 1

Bit	7	6	5	4	3	2	1	0
Name	T1E	T0E	ECIE	PCA0ME[2:0]			SYSCKE	Reserved
Type	R/W	R/W	R/W	R/W	R/W	R	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE2; SFR Page = 0x0F

Bit	Name	Function
7	T1E	**T1 Enable.** 0: T1 unavailable at Port pin. 1: T1 routed to Port pin.
6	T0E	**T0 Enable.** 0: T0 unavailable at Port pin. 1: T0 routed to Port pin.
5	ECIE	**PCA0 External Counter Input Enable.** 0: ECI unavailable at Port pin. 1: ECI routed to Port pin.
4:2	PCA0ME[2:0]	**PCA Module I/O Enable Bits.** 000: All PCA I/O unavailable at Port pins. 001: CEX0 routed to Port pin. 010: CEX0, CEX1 routed to Port pins. 011: CEX0, CEX1, CEX2 routed to Port pins. 100: CEX0, CEX1, CEX2, CEX3 routed to Port pins. 101: CEX0, CEX1, CEX2, CEX3, CEX4 routed to Port pins. 110: CEX0, CEX1, CEX2, CEX3, CEX4, CEX5 routed to Port pins. 111: RESERVED
1	SYSCKE	**/SYSCLK Output Enable.** 0: /SYSCLK unavailable at Port pin. 1: /SYSCLK output routed to Port pin.
0	Reserved	Always Write to 0.

SFR Definition 19.3. XBR2: Port I/O Crossbar Register 1

Bit	7	6	5	4	3	2	1	0
Name	WEAKPUD	XBARE	Reserved					LIN0E
Type	R/W	R/W	R/W	R/W	R/W	R	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xC7; SFR Page = 0x0F

Bit	Name	Function
7	WEAKPUD	**Port I/O Weak Pullup Disable.** 0: Weak Pullups enabled (except for Ports whose I/O are configured for analog mode). 1: Weak Pullups disabled.
6	XBARE	**Crossbar Enable.** 0: Crossbar disabled. 1: Crossbar enabled.
5:1	Reserved	Always Write to 00000b.
0	LIN0E	**LIN I/O Output Enable.** 0: LIN I/O unavailable at Port pin. 1: LIN_TX, LIN_RX routed to Port pins.

19.5. Port Match

Port match functionality allows system events to be triggered by a logic value change on P0, P1, P2 or P3. A software controlled value stored in the PnMATCH registers specifies the expected or normal logic values of P0, P1, P2, and P3. A Port mismatch event occurs if the logic levels of the Port's input pins no longer match the software controlled value. This allows Software to be notified if a certain change or pattern occurs on P0, P1, P2, or P3 input pins regardless of the XBRn settings.

The PnMASK registers can be used to individually select which of the port pins should be compared against the PnMATCH registers. A Port mismatch event is generated if (Pn & PnMASK) does not equal (PnMATCH & PnMASK), where n is 0, 1, 2 or 3

A Port mismatch event may be used to generate an interrupt or wake the device from a low power mode, such as IDLE or SUSPEND. See the Interrupts and Power Options chapters for more details on interrupt and wake-up sources.

SFR Definition 19.4. P0MASK: Port 0 Mask Register

Bit	7	6	5	4	3	2	1	0
Name	P0MASK[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xF2; SFR Page = 0x00

Bit	Name	Function
7:0	P0MASK[7:0]	**Port 0 Mask Value.** Selects P0 pins to be compared to the corresponding bits in P0MAT. 0: P0.n pin logic value is ignored and cannot cause a Port Mismatch event. 1: P0.n pin logic value is compared to P0MAT.n.

SFR Definition 19.5. P0MAT: Port 0 Match Register

Bit	7	6	5	4	3	2	1	0
Name	P0MAT[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xF1; SFR Page = 0x00

Bit	Name	Function
7:0	P0MAT[7:0]	**Port 0 Match Value.** Match comparison value used on Port 0 for bits in P0MAT which are set to 1. 0: P0.n pin logic value is compared with logic LOW. 1: P0.n pin logic value is compared with logic HIGH.

SFR Definition 19.6. P1MASK: Port 1 Mask Register

Bit	7	6	5	4	3	2	1	0
Name	P1MASK[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xF4; SFR Page = 0x00

Bit	Name	Function
7:0	P1MASK[7:0]	**Port 1 Mask Value.** Selects P1 pins to be compared to the corresponding bits in P1MAT. 0: P1.n pin logic value is ignored and cannot cause a Port Mismatch event. 1: P1.n pin logic value is compared to P1MAT.n.

SFR Definition 19.7. P1MAT: Port 1 Match Register

Bit	7	6	5	4	3	2	1	0
Name	P1MAT[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xF3; SFR Page = 0x00

Bit	Name	Function
7:0	P1MAT[7:0]	**Port 1 Match Value.** Match comparison value used on Port 1 for bits in P1MAT which are set to 1. 0: P1.n pin logic value is compared with logic LOW. 1: P1.n pin logic value is compared with logic HIGH.

SFR Definition 19.8. P2MASK: Port 2 Mask Register

Bit	7	6	5	4	3	2	1	0
Name	P2MASK[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xB2; SFR Page = 0x00

Bit	Name	Function
7:0	P2MASK[7:0]	**Port 2 Mask Value.** Selects P2 pins to be compared to the corresponding bits in P2MAT. 0: P2.n pin logic value is ignored and cannot cause a Port Mismatch event. 1: P2.n pin logic value is compared to P2MAT.n.
Note: P2.2–P2.7 are available on 40-pin and 32-pin packages.		

SFR Definition 19.9. P2MAT: Port 2 Match Register

Bit	7	6	5	4	3	2	1	0
Name	P2MAT[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xB1; SFR Page = 0x00

Bit	Name	Function
7:0	P2MAT[7:0]	**Port 2 Match Value.** Match comparison value used on Port 2 for bits in P2MAT which are set to 1. 0: P2.n pin logic value is compared with logic LOW. 1: P2.n pin logic value is compared with logic HIGH.
Note: P2.2–P2.7 are available on 40-pin and 32-pin packages.		

SFR Definition 19.10. P3MASK: Port 3 Mask Register

Bit	7	6	5	4	3	2	1	0
Name	P3MASK[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xAF; SFR Page = 0x00

Bit	Name	Function
7:0	P3MASK[7:0]	**Port 1 Mask Value.** Selects P3 pins to be compared to the corresponding bits in P3MAT. 0: P3.n pin logic value is ignored and cannot cause a Port Mismatch event. 1: P3.n pin logic value is compared to P3MAT.n.
Note: P3.0 is available on 40-pin and 32-pin packages. P3.1-P3.7 are available on 40-pin packages		

SFR Definition 19.11. P3MAT: Port 3 Match Register

Bit	7	6	5	4	3	2	1	0
Name	P3MAT[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xAE; SFR Page = 0x00

Bit	Name	Function
7:0	P3MAT[7:0]	**Port 3 Match Value.** Match comparison value used on Port 3 for bits in P3MAT which are set to 1. 0: P3.n pin logic value is compared with logic LOW. 1: P3.n pin logic value is compared with logic HIGH.
Note: P3.0 is available on 40-pin and 32-pin packages. P3.1-P3.7 are available on 40-pin packages		

19.6. Special Function Registers for Accessing and Configuring Port I/O

All Port I/O are accessed through corresponding special function registers (SFRs) that are both byte addressable and bit addressable, except for P4 which is only byte addressable. When writing to a Port, the value written to the SFR is latched to maintain the output data value at each pin. When reading, the logic levels of the Port's input pins are returned regardless of the XBRn settings (i.e., even when the pin is assigned to another signal by the Crossbar, the Port register can always read its corresponding Port I/O pin). The exception to this is the execution of the read-modify-write instructions that target a Port Latch register as the destination. The read-modify-write instructions when operating on a Port SFR are the following: ANL, ORL, XRL, JBC, CPL, INC, DEC, DJNZ and MOV, CLR or SETB, when the destination is an individual bit in a Port SFR. For these instructions, the value of the latch register (not the pin) is read, modified, and written back to the SFR.

Ports 0–3 have a corresponding PnSKIP register which allows its individual Port pins to be assigned to digital functions or skipped by the Crossbar. All Port pins used for analog functions, GPIO, or dedicated digital functions such as the EMIF should have their PnSKIP bit set to 1.

The Port input mode of the I/O pins is defined using the Port Input Mode registers (PnMDIN). Each Port cell can be configured for analog or digital I/O. This selection is required even for the digital resources selected in the XBRn registers, and is not automatic. The only exception to this is P4, which can only be used for digital I/O.

The output driver characteristics of the I/O pins are defined using the Port Output Mode registers (PnMDOUT). Each Port Output driver can be configured as either open drain or push-pull. This selection is required even for the digital resources selected in the XBRn registers, and is not automatic. The only exception to this is the SMBus (SDA, SCL) pins, which are configured as open-drain regardless of the PnMDOUT settings.

SFR Definition 19.12. P0: Port 0

Bit	7	6	5	4	3	2	1	0
Name	P0[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0x80; SFR Page = All Pages; Bit-Addressable

Bit	Name	Description	Write	Read
7:0	P0[7:0]	**Port 0 Data.** Sets the Port latch logic value or reads the Port pin logic state in Port cells configured for digital I/O.	0: Set output latch to logic LOW. 1: Set output latch to logic HIGH.	0: P0.n Port pin is logic LOW. 1: P0.n Port pin is logic HIGH.

SFR Definition 19.13. P0MDIN: Port 0 Input Mode

Bit	7	6	5	4	3	2	1	0
Name	P0MDIN[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xF1; SFR Page = 0x0F

Bit	Name	Function
7:0	P0MDIN[7:0]	**Analog Configuration Bits for P0.7–P0.0 (respectively).** Port pins configured for analog mode have their weak pull-up and digital receiver disabled. For analog mode, the pin also needs to be configured for open-drain mode in the P0MDOUT register. 0: Corresponding P0.n pin is configured for analog mode. 1: Corresponding P0.n pin is not configured for analog mode.

SFR Definition 19.14. P0MDOUT: Port 0 Output Mode

Bit	7	6	5	4	3	2	1	0
Name	P0MDOUT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA4; SFR Page = 0x0F

Bit	Name	Function
7:0	P0MDOUT[7:0]	**Output Configuration Bits for P0.7–P0.0 (respectively).** These bits are ignored if the corresponding bit in register P0MDIN is logic 0. 0: Corresponding P0.n Output is open-drain. 1: Corresponding P0.n Output is push-pull.

SFR Definition 19.15. P0SKIP: Port 0 Skip

Bit	7	6	5	4	3	2	1	0
Name	P0SKIP[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD4; SFR Page = 0x0F

Bit	Name	Function
7:0	P0SKIP[7:0]	**Port 0 Crossbar Skip Enable Bits.** These bits select Port 0 pins to be skipped by the Crossbar Decoder. Port pins used for analog, special functions or GPIO should be skipped by the Crossbar. 0: Corresponding P0.n pin is not skipped by the Crossbar. 1: Corresponding P0.n pin is skipped by the Crossbar.

SFR Definition 19.16. P1: Port 1

Bit	7	6	5	4	3	2	1	0
Name	P1[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0x90; SFR Page = All Pages; Bit-Addressable

Bit	Name	Description	Write	Read
7:0	P1[7:0]	**Port 1 Data.** Sets the Port latch logic value or reads the Port pin logic state in Port cells configured for digital I/O.	0: Set output latch to logic LOW. 1: Set output latch to logic HIGH.	0: P1.n Port pin is logic LOW. 1: P1.n Port pin is logic HIGH.

SFR Definition 19.17. P1MDIN: Port 1 Input Mode

Bit	7	6	5	4	3	2	1	0
Name	P1MDIN[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xF2; SFR Page = 0x0F

Bit	Name	Function
7:0	P1MDIN[7:0]	**Analog Configuration Bits for P1.7–P1.0 (respectively).** Port pins configured for analog mode have their weak pull-up and digital receiver disabled. For analog mode, the pin also needs to be configured for open-drain mode in the P1MDOUT register. 0: Corresponding P1.n pin is configured for analog mode. 1: Corresponding P1.n pin is not configured for analog mode.

SFR Definition 19.18. P1MDOUT: Port 1 Output Mode

Bit	7	6	5	4	3	2	1	0
Name	P1MDOUT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA5; SFR Page = 0x0F

Bit	Name	Function
7:0	P1MDOUT[7:0]	**Output Configuration Bits for P1.7–P1.0 (respectively).** These bits are ignored if the corresponding bit in register P1MDIN is logic 0. 0: Corresponding P1.n Output is open-drain. 1: Corresponding P1.n Output is push-pull.

SFR Definition 19.19. P1SKIP: Port 1 Skip

Bit	7	6	5	4	3	2	1	0
Name	P1SKIP[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD5; SFR Page = 0x0F

Bit	Name	Function
7:0	P1SKIP[7:0]	**Port 1 Crossbar Skip Enable Bits.** These bits select Port 1 pins to be skipped by the Crossbar Decoder. Port pins used for analog, special functions or GPIO should be skipped by the Crossbar. 0: Corresponding P1.n pin is not skipped by the Crossbar. 1: Corresponding P1.n pin is skipped by the Crossbar.

SFR Definition 19.20. P2: Port 2

Bit	7	6	5	4	3	2	1	0
Name	P2[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xA0; SFR Page = All Pages; Bit-Addressable

Bit	Name	Description	Write	Read
7:0	P2[7:0]	**Port 2Data.** Sets the Port latch logic value or reads the Port pin logic state in Port cells configured for digital I/O.	0: Set output latch to logic LOW. 1: Set output latch to logic HIGH.	0: P2.n Port pin is logic LOW. 1: P2.n Port pin is logic HIGH.
Note: P2.2-P2.7 are available on 40-pin and 32-pin packages.				

SFR Definition 19.21. P2MDIN: Port 2 Input Mode

Bit	7	6	5	4	3	2	1	0
Name	P2MDIN[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xF3; SFR Page = 0x0F

Bit	Name	Function
7:0	P2MDIN[7:0]	**Analog Configuration Bits for P2.7–P2.0 (respectively).** Port pins configured for analog mode have their weak pull-up and digital receiver disabled. For analog mode, the pin also needs to be configured for open-drain mode in the P2MDOUT register. 0: Corresponding P2.n pin is configured for analog mode. 1: Corresponding P2.n pin is not configured for analog mode.
Note: P2.2-P2.7 are available on 40-pin and 32-pin packages.		

SFR Definition 19.22. P2MDOUT: Port 2 Output Mode

Bit	7	6	5	4	3	2	1	0
Name	P2MDOUT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA6; SFR Page = 0x0F

Bit	Name	Function
7:0	P2MDOUT[7:0]	**Output Configuration Bits for P2.7–P2.0 (respectively).** These bits are ignored if the corresponding bit in register P2MDIN is logic 0. 0: Corresponding P2.n Output is open-drain. 1: Corresponding P2.n Output is push-pull.
Note: P2.2-P2.7 are available on 40-pin and 32-pin packages.		

SFR Definition 19.23. P2SKIP: Port 2 Skip

Bit	7	6	5	4	3	2	1	0
Name	P2SKIP[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD6; SFR Page = 0x0F

Bit	Name	Function
7:0	P2SKIP[7:0]	**Port 2 Crossbar Skip Enable Bits.** These bits select Port 2 pins to be skipped by the Crossbar Decoder. Port pins used for analog, special functions or GPIO should be skipped by the Crossbar. 0: Corresponding P2.n pin is not skipped by the Crossbar. 1: Corresponding P2.n pin is skipped by the Crossbar.
Note: P2.2-P2.7 are available on 40-pin and 32-pin packages.		

SFR Definition 19.24. P3: Port 3

Bit	7	6	5	4	3	2	1	0
Name	P3[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xB0; SFR Page = All Pages; Bit-Addressable

Bit	Name	Description	Write	Read
7:0	P3[7:0]	**Port 3 Data.** Sets the Port latch logic value or reads the Port pin logic state in Port cells configured for digital I/O.	0: Set output latch to logic LOW. 1: Set output latch to logic HIGH.	0: P3.n Port pin is logic LOW. 1: P3.n Port pin is logic HIGH.
Note: P3.0 is available on 40-pin and 32-pin packages. P3.1-P3.7 are available on 40-pin packages				

SFR Definition 19.25. P3MDIN: Port 3 Input Mode

Bit	7	6	5	4	3	2	1	0
Name	P3MDIN[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xF4; SFR Page = 0x0F

Bit	Name	Function
7:0	P3MDIN[7:0]	**Analog Configuration Bits for P3.7–P3.0 (respectively).** Port pins configured for analog mode have their weak pull-up and digital receiver disabled. For analog mode, the pin also needs to be configured for open-drain mode in the P3MDOUT register. 0: Corresponding P3.n pin is configured for analog mode. 1: Corresponding P3.n pin is not configured for analog mode.
Note: P3.0 is available on 40-pin and 32-pin packages. P3.1-P3.7 are available on 40-pin packages		

SFR Definition 19.26. P3MDOUT: Port 3 Output Mode

Bit	7	6	5	4	3	2	1	0
Name	P3MDOUT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xAE; SFR Page = 0x0F

Bit	Name	Function
7:0	P3MDOUT[7:0]	**Output Configuration Bits for P3.7–P3.0 (respectively).** These bits are ignored if the corresponding bit in register P3MDIN is logic 0. 0: Corresponding P3.n Output is open-drain. 1: Corresponding P3.n Output is push-pull.
Note: P3.0 is available on 40-pin and 32-pin packages. P3.1-P3.7 are available on 40-pin packages		

SFR Definition 19.27. P3SKIP: Port 3Skip

Bit	7	6	5	4	3	2	1	0
Name	P3SKIP[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD7; SFR Page = 0x0F

Bit	Name	Function
7:0	P3SKIP[7:0]	**Port 3 Crossbar Skip Enable Bits.** These bits select Port 3 pins to be skipped by the Crossbar Decoder. Port pins used for analog, special functions or GPIO should be skipped by the Crossbar. 0: Corresponding P3.n pin is not skipped by the Crossbar. 1: Corresponding P3.n pin is skipped by the Crossbar.
Note: P3.0 is available on 40-pin and 32-pin packages. P3.1-P3.7 are available on 40-pin packages		

SFR Definition 19.28. P4: Port 4

Bit	7	6	5	4	3	2	1	0
Name	P4[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xB5; SFR Page = All Pages

Bit	Name	Description	Write	Read
7:0	P4[7:0]	**Port 4 Data.** Sets the Port latch logic value or reads the Port pin logic state in Port cells configured for digital I/O.	0: Set output latch to logic LOW. 1: Set output latch to logic HIGH.	0: P4.n Port pin is logic LOW. 1: P4.n Port pin is logic HIGH.
Note: Port 4.0 is available on 40-pin packages.				

SFR Definition 19.29. P4MDOUT: Port 4 Output Mode

Bit	7	6	5	4	3	2	1	0
Name	P4MDOUT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xAF; SFR Page = 0x0F

Bit	Name	Function
7:0	P4MDOUT[7:0]	**Output Configuration Bits for P4.7–P4.0 (respectively).** 0: Corresponding P4.n Output is open-drain. 1: Corresponding P4.n Output is push-pull.
Note: Port 4.0 is available on 40-pin packages.		

20. Local Interconnect Network (LIN0)

Important Note: This chapter assumes an understanding of the Local Interconnect Network (LIN) protocol. For more information about the LIN protocol, including specifications, please refer to the LIN consortium (http://www.lin-subbus.org).

LIN is an asynchronous, serial communications interface used primarily in automotive networks. The Silicon Laboratories LIN controller is compliant to the 2.1 Specification, implements a complete hardware LIN interface and includes the following features:

- Selectable Master and Slave modes.
- Automatic baud rate option in slave mode.
- The internal oscillator is accurate to within 0.5% of 24 MHz across the entire temperature range and for VDD voltages greater than or equal to the minimum output of the on-chip voltage regulator, so an external oscillator is not necessary for master mode operation for most systems.

Note: The minimum system clock (SYSCLK) required when using the LIN controller is 8 MHz.

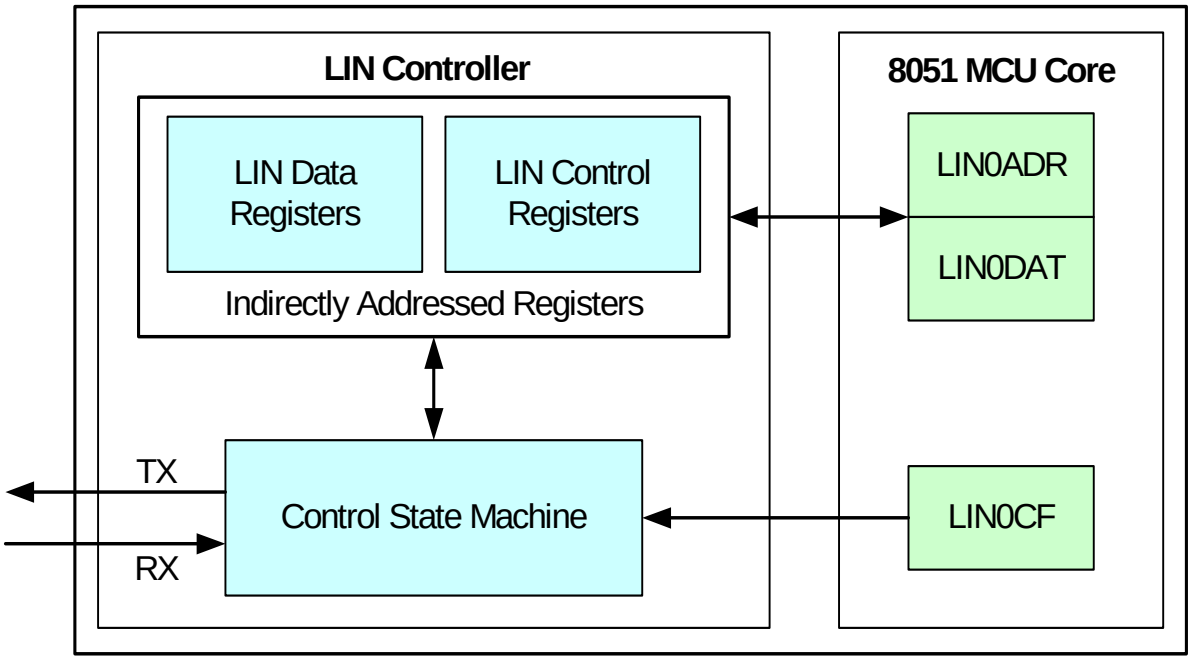


Figure 20.1. LIN Block Diagram

The LIN controller has four main components:

- LIN Access Registers—Provide the interface between the MCU core and the LIN controller.
- LIN Data Registers—Where transmitted and received message data bytes are stored.
- LIN Control Registers—Control the functionality of the LIN interface.
- Control State Machine and Bit Streaming Logic—Contains the hardware that serializes messages and controls the bus timing of the controller.

20.1. Software Interface with the LIN Controller

The selection of the mode (Master or Slave) and the automatic baud rate feature are done though the LIN0 Control Mode (LIN0CF) register. The other LIN registers are accessed indirectly through the two SFRs LIN0 Address (LIN0ADR) and LIN0 Data (LIN0DAT). The LIN0ADR register selects which LIN register is targeted by reads/writes of the LIN0DAT register. The full list of indirectly-accessible LIN registers is given in Table 20.4 on page 202.

20.2. LIN Interface Setup and Operation

The hardware based LIN controller allows for the implementation of both Master and Slave nodes with minimal firmware overhead and complete control of the interface status while allowing for interrupt and polled mode operation.

The first step to use the controller is to define the basic characteristics of the node:

Mode—Master or Slave

Baud Rate—Either defined manually or using the autobaud feature (slave mode only)

Checksum Type—Select between classic or enhanced checksum, both of which are implemented in hardware.

20.2.1. Mode Definition

Following the LIN specification, the controller implements in hardware both the Slave and Master operating modes. The mode is configured using the MODE bit (LIN0CF.6).

20.2.2. Baud Rate Options: Manual or Autobaud

The LIN controller can be selected to have its baud rate calculated manually or automatically. A master node must always have its baud rate set manually, but slave nodes can choose between a manual or automatic setup. The configuration is selected using the ABAUD bit (LIN0CF.5).

Both the manual and automatic baud rate configurations require additional setup. The following sections explain the different options available and their relation with the baud rate, along with the steps necessary to achieve the required baud rate.

20.2.3. Baud Rate Calculations: Manual Mode

The baud rate used by the LIN controller is a function of the System Clock (SYSCLK) and the LIN timing registers according to the following equation:

$$baud_rate = \frac{SYSCLK}{2^{(prescaler+1)} \times divider \times (multiplier+1)}$$

The prescaler, divider and multiplier factors are part of the LIN0DIV and LIN0MUL registers and can assume values in the following range:

Table 20.1. Baud Rate Calculation Variable Ranges

Factor	Range
prescaler	0…3
multiplier	0…31
divider	200…511

Important Note: The minimum system clock (SYSCLK) to operate the LIN controller is 8 MHz.

Use the following equations to calculate the values for the variables for the baud-rate equation:

$$multiplier = \frac{20000}{baud_rate} - 1$$

$$prescaler = \ln\left[\frac{SYSCLK}{(multiplier + 1) \times baud_rate \times 200}\right] \times \frac{1}{\ln 2} - 1$$

$$divider = \frac{SYSCLK}{(2^{(prescaler + 1)} \times (multiplier + 1) \times baud_rate)}$$

In all of these equations, the results must be rounded down to the nearest integer.

The following example shows the steps for calculating the baud rate values for a Master node running at 24 MHz and communicating at 19200 bits/sec. First, calculate the multiplier:

$$multiplier = \frac{20000}{19200} - 1 = 0.0417 \cong 0$$

Next, calculate the prescaler:

$$prescaler = \ln\frac{24000000}{(0 + 1) \times 19200 \times 200} \times \frac{1}{\ln 2} - 1 = 1.644 \cong 1$$

Finally, calculate the divider:

$$divider = \frac{24000000}{2^{(1 + 1)} \times (0 + 1) \times 19200} = 312.5 \cong 312$$

These values lead to the following baud rate:

$$baud_rate = \frac{24000000}{2^{(1 + 1)} \times (0 + 1) \times 312} \cong 19230.77$$

The following code programs the interface in Master mode, using the Enhanced Checksum and enables the interface to operate at 19230 bits/sec using a 24 MHz system clock.

```
LIN0CF   = 0x80;                        // Activate the interface
LIN0CF  |= 0x40;                        // Set the node as a Master

LIN0ADR  = 0x0D;                        // Point to the LIN0MUL register
// Initialize the register (prescaler, multiplier and bit 8 of divider)
LIN0DAT  = ( 0x01 << 6 ) + ( 0x00 << 1 ) + ( ( 0x138 & 0x0100 ) >> 8 );
LIN0ADR   = 0x0C;                       // Point to the LIN0DIV register
LIN0DAT   = (unsigned char)_0x138;      // Initialize LIN0DIV

LIN0ADR   = 0x0B;                       // Point to the LIN0SIZE register
LIN0DAT  |= 0x80;                       // Initialize the checksum as Enhanced

LIN0ADR   = 0x08;                       // Point to LIN0CTRL register
LIN0DAT   = 0x0C;                       // Reset any error and the interrupt
```

Table 20.2 includes the configuration values required for the typical system clocks and baud rates:

Table 20.2. Manual Baud Rate Parameters Examples

	Baud (bits/sec)														
	20 K			19.2 K			9.6 K			4.8 K			1 K		
SYSCLK (MHz)	Mult.	Pres.	Div.	Mult.	Pres.	Div.	Mult.	Pres.	Div.	Mult.	Pres.	Div.	Mult.	Pres.	Div.
25	0	1	312	0	1	325	1	1	325	3	1	325	19	1	312
24.5	0	1	306	0	1	319	1	1	319	3	1	319	19	1	306
24	0	1	300	0	1	312	1	1	312	3	1	312	19	1	300
22.1184	0	1	276	0	1	288	1	1	288	3	1	288	19	1	276
16	0	1	200	0	1	208	1	1	208	3	1	208	19	1	200
12.25	0	0	306	0	0	319	1	0	319	3	0	319	19	0	306
12	0	0	300	0	0	312	1	0	312	3	0	312	19	0	300
11.0592	0	0	276	0	0	288	1	0	288	3	0	288	19	0	276
8	0	0	200	0	0	208	1	0	208	3	0	208	19	0	200

20.2.4. Baud Rate Calculations—Automatic Mode

If the LIN controller is configured for slave mode, only the prescaler and divider need to be calculated:

$$\text{prescaler} = \ln\left[\frac{\text{SYSCLK}}{4000000}\right] \times \frac{1}{\ln 2} - 1$$

$$\text{divider} = \frac{\text{SYSCLK}}{2^{(\text{prescaler}+1)} \times 20000}$$

The following example calculates the values of these variables for a 24 MHz system clock:

$$\text{prescaler} = \ln\left[\frac{24000000}{4000000}\right] \times \frac{1}{\ln 2} - 1 = 1.585 \cong 1$$

$$\text{divider} = \frac{24000000}{2^{(1+1)} \times 20000} = 300$$

Table 20.3 presents some typical values of system clock and baud rate along with their factors.

Table 20.3. Autobaud Parameters Examples

System Clock (MHz)	Prescaler	Divider
25	1	312
24.5	1	306
24	1	300
22.1184	1	276
16	1	200
12.25	0	306
12	0	300
11.0592	0	276
8	0	200

20.3. LIN Master Mode Operation

The master node is responsible for the scheduling of messages and sends the header of each frame containing the SYNCH BREAK FIELD, SYNCH FIELD, and IDENTIFIER FIELD. The steps to schedule a message transmission or reception are listed below.

1. Load the 6-bit Identifier into the LIN0ID register.
2. Load the data length into the LIN0SIZE register. Set the value to the number of data bytes or "1111b" if the data length should be decoded from the identifier. Also, set the checksum type, classic or enhanced, in the same LIN0SIZE register.
3. Set the data direction by setting the TXRX bit (LIN0CTRL.5). Set the bit to 1 to perform a master transmit operation, or set the bit to 0 to perform a master receive operation.
4. If performing a master transmit operation, load the data bytes to transmit into the data buffer (LIN0DT1 to LIN0DT8).
5. Set the STREQ bit (LIN0CTRL.0) to start the message transfer. The LIN controller will schedule the message frame and request an interrupt if the message transfer is successfully completed or if an error has occurred.

This code segment shows the procedure to schedule a message in a transmission operation:

```
LIN0ADR   = 0x08;               // Point to LIN0CTRL
LIN0DAT  |= 0x20;               // Select to transmit data
LIN0ADR   = 0x0E;               // Point to LIN0ID
LIN0DAT   = 0x11;               // Load the ID, in this example 0x11
LIN0ADR   = 0x0B;               // Point to LIN0SIZE
LIN0DAT  = ( LIN0DAT & 0xF0 ) | 0x08;      // Load the size with 8

LIN0ADR  = 0x00;               // Point to Data buffer first byte
for (i=0; i<8; i++)
{
   LIN0DAT = i + 0x41;         // Load the buffer with ‘A’, ‘B’, ...
   LIN0ADR++;                  // Increment the address to the next buffer
}
LIN0ADR  = 0x08;               // Point to LIN0CTRL
LIN0DAT  = 0x01;               // Start Request
```

The application should perform the following steps when an interrupt is requested.

1. Check the DONE bit (LIN0ST.0) and the ERROR bit (LIN0ST.2).
2. If performing a master receive operation and the transfer was successful, read the received data from the data buffer.
3. If the transfer was not successful, check the error register to determine the kind of error. Further error handling has to be done by the application.
4. Set the RSTINT (LIN0CTRL.3) and RSTERR bits (LIN0CTRL.2) to reset the interrupt request and the error flags.

20.4. LIN Slave Mode Operation

When the device is configured for slave mode operation, it must wait for a command from a master node. Access from the firmware to the data buffer and ID registers of the LIN controller is only possible when a data request is pending (DTREQ bit (LIN0ST.4) is 1) and also when the LIN bus is not active (ACTIVE bit (LIN0ST.7) is set to 0).

The LIN controller in slave mode detects the header of the message frame sent by the LIN master. If slave synchronization is enabled (autobaud), the slave synchronizes its internal bit time to the master bit time.

The LIN controller configured for slave mode will generated an interrupt in one of three situations:

1. After the reception of the IDENTIFIER FIELD
2. When an error is detected
3. When the message transfer is completed.

The application should perform the following steps when an interrupt is detected:

1. Check the status of the DTREQ bit (LIN0ST.4). This bit is set when the IDENTIFIER FIELD has been received.
2. If DTREQ (LIN0ST.4) is set, read the identifier from LIN0ID and process it. If DTREQ (LIN0ST.4) is not set, continue to step 7.
3. Set the TXRX bit (LIN0CTRL.5) to 1 if the current frame is a transmit operation for the slave and set to 0 if the current frame is a receive operation for the slave.
4. Load the data length into LIN0SIZE.
5. For a slave transmit operation, load the data to transmit into the data buffer.
6. Set the DTACK bit (LIN0CTRL.4). Continue to step 10.
7. If DTREQ (LIN0ST.4) is not set, check the DONE bit (LIN0ST.0). The transmission was successful if the DONE bit is set.
8. If the transmission was successful and the current frame was a receive operation for the slave, load the received data bytes from the data buffer.
9. If the transmission was not successful, check LIN0ERR to determine the nature of the error. Further error handling has to be done by the application.
10. Set the RSTINT (LIN0CTRL.3) and RSTERR bits (LIN0CTRL.2) to reset the interrupt request and the error flags.

In addition to these steps, the application should be aware of the following:

1. If the current frame is a transmit operation for the slave, steps 1 through 5 must be completed during the IN-FRAME RESPONSE SPACE. If it is not completed in time, a timeout will be detected by the master.
2. If the current frame is a receive operation for the slave, steps 1 through 5 have to be finished until the reception of the first byte after the IDENTIFIER FIELD. Otherwise, the internal receive buffer of the LIN controller will be overwritten and a timeout error will be detected in the LIN controller.

3. The LIN controller does not directly support LIN Version 1.3 Extended Frames. If the application detects an unknown identifier (e.g. extended identifier), it has to write a 1 to the STOP bit (LIN0CTRL.7) instead of setting the DTACK (LIN0CTRL.4) bit. At that time, steps 2 through 5 can then be skipped. In this situation, the LIN controller stops the processing of LIN communication until the next SYNC BREAK is received.
4. Changing the configuration of the checksum during a transaction will cause the interface to reset and the transaction to be lost. To prevent this, the checksum should not be configured while a transaction is in progress. The same applies to changes in the LIN interface mode from slave mode to master mode and from master mode to slave mode.

20.5. Sleep Mode and Wake-Up

To reduce the system's power consumption, the LIN Protocol Specification defines a Sleep Mode. The message used to broadcast a Sleep Mode request must be transmitted by the LIN master application in the same way as a normal transmit message. The LIN slave application must decode the Sleep Mode Frame from the Identifier and data bytes. After that, it has to put the LIN slave node into the Sleep Mode by setting the SLEEP bit (LIN0CTRL.6).

If the SLEEP bit (LIN0CTRL.6) of the LIN slave application is not set and there is no bus activity for four seconds (specified bus idle timeout), the IDLTOUT bit (LIN0ST.6) is set and an interrupt request is generated. After that the application may assume that the LIN bus is in Sleep Mode and set the SLEEP bit (LIN0CTRL.6).

Sending a wake-up signal from the master or any slave node terminates the Sleep Mode of the LIN bus. To send a wake-up signal, the application has to set the WUPREQ bit (LIN0CTRL.1). After successful transmission of the wake-up signal, the DONE bit (LIN0ST.0) of the master node is set and an interrupt request is generated. The LIN slave does not generate an interrupt request after successful transmission of the wake-up signal but it generates an interrupt request if the master does not respond to the wake-up signal within 150 milliseconds. In that case, the ERROR bit (LIN0ST.2) and TOUT bit (LIN0ERR.2) are set. The application then has to decide whether or not to transmit another wake-up signal.

All LIN nodes that detect a wake-up signal will set the WAKEUP (LIN0ST.1) and DONE bits (LIN0ST.0) and generate an interrupt request. After that, the application has to clear the SLEEP bit (LIN0CTRL.6) in the LIN slave.

20.6. Error Detection and Handling

The LIN controller generates an interrupt request and stops the processing of the current frame if it detects an error. The application has to check the type of error by processing LIN0ERR. After that, it has to reset the error register and the ERROR bit (LIN0ST.2) by writing a 1 to the RSTERR bit (LIN0CTRL.2). Starting a new message with the LIN controller selected as master or sending a Wakeup signal with the LIN controller selected as a master or slave is possible only if the ERROR bit (LIN0ST.2) is set to 0.

20.7. LIN Registers

The following Special Function Registers (SFRs) and indirect registers are available for the LIN controller.

20.7.1. LIN Direct Access SFR Registers Definitions

SFR Definition 20.1. LIN0ADR: LIN0 Indirect Address Register

Bit	7	6	5	4	3	2	1	0
Name	LIN0ADR[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD3; SFR Page = 0x00

Bit	Name	Function
7:0	LIN0ADR[7:0]	**LIN Indirect Address Register Bits.** This register hold an 8-bit address used to indirectly access the LIN0 core registers. Table 20.4 lists the LIN0 core registers and their indirect addresses. Reads and writes to LIN0DAT will target the register indicated by the LIN0ADR bits.

SFR Definition 20.2. LIN0DAT: LIN0 Indirect Data Register

Bit	7	6	5	4	3	2	1	0
Name	LIN0DAT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD2; SFR Page = 0x00

Bit	Name	Function
7:0	LIN0DAT[7:0]	**LIN Indirect Data Register Bits.** When this register is read, it will read the contents of the LIN0 core register pointed to by LIN0ADR. When this register is written, it will write the value to the LIN0 core register pointed to by LIN0ADR.

SFR Definition 20.3. LIN0CF: LIN0 Control Mode Register

Bit	7	6	5	4	3	2	1	0
Name	LINEN	MODE	ABAUD					
Type	R/W	R/W	R/W	R	R	R	R	R
Reset	0	1	1	0	0	0	0	0

SFR Address = 0xC9; SFR Page = 0x0F

Bit	Name	Function
7	LINEN	**LIN Interface Enable Bit.** 0: LIN0 is disabled. 1: LIN0 is enabled.
6	MODE	**LIN Mode Selection Bit.** 0: LIN0 operates in slave mode. 1: LIN0 operates in master mode.
5	ABAUD	**LIN Mode Automatic Baud Rate Selection.** This bit only has an effect when the MODE bit is configured for slave mode. 0: Manual baud rate selection is enabled. 1: Automatic baud rate selection is enabled.
4:0	Unused	Read = 00000b; Write = Don't Care

20.7.2. LIN Indirect Access SFR Registers Definitions

Table 20.4 lists the 15 indirect registers used to configured and communicate with the LIN controller.

Table 20.4. LIN Registers* (Indirectly Addressable)

Name	Address	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
LIN0DT1	0x00	DATA1[7:0]							
LIN0DT2	0x01	DATA2[7:0]							
LIN0DT3	0x02	DATA3[7:0]							
LIN0DT4	0x03	DATA4[7:0]							
LIN0DT5	0x04	DATA5[7:0]							
LIN0DT6	0x05	DATA67:0]							
LIN0DT7	0x06	DATA7[7:0]							
LIN0DT8	0x07	DATA8[7:0]							
LIN0CTRL	0x08	STOP(s)	SLEEP(s)	TXRX	DTACK(s)	RSTINT	RSTERR	WUPREQ	STREQ(m)
LIN0ST	0x09	ACTIVE	IDLTOUT	ABORT(s)	DTREQ(s)	LININT	ERROR	WAKEUP	DONE
LIN0ERR	0x0A				SYNCH(s)	PRTY(s)	TOUT	CHK	BITERR
LIN0SIZE	0x0B	ENHCHK				LINSIZE[3:0]			
LIN0DIV	0x0C	DIVLSB[7:0]							
LIN0MUL	0x0D	PRESCL[1:0]		LINMUL[4:0]					DIV9
LIN0ID	0x0E			ID5	ID4	ID3	ID2	ID1	ID0

***Note:** These registers are used in both master and slave mode. The register bits marked with (m) are accessible only in Master mode while the register bits marked with (s) are accessible only in slave mode. All other registers are accessible in both modes.

LIN Register Definition 20.4. LIN0DTn: LIN0 Data Byte n

Bit	7	6	5	4	3	2	1	0
Name	DATAn[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

Indirect Address: LIN0DT1 = 0x00, LIN0DT2 = 0x01, LIN0DT3 = 0x02, LIN0DT4 = 0x03, LIN0DT5 = 0x04, LIN0DT6 = 0x05, LIN0DT7 = 0x06, LIN0DT8 = 0x07

Bit	Name	Function
7:0	DATAn[7:0]	**LIN Data Byte n.** Serial Data Byte that is received or transmitted across the LIN interface.

LIN Register Definition 20.5. LIN0CTRL: LIN0 Control Register

Bit	7	6	5	4	3	2	1	0
Name	STOP	SLEEP	TXRX	DTACK	RSTINT	RSTERR	WUPREQ	STREQ
Type	W	R/W	R/W	R/W	W	W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Indirect Address = 0x08

Bit	Name	Function
7	STOP	**Stop Communication Processing Bit. (slave mode only)** This bit always reads as 0. 0: No effect. 1: Block the processing of LIN communications until the next SYNC BREAK signal.
6	SLEEP	**Sleep Mode Bit. (slave mode only)** 0: Wake the device after receiving a Wakeup interrupt. 1: Put the device into sleep mode after receiving a Sleep Mode frame or a bus idle timeout.
5	TXRX	**Transmit / Receive Selection Bit.** 0: Current frame is a receive operation. 1: Current frame is a transmit operation.
4	DTACK	**Data Acknowledge Bit. (slave mode only)** Set to 1 after handling a data request interrupt to acknowledge the transfer. The bit will automatically be cleared to 0 by the LIN controller.
3	RSTINT	**Reset Interrupt Bit.** This bit always reads as 0. 0: No effect. 1: Reset the LININT bit (LIN0ST.3).
2	RSTERR	**Reset Error Bit.** This bit always reads as 0. 0: No effect. 1: Reset the error bits in LIN0ST and LIN0ERR.
1	WUPREQ	**Wakeup Request Bit.** Set to 1 to terminate sleep mode by sending a wakeup signal. The bit will automatically be cleared to 0 by the LIN controller.
0	STREQ	**Start Request Bit. (master mode only)** 1: Start a LIN transmission. This should be set only after loading the identifier, data length and data buffer if necessary. The bit is reset to 0 upon transmission completion or error detection.

LIN Register Definition 20.6. LIN0ST: LIN0 Status Register

Bit	7	6	5	4	3	2	1	0
Name	ACTIVE	IDLTOUT	ABORT	DTREQ	LININT	ERROR	WAKEUP	DONE
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Indirect Address = 0x09

Bit	Name	Function
7	ACTIVE	**LIN Active Indicator Bit.** 0: No transmission activity detected on the LIN bus. 1: Transmission activity detected on the LIN bus.
6	IDLT	**Bus Idle Timeout Bit. (slave mode only)** 0: The bus has not been idle for four seconds. 1: No bus activity has been detected for four seconds, but the bus is not yet in Sleep mode.
5	ABORT	**Aborted Transmission Bit. (slave mode only)** 0: The current transmission has not been interrupted or stopped. This bit is reset to 0 after receiving a SYNCH BREAK that does not interrupt a pending transmission. 1: New SYNCH BREAK detected before the end of the last transmission or the STOP bit (LIN0CTRL.7) has been set.
4	DTREQ	**Data Request Bit. (slave mode only)** 0: Data identifier has not been received. 1: Data identifier has been received.
3	LININT	**Interrupt Request Bit.** 0: An interrupt is not pending. This bit is cleared by setting RSTINT (LIN0CTRL.3) 1: There is a pending LIN0 interrupt.
2	ERROR	**Communication Error Bit.** 0: No error has been detected. This bit is cleared by setting RSTERR (LIN0CTRL.2) 1: An error has been detected.
1	WAKEUP	**Wakeup Bit.** 0: A wakeup signal is not being transmitted and has not been received. 1: A wakeup signal is being transmitted or has been received
0	DONE	**Transmission Complete Bit.** 0: A transmission is not in progress or has not been started. This bit is cleared at the start of a transmission. 1: The current transmission is complete.

LIN Register Definition 20.7. LIN0ERR: LIN0 Error Register

Bit	7	6	5	4	3	2	1	0
Name				SYNCH	PRTY	TOUT	CHK	BITERR
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Indirect Address = 0x0A

Bit	Name	Function
7:5	Unused	Read = 000b; Write = Don't Care
4	SYNCH	**Synchronization Error Bit (slave mode only).** 0: No error with the SYNCH FIELD has been detected. 1: Edges of the SYNCH FIELD are outside of the maximum tolerance.
3	PRTY	**Parity Error Bit (slave mode only).** 0: No parity error has been detected. 1: A parity error has been detected.
2	TOUT	**Timeout Error Bit.** 0: A timeout error has not been detected. 1: A timeout error has been detected. This error is detected whenever one of the following conditions is met: • The master is expecting data from a slave and the slave does not respond. • The slave is expecting data but no data is transmitted on the bus. • A frame is not finished within the maximum frame length. • The application does not set the DTACK bit (LIN0CTRL.4) or STOP bit (LIN0CTRL.7) until the end of the reception of the first byte after the identifier.
1	CHK	**Checksum Error Bit.** 0: Checksum error has not been detected. 1: Checksum error has been detected.
0	BITERR	**Bit Transmission Error Bit.** 0: No error in transmission has been detected. 1: The bit value monitored during transmission is different than the bit value sent.

LIN Register Definition 20.8. LIN0SIZE: LIN0 Message Size Register

Bit	7	6	5	4	3	2	1	0
Name	ENHCHK				LINSIZE[3:0]			
Type	R/W	R	R	R	R/W			
Reset	0	0	0	0	0	0	0	0

Indirect Address = 0x0B

Bit	Name	Function
7	ENHCHK	**Checksum Selection Bit.** 0: Use the classic, specification 1.3 compliant checksum. Checksum covers the data bytes. 1: Use the enhanced, specification 2.0 compliant checksum. Checksum covers data bytes and protected identifier.
6:4	Unused	Read = 000b; Write = Don't Care
3:0	LINSIZE[3:0]	**Data Field Size.** 0000: 0 data bytes 0001: 1 data byte 0010: 2 data bytes 0011: 3 data bytes 0100: 4 data bytes 0101: 5 data bytes 0110: 6 data bytes 0111: 7 data bytes 1000: 8 data bytes 1001-1110: RESERVED 1111: Use the ID[1:0] bits (LIN0ID[5:4]) to determine the data length.

LIN Register Definition 20.9. LIN0DIV: LIN0 Divider Register

Bit	7	6	5	4	3	2	1	0
Name	DIVLSB[3:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

Indirect Address = 0x0C

Bit	Name	Function
7:0	DIVLSB	**LIN Baud Rate Divider Least Significant Bits.** The 8 least significant bits for the baud rate divider. The 9th and most significant bit is the DIV9 bit (LIN0MUL.0). The valid range for the divider is 200 to 511.

LIN Register Definition 20.10. LIN0MUL: LIN0 Multiplier Register

Bit	7	6	5	4	3	2	1	0
Name	PRESCL[1:0]		LINMUL[4:0]					DIV9
Type	R/W		R/W					R/W
Reset	1	1	1	1	1	1	1	1

Indirect Address = 0x0D

Bit	Name	Function
7:6	PRESCL[1:0]	**LIN Baud Rate Prescaler Bits.** These bits are the baud rate prescaler bits.
5:1	LINMUL[4:0]	**LIN Baud Rate Multiplier Bits.** These bits are the baud rate multiplier bits. These bits are not used in slave mode.
0	DIV9	**LIN Baud Rate Divider Most Significant Bit.** The most significant bit of the baud rate divider. The 8 least significant bits are in LIN0DIV. The valid range for the divider is 200 to 511.

LIN Register Definition 20.11. LIN0ID: LIN0 Identifier Register

Bit	7	6	5	4	3	2	1	0
Name			ID[5:0]					
Type	R	R	R/W					
Reset	0	0	0	0	0	0	0	0

Indirect Address = 0x0E

Bit	Name	Function
7:6	Unused	Read = 00b; Write = Don't Care.
5:0	ID[5:0]	**LIN Identifier Bits.** These bits form the data identifier. If the LINSIZE bits (LIN0SIZE[3:0]) are 1111b, bits ID[5:4] are used to determine the data size and are interpreted as follows: 00: 2 bytes 01: 2 bytes 10: 4 bytes 11: 8 bytes

21. Controller Area Network (CAN0)

Important Documentation Note: The Bosch CAN Controller is integrated in the C8051F550/1/4/5, ‘F560/1/4/5/8/9, and ‘F572/3 devices. This section of the data sheet gives a description of the CAN controller as an overview and offers a description of how the Silicon Labs CIP-51 MCU interfaces with the on-chip Bosch CAN controller. In order to use the CAN controller, refer to Bosch’s C_CAN User’s Manual as an accompanying manual to the Silicon Labs’ data sheet.

The C8051F550/1/4/5, ‘F560/1/4/5/8/9, and ‘F572/3 devices feature a Control Area Network (CAN) controller that enables serial communication using the CAN protocol. Silicon Labs CAN facilitates communication on a CAN network in accordance with the Bosch specification 2.0A (basic CAN) and 2.0B (full CAN). The CAN controller consists of a CAN Core, Message RAM (separate from the CIP-51 RAM), a message handler state machine, and control registers. Silicon Labs CAN is a protocol controller and does not provide physical layer drivers (i.e., transceivers). Figure 21.1 shows an example typical configuration on a CAN bus.

Silicon Labs’ CAN operates at bit rates of up to 1 Mbit/second, though this can be limited by the physical layer chosen to transmit data on the CAN bus. The CAN processor has 32 Message Objects that can be configured to transmit or receive data. Incoming data, message objects and their identifier masks are stored in the CAN message RAM. All protocol functions for transmission of data and acceptance filtering is performed by the CAN controller and not by the CIP-51 MCU. In this way, minimal CPU bandwidth is needed to use CAN communication. The CIP-51 configures the CAN controller, accesses received data, and passes data for transmission via Special Function Registers (SFRs) in the CIP-51.

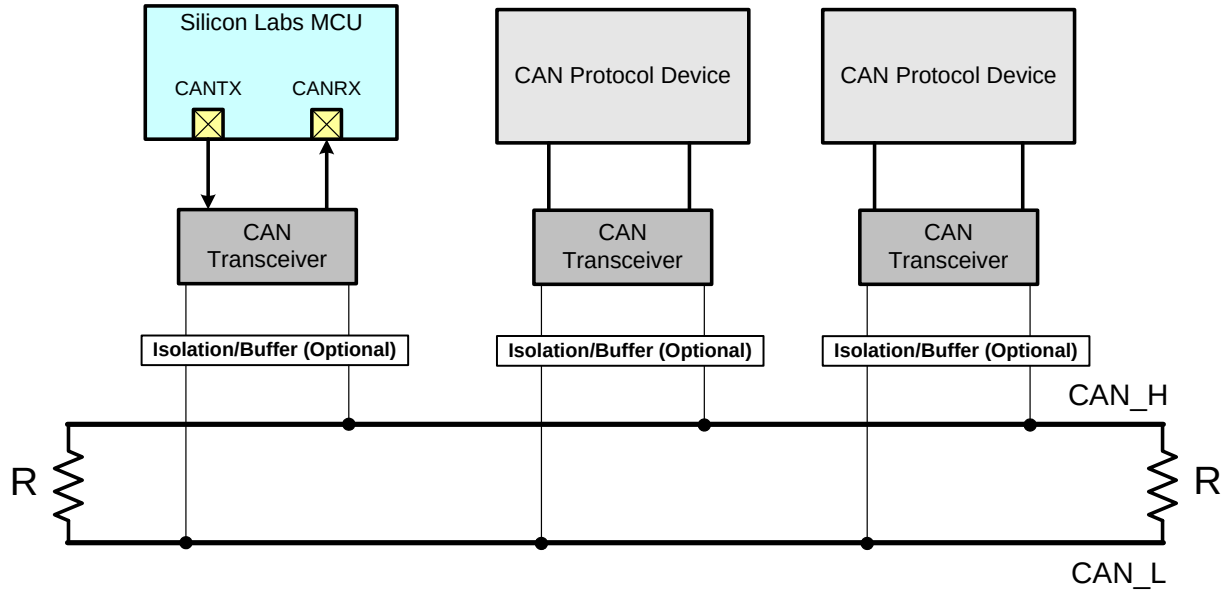


Figure 21.1. Typical CAN Bus Configuration

21.1. Bosch CAN Controller Operation

The CAN Controller featured in the C8051F550/1/4/5, ‘F560/1/4/5/8/9, and ‘F572/3 devices is a full implementation of Bosch’s full CAN module and fully complies with CAN specification 2.0B. A block diagram of the CAN controller is shown in Figure 21.2. The CAN Core provides shifting (CANTX and CANRX), serial/parallel conversion of messages, and other protocol related tasks such as transmission of data and acceptance filtering. The message RAM stores 32 message objects which can be received or transmitted on a CAN network. The CAN registers and message handler provide an interface for data transfer and notification between the CAN controller and the CIP-51.

The function and use of the CAN Controller is detailed in the Bosch CAN User’s Guide. The User’s Guide should be used as a reference to configure and use the CAN controller. This data sheet describes how to access the CAN controller.

All of the CAN controller registers are located on SFR Page 0x0C. Before accessing any of the CAN registers, the SFRPAGE register must be set to 0x0C.

The CAN Controller is typically initialized using the following steps:

1. Set the SFRPAGE register to the CAN registers page (page 0x0C).
2. Set the INIT and the CCE bits to 1 in CAN0CN. See the CAN User’s Guide for bit definitions.
3. Set timing parameters in the Bit Timing Register and the BRP Extension Register.
4. Initialize each message object or set its MsgVal bit to NOT VALID.
5. Reset the INIT bit to 0.

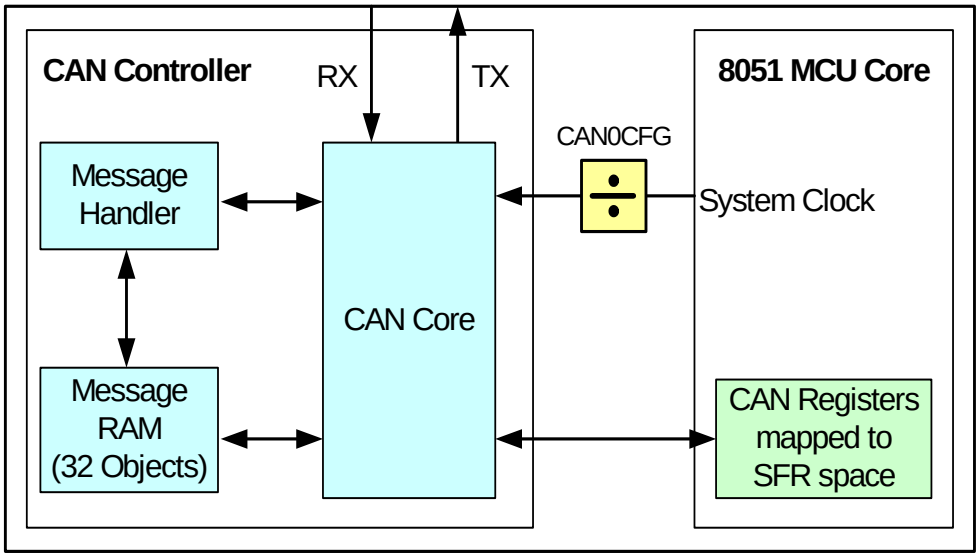


Figure 21.2. CAN Controller Diagram

21.1.1. CAN Controller Timing

The CAN controller’s clock (f_{sys}) is derived from the CIP-51 system clock (SYSCLK). The internal oscillator is accurate to within 0.5% of 24 MHz across the entire temperature range and for VDD voltages greater than or equal to the minimum output of the on-chip voltage regulator, so an external oscillator is not required for CAN communication for most systems.

Refer to Section “4.10.4 Oscillator Tolerance Range” in the Bosch CAN User’s Guide for further information regarding this topic.

The CAN controller clock must be less than or equal to 25 MHz. If the CIP-51 system clock is above 25 MHz, the divider in the CAN0CFG register must be set to divide the CAN controller clock down to an appropriate speed.

21.1.2. CAN Register Access

The CAN controller clock divider selected in the CAN0CFG SFR affects how the CAN registers can be accessed. If the divider is set to 1, then a CAN SFR can immediately be read after it is written. If the divider is set to a value other than 1, then a read of a CAN SFR that has just been written must be delayed by a certain number of cycles. This delay can be performed using a NOP or some other instruction that does not attempt to read the register. This access limitation applies to read and read-modify-write instructions that occur immediately after a write. The full list of affected instructions is ANL, ORL, MOV, XCH, and XRL.

For example, with the CAN0CFG divider set to 1, the CAN0CN SFR can be accessed as follows:

```
MOV CAN0CN, #041          ; Enable access to Bit Timing Register
MOV R7, CAN0CN            ; Copy CAN0CN to R7
```

With the CAN0CFG divider set to /2, the same example code requires an additional NOP:

```
MOV CAN0CN, #041          ; Enable access to Bit Timing Register
NOP                       ; Wait for write to complete
MOV R7, CAN0CN            ; Copy CAN0CN to R7
```

The number of delay cycles required is dependent on the divider setting. With a divider of 2, the read must wait for 1 system clock cycle. With a divider of 4, the read must wait 3 system clock cycles, and with the divider set to 8, the read must wait 7 system clock cycles. The delay only needs to be applied when reading the same register that was written. The application can write and read other CAN SFRs without any delay.

21.1.3. Example Timing Calculation for 1 Mbit/Sec Communication

This example shows how to configure the CAN controller timing parameters for a 1 Mbit/Sec bit rate. Table 21.1 shows timing-related system parameters needed for the calculation.

Table 21.1. Background System Information

Parameter	Value	Description
CIP-51 system clock (SYSCLK)	24 MHz	Internal Oscillator Max
CAN controller clock (f_{sys})	24 MHz	CAN0CFG divider set to 1
CAN clock period (t_{sys})	41.667 ns	Derived from $1/f_{sys}$
CAN time quantum (t_q)	41.667 ns	Derived from t_{sys} x BRP[1,2]
CAN bus length	10 m	5 ns/m signal delay between CAN nodes
Propogation delay time[3]	400 ns	2 x (transceiver loop delay + bus line delay)

Notes:

1. The CAN time quantum is the smallest unit of time recognized by the CAN controller. Bit timing parameters are specified in integer multiples of the time quantum.
2. The Baud Rate Prescaler (BRP) is defined as the value of the BRP Extension Register plus 1. The BRP extension register has a reset value of 0x0000. The BRP has a reset value of 1.
3. Based on an ISO-11898 compliant transceiver. CAN does not specify a physical layer.

Each bit transmitted on a CAN network has 4 segments (Sync_Seg, Prop_Seg, Phase_Seg1, and Phase_Seg2), as shown in Figure 18.3. The sum of these segments determines the CAN bit time (1/bit rate). In this example, the desired bit rate is 1 Mbit/sec; therefore, the desired bit time is 1000 ns.

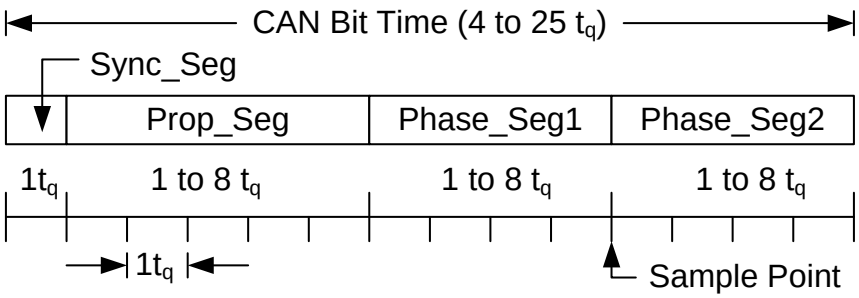


Figure 21.3. Four segments of a CAN Bit

The length of the 4 bit segments must be adjusted so that their sum is as close as possible to the desired bit time. Since each segment must be an integer multiple of the time quantum (t_q), the closest achievable bit time is 24 tq (1000.008 ns), yielding a bit rate of 0.999992 Mbit/sec. The Sync_Seg is a constant 1 tq. The Prop_Seg must be greater than or equal to the propagation delay of 400 ns and so the choice is 10 tq (416.67 ns).

The remaining time quanta (13 tq) in the bit time are divided between Phase_Seg1 and Phase_Seg2 as shown in. Based on this equation, Phase_Seg1 = 6 tq and Phase_Seg2 = 7 tq.

Phase_Seg1 + Phase_Seg2 = Bit_Time – (Synch_Seg + Prop_Seg)

1. If Phase_Seg1 + Phase_Seg2 is even, then Phase_Seg2 = Phase_Seg1. If the sum is odd, Phase_Seg2 = Phase_Seg1 + 1.
2. Phase_Seg2 should be at least 2 tq.

Equation 21.1. Assigning the Phase Segments

The Synchronization Jump Width (SJW) timing parameter is defined by. It is used for determining the value written to the Bit Timing Register and for determining the required oscillator tolerance. Since we are using a quartz crystal as the system clock source, an oscillator tolerance calculation is not needed.

SJW = minimum (4, Phase_Seg1)

Equation 21.2. Synchronization Jump Width (SJW)

The value written to the Bit Timing Register can be calculated using Equation 18.3. The BRP Extension register is left at its reset value of 0x0000.

BRPE = BRP – 1 = BRP Extension Register = 0x0000

SJWp = SJW – 1 = minimum (4, 6) – 1 = 3

TSEG1 = Prop_Seg + Phase_Seg1 - 1 = 10 + 6 – 1 = 15

TSEG2 = Phase_Seg2 – 1 = 6

Bit Timing Register = (TSEG2 x 0x1000) + (TSEG1 x 0x0100)

Bit Timing Register = (TSEG2 x 0x1000) + (TSEG1 x 0x0100) + (SJWp x 0x0040) + BRPE = 0x6FC0

Equation 21.3. Calculating the Bit Timing Register Value

21.2. CAN Registers

CAN registers are classified as follows:

1. **CAN Controller Protocol Registers**: CAN control, interrupt, error control, bus status, test modes.
2. **Message Object Interface Registers**: Used to configure 32 Message Objects, send and receive data to and from Message Objects. The CIP-51 MCU accesses the CAN message RAM via the Message Object Interface Registers. Upon writing a message object number to an IF1 or IF2 Command Request Register, the contents of the associated Interface Registers (IF1 or IF2) will be transferred to or from the message object in CAN RAM.
3. **Message Handler Registers**: These read only registers are used to provide information to the CIP-51 MCU about the message objects (MSGVLD flags, Transmission Request Pending, New Data Flags) and Interrupts Pending (which Message Objects have caused an interrupt or status interrupt condition).

For the registers other than CAN0CFG, refer to the Bosch CAN User's Guide for information on the function and use of the CAN Control Protocol Registers.

21.2.1. CAN Controller Protocol Registers

The CAN Control Protocol Registers are used to configure the CAN controller, process interrupts, monitor bus status, and place the controller in test modes.

The registers are: CAN Control Register (CAN0CN), CAN Clock Configuration (CAN0CFG), CAN Status Register (CAN0STA), CAN Test Register (CAN0TST), Error Counter Register, Bit Timing Register, and the Baud Rate Prescaler (BRP) Extension Register.

21.2.2. Message Object Interface Registers

There are two sets of Message Object Interface Registers used to configure the 32 Message Objects that transmit and receive data to and from the CAN bus. Message objects can be configured for transmit or receive, and are assigned arbitration message identifiers for acceptance filtering by all CAN nodes.

Message Objects are stored in Message RAM, and are accessed and configured using the Message Object Interface Registers.

21.2.3. Message Handler Registers

The Message Handler Registers are read only registers. The message handler registers provide interrupt, error, transmit/receive requests, and new data information.

21.2.4. CAN Register Assignment

The standard Bosch CAN registers are mapped to SFR space as shown below and their full definitions are available in the CAN User's Guide. The name shown in the Name column matches what is provided in the CAN User's Guide. One additional SFR which is not a standard Bosch CAN register, CAN0CFG, is provided to configure the CAN clock. All CAN registers are located on SFR Page 0x0C.

Table 21.2. Standard CAN Registers and Reset Values

CAN Addr.	Name	SFR Name (High)	SFR Addr.	SFR Name (Low)	SFR Addr.	16-bit SFR	Reset Value
0x00	CAN Control Register	—	—	CAN0CN	0xC0	—	0x01
0x02	Status Register	—	—	CAN0STAT	0x94	—	0x00
0x04	Error Counter[1]	CAN0ERRH	0x97	CAN0ERRL	0x96	CAN0ERR	0x0000
0x06	Bit Timing Register[2]	CAN0BTH	0x9B	CAN0BTL	0x9A	CAN0BT	0x2301
0x08	Interrupt Register[1]	CAN0IIDH	0x9D	CAN0IIDL	0x9C	CAN0IID	0x0000
0x0A	Test Register	—	—	CAN0TST	0x9E	—	0x00[3,4]
0x0C	BRP Extension Register[2]	—	—	CAN0BRPE	0xA1	—	0x00
0x10	IF1 Command Request	CAN0IF1CRH	0xBF	CAN0IF1CRL	0xBE	CAN0IF1CR	0x0001
0x12	IF1 Command Mask	CAN0IF1CMH	0xC3	CAN0IF1CML	0xC2	CAN0IF1CM	0x0000
0x14	IF1 Mask 1	CAN0IF1M1H	0xC5	CAN0IF1M1L	0xC4	CAN0IF1M1	0xFFFF
0x16	IF1 Mask 2	CAN0IF1M2H	0xC7	CAN0IF1M2L	0xC6	CAN0IF1M2	0xFFFF
0x18	IF1 Arbitration 1	CAN0IF1A1H	0xCB	CAN0IF1A1L	0xCA	CAN0IF1A1	0x0000
0x1A	IF1 Arbitration 2	CAN0IF1A2H	0xCD	CAN0IF1A2L	0xCC	CAN0IF1A2	0x0000
0x1C	IF1 Message Control	CAN0IF1MCH	0xD3	CAN0IF1MCL	0xD2	CAN0IF1MC	0x0000
0x1E	IF1 Data A 1	CAN0IF1DA1H	0xD5	CAN0IF1DA1L	0xD4	CAN0IF1DA1	0x0000
0x20	IF1 Data A 2	CAN0IF1DA2H	0xD7	CAN0IF1DA2L	0xD6	CAN0IF1DA2	0x0000
0x22	IF1 Data B 1	CAN0IF1DB1H	0xDB	CAN0IF1DB1L	0xDA	CAN0IF1DB1	0x0000
0x24	IF1 Data B 2	CAN0IF1DB2H	0xDD	CAN0IF1DB2L	0xDC	CAN0IF1DB2	0x0000
0x40	IF2 Command Request	CAN0IF2CRH	0xDF	CAN0IF2CRL	0xDE	CAN0IF2CR	0x0001
0x42	IF2 Command Mask	CAN0IF2CMH	0xE3	CAN0IF2CML	0xE2	CAN0IF2CM	0x0000
0x44	IF2 Mask 1	CAN0IF2M1H	0xEB	CAN0IF2M1L	0xEA	CAN0IF2M1	0xFFFF
0x46	IF2 Mask 2	CAN0IF2M2H	0xED	CAN0IF2M2L	0xEC	CAN0IF2M2	0xFFFF
0x48	IF2 Arbitration 1	CAN0IF2A1H	0xEF	CAN0IF2A1L	0xEE	CAN0IF2A1	0x0000
0x4A	IF2 Arbitration 2	CAN0IF2A2H	0xF3	CAN0IF2A2L	0xF2	CAN0IF2A2	0x0000
0x4C	IF2 Message Control	CAN0IF2MCH	0xCF	CAN0IF2MCL	0xCE	CAN0IF2MC	0x0000
0x4E	IF2 Data A 1	CAN0IF2DA1H	0xF7	CAN0IF2DA1L	0xF6	CAN0IF2DA1	0x0000

Notes:
1. Read-only register.
2. Write-enabled by CCE.
3. The reset value of CAN0TST could also be r0000000b, where r signifies the value of the CAN RX pin.
4. Write-enabled by Test.

Table 21.2. Standard CAN Registers and Reset Values

CAN Addr.	Name	SFR Name (High)	SFR Addr.	SFR Name (Low)	SFR Addr.	16-bit SFR	Reset Value
0x50	IF2 Data A 2	CAN0IF2DA2H	0xFB	CAN0IF2DA2L	0xFA	CAN0IF2DA2	0x0000
0x52	IF2 Data B 1	CAN0IF2DB1H	0xFD	CAN0IF2DB1L	0xFC	CAN0IF2DB1	0x0000
0x54	IF2 Data B 2	CAN0IF2DB2H	0xFF	CAN0IF2DB2L	0xFE	CAN0IF2DB2	0x0000
0x80	Transmission Request 1[1]	CAN0TR1H	0xA3	CAN0TR1L	0xA2	CAN0TR1	0x0000
0x82	Transmission Request 2[1]	CAN0TR2H	0xA5	CAN0TR2L	0xA4	CAN0TR2	0x0000
0x90	New Data 1[1]	CAN0ND1H	0xAB	CAN0ND1L	0xAA	CAN0ND1	0x0000
0x92	New Data 2[1]	CAN0ND2H	0xAD	CAN0ND2L	0xAC	CAN0ND2	0x0000
0xA0	Interrupt Pending 1[1]	CAN0IP1H	0xAF	CAN0IP1L	0xAE	CAN0IP1	0x0000
0xA2	Interrupt Pending 2 [1]	CAN0IP2H	0xB3	CAN0IP2L	0xB2	CAN0IP2	0x0000
0xB0	Message Valid 1[1]	CAN0MV1H	0xBB	CAN0MV1L	0xBA	CAN0MV1	0x0000
0xB2	Message Valid 2[1]	CAN0MV2H	0xBD	CAN0MV2L	0xBC	CAN0MV2	0x0000

Notes:
1. Read-only register.
2. Write-enabled by CCE.
3. The reset value of CAN0TST could also be r0000000b, where r signifies the value of the CAN RX pin.
4. Write-enabled by Test.

SFR Definition 21.1. CAN0CFG: CAN Clock Configuration

Bit	7	6	5	4	3	2	1	0
Name	Unused	Unused	Unused	Unused	Unused	Unused	SYSDIV[1:0]	
Type	R	R	R	R	R	R	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x92; SFR Page = 0x0C

Bit	Name	Function
7:2	Unused	Read = 000000b; Write = Don't Care.
1:0	SYSDIV[1:0]	**CAN System Clock Divider Bits.** The CAN controller clock is derived from the CIP-51 system clock. The CAN controller clock must be less than or equal to 25 MHz. 00: CAN controller clock = System Clock/1. 01: CAN controller clock = System Clock/2. 10: CAN controller clock = System Clock/4. 11: CAN controller clock = System Clock/8.

22. SMBus

The SMBus I/O interface is a two-wire, bi-directional serial bus. The SMBus is compliant with the System Management Bus Specification, version 1.1, and compatible with the I2C serial bus. Reads and writes to the interface by the system controller are byte oriented with the SMBus interface autonomously controlling the serial transfer of the data. Data can be transferred at up to 1/20th of the system clock as a master or slave (this can be faster than allowed by the SMBus specification, depending on the system clock used). A method of extending the clock-low duration is available to accommodate devices with different speed capabilities on the same bus.

The SMBus interface may operate as a master and/or slave, and may function on a bus with multiple masters. The SMBus provides control of SDA (serial data), SCL (serial clock) generation and synchronization, arbitration logic, and START/STOP control and generation. A block diagram of the SMBus peripheral and the associated SFRs is shown in Figure 22.1.

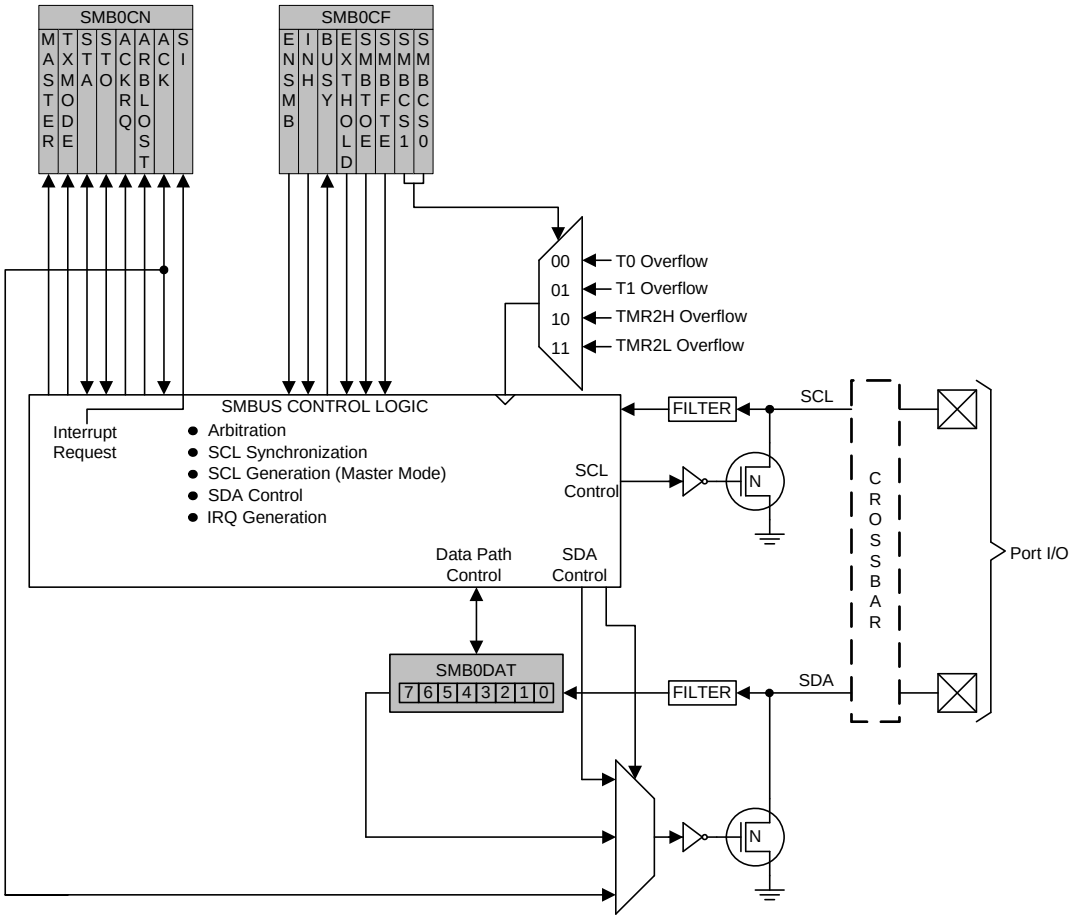


Figure 22.1. SMBus Block Diagram

22.1. Supporting Documents

It is assumed the reader is familiar with or has access to the following supporting documents:

1. The I^2C-Bus and How to Use It (including specifications), Philips Semiconductor.
2. The I^2C-Bus Specification—Version 2.0, Philips Semiconductor.
3. System Management Bus Specification—Version 1.1, SBS Implementers Forum.

22.2. SMBus Configuration

Figure 22.2 shows a typical SMBus configuration. The SMBus specification allows any recessive voltage between 3.0 V and 5.0 V; different devices on the bus may operate at different voltage levels. The bi-directional SCL (serial clock) and SDA (serial data) lines must be connected to a positive power supply voltage through a pullup resistor or similar circuit. Every device connected to the bus must have an open-drain or open-collector output for both the SCL and SDA lines, so that both are pulled high (recessive state) when the bus is free. The maximum number of devices on the bus is limited only by the requirement that the rise and fall times on the bus not exceed 300 ns and 1000 ns, respectively.

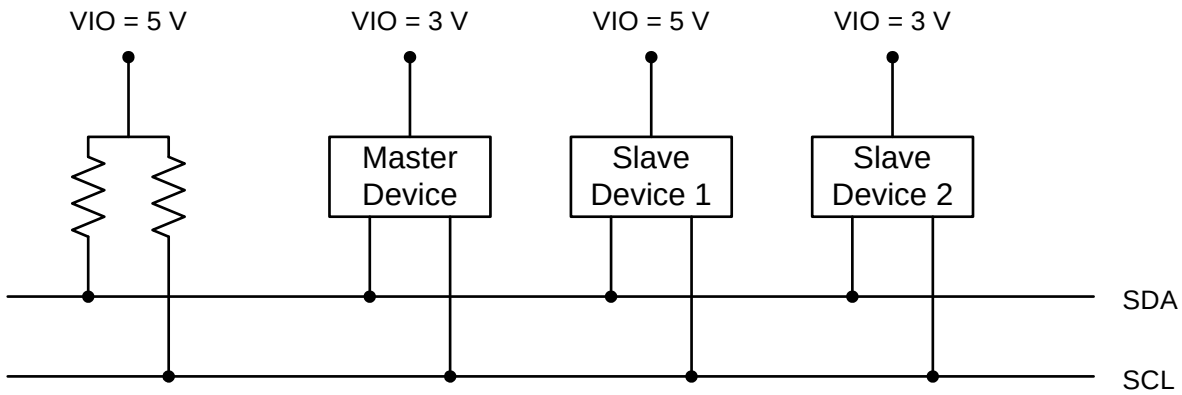


Figure 22.2. Typical SMBus Configuration

22.3. SMBus Operation

Two types of data transfers are possible: data transfers from a master transmitter to an addressed slave receiver (WRITE), and data transfers from an addressed slave transmitter to a master receiver (READ). The master device initiates both types of data transfers and provides the serial clock pulses on SCL. The SMBus interface may operate as a master or a slave, and multiple master devices on the same bus are supported. If two or more masters attempt to initiate a data transfer simultaneously, an arbitration scheme is employed with a single master always winning the arbitration. It is not necessary to specify one device as the Master in a system; any device who transmits a START and a slave address becomes the master for the duration of that transfer.

A typical SMBus transaction consists of a START condition followed by an address byte (Bits7–1: 7-bit slave address; Bit0: R/W direction bit), one or more bytes of data, and a STOP condition. Bytes that are received (by a master or slave) are acknowledged (ACK) with a low SDA during a high SCL (see Figure 22.3). If the receiving device does not ACK, the transmitting device will read a NACK (not acknowledge), which is a high SDA during a high SCL.

The direction bit (R/W) occupies the least-significant bit position of the address byte. The direction bit is set to logic 1 to indicate a "READ" operation and cleared to logic 0 to indicate a "WRITE" operation.

All transactions are initiated by a master, with one or more addressed slave devices as the target. The master generates the START condition and then transmits the slave address and direction bit. If the transaction is a WRITE operation from the master to the slave, the master transmits the data a byte at a time waiting for an ACK from the slave at the end of each byte. For READ operations, the slave transmits the data waiting for an ACK from the master at the end of each byte. At the end of the data transfer, the master generates a STOP condition to terminate the transaction and free the bus. Figure 22.3 illustrates a typical SMBus transaction.

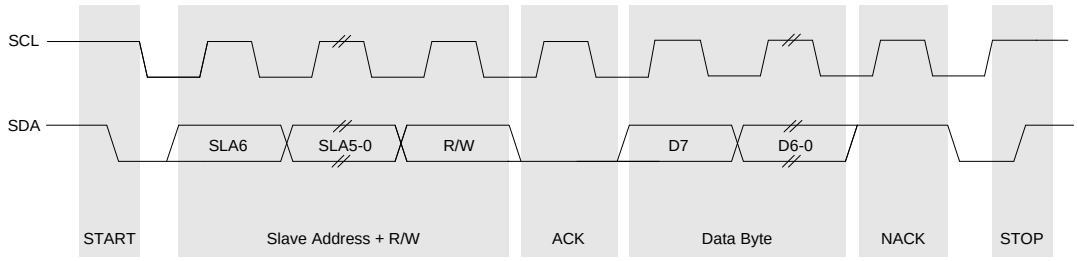


Figure 22.3. SMBus Transaction

22.3.1. Transmitter Vs. Receiver

On the SMBus communications interface, a device is the “transmitter” when it is sending an address or data byte to another device on the bus. A device is a “receiver” when an address or data byte is being sent to it from another device on the bus. The transmitter controls the SDA line during the address or data byte. After each byte of address or data information is sent by the transmitter, the receiver sends an ACK or NACK bit during the ACK phase of the transfer, during which time the receiver controls the SDA line.

22.3.2. Arbitration

A master may start a transfer only if the bus is free. The bus is free after a STOP condition or after the SCL and SDA lines remain high for a specified time (see Section “22.3.5. SCL High (SMBus Free) Timeout” on page 221). In the event that two or more devices attempt to begin a transfer at the same time, an arbitration scheme is employed to force one master to give up the bus. The master devices continue transmitting until one attempts a HIGH while the other transmits a LOW. Since the bus is open-drain, the bus will be pulled LOW. The master attempting the HIGH will detect a LOW SDA and lose the arbitration. The winning master continues its transmission without interruption; the losing master becomes a slave and receives the rest of the transfer if addressed. This arbitration scheme is non-destructive: one device always wins, and no data is lost.

22.3.3. Clock Low Extension

SMBus provides a clock synchronization mechanism, similar to I^2C, which allows devices with different speed capabilities to coexist on the bus. A clock-low extension is used during a transfer in order to allow slower slave devices to communicate with faster masters. The slave may temporarily hold the SCL line LOW to extend the clock low period, effectively decreasing the serial clock frequency.

22.3.4. SCL Low Timeout

If the SCL line is held low by a slave device on the bus, no further communication is possible. Furthermore, the master cannot force the SCL line high to correct the error condition. To solve this problem, the SMBus protocol specifies that devices participating in a transfer must detect any clock cycle held low longer than 25 ms as a “timeout” condition. Devices that have detected the timeout condition must reset the communication no later than 10 ms after detecting the timeout condition.

When the SMBTOE bit in SMB0CF is set, Timer 3 is used to detect SCL low timeouts. Timer 3 is forced to reload when SCL is high, and allowed to count when SCL is low. With Timer 3 enabled and configured to

overflow after 25 ms (and SMBTOE set), the Timer 3 interrupt service routine can be used to reset (disable and re-enable) the SMBus in the event of an SCL low timeout.

22.3.5. SCL High (SMBus Free) Timeout

The SMBus specification stipulates that if the SCL and SDA lines remain high for more that 50 µs, the bus is designated as free. When the SMBFTE bit in SMB0CF is set, the bus will be considered free if SCL and SDA remain high for more than 10 SMBus clock source periods (as defined by the timer configured for the SMBus clock source). If the SMBus is waiting to generate a Master START, the START will be generated following this timeout. Note that a clock source is required for free timeout detection, even in a slave-only implementation.

22.4. Using the SMBus

The SMBus can operate in both Master and Slave modes. The interface provides timing and shifting control for serial transfers; higher level protocol is determined by user software. The SMBus interface provides the following application-independent features:

- Byte-wise serial data transfers
- Clock signal generation on SCL (Master Mode only) and SDA data synchronization
- Timeout/bus error recognition, as defined by the SMB0CF configuration register
- START/STOP timing, detection, and generation
- Bus arbitration
- Interrupt generation
- Status information

SMBus interrupts are generated for each data byte or slave address that is transferred. The point at which the interrupt is generated depends on whether the hardware is acting as a data transmitter or receiver. When a transmitter (i.e. sending address/data, receiving an ACK), this interrupt is generated after the ACK cycle so that software may read the received ACK value; when receiving data (i.e. receiving address/data, sending an ACK), this interrupt is generated before the ACK cycle so that software may define the outgoing ACK value. See Section 22.5 for more details on transmission sequences.

Interrupts are also generated to indicate the beginning of a transfer when a master (START generated), or the end of a transfer when a slave (STOP detected). Software should read the SMB0CN (SMBus Control register) to find the cause of the SMBus interrupt. The SMB0CN register is described in Section 22.4.2; Table 22.4 provides a quick SMB0CN decoding reference.

22.4.1. SMBus Configuration Register

The SMBus Configuration register (SMB0CF) is used to enable the SMBus Master and/or Slave modes, select the SMBus clock source, and select the SMBus timing and timeout options. When the ENSMB bit is set, the SMBus is enabled for all master and slave events. Slave events may be disabled by setting the INH bit. With slave events inhibited, the SMBus interface will still monitor the SCL and SDA pins; however, the interface will NACK all received addresses and will not generate any slave interrupts. When the INH bit is set, all slave events will be inhibited following the next START (interrupts will continue for the duration of the current transfer).

Table 22.1. SMBus Clock Source Selection

SMBCS1	SMBCS0	SMBus Clock Source
0	0	Timer 0 Overflow
0	1	Timer 1 Overflow
1	0	Timer 2 High Byte Overflow
1	1	Timer 2 Low Byte Overflow

The SMBCS1–0 bits select the SMBus clock source, which is used only when operating as a master or when the Free Timeout detection is enabled. When operating as a master, overflows from the selected source determine the absolute minimum SCL low and high times as defined in Equation 22.1. Note that the selected clock source may be shared by other peripherals so long as the timer is left running at all times. For example, Timer 1 overflows may generate the SMBus and UART baud rates simultaneously. Timer configuration is covered in Section “25. Timers” on page 259.

$$T_{HighMin} = T_{LowMin} = \frac{1}{f_{ClockSourceOverflow}}$$

Equation 22.1. Minimum SCL High and Low Times

The selected clock source should be configured to establish the minimum SCL High and Low times as per Equation 22.1. When the interface is operating as a master (and SCL is not driven or extended by any other devices on the bus), the typical SMBus bit rate is approximated by Equation 22.2.

$$BitRate = \frac{f_{ClockSourceOverflow}}{3}$$

Equation 22.2. Typical SMBus Bit Rate

Figure 22.4 shows the typical SCL generation described by Equation 22.2. Notice that T_{HIGH} is typically twice as large as T_{LOW}. The actual SCL output may vary due to other devices on the bus (SCL may be extended low by slower slave devices, or driven low by contending master devices). The bit rate when operating as a master will never exceed the limits defined by equation Equation 22.1.

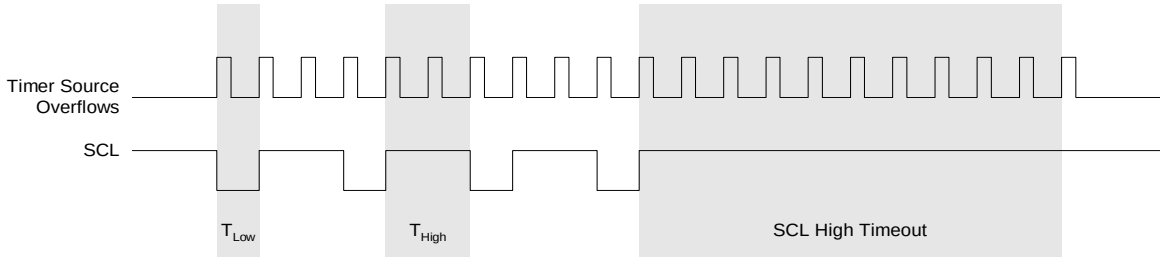


Figure 22.4. Typical SMBus SCL Generation

Setting the EXTHOLD bit extends the minimum setup and hold times for the SDA line. The minimum SDA setup time defines the absolute minimum time that SDA is stable before SCL transitions from low-to-high. The minimum SDA hold time defines the absolute minimum time that the current SDA value remains stable after SCL transitions from high-to-low. EXTHOLD should be set so that the minimum setup and hold times meet the SMBus Specification requirements of 250 ns and 300 ns, respectively. Table 22.2 shows the minimum setup and hold times for the two EXTHOLD settings. Setup and hold time extensions are typically necessary when SYSCLK is above 10 MHz.

Table 22.2. Minimum SDA Setup and Hold Times

EXTHOLD	Minimum SDA Setup Time	Minimum SDA Hold Time
0	T_{low} – 4 system clocks or 1 system clock + s/w delay*	3 system clocks
1	11 system clocks	12 system clocks

***Note:** Setup Time for ACK bit transmissions and the MSB of all data transfers. When using software acknowledgement, the s/w delay occurs between the time SMB0DAT or ACK is written and when SI is cleared. Note that if SI is cleared in the same write that defines the outgoing ACK value, s/w delay is zero.

With the SMBTOE bit set, Timer 3 should be configured to overflow after 25 ms in order to detect SCL low timeouts (see Section “22.3.4. SCL Low Timeout” on page 220). The SMBus interface will force Timer 3 to reload while SCL is high, and allow Timer 3 to count when SCL is low. The Timer 3 interrupt service routine should be used to reset SMBus communication by disabling and re-enabling the SMBus.

SMBus Free Timeout detection can be enabled by setting the SMBFTE bit. When this bit is set, the bus will be considered free if SDA and SCL remain high for more than 10 SMBus clock source periods (see Figure 22.4).

SFR Definition 22.1. SMB0CF: SMBus Clock/Configuration

Bit	7	6	5	4	3	2	1	0
Name	ENSMB	INH	BUSY	EXTHOLD	SMBTOE	SMBFTE	SMBCS[1:0]	
Type	R/W	R/W	R	R/W	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xC1; SFR Page = 0x00

Bit	Name	Function
7	ENSMB	**SMBus Enable.** This bit enables the SMBus interface when set to 1. When enabled, the interface constantly monitors the SDA and SCL pins.
6	INH	**SMBus Slave Inhibit.** When this bit is set to logic 1, the SMBus does not generate an interrupt when slave events occur. This effectively removes the SMBus slave from the bus. Master Mode interrupts are not affected.
5	BUSY	**SMBus Busy Indicator.** This bit is set to logic 1 by hardware when a transfer is in progress. It is cleared to logic 0 when a STOP or free-timeout is sensed.
4	EXTHOLD	**SMBus Setup and Hold Time Extension Enable.** This bit controls the SDA setup and hold times according to Table 22.2. 0: SDA Extended Setup and Hold Times disabled. 1: SDA Extended Setup and Hold Times enabled.
3	SMBTOE	**SMBus SCL Timeout Detection Enable.** This bit enables SCL low timeout detection. If set to logic 1, the SMBus forces Timer 3 to reload while SCL is high and allows Timer 3 to count when SCL goes low. If Timer 3 is configured to Split Mode, only the High Byte of the timer is held in reload while SCL is high. Timer 3 should be programmed to generate interrupts at 25 ms, and the Timer 3 interrupt service routine should reset SMBus communication.
2	SMBFTE	**SMBus Free Timeout Detection Enable.** When this bit is set to logic 1, the bus will be considered free if SCL and SDA remain high for more than 10 SMBus clock source periods.
1:0	SMBCS[1:0]	**SMBus Clock Source Selection.** These two bits select the SMBus clock source, which is used to generate the SMBus bit rate. The selected device should be configured according to Equation 22.1. 00: Timer 0 Overflow 01: Timer 1 Overflow 10:Timer 2 High Byte Overflow 11: Timer 2 Low Byte Overflow

22.4.2. SMB0CN Control Register

SMB0CN is used to control the interface and to provide status information (see SFR Definition 22.2). The higher four bits of SMB0CN (MASTER, TXMODE, STA, and STO) form a status vector that can be used to jump to service routines. MASTER indicates whether a device is the master or slave during the current transfer. TXMODE indicates whether the device is transmitting or receiving data for the current byte.

STA and STO indicate that a START and/or STOP has been detected or generated since the last SMBus interrupt. STA and STO are also used to generate START and STOP conditions when operating as a master. Writing a 1 to STA will cause the SMBus interface to enter Master Mode and generate a START when the bus becomes free (STA is not cleared by hardware after the START is generated). Writing a 1 to STO while in Master Mode will cause the interface to generate a STOP and end the current transfer after the next ACK cycle. If STO and STA are both set (while in Master Mode), a STOP followed by a START will be generated.

As a receiver, writing the ACK bit defines the outgoing ACK value; as a transmitter, reading the ACK bit indicates the value received during the last ACK cycle. ACKRQ is set each time a byte is received, indicating that an outgoing ACK value is needed. When ACKRQ is set, software should write the desired outgoing value to the ACK bit before clearing SI. A NACK will be generated if software does not write the ACK bit before clearing SI. SDA will reflect the defined ACK value immediately following a write to the ACK bit; however SCL will remain low until SI is cleared. If a received slave address is not acknowledged, further slave events will be ignored until the next START is detected.

The ARBLOST bit indicates that the interface has lost an arbitration. This may occur anytime the interface is transmitting (master or slave). A lost arbitration while operating as a slave indicates a bus error condition. ARBLOST is cleared by hardware each time SI is cleared.

The SI bit (SMBus Interrupt Flag) is set at the beginning and end of each transfer, after each byte frame, or when an arbitration is lost; see Table 22.3 for more details.

Important Note About the SI Bit: The SMBus interface is stalled while SI is set; thus SCL is held low, and the bus is stalled until software clears SI.

SFR Definition 22.2. SMB0CN: SMBus Control

Bit	7	6	5	4	3	2	1	0
Name	MASTER	TXMODE	STA	STO	ACKRQ	ARBLOST	ACK	SI
Type	R	R	R/W	R/W	R	R	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xC0; Bit-Addressable; SFR Page =0x00

Bit	Name	Description	Read	Write
7	MASTER	**SMBus Master/Slave Indicator.** This read-only bit indicates when the SMBus is operating as a master.	0: SMBus operating in slave mode. 1: SMBus operating in master mode.	N/A
6	TXMODE	**SMBus Transmit Mode Indicator.** This read-only bit indicates when the SMBus is operating as a transmitter.	0: SMBus in Receiver Mode. 1: SMBus in Transmitter Mode.	N/A
5	STA	**SMBus Start Flag.**	0: No Start or repeated Start detected. 1: Start or repeated Start detected.	0: No Start generated. 1: When Configured as a Master, initiates a START or repeated START.
4	STO	**SMBus Stop Flag.**	0: No Stop condition detected. 1: Stop condition detected (if in Slave Mode) or pending (if in Master Mode).	0: No STOP condition is transmitted. 1: When configured as a Master, causes a STOP condition to be transmitted after the next ACK cycle. Cleared by Hardware.
3	ACKRQ	**SMBus Acknowledge Request.**	0: No Ack requested 1: ACK requested	N/A
2	ARBLOST	**SMBus Arbitration Lost Indicator.**	0: No arbitration error. 1: Arbitration Lost	N/A
1	ACK	**SMBus Acknowledge.**	0: NACK received. 1: ACK received.	0: Send NACK 1: Send ACK
0	SI	**SMBus Interrupt Flag.** This bit is set by hardware under the conditions listed in Table 15.3. SI must be cleared by software. While SI is set, SCL is held low and the SMBus is stalled.	0: No interrupt pending 1: Interrupt Pending	0: Clear interrupt, and initiate next state machine event. 1: Force interrupt.

Table 22.3. Sources for Hardware Changes to SMB0CN

Bit	Set by Hardware When:	Cleared by Hardware When:
MASTER	■ A START is generated.	■ A STOP is generated. ■ Arbitration is lost.
TXMODE	■ START is generated. ■ SMB0DAT is written before the start of an SMBus frame.	■ A START is detected. ■ Arbitration is lost. ■ SMB0DAT is not written before the start of an SMBus frame.
STA	■ A START followed by an address byte is received.	■ Must be cleared by software.
STO	■ A STOP is detected while addressed as a slave. ■ Arbitration is lost due to a detected STOP.	■ A pending STOP is generated.
ACKRQ	■ A byte has been received and an ACK response value is needed.	■ After each ACK cycle.
ARBLOST	■ A repeated START is detected as a MASTER when STA is low (unwanted repeated START). ■ SCL is sensed low while attempting to generate a STOP or repeated START condition. ■ SDA is sensed low while transmitting a 1 (excluding ACK bits).	■ Each time SI is cleared.
ACK	■ The incoming ACK value is low (ACKNOWLEDGE).	■ The incoming ACK value is high (NOT ACKNOWLEDGE).
SI	■ A START has been generated. ■ Lost arbitration. ■ A byte has been transmitted and an ACK/NACK received. ■ A byte has been received. ■ A START or repeated START followed by a slave address + R/W has been received. ■ A STOP has been received.	■ Must be cleared by software.

22.4.3. Data Register

The SMBus Data register SMB0DAT holds a byte of serial data to be transmitted or one that has just been received. Software may safely read or write to the data register when the SI flag is set. Software should not attempt to access the SMB0DAT register when the SMBus is enabled and the SI flag is cleared to logic 0, as the interface may be in the process of shifting a byte of data into or out of the register.

Data in SMB0DAT is always shifted out MSB first. After a byte has been received, the first bit of received data is located at the MSB of SMB0DAT. While data is being shifted out, data on the bus is simultaneously being shifted in. SMB0DAT always contains the last data byte present on the bus. In the event of lost arbitration, the transition from master transmitter to slave receiver is made with the correct data or address in SMB0DAT.

SFR Definition 22.3. SMB0DAT: SMBus Data

Bit	7	6	5	4	3	2	1	0
Name	SMB0DAT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xC2; SMB0DAT = 0x00

Bit	Name	Function
7:0	SMB0DAT[7:0]	**SMBus Data.** The SMB0DAT register contains a byte of data to be transmitted on the SMBus serial interface or a byte that has just been received on the SMBus serial interface. The CPU can read from or write to this register whenever the SI serial interrupt flag (SMB0CN.0) is set to logic 1. The serial data in the register remains stable as long as the SI flag is set. When the SI flag is not set, the system may be in the process of shifting data in/out and the CPU should not attempt to access this register.

22.5. SMBus Transfer Modes

The SMBus interface may be configured to operate as master and/or slave. At any particular time, it will be operating in one of the following four modes: Master Transmitter, Master Receiver, Slave Transmitter, or Slave Receiver. The SMBus interface enters Master Mode any time a START is generated, and remains in Master Mode until it loses an arbitration or generates a STOP. An SMBus interrupt is generated at the end of all SMBus byte frames. As a receiver, the interrupt for an ACK occurs **before** the ACK. As a transmitter, interrupts occur **after** the ACK.

22.5.1. Write Sequence (Master)

During a write sequence, an SMBus master writes data to a slave device. The master in this transfer will be a transmitter during the address byte, and a transmitter during all data bytes. The SMBus interface generates the START condition and transmits the first byte containing the address of the target slave and the data direction bit. In this case the data direction bit (R/W) will be logic 0 (WRITE). The master then transmits one or more bytes of serial data. After each byte is transmitted, an acknowledge bit is generated by the slave. The transfer is ended when the STO bit is set and a STOP is generated. Note that the interface will switch to Master Receiver Mode if SMB0DAT is not written following a Master Transmitter interrupt. Figure 22.5 shows a typical master write sequence. Two transmit data bytes are shown, though any number of bytes may be transmitted. Notice that all of the 'data byte transferred' interrupts occur **after** the ACK cycle in this mode.

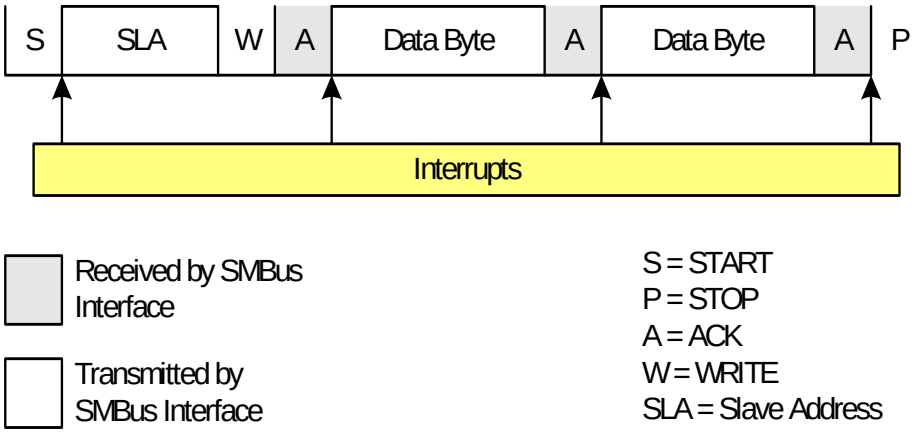


Figure 22.5. Typical Master Write Sequence

22.5.2. Read Sequence (Master)

During a read sequence, an SMBus master reads data from a slave device. The master in this transfer will be a transmitter during the address byte, and a receiver during all data bytes. The SMBus interface generates the START condition and transmits the first byte containing the address of the target slave and the data direction bit. In this case the data direction bit (R/W) will be logic 1 (READ). Serial data is then received from the slave on SDA while the SMBus outputs the serial clock. The slave transmits one or more bytes of serial data. An interrupt is generated after each received byte.

Software must write the ACK bit at that time to ACK or NACK the received byte. Writing a 1 to the ACK bit generates an ACK; writing a 0 generates a NACK. Software should write a 0 to the ACK bit for the last data transfer, to transmit a NACK. The interface exits Master Receiver Mode after the STO bit is set and a STOP is generated. The interface will switch to Master Transmitter Mode if SMB0DAT is written while an active Master Receiver. Figure 22.6 shows a typical master read sequence. Two received data bytes are shown, though any number of bytes may be received. Notice that the ‘data byte transferred’ interrupts occur **before** the ACK cycle in this mode.

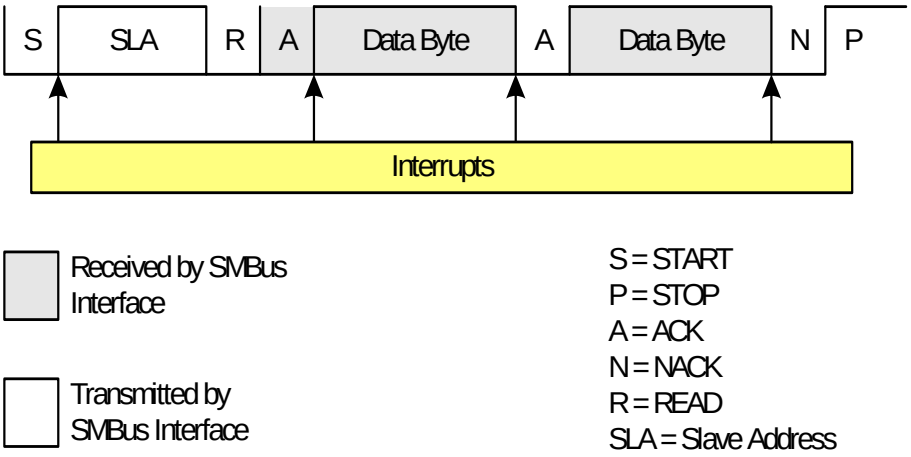


Figure 22.6. Typical Master Read Sequence

22.5.3. Write Sequence (Slave)

During a write sequence, an SMBus master writes data to a slave device. The slave in this transfer will be a receiver during the address byte, and a receiver during all data bytes. When slave events are enabled (INH = 0), the interface enters Slave Receiver Mode when a START followed by a slave address and direction bit (WRITE in this case) is received. Upon entering Slave Receiver Mode, an interrupt is generated and the ACKRQ bit is set. The software must respond to the received slave address with an ACK, or ignore the received slave address with a NACK.

If the received slave address is ignored, slave interrupts will be inhibited until the next START is detected. If the received slave address is acknowledged, zero or more data bytes are received. Software must write the ACK bit at that time to ACK or NACK the received byte.

The interface exits Slave Receiver Mode after receiving a STOP. Note that the interface will switch to Slave Transmitter Mode if SMB0DAT is written while an active Slave Receiver. Figure 22.7 shows a typical slave write sequence. Two received data bytes are shown, though any number of bytes may be received. Notice that the 'data byte transferred' interrupts occur **before** the ACK in this mode.

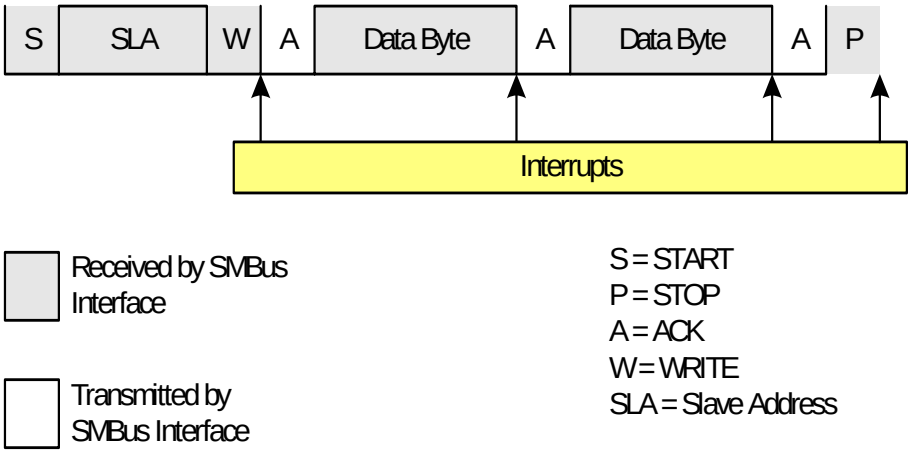


Figure 22.7. Typical Slave Write Sequence

22.5.4. Read Sequence (Slave)

During a read sequence, an SMBus master reads data from a slave device. The slave in this transfer will be a receiver during the address byte, and a transmitter during all data bytes. When slave events are enabled (INH = 0), the interface enters Slave Receiver Mode (to receive the slave address) when a START followed by a slave address and direction bit (READ in this case) is received. Upon entering Slave Receiver Mode, an interrupt is generated and the ACKRQ bit is set. The software must respond to the received slave address with an ACK, or ignore the received slave address with a NACK. The interrupt will occur after the ACK cycle.

If the received slave address is ignored, slave interrupts will be inhibited until the next START is detected. If the received slave address is acknowledged, zero or more data bytes are transmitted. If the received slave address is acknowledged, data should be written to SMB0DAT to be transmitted. The interface enters Slave Transmitter Mode, and transmits one or more bytes of data. After each byte is transmitted, the master sends an acknowledge bit; if the acknowledge bit is an ACK, SMB0DAT should be written with the next data byte. If the acknowledge bit is a NACK, SMB0DAT should not be written to before SI is cleared (Note: an error condition may be generated if SMB0DAT is written following a received NACK while in Slave Transmitter Mode). The interface exits Slave Transmitter Mode after receiving a STOP. Note that the interface will switch to Slave Receiver Mode if SMB0DAT is not written following a Slave Transmitter interrupt. Figure 22.8 shows a typical slave read sequence. Two transmitted data bytes are shown, though any number of bytes may be transmitted. Notice that all of the ‘data byte transferred’ interrupts occur **after** the ACK cycle in this mode.

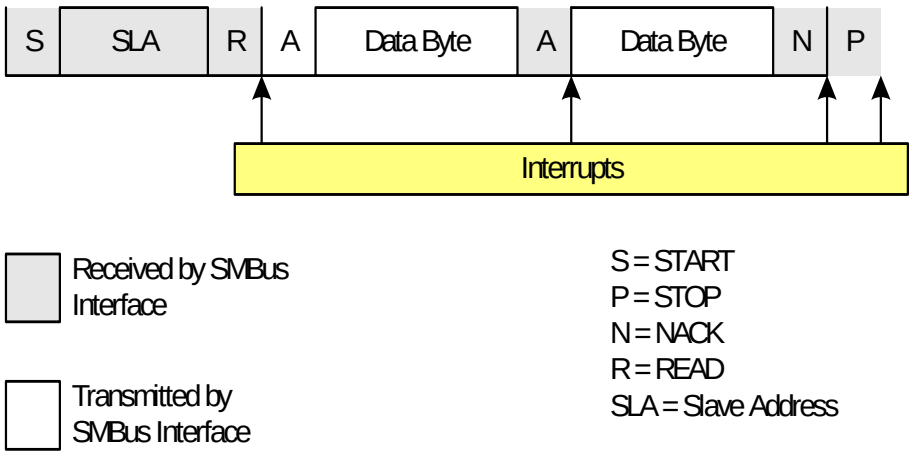


Figure 22.8. Typical Slave Read Sequence

22.6. SMBus Status Decoding

The current SMBus status can be easily decoded using the SMB0CN register. In the tables, STATUS VECTOR refers to the four upper bits of SMB0CN: MASTER, TXMODE, STA, and STO. The shown response options are only the typical responses; application-specific procedures are allowed as long as they conform to the SMBus specification. Highlighted responses are allowed by hardware but do not conform to the SMBus specification.

Table 22.4. SMBus Status Decoding

Mode	Values Read				Current SMbus State	Typical Response Options	Values to Write			Next Status Vector Expected
	Status Vector	ACKRQ	ARBLOST	ACK			STA	STO	ACK	
Master Transmitter	1110	0	0	X	A master START was generated.	Load slave address + R/W into SMB0DAT.	0	0	X	1100
	1100	0	0	0	A master data or address byte was transmitted; NACK received.	Set STA to restart transfer.	1	0	X	1110
						Abort transfer.	0	1	X	—
		0	0	1	A master data or address byte was transmitted; ACK received.	Load next data byte into SMB0DAT.	0	0	X	1100
						End transfer with STOP.	0	1	X	—
						End transfer with STOP and start another transfer.	1	1	X	—
						Send repeated START.	1	0	X	1110
						Switch to Master Receiver Mode (clear SI without writing new data to SMB0DAT).	0	0	X	1000
Master Receiver	1000	1	0	X	A master data byte was received; ACK requested.	Acknowledge received byte; Read SMB0DAT.	0	0	1	1000
						Send NACK to indicate last byte, and send STOP.	0	1	0	—
						Send NACK to indicate last byte, and send STOP followed by START.	1	1	0	1110
						Send ACK followed by repeated START.	1	0	1	1110
						Send NACK to indicate last byte, and send repeated START.	1	0	0	1110
						Send ACK and switch to Master Transmitter Mode (write to SMB0DAT before clearing SI).	0	0	1	1100
						Send NACK and switch to Master Transmitter Mode (write to SMB0DAT before clearing SI).	0	0	0	1100

Table 22.4. SMBus Status Decoding (Continued)

Mode	Values Read				Current SMbus State	Typical Response Options	Values to Write			Next Status Vector Expected
	Status Vector	ACKRQ	ARBLOST	ACK			STA	STO	ACK	
Slave Transmitter	0100	0	0	0	A slave byte was transmitted; NACK received.	No action required (expecting STOP condition).	0	0	X	0001
		0	0	1	A slave byte was transmitted; ACK received.	Load SMB0DAT with next data byte to transmit.	0	0	X	0100
		0	1	X	A Slave byte was transmitted; error detected.	No action required (expecting Master to end transfer).	0	0	X	0001
	0101	0	X	X	An illegal STOP or bus error was detected while a Slave Transmission was in progress.	Clear STO.	0	0	X	—
Slave Receiver	0010	1	0	X	A slave address + R/W was received; ACK requested.	If Write, Acknowledge received address	0	0	1	0000
						If Read, Load SMB0DAT with data byte; ACK received address	0	0	1	0100
						NACK received address.	0	0	0	—
		1	1	X	Lost arbitration as master; slave address + R/W received; ACK requested.	If Write, Acknowledge received address	0	0	1	0000
						If Read, Load SMB0DAT with data byte; ACK received address	0	0	1	0100
						NACK received address.	0	0	0	—
						Reschedule failed transfer; NACK received address.	1	0	0	1110
	0001	0	0	X	A STOP was detected while addressed as a Slave Transmitter or Slave Receiver.	Clear STO.	0	0	X	—
		1	1	X	Lost arbitration while attempting a STOP.	No action required (transfer complete/aborted).	0	0	0	—
	0000	1	0	X	A slave byte was received; ACK requested.	Acknowledge received byte; Read SMB0DAT.	0	0	1	0000
						NACK received byte.	0	0	0	—
Bus Error Condition	0010	0	1	X	Lost arbitration while attempting a repeated START.	Abort failed transfer.	0	0	X	—
						Reschedule failed transfer.	1	0	X	1110
	0001	0	1	X	Lost arbitration due to a detected STOP.	Abort failed transfer.	0	0	X	—
						Reschedule failed transfer.	1	0	X	1110
	0000	1	1	X	Lost arbitration while transmitting a data byte as master.	Abort failed transfer.	0	0	0	—
						Reschedule failed transfer.	1	0	0	1110

23. UART0

UART0 is an asynchronous, full duplex serial port offering a variety of data formatting options. A dedicated baud rate generator with a 16-bit timer and selectable prescaler is included, which can generate a wide range of baud rates (details in Section “23.1. Baud Rate Generator” on page 235). A received data FIFO allows UART0 to receive up to three data bytes before data is lost and an overflow occurs.

UART0 has six associated SFRs. Three are used for the Baud Rate Generator (SBCON0, SBRLH0, and SBRLL0), two are used for data formatting, control, and status functions (SCON0, SMOD0), and one is used to send and receive data (SBUF0). The single SBUF0 location provides access to both the transmit holding register and the receive FIFO. **Writes to SBUF0 always access the Transmit register. Reads of SBUF0 always access the first byte of the Receive FIFO; it is not possible to read data from the Transmit Holding Register.**

With UART0 interrupts enabled, an interrupt is generated each time a transmit is completed (TI0 is set in SCON0), or a data byte has been received (RI0 is set in SCON0). The UART0 interrupt flags are not cleared by hardware when the CPU vectors to the interrupt service routine. They must be cleared manually by software, allowing software to determine the cause of the UART0 interrupt (transmit complete or receive complete). If additional bytes are available in the Receive FIFO, the RI0 bit cannot be cleared by software.

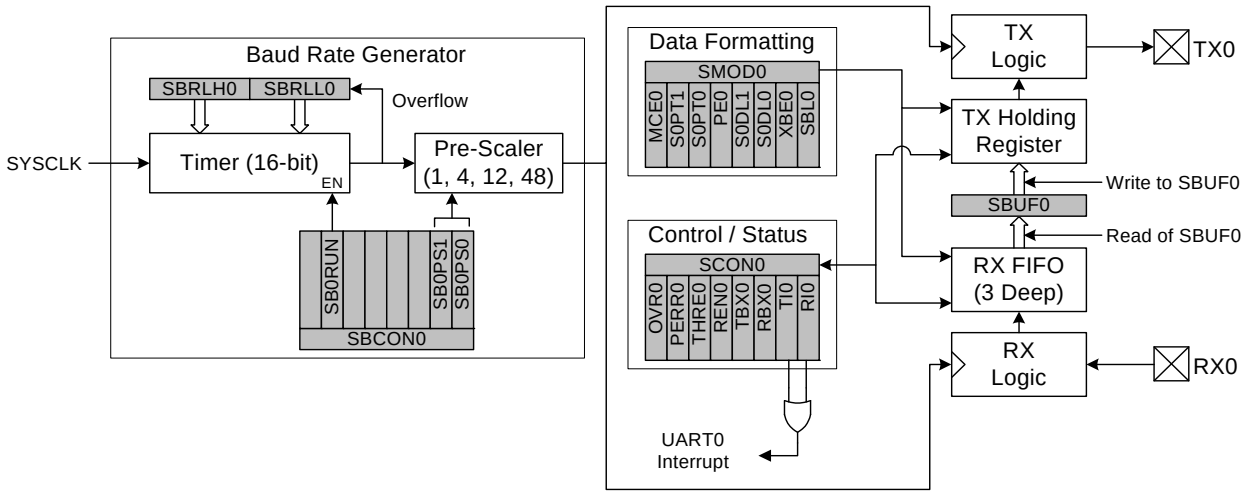


Figure 23.1. UART0 Block Diagram

23.1. Baud Rate Generator

The UART0 baud rate is generated by a dedicated 16-bit timer which runs from the controller’s core clock (SYSCLK) and has prescaler options of 1, 4, 12, or 48. The timer and prescaler options combined allow for a wide selection of baud rates over many clock frequencies.

The baud rate generator is configured using three registers: SBCON0, SBRLH0, and SBRLL0. The UART0 Baud Rate Generator Control Register (SBCON0, SFR Definition 23.4) enables or disables the baud rate generator and selects the prescaler value for the timer. The baud rate generator must be enabled for UART0 to function. Registers SBRLH0 and SBRLL0 contain a 16-bit reload value for the dedicated 16-bit timer. The internal timer counts up from the reload value on every clock tick. On timer overflows (0xFFFF to 0x0000), the timer is reloaded. The baud rate for UART0 is defined in Equation 23.1, where “BRG Clock” is the baud rate generator’s selected clock source. For reliable UART operation, it is recommended that the UART baud rate is not configured for baud rates faster than SYSCLK/16.

$$\text{Baud Rate} = \frac{\text{SYSCLK}}{(65536 - (\text{SBRLH0:SBRLL0}))} \times \frac{1}{2} \times \frac{1}{\text{Prescaler}}$$

Equation 23.1. UART0 Baud Rate

A quick reference for typical baud rates and clock frequencies is given in Table 23.1.

Table 23.1. Baud Rate Generator Settings for Standard Baud Rates

	Target Baud Rate (bps)	Actual Baud Rate (bps)	Baud Rate Error	Oscillator Divide Factor	SB0PS[1:0] (Prescaler Bits)	Reload Value in SBRLH0:SBRLL0
SYSCLK = 48	230400	230769	0.16%	208	11	0xFF98
	115200	115385	0.16%	416	11	0xFF30
	57600	57554	0.08%	834	11	0xFE5F
	28800	28812	0.04%	1666	11	0xFCBF
	14400	14397	0.02%	3334	11	0xF97D
	9600	9600	0.00%	5000	11	0xF63C
	2400	2400	0.00%	20000	11	0xD8F0
	1200	1200	0.00%	40000	11	0xB1E0
SYSCLK = 24	230400	230769	0.16%	104	11	0xFFCC
	115200	115385	0.16%	208	11	0xFF98
	57600	57692	0.16%	416	11	0xFF30
	28800	28777	0.08%	834	11	0xFE5F
	14400	14406	0.04%	1666	11	0xFCBF
	9600	9600	0.00%	2500	11	0xFB1E
	2400	2400	0.00%	10000	11	0xEC78
	1200	1200	0.00%	20000	11	0xD8F0
SYSCLK = 12	230400	230769	0.16%	52	11	0xFFE6
	115200	115385	0.16%	104	11	0xFFCC
	57600	57692	0.16%	208	11	0xFF98
	28800	28846	0.16%	416	11	0xFF30
	14400	14388	0.08%	834	11	0xFE5F
	9600	9600	0.00%	1250	11	0xFD8F
	2400	2400	0.00%	5000	11	0xF63C
	1200	1200	0.00%	10000	11	0xEC78

23.2. Data Format

UART0 has a number of available options for data formatting. Data transfers begin with a start bit (logic low), followed by the data bits (sent LSB-first), a parity or extra bit (if selected), and end with one or two stop bits (logic high). The data length is variable between 5 and 8 bits. A parity bit can be appended to the data, and automatically generated and detected by hardware for even, odd, mark, or space parity. The stop bit length is selectable between 1 and 2 bit times, and a multi-processor communication mode is available for implementing networked UART buses. All of the data formatting options can be configured using the SMOD0 register, shown in SFR Definition 23.2. Figure 23.2 shows the timing for a UART0 transaction without parity or an extra bit enabled. Figure 23.3 shows the timing for a UART0 transaction with parity enabled (PE0 = 1). Figure 23.4 is an example of a UART0 transaction when the extra bit is enabled (XBE0 = 1). Note that the extra bit feature is not available when parity is enabled, and the second stop bit is only an option for data lengths of 6, 7, or 8 bits.

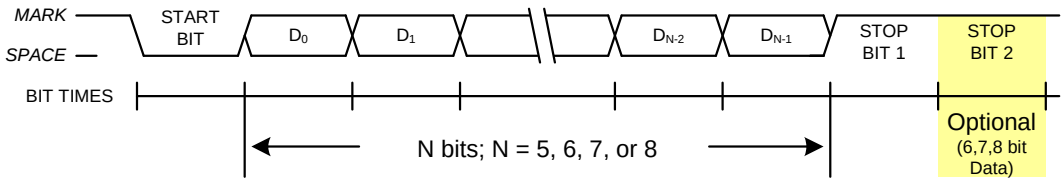


Figure 23.2. UART0 Timing Without Parity or Extra Bit

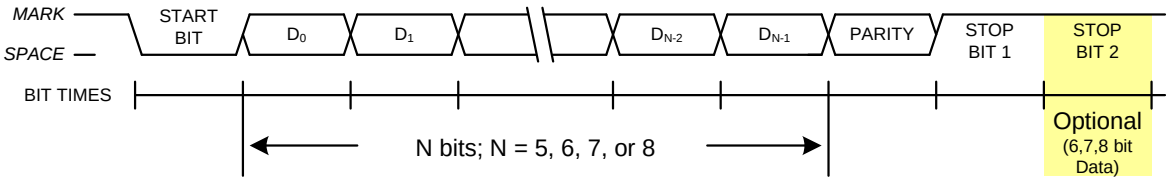


Figure 23.3. UART0 Timing With Parity

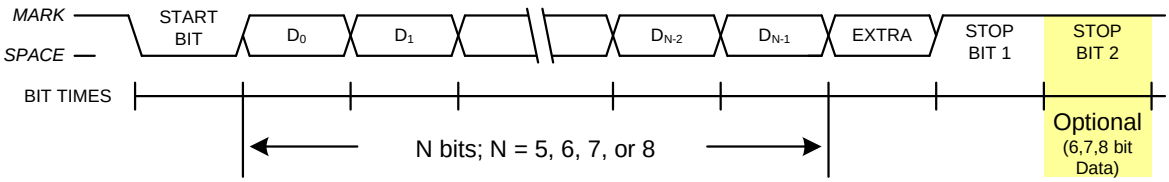


Figure 23.4. UART0 Timing With Extra Bit

23.3. Configuration and Operation

UART0 provides standard asynchronous, full duplex communication. It can operate in a point-to-point serial communications application, or as a node on a multi-processor serial interface. To operate in a point-to-point application, where there are only two devices on the serial bus, the MCE0 bit in SMOD0 should be cleared to 0. For operation as part of a multi-processor communications bus, the MCE0 and XBE0 bits should both be set to 1. In both types of applications, data is transmitted from the microcontroller on the TX0 pin, and received on the RX0 pin. The TX0 and RX0 pins are configured using the crossbar and the Port I/O registers, as detailed in Section “19. Port Input/Output” on page 169.

In typical UART communications, The transmit (TX) output of one device is connected to the receive (RX) input of the other device, either directly or through a bus transceiver, as shown in Figure 23.5.

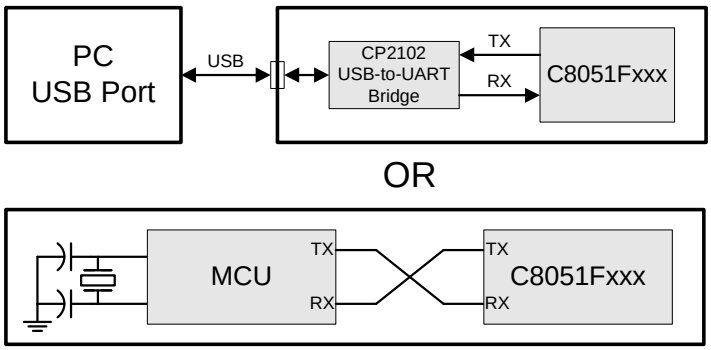


Figure 23.5. Typical UART Interconnect Diagram

23.3.1. Data Transmission

Data transmission is double-buffered and begins when software writes a data byte to the SBUF0 register. Writing to SBUF0 places data in the Transmit Holding Register, and the Transmit Holding Register Empty flag (THRE0) will be cleared to 0. If the UART’s shift register is empty (i.e., no transmission in progress), the data will be placed in the Transmit Holding Register until the current transmission is complete. The TI0 Transmit Interrupt Flag (SCON0.1) will be set at the end of any transmission (the beginning of the stop-bit time). If enabled, an interrupt will occur when TI0 is set.

Note: THRE0 can have a momentary glitch high when the UART Transmit Holding Register is not empty. The glitch will occur some time after SBUF0 was written with the previous byte and does not occur if THRE0 is checked in the instruction(s) immediately following the write to SBUF0. When firmware writes SBUF0 and SBUF0 is not empty, TX0 will be stuck low until the next device reset. Firmware should use or poll on TI0 rather than THRE0 for asynchronous UART writes that may have a random delay in between transactions.

If the extra bit function is enabled (XBE0 = 1) and the parity function is disabled (PE0 = ‘0’), the value of the TBX0 (SCON0.3) bit will be sent in the extra bit position. When the parity function is enabled (PE0 = 1), hardware will generate the parity bit according to the selected parity type (selected with S0PT[1:0]), and append it to the data field. Note: when parity is enabled, the extra bit function is not available.

23.3.2. Data Reception

Data reception can begin any time after the REN0 Receive Enable bit (SCON0.4) is set to logic 1. After the stop bit is received, the data byte will be stored in the receive FIFO if the following conditions are met: the receive FIFO (3 bytes deep) must not be full, and the stop bit(s) must be logic 1. In the event that the receive FIFO is full, the incoming byte will be lost, and a Receive FIFO Overrun Error will be generated (OVR0 in register SCON0 will be set to logic 1). If the stop bit(s) were logic 0, the incoming data will not be stored in the receive FIFO. If the reception conditions are met, the data is stored in the receive FIFO, and

the RI0 flag will be set. Note: when MCE0 = 1, RI0 will only be set if the extra bit was equal to 1. Data can be read from the receive FIFO by reading the SBUF0 register. The SBUF0 register represents the oldest byte in the FIFO. After SBUF0 is read, the next byte in the FIFO is immediately loaded into SBUF0, and space is made available in the FIFO for another incoming byte. If enabled, an interrupt will occur when RI0 is set. RI0 can only be cleared to '0' by software when there is no more information in the FIFO. The recommended procedure to empty the FIFO contents is as follows:

1. Clear RI0 to 0.
2. Read SBUF0.
3. Check RI0, and repeat at step 1 if RI0 is set to 1.

If the extra bit function is enabled (XBE0 = 1) and the parity function is disabled (PE0 = 0), the extra bit for the oldest byte in the FIFO can be read from the RBX0 bit (SCON0.2). If the extra bit function is not enabled, the value of the stop bit for the oldest FIFO byte will be presented in RBX0. When the parity function is enabled (PE0 = 1), hardware will check the received parity bit against the selected parity type (selected with S0PT[1:0]) when receiving data. If a byte with parity error is received, the PERR0 flag will be set to 1. This flag must be cleared by software. Note: when parity is enabled, the extra bit function is not available.

Note: The UART Receive FIFO pointer can be corrupted if the UART receives a byte and firmware reads a byte from the FIFO at the same time. When this occurs, firmware will lose the received byte and the FIFO receive overrun flag (OVR0) will also be set to 1. Systems using the UART Receive FIFO should ensure that the FIFO isn't accessed by hardware and firmware at the same time. In other words, firmware should ensure to read the FIFO before the next byte is received.

23.3.3. Multiprocessor Communications

UART0 supports multiprocessor communication between a master processor and one or more slave processors by special use of the extra data bit. When a master processor wants to transmit to one or more slaves, it first sends an address byte to select the target(s). An address byte differs from a data byte in that its extra bit is logic 1; in a data byte, the extra bit is always set to logic 0.

Setting the MCE0 bit (SMOD0.7) of a slave processor configures its UART such that when a stop bit is received, the UART will generate an interrupt only if the extra bit is logic 1 (RBX0 = 1) signifying an address byte has been received. In the UART interrupt handler, software will compare the received address with the slave's own assigned address. If the addresses match, the slave will clear its MCE0 bit to enable interrupts on the reception of the following data byte(s). Slaves that weren't addressed leave their MCE0 bits set and do not generate interrupts on the reception of the following data bytes, thereby ignoring the data. Once the entire message is received, the addressed slave resets its MCE0 bit to ignore all transmissions until it receives the next address byte.

Multiple addresses can be assigned to a single slave and/or a single address can be assigned to multiple slaves, thereby enabling "broadcast" transmissions to more than one slave simultaneously. The master processor can be configured to receive all transmissions or a protocol can be implemented such that the master/slave role is temporarily reversed to enable half-duplex transmission between the original master and slave(s).

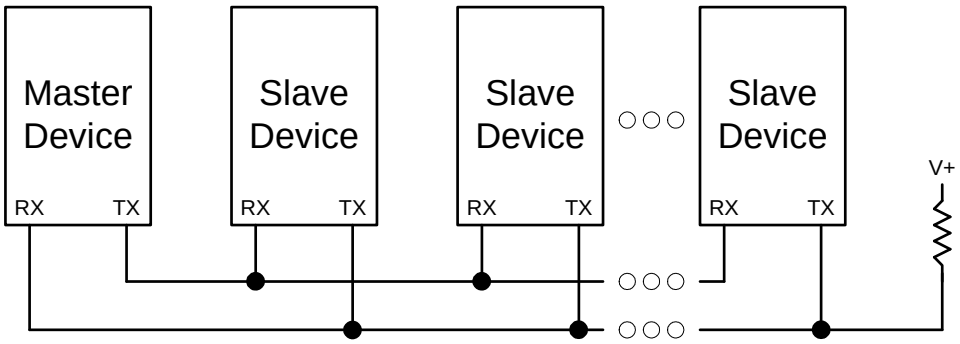


Figure 23.6. UART Multi-Processor Mode Interconnect Diagram

SFR Definition 23.1. SCON0: Serial Port 0 Control

Bit	7	6	5	4	3	2	1	0
Name	OVR0	PERR0	THRE0	REN0	TBX0	RBX0	TI0	RI0
Type	R/W	R/W	R	R/W	R/W	R/W	R/W	R/W
Reset	0	0	1	0	0	0	0	0

SFR Address = 0x98; Bit-Addressable; SFR Page = 0x00

Bit	Name	Function
7	OVR0	**Receive FIFO Overrun Flag.** 0: Receive FIFO Overrun has not occurred 1: Receive FIFO Overrun has occurred; A received character has been discarded due to a full FIFO.
6	PERR0	**Parity Error Flag.** When parity is enabled, this bit indicates that a parity error has occurred. It is set to 1 when the parity of the oldest byte in the FIFO does not match the selected Parity Type. 0: Parity error has not occurred 1: Parity error has occurred. This bit must be cleared by software.
5	THRE0	**Transmit Holding Register Empty Flag.** THRE0 can have a momentary glitch high when the UART Transmit Holding Register is not empty. The glitch will occur some time after SBUF0 was written with the previous byte and does not occur if THRE0 is checked in the instruction(s) immediately following the write to SBUF0. When firmware writes SBUF0 and SBUF0 is not empty, TX0 will be stuck low until the next device reset. Firmware should use or poll on TI0 rather than THRE0 for asynchronous UART writes that may have a random delay in between transactions. 0: Transmit Holding Register not Empty—do not write to SBUF0. 1: Transmit Holding Register Empty—it is safe to write to SBUF0.
4	REN0	**Receive Enable.** This bit enables/disables the UART receiver. When disabled, bytes can still be read from the receive FIFO. 0: UART1 reception disabled. 1: UART1 reception enabled.
3	TBX0	**Extra Transmission Bit.** The logic level of this bit will be assigned to the extra transmission bit when XBE0 is set to 1. This bit is not used when Parity is enabled.
2	RBX0	**Extra Receive Bit.** RBX0 is assigned the value of the extra bit when XBE1 is set to 1. If XBE1 is cleared to 0, RBX1 will be assigned the logic level of the first stop bit. This bit is not valid when Parity is enabled.
1	TI0	**Transmit Interrupt Flag.** Set to a 1 by hardware after data has been transmitted, at the beginning of the STOP bit. When the UART0 interrupt is enabled, setting this bit causes the CPU to vector to the UART0 interrupt service routine. This bit must be cleared manually by software.
0	RI0	**Receive Interrupt Flag.** Set to 1 by hardware when a byte of data has been received by UART0 (set at the STOP bit sampling time). When the UART0 interrupt is enabled, setting this bit to 1 causes the CPU to vector to the UART0 interrupt service routine. This bit must be cleared manually by software. Note that RI0 will remain set to ‘1’ as long as there is data still in the UART FIFO. After the last byte has been shifted from the FIFO to SBUF0, RI0 can be cleared.

SFR Definition 23.2. SMOD0: Serial Port 0 Control

Bit	7	6	5	4	3	2	1	0
Name	MCE0	S0PT[1:0]		PE0	S0DL[1:0]		XBE0	SBL0
Type	R/W	R/W	R	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	1	1	0	0

SFR Address = 0xA9; SFR Page = 0x00

Bit	Name	Function
7	MCE0	**Multiprocessor Communication Enable.** 0: RI0 will be activated if stop bit(s) are 1. 1: RI0 will be activated if stop bit(s) and extra bit are 1. Extra bit must be enabled using XBE0.
6:5	S0PT[1:0]	**Parity Type Select Bits.** 00: Odd Parity 01: Even Parity 10: Mark Parity 11: Space Parity.
4	PE0	**Parity Enable.** This bit enables hardware parity generation and checking. The parity type is selected by bits S0PT[1:0] when parity is enabled. 0: Hardware parity is disabled. 1: Hardware parity is enabled.
3:2	S0DL[1:0]	**Data Length.** 00: 5-bit data 01: 6-bit data 10: 7-bit data 11: 8-bit data
1	XBE0	**Extra Bit Enable.** When enabled, the value of TBX0 will be appended to the data field 0: Extra Bit is disabled. 1: Extra Bit is enabled.
0	SBL0	**Stop Bit Length.** 0: Short—stop bit is active for one bit time 1: Long—stop bit is active for two bit times (data length = 6, 7, or 8 bits), or 1.5 bit times (data length = 5 bits).

SFR Definition 23.3. SBUF0: Serial (UART0) Port Data Buffer

Bit	7	6	5	4	3	2	1	0
Name	SBUF0[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x99; SFR Page = 0x00

Bit	Name	Function
7:0	SBUF0[7:0]	**Serial Data Buffer Bits 7–0 (MSB–LSB).** This SFR accesses two registers; a transmit shift register and a receive latch register. When data is written to SBUF0, it goes to the transmit shift register and is held for serial transmission. Writing a byte to SBUF0 initiates the transmission. A read of SBUF0 returns the contents of the receive latch.

SFR Definition 23.4. SBCON0: UART0 Baud Rate Generator Control

Bit	7	6	5	4	3	2	1	0
Name	Reserved	SB0RUN	Reserved	Reserved	Reserved	Reserved	SB0PS[1:0]	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xAB; SFR Page = 0x0F

Bit	Name	Function
7	Reserved	Read = 0b; Must Write 0b;
6	SB0RUN	**Baud Rate Generator Enable.** 0: Baud Rate Generator disabled. UART0 will not function. 1: Baud Rate Generator enabled.
5:2	Reserved	Read = 0000b; Must Write = 0000b;
1:0	SB0PS[1:0]	**Baud Rate Prescaler Select.** 00: Prescaler = 12. 01: Prescaler = 4. 10: Prescaler = 48. 11: Prescaler = 1.

SFR Definition 23.5. SBRLH0: UART0 Baud Rate Generator Reload High Byte

Bit	7	6	5	4	3	2	1	0
Name	SBRLH0[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xAD; SFR Page = 0x0F

Bit	Name	Function
7:0	SBRLH0[7:0]	**High Byte of Reload Value for UART0 Baud Rate Generator.** This value is loaded into the high byte of the UART0 baud rate generator when the counter overflows from 0xFFFF to 0x0000.

SFR Definition 23.6. SBRLL0: UART0 Baud Rate Generator Reload Low Byte

Bit	7	6	5	4	3	2	1	0
Name	SBRLL0[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xAC; SFR Page = 0x0F

Bit	Name	Function
7:0	SBRLL0[7:0]	**Low Byte of Reload Value for UART0 Baud Rate Generator.** This value is loaded into the low byte of the UART0 baud rate generator when the counter overflows from 0xFFFF to 0x0000.

24. Enhanced Serial Peripheral Interface (SPI0)

The Enhanced Serial Peripheral Interface (SPI0) provides access to a flexible, full-duplex synchronous serial bus. SPI0 can operate as a master or slave device in both 3-wire or 4-wire modes, and supports multiple masters and slaves on a single SPI bus. The slave-select (NSS) signal can be configured as an input to select SPI0 in slave mode, or to disable Master Mode operation in a multi-master environment, avoiding contention on the SPI bus when more than one master attempts simultaneous data transfers. NSS can also be configured as a chip-select output in master mode, or disabled for 3-wire operation. Additional general purpose port I/O pins can be used to select multiple slave devices in master mode.

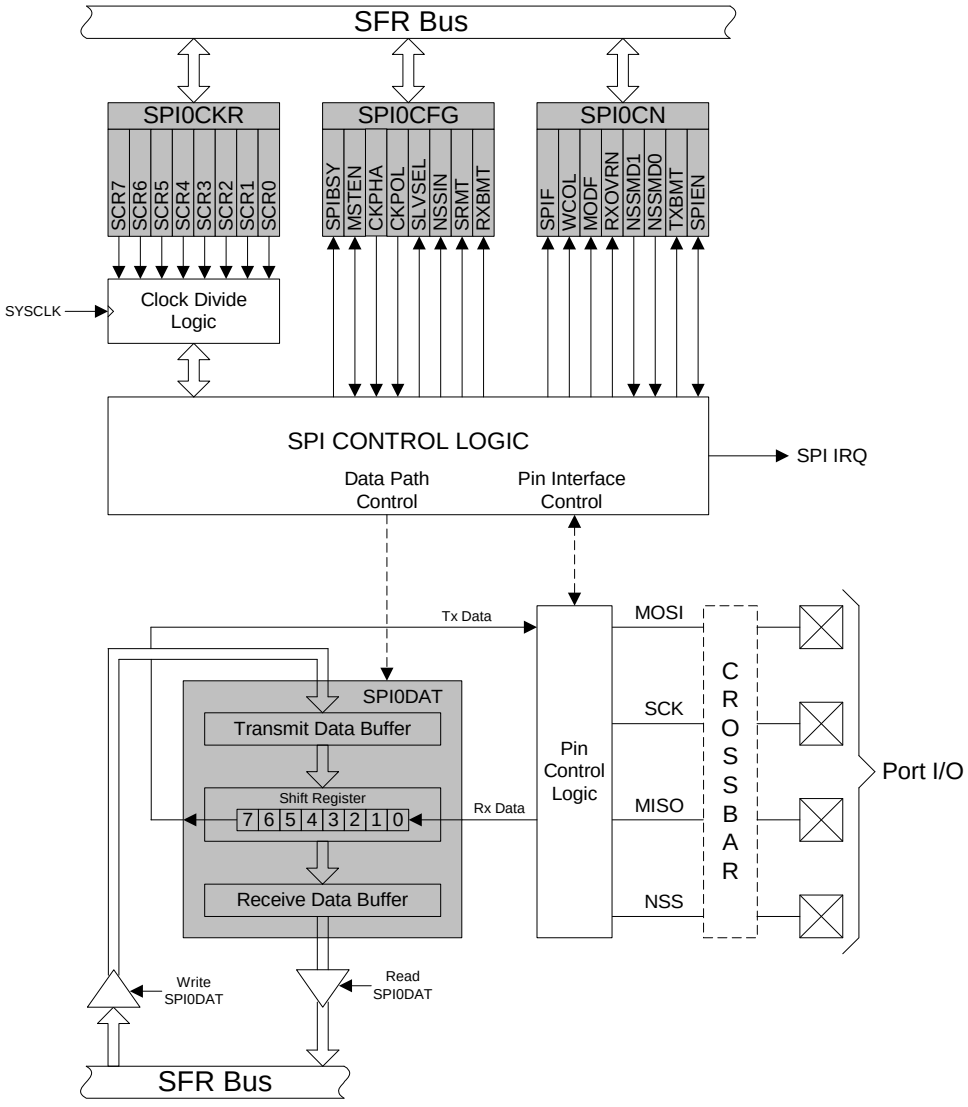


Figure 24.1. SPI Block Diagram

24.1. Signal Descriptions

The four signals used by SPI0 (MOSI, MISO, SCK, NSS) are described below.

24.1.1. Master Out, Slave In (MOSI)

The master-out, slave-in (MOSI) signal is an output from a master device and an input to slave devices. It is used to serially transfer data from the master to the slave. This signal is an output when SPI0 is operating as a master and an input when SPI0 is operating as a slave. Data is transferred most-significant bit first. When configured as a master, MOSI is driven by the MSB of the shift register in both 3- and 4-wire mode.

24.1.2. Master In, Slave Out (MISO)

The master-in, slave-out (MISO) signal is an output from a slave device and an input to the master device. It is used to serially transfer data from the slave to the master. This signal is an input when SPI0 is operating as a master and an output when SPI0 is operating as a slave. Data is transferred most-significant bit first. The MISO pin is placed in a high-impedance state when the SPI module is disabled and when the SPI operates in 4-wire mode as a slave that is not selected. When acting as a slave in 3-wire mode, MISO is always driven by the MSB of the shift register.

24.1.3. Serial Clock (SCK)

The serial clock (SCK) signal is an output from the master device and an input to slave devices. It is used to synchronize the transfer of data between the master and slave on the MOSI and MISO lines. SPI0 generates this signal when operating as a master. The SCK signal is ignored by a SPI slave when the slave is not selected (NSS = 1) in 4-wire slave mode.

24.1.4. Slave Select (NSS)

The function of the slave-select (NSS) signal is dependent on the setting of the NSSMD1 and NSSMD0 bits in the SPI0CN register. There are three possible modes that can be selected with these bits:

1. NSSMD[1:0] = 00: 3-Wire Master or 3-Wire Slave Mode: SPI0 operates in 3-wire mode, and NSS is disabled. When operating as a slave device, SPI0 is always selected in 3-wire mode. Since no select signal is present, SPI0 must be the only slave on the bus in 3-wire mode. This is intended for point-to-point communication between a master and one slave.
2. NSSMD[1:0] = 01: 4-Wire Slave or Multi-Master Mode: SPI0 operates in 4-wire mode, and NSS is enabled as an input. When operating as a slave, NSS selects the SPI0 device. When operating as a master, a 1-to-0 transition of the NSS signal disables the master function of SPI0 so that multiple master devices can be used on the same SPI bus.
3. NSSMD[1:0] = 1x: 4-Wire Master Mode: SPI0 operates in 4-wire mode, and NSS is enabled as an output. The setting of NSSMD0 determines what logic level the NSS pin will output. This configuration should only be used when operating SPI0 as a master device.

See Figure 24.2, Figure 24.3, and Figure 24.4 for typical connection diagrams of the various operational modes. **Note that the setting of NSSMD bits affects the pinout of the device.** When in 3-wire master or 3-wire slave mode, the NSS pin will not be mapped by the crossbar. In all other modes, the NSS signal will be mapped to a pin on the device. See Section “19. Port Input/Output” on page 169 for general purpose port I/O and crossbar information.

24.2. SPI0 Master Mode Operation

A SPI master device initiates all data transfers on a SPI bus. SPI0 is placed in master mode by setting the Master Enable flag (MSTEN, SPI0CN.6). Writing a byte of data to the SPI0 data register (SPI0DAT) when in master mode writes to the transmit buffer. If the SPI shift register is empty, the byte in the transmit buffer is moved to the shift register, and a data transfer begins. The SPI0 master immediately shifts out the data serially on the MOSI line while providing the serial clock on SCK. The SPIF (SPI0CN.7) flag is set to logic 1 at the end of the transfer. If interrupts are enabled, an interrupt request is generated when the SPIF flag is set. While the SPI0 master transfers data to a slave on the MOSI line, the addressed SPI slave device simultaneously transfers the contents of its shift register to the SPI master on the MISO line in a full-duplex operation. Therefore, the SPIF flag serves as both a transmit-complete and receive-data-ready flag. The data byte received from the slave is transferred MSB-first into the master's shift register. When a byte is fully shifted into the register, it is moved to the receive buffer where it can be read by the processor by reading SPI0DAT.

When configured as a master, SPI0 can operate in one of three different modes: multi-master mode, 3-wire single-master mode, and 4-wire single-master mode. The default, multi-master mode is active when NSSMD1 (SPI0CN.3) = 0 and NSSMD0 (SPI0CN.2) = 1. In this mode, NSS is an input to the device, and is used to disable the master SPI0 when another master is accessing the bus. When NSS is pulled low in this mode, MSTEN (SPI0CN.6) and SPIEN (SPI0CN.0) are set to 0 to disable the SPI master device, and a Mode Fault is generated (MODF, SPI0CN.5 = 1). Mode Fault will generate an interrupt if enabled. SPI0 must be manually re-enabled in software under these circumstances. In multi-master systems, devices will typically default to being slave devices while they are not acting as the system master device. In multi-master mode, slave devices can be addressed individually (if needed) using general-purpose I/O pins. Figure 24.2 shows a connection diagram between two master devices in multiple-master mode.

3-wire single-master mode is active when NSSMD1 (SPI0CN.3) = 0 and NSSMD0 (SPI0CN.2) = 0. In this mode, NSS is not used, and is not mapped to an external port pin through the crossbar. Any slave devices that must be addressed in this mode should be selected using general-purpose I/O pins. Figure 24.3 shows a connection diagram between a master device in 3-wire master mode and a slave device.

4-wire single-master mode is active when NSSMD1 (SPI0CN.3) = 1. In this mode, NSS is configured as an output pin, and can be used as a slave-select signal for a single SPI device. In this mode, the output value of NSS is controlled (in software) with the bit NSSMD0 (SPI0CN.2). Additional slave devices can be addressed using general-purpose I/O pins. Figure 24.4 shows a connection diagram for a master device in 4-wire master mode and two slave devices.

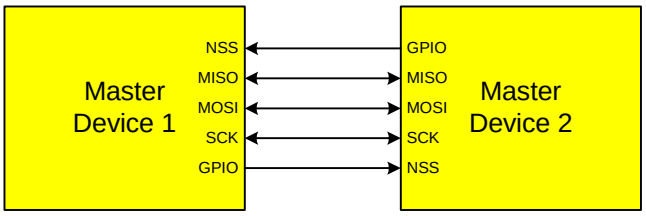


Figure 24.2. Multiple-Master Mode Connection Diagram

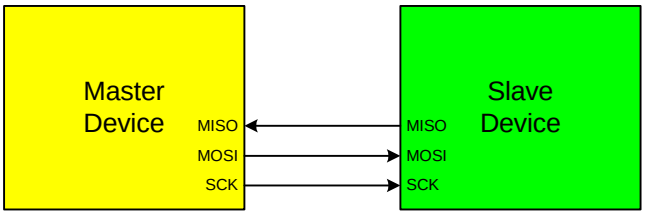


Figure 24.3. 3-Wire Single Master and 3-Wire Single Slave Mode Connection Diagram

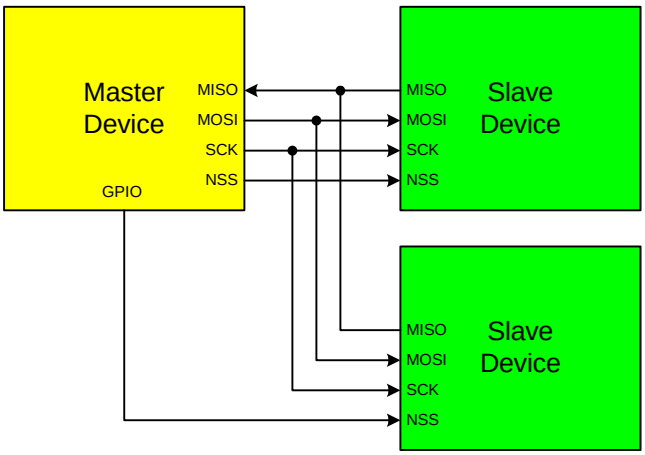


Figure 24.4. 4-Wire Single Master Mode and 4-Wire Slave Mode Connection Diagram

24.3. SPI0 Slave Mode Operation

When SPI0 is enabled and not configured as a master, it will operate as a SPI slave. As a slave, bytes are shifted in through the MOSI pin and out through the MISO pin by a master device controlling the SCK signal. A bit counter in the SPI0 logic counts SCK edges. When 8 bits have been shifted through the shift register, the SPIF flag is set to logic 1, and the byte is copied into the receive buffer. Data is read from the receive buffer by reading SPI0DAT. A slave device cannot initiate transfers. Data to be transferred to the master device is pre-loaded into the shift register by writing to SPI0DAT. Writes to SPI0DAT are double-buffered, and are placed in the transmit buffer first. If the shift register is empty, the contents of the transmit buffer will immediately be transferred into the shift register. When the shift register already contains data, the SPI will load the shift register with the transmit buffer's contents after the last SCK edge of the next (or current) SPI transfer.

When configured as a slave, SPI0 can be configured for 4-wire or 3-wire operation. The default, 4-wire slave mode, is active when NSSMD1 (SPI0CN.3) = 0 and NSSMD0 (SPI0CN.2) = 1. In 4-wire mode, the NSS signal is routed to a port pin and configured as a digital input. SPI0 is enabled when NSS is logic 0, and disabled when NSS is logic 1. The bit counter is reset on a falling edge of NSS. Note that the NSS signal must be driven low at least 2 system clocks before the first active edge of SCK for each byte transfer. Figure 24.4 shows a connection diagram between two slave devices in 4-wire slave mode and a master device.

3-wire slave mode is active when NSSMD1 (SPI0CN.3) = 0 and NSSMD0 (SPI0CN.2) = 0. NSS is not used in this mode, and is not mapped to an external port pin through the crossbar. Since there is no way of uniquely addressing the device in 3-wire slave mode, SPI0 must be the only slave device present on the bus. It is important to note that in 3-wire slave mode there is no external means of resetting the bit counter that determines when a full byte has been received. The bit counter can only be reset by disabling and re-enabling SPI0 with the SPIEN bit. Figure 24.3 shows a connection diagram between a slave device in 3-wire slave mode and a master device.

24.4. SPI0 Interrupt Sources

When SPI0 interrupts are enabled, the following four flags will generate an interrupt when they are set to logic 1:

All of the following bits must be cleared by software.

1. The SPI Interrupt Flag, SPIF (SPI0CN.7) is set to logic 1 at the end of each byte transfer. This flag can occur in all SPI0 modes.
2. The Write Collision Flag, WCOL (SPI0CN.6) is set to logic 1 if a write to SPI0DAT is attempted when the transmit buffer has not been emptied to the SPI shift register. When this occurs, the write to SPI0DAT will be ignored, and the transmit buffer will not be written.This flag can occur in all SPI0 modes.
3. The Mode Fault Flag MODF (SPI0CN.5) is set to logic 1 when SPI0 is configured as a master, and for multi-master mode and the NSS pin is pulled low. When a Mode Fault occurs, the MSTEN and SPIEN bits in SPI0CN are set to logic 0 to disable SPI0 and allow another master device to access the bus.
4. The Receive Overrun Flag RXOVRN (SPI0CN.4) is set to logic 1 when configured as a slave, and a transfer is completed and the receive buffer still holds an unread byte from a previous transfer. The new byte is not transferred to the receive buffer, allowing the previously received data byte to be read. The data byte which caused the overrun is lost.

24.5. Serial Clock Phase and Polarity

Four combinations of serial clock phase and polarity can be selected using the clock control bits in the SPI0 Configuration Register (SPI0CFG). The CKPHA bit (SPI0CFG.5) selects one of two clock phases (edge used to latch the data). The CKPOL bit (SPI0CFG.4) selects between an active-high or active-low clock. Both master and slave devices must be configured to use the same clock phase and polarity. SPI0 should be disabled (by clearing the SPIEN bit, SPI0CN.0) when changing the clock phase or polarity. The clock and data line relationships for master mode are shown in Figure 24.5. For slave mode, the clock and data relationships are shown in Figure 24.6 and Figure 24.7. CKPHA must be set to 0 on both the master and slave SPI when communicating between two of the following devices: C8051F04x, C8051F06x, C8051F12x, C8051F31x, C8051F32x, and C8051F33x.

The SPI0 Clock Rate Register (SPI0CKR) as shown in SFR Definition 24.3 controls the master mode serial clock frequency. This register is ignored when operating in slave mode. When the SPI is configured as a master, the maximum data transfer rate (bits/sec) is one-half the system clock frequency or 12.5 MHz, whichever is slower. When the SPI is configured as a slave, the maximum data transfer rate (bits/sec) for full-duplex operation is 1/10 the system clock frequency, provided that the master issues SCK, NSS (in 4-wire slave mode), and the serial input data synchronously with the slave's system clock. If the master issues SCK, NSS, and the serial input data asynchronously, the maximum data transfer rate (bits/sec) must be less than 1/10 the system clock frequency. In the special case where the master only wants to transmit data to the slave and does not need to receive data from the slave (i.e. half-duplex operation), the SPI slave can receive data at a maximum data transfer rate (bits/sec) of 1/4 the system clock frequency. This is provided that the master issues SCK, NSS, and the serial input data synchronously with the slave's system clock.

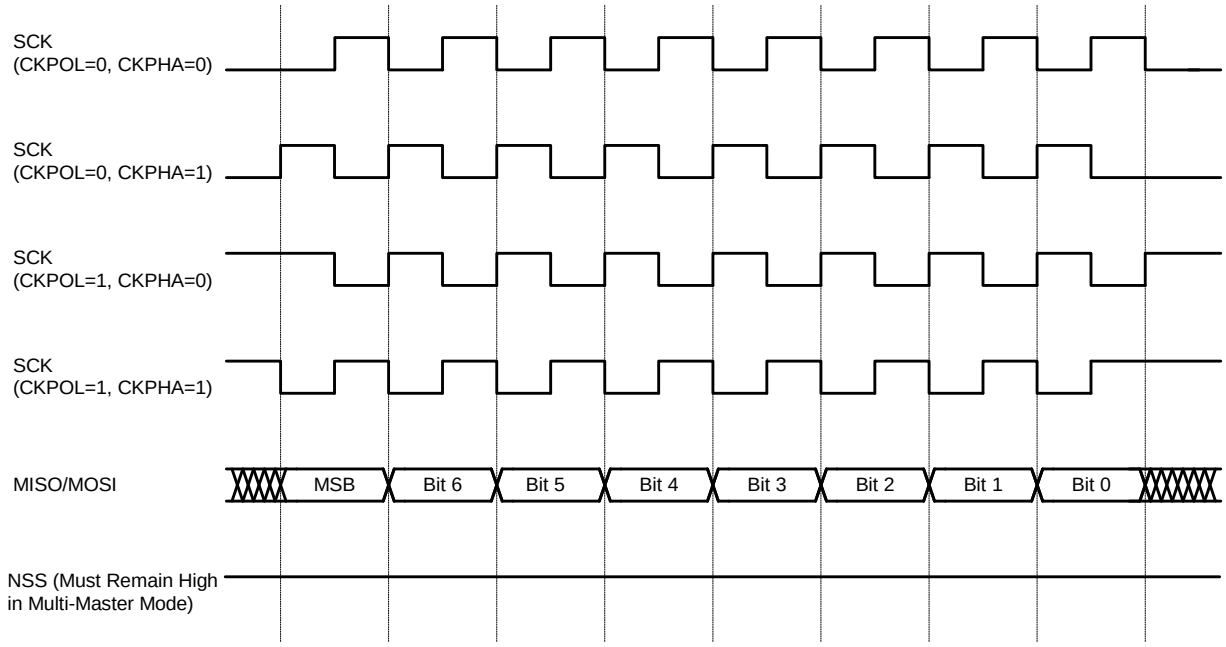


Figure 24.5. Master Mode Data/Clock Timing

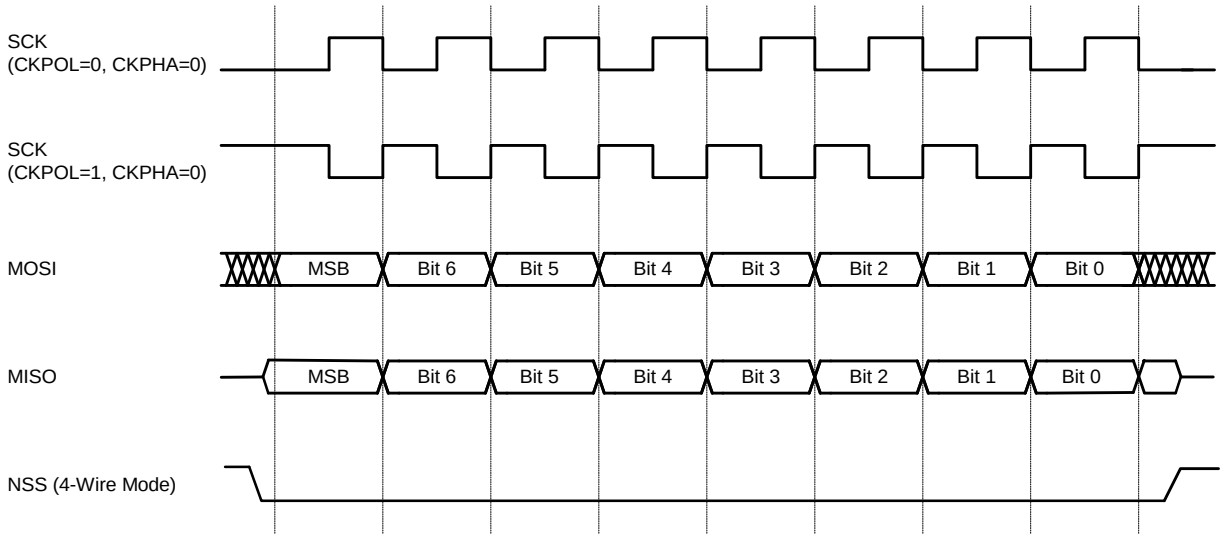


Figure 24.6. Slave Mode Data/Clock Timing (CKPHA = 0)

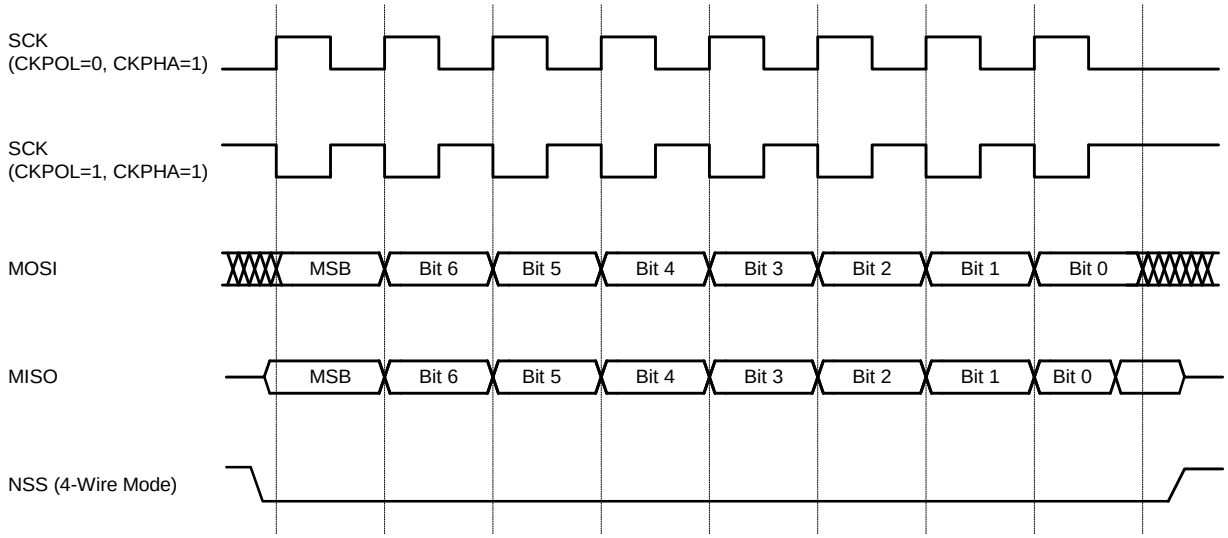


Figure 24.7. Slave Mode Data/Clock Timing (CKPHA = 1)

24.6. SPI Special Function Registers

SPI0 is accessed and controlled through four special function registers in the system controller: SPI0CN Control Register, SPI0DAT Data Register, SPI0CFG Configuration Register, and SPI0CKR Clock Rate Register. The four special function registers related to the operation of the SPI0 Bus are described in the following figures.

SFR Definition 24.1. SPI0CFG: SPI0 Configuration

Bit	7	6	5	4	3	2	1	0
Name	SPIBSY	MSTEN	CKPHA	CKPOL	SLVSEL	NSSIN	SRMT	RXBMT
Type	R	R/W	R/W	R/W	R	R	R	R
Reset	0	0	0	0	0	1	1	1

SFR Address = 0xA1; SFR Page = 0x00

Bit	Name	Function
7	SPIBSY	**SPI Busy.** This bit is set to logic 1 when a SPI transfer is in progress (master or slave mode).
6	MSTEN	**Master Mode Enable.** 0: Disable master mode. Operate in slave mode. 1: Enable master mode. Operate as a master.
5	CKPHA	**SPI0 Clock Phase.** 0: Data centered on first edge of SCK period.* 1: Data centered on second edge of SCK period.*
4	CKPOL	**SPI0 Clock Polarity.** 0: SCK line low in idle state. 1: SCK line high in idle state.
3	SLVSEL	**Slave Selected Flag.** This bit is set to logic 1 whenever the NSS pin is low indicating SPI0 is the selected slave. It is cleared to logic 0 when NSS is high (slave not selected). This bit does not indicate the instantaneous value at the NSS pin, but rather a de-glitched version of the pin input.
2	NSSIN	**NSS Instantaneous Pin Input.** This bit mimics the instantaneous value that is present on the NSS port pin at the time that the register is read. This input is not de-glitched.
1	SRMT	**Shift Register Empty (valid in slave mode only).** This bit will be set to logic 1 when all data has been transferred in/out of the shift register, and there is no new information available to read from the transmit buffer or write to the receive buffer. It returns to logic 0 when a data byte is transferred to the shift register from the transmit buffer or by a transition on SCK. SRMT = 1 when in Master Mode.
0	RXBMT	**Receive Buffer Empty (valid in slave mode only).** This bit will be set to logic 1 when the receive buffer has been read and contains no new information. If there is new information available in the receive buffer that has not been read, this bit will return to logic 0. RXBMT = 1 when in Master Mode.

Note: In slave mode, data on MOSI is sampled in the center of each data bit. In master mode, data on MISO is sampled one SYSCLK before the end of each data bit, to provide maximum settling time for the slave device. See Table 24.1 for timing parameters.

SFR Definition 24.2. SPI0CN: SPI0 Control

Bit	7	6	5	4	3	2	1	0
Name	SPIF	WCOL	MODF	RXOVRN	NSSMD[1:0]		TXBMT	SPIEN
Type	R/W	R/W	R/W	R/W	R/W		R	R/W
Reset	0	0	0	0	0	1	1	0

SFR Address = 0xF8; Bit-Addressable; SFR Page = 0x00

Bit	Name	Function
7	SPIF	**SPI0 Interrupt Flag.** This bit is set to logic 1 by hardware at the end of a data transfer. If interrupts are enabled, setting this bit causes the CPU to vector to the SPI0 interrupt service routine. This bit is not automatically cleared by hardware. It must be cleared by software.
6	WCOL	**Write Collision Flag.** This bit is set to logic 1 by hardware (and generates a SPI0 interrupt) to indicate a write to the SPI0 data register was attempted while a data transfer was in progress. It must be cleared by software.
5	MODF	**Mode Fault Flag.** This bit is set to logic 1 by hardware (and generates a SPI0 interrupt) when a master mode collision is detected (NSS is low, MSTEN = 1, and NSSMD[1:0] = 01). This bit is not automatically cleared by hardware. It must be cleared by software.
4	RXOVRN	**Receive Overrun Flag (valid in slave mode only).** This bit is set to logic 1 by hardware (and generates a SPI0 interrupt) when the receive buffer still holds unread data from a previous transfer and the last bit of the current transfer is shifted into the SPI0 shift register. This bit is not automatically cleared by hardware. It must be cleared by software.
3:2	NSSMD[1:0]	**Slave Select Mode.** Selects between the following NSS operation modes: (See Section 24.2 and Section 24.3). 00: 3-Wire Slave or 3-Wire Master Mode. NSS signal is not routed to a port pin. 01: 4-Wire Slave or Multi-Master Mode (Default). NSS is an input to the device. 1x: 4-Wire Single-Master Mode. NSS signal is mapped as an output from the device and will assume the value of NSSMD0.
1	TXBMT	**Transmit Buffer Empty.** This bit will be set to logic 0 when new data has been written to the transmit buffer. When data in the transmit buffer is transferred to the SPI shift register, this bit will be set to logic 1, indicating that it is safe to write a new byte to the transmit buffer.
0	SPIEN	**SPI0 Enable.** 0: SPI disabled. 1: SPI enabled.

SFR Definition 24.3. SPI0CKR: SPI0 Clock Rate

Bit	7	6	5	4	3	2	1	0
Name	SCR[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA2; SFR Page = 0x00

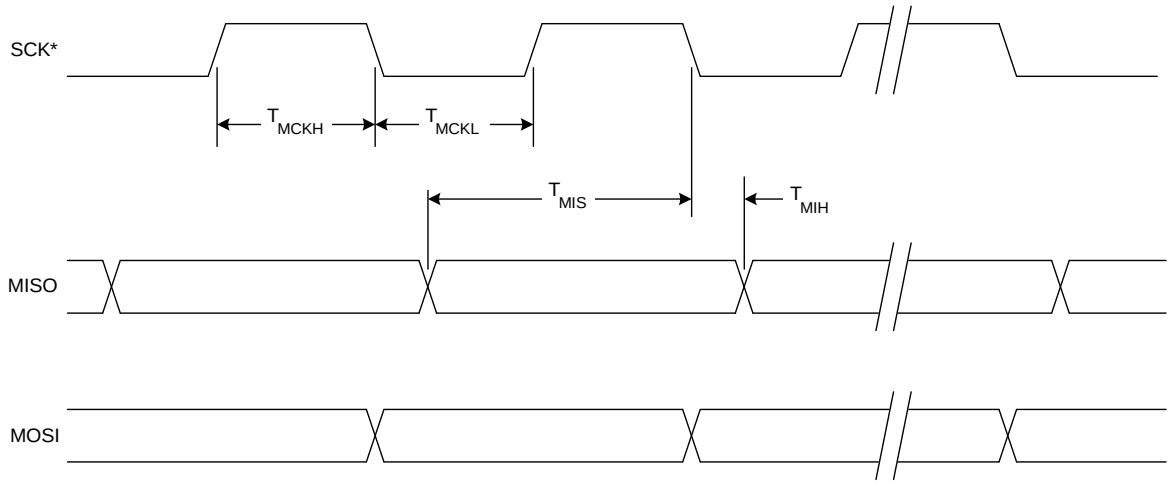
Bit	Name	Function
7:0	SCR[7:0]	**SPI0 Clock Rate.** These bits determine the frequency of the SCK output when the SPI0 module is configured for master mode operation. The SCK clock frequency is a divided version of the system clock, and is given in the following equation, where SYSCLK is the system clock frequency and SPI0CKR is the 8-bit value held in the SPI0CKR register. $f_{SCK} = \frac{SYSCLK}{2 \times (SPI0CKR[7:0] + 1)}$ for 0 <= SPI0CKR <= 255 Example: If SYSCLK = 2 MHz and SPI0CKR = 0x04, $f_{SCK} = \frac{2000000}{2 \times (4 + 1)}$ $f_{SCK} = 200\ kHz$

SFR Definition 24.4. SPI0DAT: SPI0 Data

Bit	7	6	5	4	3	2	1	0
Name	SPI0DAT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

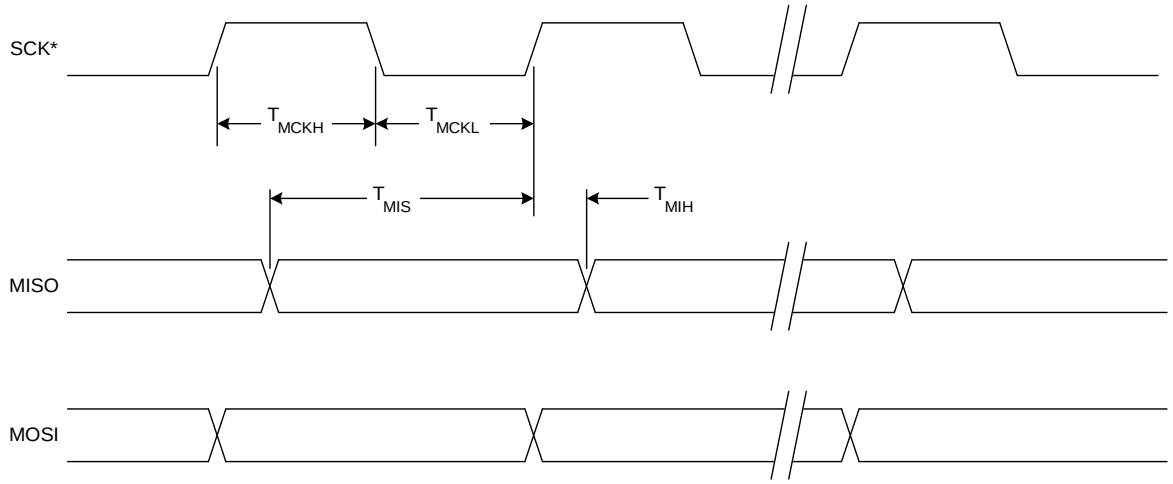
SFR Address = 0xA3; SFR Page = 0x00

Bit	Name	Function
7:0	SPI0DAT[7:0]	**SPI0 Transmit and Receive Data.** The SPI0DAT register is used to transmit and receive SPI0 data. Writing data to SPI0DAT places the data into the transmit buffer and initiates a transfer when in Master Mode. A read of SPI0DAT returns the contents of the receive buffer.



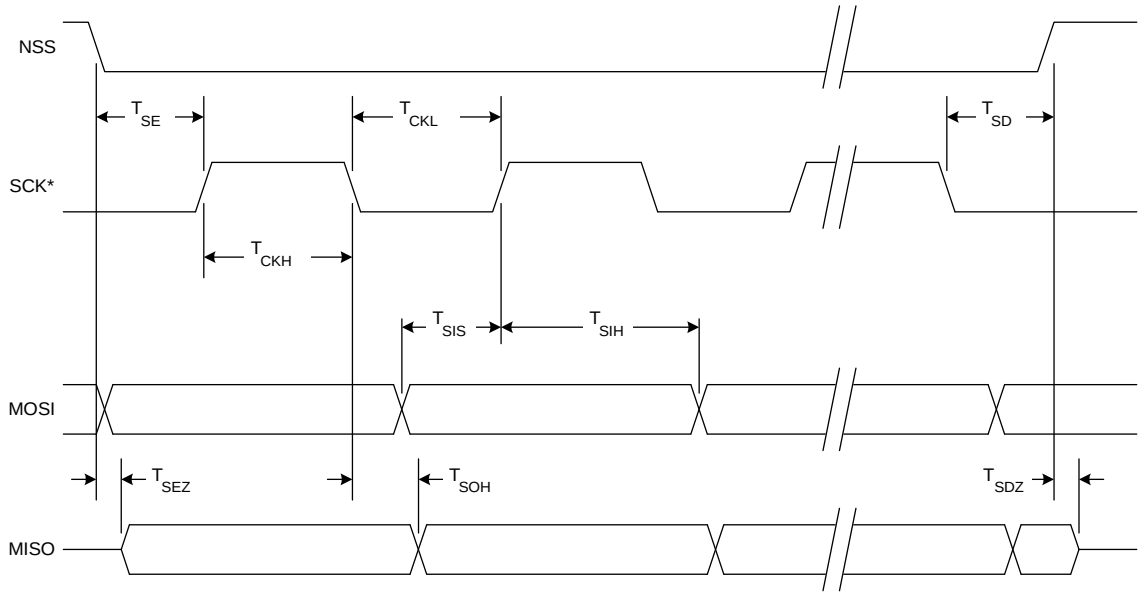
* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.

Figure 24.8. SPI Master Timing (CKPHA = 0)



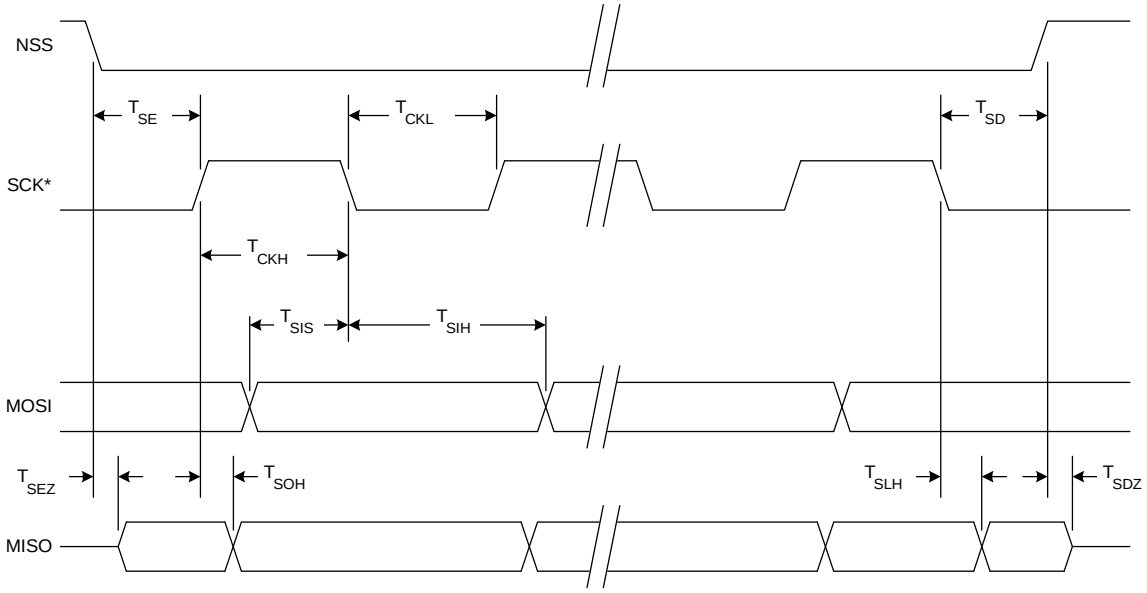
* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.

Figure 24.9. SPI Master Timing (CKPHA = 1)



* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.

Figure 24.10. SPI Slave Timing (CKPHA = 0)



* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.

Figure 24.11. SPI Slave Timing (CKPHA = 1)

Table 24.1. SPI Slave Timing Parameters

Parameter	Description	Min	Max	Units
Master Mode Timing* (See Figure 24.8 and Figure 24.9)				
T_{MCKH}	SCK High Time	1 x T_{SYSCLK}	—	ns
T_{MCKL}	SCK Low Time	1 x T_{SYSCLK}	—	ns
T_{MIS}	MISO Valid to SCK Shift Edge	1 x T_{SYSCLK} + 20	—	ns
T_{MIH}	SCK Shift Edge to MISO Change	0	—	ns
Slave Mode Timing* (See Figure 24.10 and Figure 24.11)				
T_{SE}	NSS Falling to First SCK Edge	2 x T_{SYSCLK}	—	ns
T_{SD}	Last SCK Edge to NSS Rising	2 x T_{SYSCLK}	—	ns
T_{SEZ}	NSS Falling to MISO Valid	—	4 x T_{SYSCLK}	ns
T_{SDZ}	NSS Rising to MISO High-Z	—	4 x T_{SYSCLK}	ns
T_{CKH}	SCK High Time	5 x T_{SYSCLK}	—	ns
T_{CKL}	SCK Low Time	5 x T_{SYSCLK}	—	ns
T_{SIS}	MOSI Valid to SCK Sample Edge	2 x T_{SYSCLK}	—	ns
T_{SIH}	SCK Sample Edge to MOSI Change	2 x T_{SYSCLK}	—	ns
T_{SOH}	SCK Shift Edge to MISO Change	—	4 x T_{SYSCLK}	ns
T_{SLH}	Last SCK Edge to MISO Change (CKPHA = 1 ONLY)	6 x T_{SYSCLK}	8 x T_{SYSCLK}	ns

***Note:** T_{SYSCLK} is equal to one period of the device system clock (SYSCLK).

25. Timers

Each MCU includes four counter/timers: two are 16-bit counter/timers compatible with those found in the standard 8051, and two are 16-bit auto-reload timer for use with the ADC, SMBus, or for general purpose use. These timers can be used to measure time intervals, count external events and generate periodic interrupt requests. Timer 0 and Timer 1 are nearly identical and have four primary modes of operation. Timer 2 and Timer 3 offer 16-bit and split 8-bit timer functionality with auto-reload.

Timer 0 and Timer 1 Modes	Timer 2 Modes	Timer 3 Modes
13-bit counter/timer	16-bit timer with auto-reload	16-bit timer with auto-reload
16-bit counter/timer		
8-bit counter/timer with auto-reload	Two 8-bit timers with auto-reload	Two 8-bit timers with auto-reload
Two 8-bit counter/timers (Timer 0 only)		

Timers 0 and 1 may be clocked by one of five sources, determined by the Timer Mode Select bits (T1M–T0M) and the Clock Scale bits (SCA1–SCA0). The Clock Scale bits define a pre-scaled clock from which Timer 0 and/or Timer 1 may be clocked (See SFR Definition 25.1 for pre-scaled clock selection).Timer 0/1 may then be configured to use this pre-scaled clock signal or the system clock.

Timer 2 and Timer 3 may be clocked by the system clock, the system clock divided by 12, or the external oscillator clock source divided by 8.

Timer 0 and Timer 1 may also be operated as counters. When functioning as a counter, a counter/timer register is incremented on each high-to-low transition at the selected input pin (T0 or T1). Events with a frequency of up to one-fourth the system clock frequency can be counted. The input signal need not be periodic, but it should be held at a given level for at least two full system clock cycles to ensure the level is properly sampled.

SFR Definition 25.1. CKCON: Clock Control

Bit	7	6	5	4	3	2	1	0
Name	T3MH	T3ML	T2MH	T2ML	T1M	T0M	SCA[1:0]	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8E; SFR Page = All Pages

Bit	Name	Function
7	T3MH	**Timer 3 High Byte Clock Select.** Selects the clock supplied to the Timer 3 high byte (split 8-bit timer mode only). 0: Timer 3 high byte uses the clock defined by the T3XCLK bit in TMR3CN. 1: Timer 3 high byte uses the system clock.
6	T3ML	**Timer 3 Low Byte Clock Select.** Selects the clock supplied to Timer 3. Selects the clock supplied to the lower 8-bit timer in split 8-bit timer mode. 0: Timer 3 low byte uses the clock defined by the T3XCLK bit in TMR3CN. 1: Timer 3 low byte uses the system clock.
5	T2MH	**Timer 2 High Byte Clock Select.** Selects the clock supplied to the Timer 2 high byte (split 8-bit timer mode only). 0: Timer 2 high byte uses the clock defined by the T2XCLK bit in TMR2CN. 1: Timer 2 high byte uses the system clock.
4	T2ML	**Timer 2 Low Byte Clock Select.** Selects the clock supplied to Timer 2. If Timer 2 is configured in split 8-bit timer mode, this bit selects the clock supplied to the lower 8-bit timer. 0: Timer 2 low byte uses the clock defined by the T2XCLK bit in TMR2CN. 1: Timer 2 low byte uses the system clock.
3	T1	**Timer 1 Clock Select.** Selects the clock source supplied to Timer 1. Ignored when C/T1 is set to 1. 0: Timer 1 uses the clock defined by the prescale bits SCA[1:0]. 1: Timer 1 uses the system clock.
2	T0	**Timer 0 Clock Select.** Selects the clock source supplied to Timer 0. Ignored when C/T0 is set to 1. 0: Counter/Timer 0 uses the clock defined by the prescale bits SCA[1:0]. 1: Counter/Timer 0 uses the system clock.
1:0	SCA[1:0]	**Timer 0/1 Prescale Bits.** These bits control the Timer 0/1 Clock Prescaler: 00: System clock divided by 12 01: System clock divided by 4 10: System clock divided by 48 11: External clock divided by 8 (synchronized with the system clock)

25.1. Timer 0 and Timer 1

Each timer is implemented as a 16-bit register accessed as two separate bytes: a low byte (TL0 or TL1) and a high byte (TH0 or TH1). The Counter/Timer Control register (TCON) is used to enable Timer 0 and Timer 1 as well as indicate status. Timer 0 interrupts can be enabled by setting the ET0 bit in the IE register (Section “13.2. Interrupt Register Descriptions” on page 115); Timer 1 interrupts can be enabled by setting the ET1 bit in the IE register (Section “13.2. Interrupt Register Descriptions” on page 115). Both counter/timers operate in one of four primary modes selected by setting the Mode Select bits T1M1–T0M0 in the Counter/Timer Mode register (TMOD). Each timer can be configured independently. Each operating mode is described below.

25.1.1. Mode 0: 13-bit Counter/Timer

Timer 0 and Timer 1 operate as 13-bit counter/timers in Mode 0. The following describes the configuration and operation of Timer 0. However, both timers operate identically, and Timer 1 is configured in the same manner as described for Timer 0.

The TH0 register holds the eight MSBs of the 13-bit counter/timer. TL0 holds the five LSBs in bit positions TL0.4–TL0.0. The three upper bits of TL0 (TL0.7–TL0.5) are indeterminate and should be masked out or ignored when reading. As the 13-bit timer register increments and overflows from 0x1FFF (all ones) to 0x0000, the timer overflow flag TF0 (TCON.5) is set and an interrupt will occur if Timer 0 interrupts are enabled.

The C/T0 bit (TMOD.2) selects the counter/timer's clock source. When C/T0 is set to logic 1, high-to-low transitions at the selected Timer 0 input pin (T0) increment the timer register (Refer to Section “19.3. Priority Crossbar Decoder” on page 172 for information on selecting and configuring external I/O pins). Clearing C/T selects the clock defined by the T0M bit (CKCON.3). When T0M is set, Timer 0 is clocked by the system clock. When T0M is cleared, Timer 0 is clocked by the source selected by the Clock Scale bits in CKCON (see SFR Definition 25.1).

Setting the TR0 bit (TCON.4) enables the timer when either GATE0 (TMOD.3) is logic 0 or the input signal $\overline{\text{INT0}}$ is active as defined by bit IN0PL in register IT01CF (see SFR Definition 13.7). Setting GATE0 to 1 allows the timer to be controlled by the external input signal $\overline{\text{INT0}}$ (see Section “13.2. Interrupt Register Descriptions” on page 115), facilitating pulse width measurements.

TR0	GATE0	$\overline{\text{INT0}}$	Counter/Timer
0	X	X	Disabled
1	0	X	Enabled
1	1	0	Disabled
1	1	1	Enabled
Note: X = Don't Care			

Setting TR0 does not force the timer to reset. The timer registers should be loaded with the desired initial value before the timer is enabled.

TL1 and TH1 form the 13-bit register for Timer 1 in the same manner as described above for TL0 and TH0. Timer 1 is configured and controlled using the relevant TCON and TMOD bits just as with Timer 0. The input signal $\overline{\text{INT1}}$ is used with Timer 1; the $\overline{\text{INT1}}$ polarity is defined by bit IN1PL in register IT01CF (see SFR Definition 13.7).

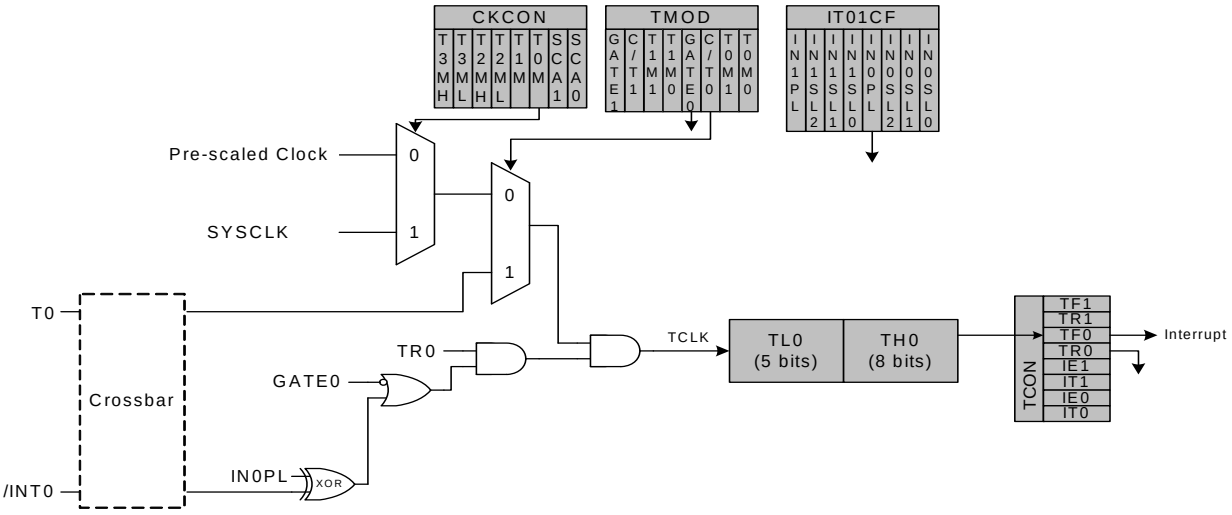


Figure 25.1. T0 Mode 0 Block Diagram

25.1.2. Mode 1: 16-bit Counter/Timer

Mode 1 operation is the same as Mode 0, except that the counter/timer registers use all 16 bits. The counter/timers are enabled and configured in Mode 1 in the same manner as for Mode 0.

25.1.3. Mode 2: 8-bit Counter/Timer with Auto-Reload

Mode 2 configures Timer 0 and Timer 1 to operate as 8-bit counter/timers with automatic reload of the start value. TL0 holds the count and TH0 holds the reload value. When the counter in TL0 overflows from all ones to 0x00, the timer overflow flag TF0 (TCON.5) is set and the counter in TL0 is reloaded from TH0. If Timer 0 interrupts are enabled, an interrupt will occur when the TF0 flag is set. The reload value in TH0 is not changed. TL0 must be initialized to the desired value before enabling the timer for the first count to be correct. When in Mode 2, Timer 1 operates identically to Timer 0.

Both counter/timers are enabled and configured in Mode 2 in the same manner as Mode 0. Setting the TR0 bit (TCON.4) enables the timer when either GATE0 (TMOD.3) is logic 0 or when the input signal INT0 is active as defined by bit IN0PL in register IT01CF (see Section “13.3. External Interrupts INT0 and INT1” on page 122 for details on the external input signals INT0 and INT1).

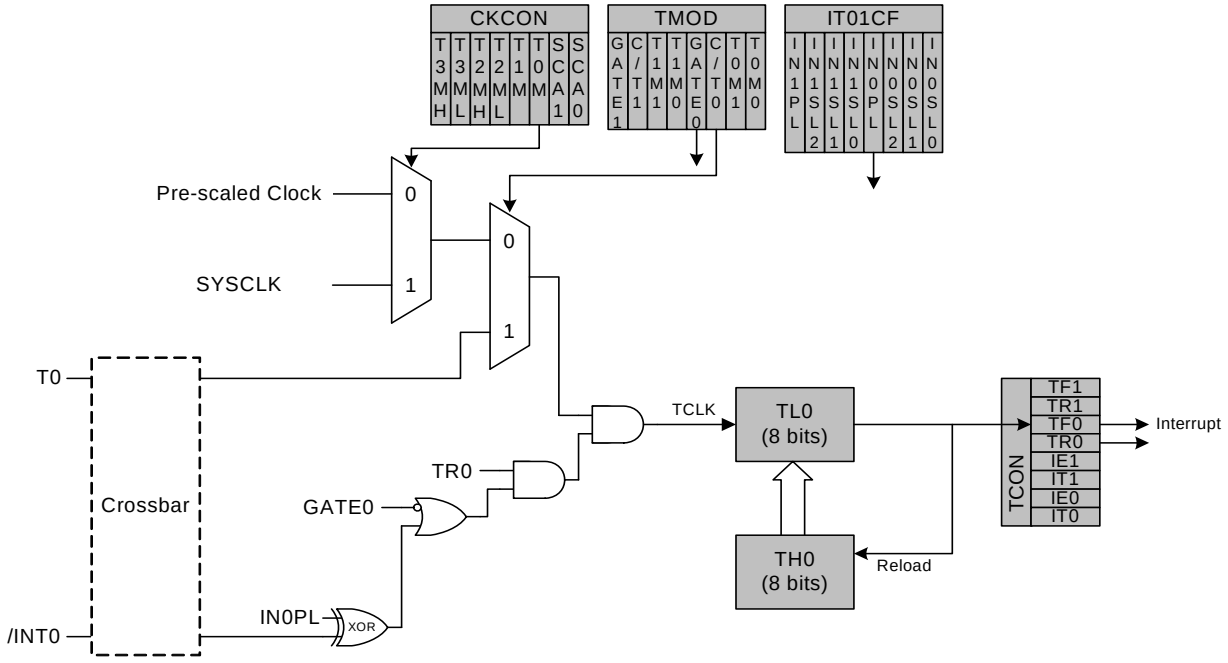


Figure 25.2. T0 Mode 2 Block Diagram

25.1.4. Mode 3: Two 8-bit Counter/Timers (Timer 0 Only)

In Mode 3, Timer 0 is configured as two separate 8-bit counter/timers held in TL0 and TH0. The counter/timer in TL0 is controlled using the Timer 0 control/status bits in TCON and TMOD: TR0, C/T0, GATE0 and TF0. TL0 can use either the system clock or an external input signal as its timebase. The TH0 register is restricted to a timer function sourced by the system clock or prescaled clock. TH0 is enabled using the Timer 1 run control bit TR1. TH0 sets the Timer 1 overflow flag TF1 on overflow and thus controls the Timer 1 interrupt.

Timer 1 is inactive in Mode 3. When Timer 0 is operating in Mode 3, Timer 1 can be operated in Modes 0, 1 or 2, but cannot be clocked by external signals nor set the TF1 flag and generate an interrupt. However, the Timer 1 overflow can be used to generate baud rates for the SMBus and/or UART, and/or initiate ADC conversions. While Timer 0 is operating in Mode 3, Timer 1 run control is handled through its mode settings. To run Timer 1 while Timer 0 is in Mode 3, set the Timer 1 Mode as 0, 1, or 2. To disable Timer 1, configure it for Mode 3.

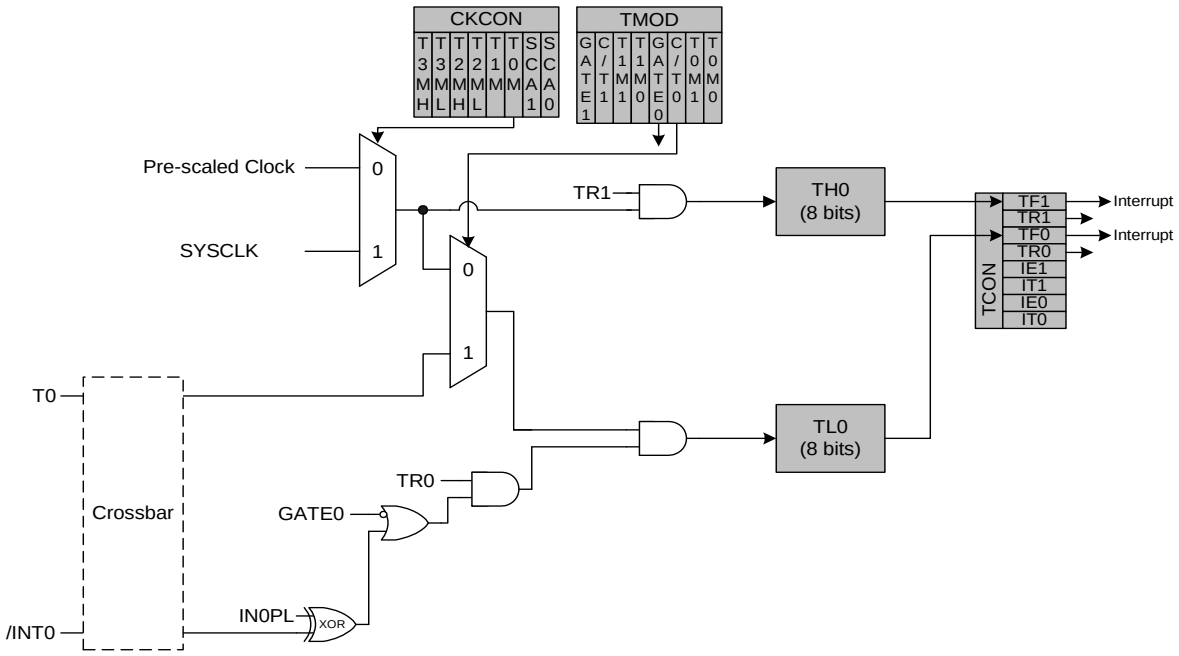


Figure 25.3. T0 Mode 3 Block Diagram

SFR Definition 25.2. TCON: Timer Control

Bit	7	6	5	4	3	2	1	0
Name	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x88; Bit-Addressable; SFR Page = All Pages

Bit	Name	Function
7	TF1	**Timer 1 Overflow Flag.** Set to 1 by hardware when Timer 1 overflows. This flag can be cleared by software but is automatically cleared when the CPU vectors to the Timer 1 interrupt service routine.
6	TR1	**Timer 1 Run Control.** Timer 1 is enabled by setting this bit to 1.
5	TF0	**Timer 0 Overflow Flag.** Set to 1 by hardware when Timer 0 overflows. This flag can be cleared by software but is automatically cleared when the CPU vectors to the Timer 0 interrupt service routine.
4	TR0	**Timer 0 Run Control.** Timer 0 is enabled by setting this bit to 1.
3	IE1	**External Interrupt 1.** This flag is set by hardware when an edge/level of type defined by IT1 is detected. It can be cleared by software but is automatically cleared when the CPU vectors to the External Interrupt 1 service routine in edge-triggered mode.
2	IT1	**Interrupt 1 Type Select.** This bit selects whether the configured $\overline{\text{INT1}}$ interrupt will be edge or level sensitive. $\overline{\text{INT1}}$ is configured active low or high by the IN1PL bit in the IT01CF register (see SFR Definition 13.7). 0: $\overline{\text{INT1}}$ is level triggered. 1: $\overline{\text{INT1}}$ is edge triggered.
1	IE0	**External Interrupt 0.** This flag is set by hardware when an edge/level of type defined by IT1 is detected. It can be cleared by software but is automatically cleared when the CPU vectors to the External Interrupt 0 service routine in edge-triggered mode.
0	IT0	**Interrupt 0 Type Select.** This bit selects whether the configured $\overline{\text{INT0}}$ interrupt will be edge or level sensitive. $\overline{\text{INT0}}$ is configured active low or high by the IN0PL bit in register IT01CF (see SFR Definition 13.7). 0: $\overline{\text{INT0}}$ is level triggered. 1: $\overline{\text{INT0}}$ is edge triggered.

SFR Definition 25.3. TMOD: Timer Mode

Bit	7	6	5	4	3	2	1	0
Name	GATE1	C/T1	T1M[1:0]		GATE0	C/T0	T0M[1:0]	
Type	R/W	R/W	R/W		R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x89; SFR Page = All Pages

Bit	Name	Function
7	GATE1	**Timer 1 Gate Control.** 0: Timer 1 enabled when TR1 = 1 irrespective of $\overline{\text{INT1}}$ logic level. 1: Timer 1 enabled only when TR1 = 1 AND $\overline{\text{INT1}}$ is active as defined by bit IN1PL in register IT01CF (see SFR Definition 13.7).
6	C/T1	**Counter/Timer 1 Select.** 0: Timer: Timer 1 incremented by clock defined by T1M bit in register CKCON. 1: Counter: Timer 1 incremented by high-to-low transitions on external pin (T1).
5:4	T1M[1:0]	**Timer 1 Mode Select.** These bits select the Timer 1 operation mode. 00: Mode 0, 13-bit Counter/Timer 01: Mode 1, 16-bit Counter/Timer 10: Mode 2, 8-bit Counter/Timer with Auto-Reload 11: Mode 3, Timer 1 Inactive
3	GATE0	**Timer 0 Gate Control.** 0: Timer 0 enabled when TR0 = 1 irrespective of $\overline{\text{INT0}}$ logic level. 1: Timer 0 enabled only when TR0 = 1 AND $\overline{\text{INT0}}$ is active as defined by bit IN0PL in register IT01CF (see SFR Definition 13.7).
2	C/T0	**Counter/Timer 0 Select.** 0: Timer: Timer 0 incremented by clock defined by T0M bit in register CKCON. 1: Counter: Timer 0 incremented by high-to-low transitions on external pin (T0).
1:0	T0M[1:0]	**Timer 0 Mode Select.** These bits select the Timer 0 operation mode. 00: Mode 0, 13-bit Counter/Timer 01: Mode 1, 16-bit Counter/Timer 10: Mode 2, 8-bit Counter/Timer with Auto-Reload 11: Mode 3, Two 8-bit Counter/Timers

SFR Definition 25.4. TL0: Timer 0 Low Byte

Bit	7	6	5	4	3	2	1	0
Name	TL0[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8A; SFR Page = All Pages

Bit	Name	Function
7:0	TL0[7:0]	**Timer 0 Low Byte.** The TL0 register is the low byte of the 16-bit Timer 0.

SFR Definition 25.5. TL1: Timer 1 Low Byte

Bit	7	6	5	4	3	2	1	0
Name	TL1[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8B; SFR Page = All Pages

Bit	Name	Function
7:0	TL1[7:0]	**Timer 1 Low Byte.** The TL1 register is the low byte of the 16-bit Timer 1.

SFR Definition 25.6. TH0: Timer 0 High Byte

Bit	7	6	5	4	3	2	1	0
Name	TH0[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8C; SFR Page = All Pages

Bit	Name	Function
7:0	TH0[7:0]	**Timer 0 High Byte.** The TH0 register is the high byte of the 16-bit Timer 0.

SFR Definition 25.7. TH1: Timer 1 High Byte

Bit	7	6	5	4	3	2	1	0
Name	TH1[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8D; SFR Page = All Pages

Bit	Name	Function
7:0	TH1[7:0]	**Timer 1 High Byte.** The TH1 register is the high byte of the 16-bit Timer 1.

25.2. Timer 2

Timer 2 is a 16-bit timer formed by two 8-bit SFRs: TMR2L (low byte) and TMR2H (high byte). Timer 2 may operate in 16-bit auto-reload mode or (split) 8-bit auto-reload mode. The T2SPLIT bit (TMR2CN.3) defines the Timer 2 operation mode.

Timer 2 may be clocked by the system clock, the system clock divided by 12, or the external oscillator source divided by 8. The external clock mode is ideal for real-time clock (RTC) functionality, where the internal oscillator drives the system clock while Timer 2 (and/or the PCA) is clocked by an external precision oscillator. Note that the external oscillator source divided by 8 is synchronized with the system clock.

25.2.1. 16-bit Timer with Auto-Reload

When T2SPLIT (TMR2CN.3) is zero, Timer 2 operates as a 16-bit timer with auto-reload. Timer 2 can be clocked by SYSCLK, SYSCLK divided by 12, or the external oscillator clock source divided by 8. As the 16-bit timer register increments and overflows from 0xFFFF to 0x0000, the 16-bit value in the Timer 2 reload registers (TMR2RLH and TMR2RLL) is loaded into the Timer 2 register as shown in Figure 25.4, and the Timer 2 High Byte Overflow Flag (TMR2CN.7) is set. If Timer 2 interrupts are enabled (if IE.5 is set), an interrupt will be generated on each Timer 2 overflow. Additionally, if Timer 2 interrupts are enabled and the TF2LEN bit is set (TMR2CN.5), an interrupt will be generated each time the lower 8 bits (TMR2L) overflow from 0xFF to 0x00.

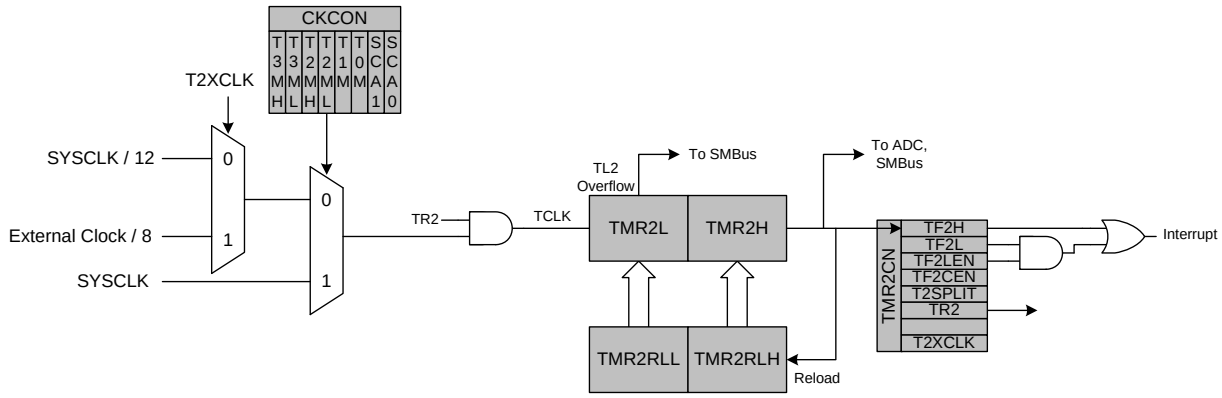


Figure 25.4. Timer 2 16-Bit Mode Block Diagram

25.2.2. 8-bit Timers with Auto-Reload

When T2SPLIT is set, Timer 2 operates as two 8-bit timers (TMR2H and TMR2L). Both 8-bit timers operate in auto-reload mode as shown in Figure 25.5. TMR2RLL holds the reload value for TMR2L; TMR2RLH holds the reload value for TMR2H. The TR2 bit in TMR2CN handles the run control for TMR2H. TMR2L is always running when configured for 8-bit Mode.

Each 8-bit timer may be configured to use SYSCLK, SYSCLK divided by 12, or the external oscillator clock source divided by 8. The Timer 2 Clock Select bits (T2MH and T2ML in CKCON) select either SYSCLK or the clock defined by the Timer 2 External Clock Select bit (T2XCLK in TMR2CN), as follows:

T2MH	T2XCLK	TMR2H Clock Source
0	0	SYSCLK/12
0	1	External Clock/8
1	X	SYSCLK

T2ML	T2XCLK	TMR2L Clock Source
0	0	SYSCLK/12
0	1	External Clock/8
1	X	SYSCLK

The TF2H bit is set when TMR2H overflows from 0xFF to 0x00; the TF2L bit is set when TMR2L overflows from 0xFF to 0x00. When Timer 2 interrupts are enabled (IE.5), an interrupt is generated each time TMR2H overflows. If Timer 2 interrupts are enabled and TF2LEN (TMR2CN.5) is set, an interrupt is generated each time either TMR2L or TMR2H overflows. When TF2LEN is enabled, software must check the TF2H and TF2L flags to determine the source of the Timer 2 interrupt. The TF2H and TF2L interrupt flags are not cleared by hardware and must be manually cleared by software.

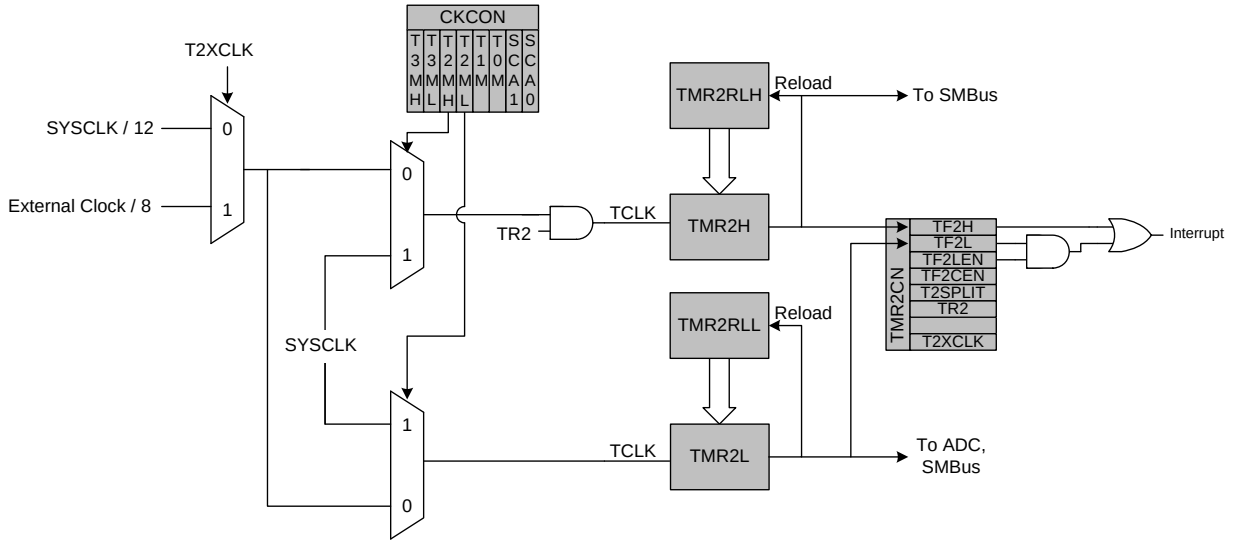


Figure 25.5. Timer 2 8-Bit Mode Block Diagram

25.2.3. External Oscillator Capture Mode

Capture Mode allows the external oscillator to be measured against the system clock. Timer 2 can be clocked from the system clock, or the system clock divided by 12, depending on the T2ML (CKCON.4), and T2XCLK bits. When a capture event is generated, the contents of Timer 2 (TMR2H:TMR2L) are loaded into the Timer 2 reload registers (TMR2RLH:TMR2RLL) and the TF2H flag is set. A capture event is generated by the falling edge of the clock source being measured, which is the external oscillator / 8. By recording the difference between two successive timer capture values, the external oscillator frequency can be determined with respect to the Timer 2 clock. The Timer 2 clock should be much faster than the capture clock to achieve an accurate reading. Timer 2 should be in 16-bit auto-reload mode when using Capture Mode.

For example, if T2ML = 1b and TF2CEN = 1b, Timer 2 will clock every SYSCLK and capture every external clock divided by 8. If the SYSCLK is 24 MHz and the difference between two successive captures is 5984, then the external clock frequency is as follows:

24 MHz/(5984/8) = 0.032086 MHz or 32.086 kHz

This mode allows software to determine the external oscillator frequency when an RC network or capacitor is used to generate the clock source.

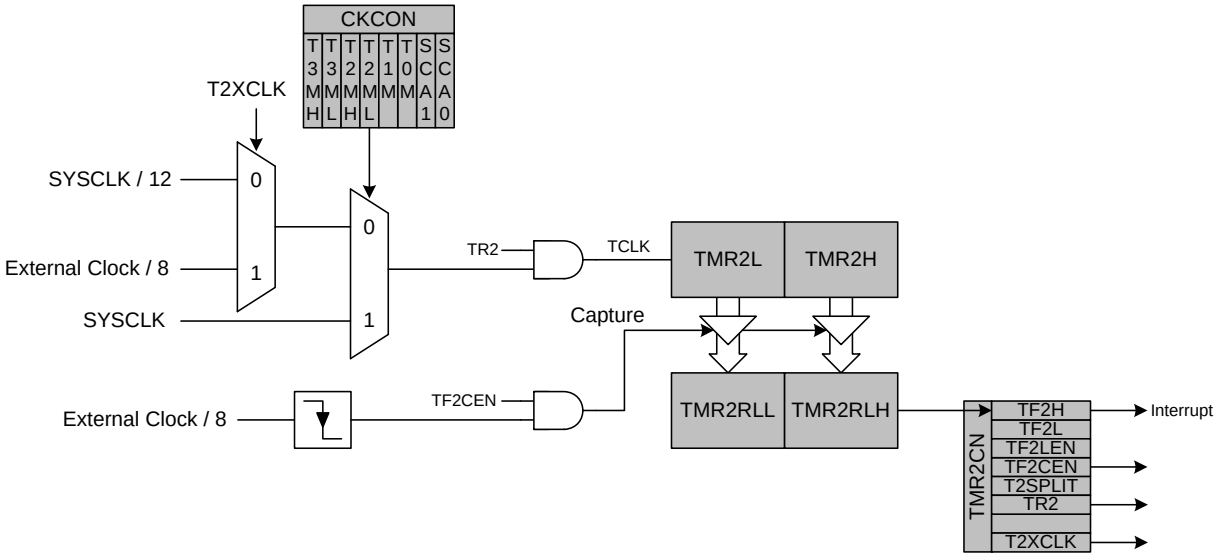


Figure 25.6. Timer 2 External Oscillator Capture Mode Block Diagram

SFR Definition 25.8. TMR2CN: Timer 2 Control

Bit	7	6	5	4	3	2	1	0
Name	TF2H	TF2L	TF2LEN	TF2CEN	T2SPLIT	TR2		T2XCLK
Type	R/W	R/W	R/W	R/W	R/W	R/W	R	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xC8; Bit-Addressable; SFR Page = 0x00

Bit	Name	Function
7	TF2H	**Timer 2 High Byte Overflow Flag.** Set by hardware when the Timer 2 high byte overflows from 0xFF to 0x00. In 16 bit mode, this will occur when Timer 2 overflows from 0xFFFF to 0x0000. When the Timer 2 interrupt is enabled, setting this bit causes the CPU to vector to the Timer 2 interrupt service routine. This bit is not automatically cleared by hardware.
6	TF2L	**Timer 2 Low Byte Overflow Flag.** Set by hardware when the Timer 2 low byte overflows from 0xFF to 0x00. TF2L will be set when the low byte overflows regardless of the Timer 2 mode. This bit is not automatically cleared by hardware.
5	TF2LEN	**Timer 2 Low Byte Interrupt Enable.** When set to 1, this bit enables Timer 2 Low Byte interrupts. If Timer 2 interrupts are also enabled, an interrupt will be generated when the low byte of Timer 2 overflows.
4	TF2CEN	**Timer 2 Capture Mode Enable.** 0: Timer 2 Capture Mode is disabled. 1: Timer 2 Capture Mode is enabled.
3	T2SPLIT	**Timer 2 Split Mode Enable.** When this bit is set, Timer 2 operates as two 8-bit timers with auto-reload. 0: Timer 2 operates in 16-bit auto-reload mode. 1: Timer 2 operates as two 8-bit auto-reload timers.
2	TR2	**Timer 2 Run Control.** Timer 2 is enabled by setting this bit to 1. In 8-bit mode, this bit enables/disables TMR2H only; TMR2L is always enabled in split mode.
1	Unused	Read = 0b; Write = Don't Care
0	T2XCLK	**Timer 2 External Clock Select.** This bit selects the external clock source for Timer 2. If Timer 2 is in 8-bit mode, this bit selects the external oscillator clock source for both timer bytes. However, the Timer 2 Clock Select bits (T2MH and T2ML in register CKCON) may still be used to select between the external clock and the system clock for either timer. 0: Timer 2 clock is the system clock divided by 12. 1: Timer 2 clock is the external clock divided by 8 (synchronized with SYSCLK).

SFR Definition 25.9. TMR2RLL: Timer 2 Reload Register Low Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR2RLL[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xCA; SFR Page = 0x00

Bit	Name	Function
7:0	TMR2RLL[7:0]	**Timer 2 Reload Register Low Byte.** TMR2RLL holds the low byte of the reload value for Timer 2.

SFR Definition 25.10. TMR2RLH: Timer 2 Reload Register High Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR2RLH[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xCB; SFR Page = 0x00

Bit	Name	Function
7:0	TMR2RLH[7:0]	**Timer 2 Reload Register High Byte.** TMR2RLH holds the high byte of the reload value for Timer 2.

SFR Definition 25.11. TMR2L: Timer 2 Low Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR2L[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xCC; SFR Page = 0x00

Bit	Name	Function
7:0	TMR2L[7:0]	**Timer 2 Low Byte.** In 16-bit mode, the TMR2L register contains the low byte of the 16-bit Timer 2. In 8-bit mode, TMR2L contains the 8-bit low byte timer value.

SFR Definition 25.12. TMR2H Timer 2 High Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR2H[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xCD; SFR Page = 0x00

Bit	Name	Function
7:0	TMR2H[7:0]	**Timer 2 High Byte.** In 16-bit mode, the TMR2H register contains the high byte of the 16-bit Timer 2. In 8-bit mode, TMR2H contains the 8-bit high byte timer value.

25.3. Timer 3

Timer 3 is a 16-bit timer formed by two 8-bit SFRs: TMR3L (low byte) and TMR3H (high byte). Timer 3 may operate in 16-bit auto-reload mode or (split) 8-bit auto-reload mode. The T3SPLIT bit (TMR3CN.3) defines the Timer 3 operation mode.

Timer 3 may be clocked by the system clock, the system clock divided by 12, or the external oscillator source divided by 8. The external clock mode is ideal for real-time clock (RTC) functionality, where the internal oscillator drives the system clock while Timer 3 (and/or the PCA) is clocked by an external precision oscillator. Note that the external oscillator source divided by 8 is synchronized with the system clock.

25.3.1. 16-Bit Timer with Auto-Reload

When T3SPLIT (TMR3CN.3) is zero, Timer 3 operates as a 16-bit timer with auto-reload. Timer 3 can be clocked by SYSCLK, SYSCLK divided by 12, or the external oscillator clock source divided by 8. As the 16-bit timer register increments and overflows from 0xFFFF to 0x0000, the 16-bit value in the Timer 3 reload registers (TMR3RLH and TMR3RLL) is loaded into the Timer 3 register as shown in Figure 25.7, and the Timer 3 High Byte Overflow Flag (TMR3CN.7) is set. If Timer 3 interrupts are enabled, an interrupt will be generated on each Timer 3 overflow. Additionally, if Timer 3 interrupts are enabled and the TF3LEN bit is set (TMR3CN.5), an interrupt will be generated each time the lower 8 bits (TMR3L) overflow from 0xFF to 0x00.

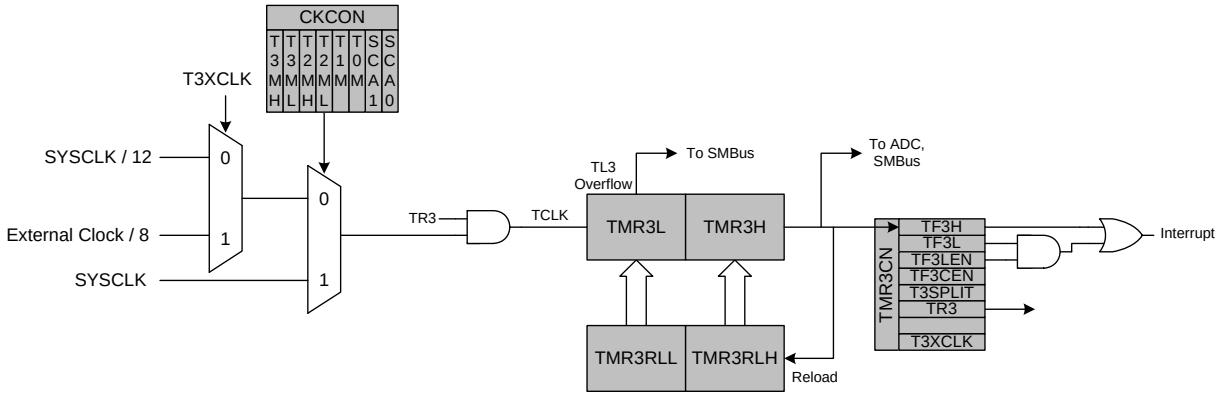


Figure 25.7. Timer 3 16-Bit Mode Block Diagram

25.3.2. 8-Bit Timers with Auto-Reload

When T3SPLIT is set, Timer 3 operates as two 8-bit timers (TMR3H and TMR3L). Both 8-bit timers operate in auto-reload mode as shown in Figure 25.8. TMR3RLL holds the reload value for TMR3L; TMR3RLH holds the reload value for TMR3H. The TR3 bit in TMR3CN handles the run control for TMR3H. TMR3L is always running when configured for 8-bit Mode.

Each 8-bit timer may be configured to use SYSCLK, SYSCLK divided by 12, or the external oscillator clock source divided by 8. The Timer 3 Clock Select bits (T3MH and T3ML in CKCON) select either SYSCLK or the clock defined by the Timer 3 External Clock Select bit (T3XCLK in TMR3CN), as follows:

T3MH	T3XCLK	TMR3H Clock Source
0	0	SYSCLK/12
0	1	External Clock/8
1	X	SYSCLK

T3ML	T3XCLK	TMR3L Clock Source
0	0	SYSCLK/12
0	1	External Clock/8
1	X	SYSCLK

The TF3H bit is set when TMR3H overflows from 0xFF to 0x00; the TF3L bit is set when TMR3L overflows from 0xFF to 0x00. When Timer 3 interrupts are enabled, an interrupt is generated each time TMR3H overflows. If Timer 3 interrupts are enabled and TF3LEN (TMR3CN.5) is set, an interrupt is generated each time either TMR3L or TMR3H overflows. When TF3LEN is enabled, software must check the TF3H and TF3L flags to determine the source of the Timer 3 interrupt. The TF3H and TF3L interrupt flags are not cleared by hardware and must be manually cleared by software.

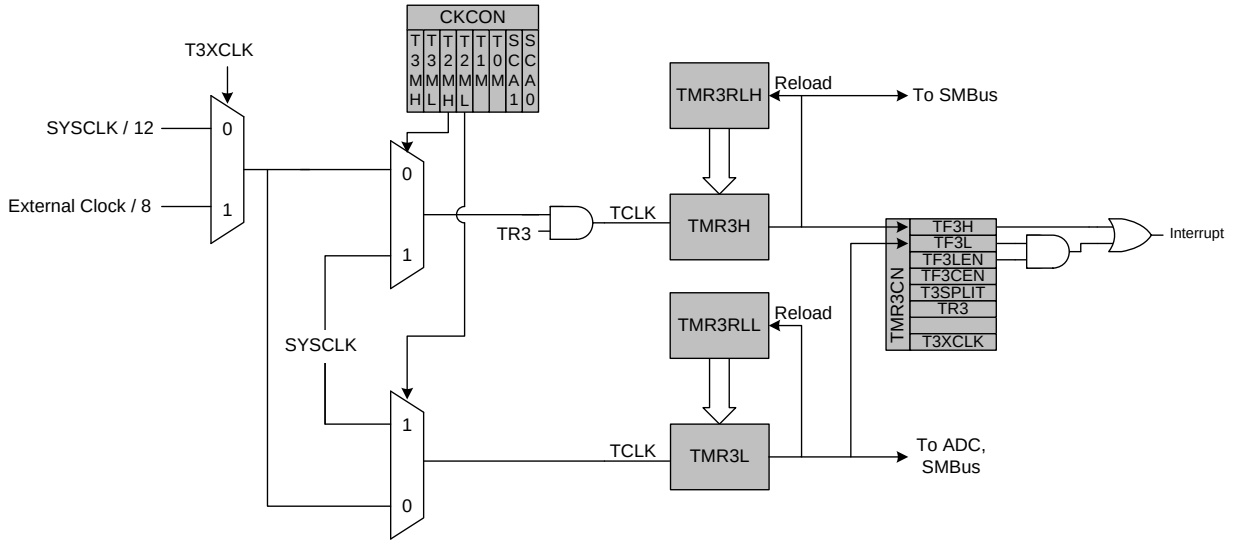


Figure 25.8. Timer 3 8-Bit Mode Block Diagram

25.3.3. External Oscillator Capture Mode

Capture Mode allows the external oscillator to be measured against the system clock. Timer 3 can be clocked from the system clock, or the system clock divided by 12, depending on the T3ML (CKCON.6), and T3XCLK bits. When a capture event is generated, the contents of Timer 3 (TMR3H:TMR3L) are loaded into the Timer 3 reload registers (TMR3RLH:TMR3RLL) and the TF3H flag is set. A capture event is generated by the falling edge of the clock source being measured, which is the external oscillator/8. By recording the difference between two successive timer capture values, the external oscillator frequency can be determined with respect to the Timer 3 clock. The Timer 3 clock should be much faster than the capture clock to achieve an accurate reading. Timer 3 should be in 16-bit auto-reload mode when using Capture Mode.

If the SYSCLK is 24 MHz and the difference between two successive captures is 5861, then the external clock frequency is as follows:

24 MHz/(5861/8) = 0.032754 MHz or 32.754 kHz

This mode allows software to determine the external oscillator frequency when an RC network or capacitor is used to generate the clock source.

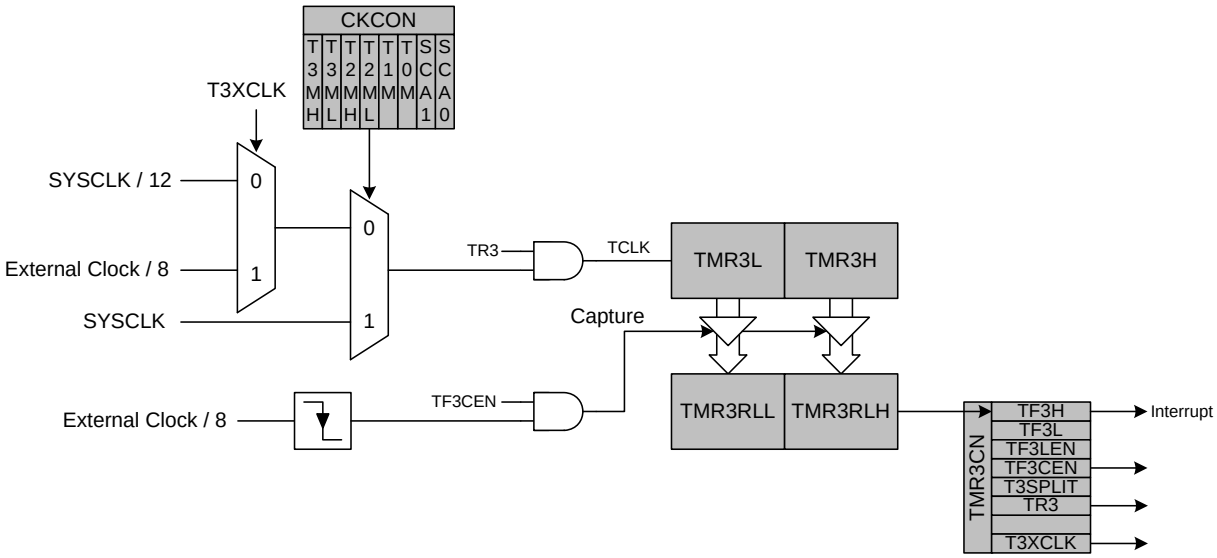


Figure 25.9. Timer 3 External Oscillator Capture Mode Block Diagram

SFR Definition 25.13. TMR3CN: Timer 3 Control

Bit	7	6	5	4	3	2	1	0
Name	TF3H	TF3L	TF3LEN	TF3CEN	T3SPLIT	TR3		T3XCLK
Type	R/W	R/W	R/W	R/W	R/W	R/W	R	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x91;SFR Page = 0x00

Bit	Name	Function
7	TF3H	**Timer 3 High Byte Overflow Flag.** Set by hardware when the Timer 3 high byte overflows from 0xFF to 0x00. In 16 bit mode, this will occur when Timer 3 overflows from 0xFFFF to 0x0000. When the Timer 3 interrupt is enabled, setting this bit causes the CPU to vector to the Timer 3 interrupt service routine. This bit is not automatically cleared by hardware.
6	TF3L	**Timer 3 Low Byte Overflow Flag.** Set by hardware when the Timer 3 low byte overflows from 0xFF to 0x00. TF3L will be set when the low byte overflows regardless of the Timer 3 mode. This bit is not automatically cleared by hardware.
5	TF3LEN	**Timer 3 Low Byte Interrupt Enable.** When set to 1, this bit enables Timer 3 Low Byte interrupts. If Timer 3 interrupts are also enabled, an interrupt will be generated when the low byte of Timer 3 overflows.
4	TF3CEN	**Timer 3 Capture Mode Enable.** 0: Timer 3 Capture Mode is disabled. 1: Timer 3 Capture Mode is enabled.
3	T3SPLIT	**Timer 3 Split Mode Enable.** When this bit is set, Timer 3 operates as two 8-bit timers with auto-reload. 0: Timer 3 operates in 16-bit auto-reload mode. 1: Timer 3 operates as two 8-bit auto-reload timers.
2	TR3	**Timer 3 Run Control.** Timer 3 is enabled by setting this bit to 1. In 8-bit mode, this bit enables/disables TMR3H only; TMR3L is always enabled in split mode.
1	Unused	Read = 0b; Write = Don't Care
0	T3XCLK	**Timer 3 External Clock Select.** This bit selects the external clock source for Timer 3. If Timer 3 is in 8-bit mode, this bit selects the external oscillator clock source for both timer bytes. However, the Timer 3 Clock Select bits (T3MH and T3ML in register CKCON) may still be used to select between the external clock and the system clock for either timer. 0: Timer 3 clock is the system clock divided by 12. 1: Timer 3 clock is the external clock divided by 8 (synchronized with SYSCLK).

SFR Definition 25.14. TMR3RLL: Timer 3 Reload Register Low Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR3RLL[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x92; SFR Page = 0x00

Bit	Name	Function
7:0	TMR3RLL[7:0]	**Timer 3 Reload Register Low Byte.** TMR3RLL holds the low byte of the reload value for Timer 3.

SFR Definition 25.15. TMR3RLH: Timer 3 Reload Register High Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR3RLH[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x93; SFR Page = 0x00

Bit	Name	Function
7:0	TMR3RLH[7:0]	**Timer 3 Reload Register High Byte.** TMR3RLH holds the high byte of the reload value for Timer 3.

SFR Definition 25.16. TMR3L: Timer 3 Low Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR3L[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x94; SFR Page = 0x00

Bit	Name	Function
7:0	TMR3L[7:0]	**Timer 3 Low Byte.** In 16-bit mode, the TMR3L register contains the low byte of the 16-bit Timer 3. In 8-bit mode, TMR3L contains the 8-bit low byte timer value.

SFR Definition 25.17. TMR3H Timer 3 High Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR3H[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x95; SFR Page = 0x00

Bit	Name	Function
7:0	TMR3H[7:0]	**Timer 3 High Byte.** In 16-bit mode, the TMR3H register contains the high byte of the 16-bit Timer 3. In 8-bit mode, TMR3H contains the 8-bit high byte timer value.

26. Programmable Counter Array

The Programmable Counter Array (PCA0) provides enhanced timer functionality while requiring less CPU intervention than the standard 8051 counter/timers. The PCA consists of a dedicated 16-bit counter/timer and six 16-bit capture/compare modules. Each capture/compare module has its own associated I/O line (CEXn) which is routed through the Crossbar to Port I/O when enabled. The counter/timer is driven by a programmable timebase that can select between six sources: system clock, system clock divided by four, system clock divided by twelve, the external oscillator clock source divided by 8, Timer 0 overflows, or an external clock signal on the ECI input pin. Each capture/compare module may be configured to operate independently in one of six modes: Edge-Triggered Capture, Software Timer, High-Speed Output, Frequency Output, 8 to 11-Bit PWM, or 16-Bit PWM (each mode is described in Section “26.3. Capture/Compare Modules” on page 283). The external oscillator clock option is ideal for real-time clock (RTC) functionality, allowing the PCA to be clocked by a precision external oscillator while the internal oscillator drives the system clock. The PCA is configured and controlled through the system controller's Special Function Registers. The PCA block diagram is shown in Figure 26.1

Important Note: The PCA Module 5 may be used as a watchdog timer (WDT), and is enabled in this mode following a system reset. **Access to certain PCA registers is restricted while WDT mode is enabled**. See Section 26.4 for details.

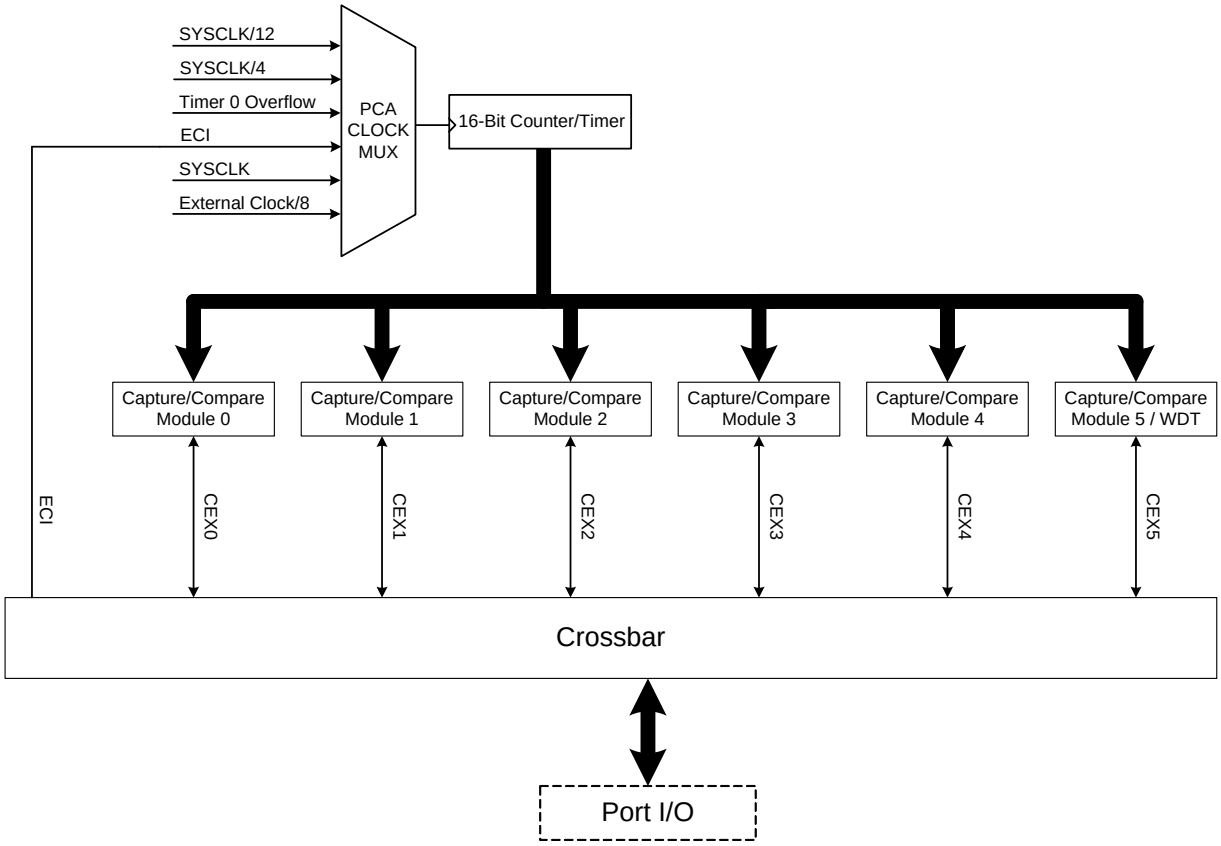


Figure 26.1. PCA Block Diagram

26.1. PCA Counter/Timer

The 16-bit PCA counter/timer consists of two 8-bit SFRs: PCA0L and PCA0H. PCA0H is the high byte (MSB) of the 16-bit counter/timer and PCA0L is the low byte (LSB). Reading PCA0L automatically latches the value of PCA0H into a “snapshot” register; the following PCA0H read accesses this “snapshot” register. **Reading the PCA0L Register first guarantees an accurate reading of the entire 16-bit PCA0 counter.** Reading PCA0H or PCA0L does not disturb the counter operation. The CPS[2:0] bits in the PCA0MD register select the timebase for the counter/timer as shown in Table 26.1.

When the counter/timer overflows from 0xFFFF to 0x0000, the Counter Overflow Flag (CF) in PCA0MD is set to logic 1 and an interrupt request is generated if CF interrupts are enabled. Setting the ECF bit in PCA0MD to logic 1 enables the CF flag to generate an interrupt request. The CF bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software. Clearing the CIDL bit in the PCA0MD register allows the PCA to continue normal operation while the CPU is in Idle mode.

Table 26.1. PCA Timebase Input Options

CPS2	CPS1	CPS0	Timebase
0	0	0	System clock divided by 12.
0	0	1	System clock divided by 4.
0	1	0	Timer 0 overflow.
0	1	1	High-to-low transitions on ECI (max rate = system clock divided by 4).
1	0	0	System clock.
1	0	1	External oscillator source divided by 8.*
1	1	x	Reserved.
***Note:** External oscillator source divided by 8 is synchronized with the system clock.			

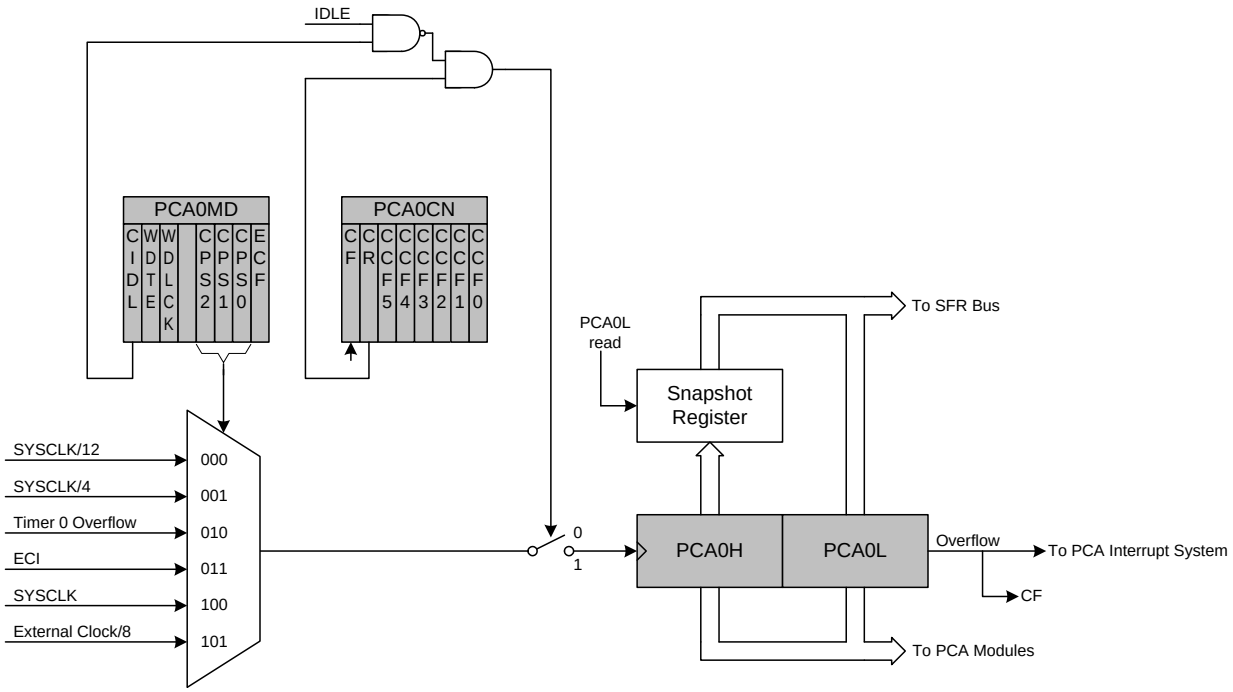


Figure 26.2. PCA Counter/Timer Block Diagram

26.2. PCA0 Interrupt Sources

Figure 26.3 shows a diagram of the PCA interrupt tree. There are five independent event flags that can be used to generate a PCA0 interrupt. They are as follows: the main PCA counter overflow flag (CF), which is set upon a 16-bit overflow of the PCA0 counter, an intermediate overflow flag (COVF), which can be set on an overflow from the 8th, 9th, 10th, or 11th bit of the PCA0 counter, and the individual flags for each PCA channel (CCF0, CCF1, CCF2, CCF3, CCF4, and CCF5), which are set according to the operation mode of that module. These event flags are always set when the trigger condition occurs. Each of these flags can be individually selected to generate a PCA0 interrupt, using the corresponding interrupt enable flag (ECF for CF, ECOV for COVF, and ECCFn for each CCFn). PCA0 interrupts must be globally enabled before any individual interrupt sources are recognized by the processor. PCA0 interrupts are globally enabled by setting the EA bit and the EPCA0 bit to logic 1.

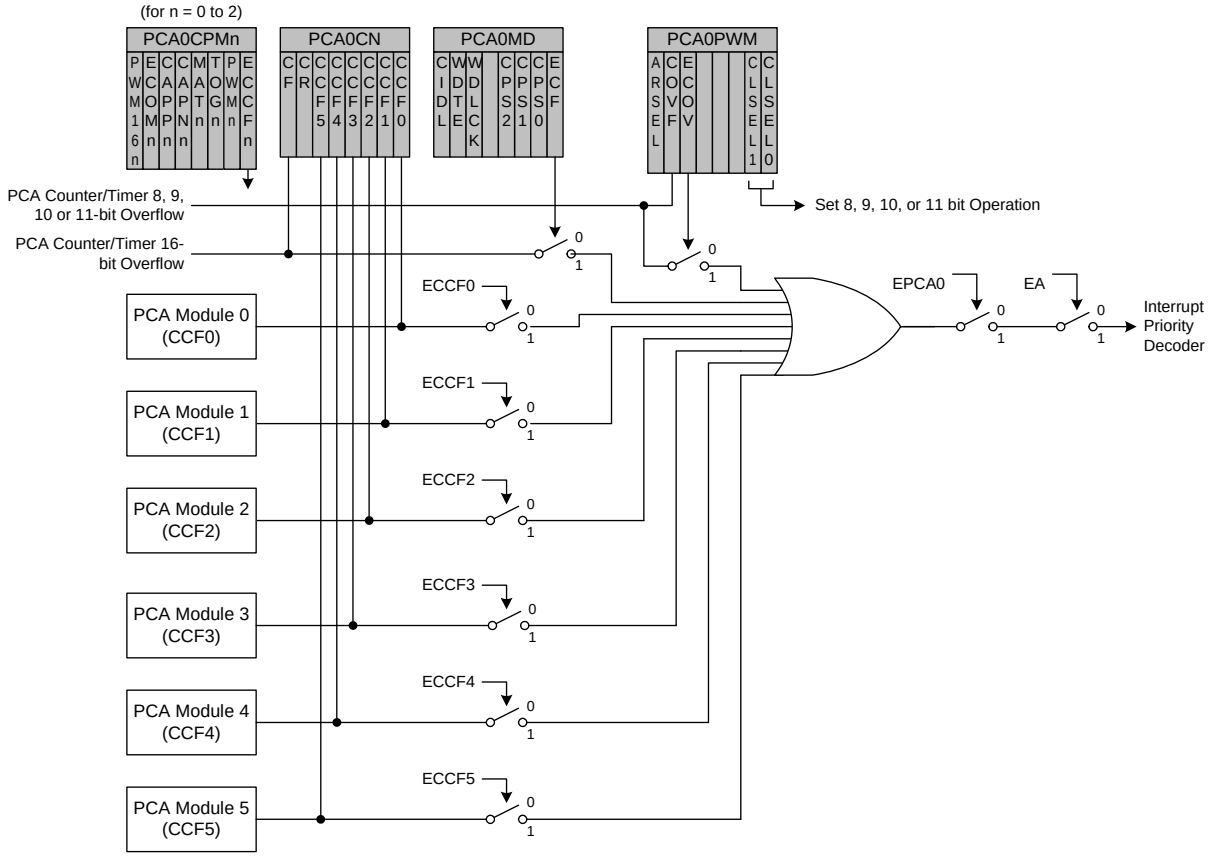


Figure 26.3. PCA Interrupt Block Diagram

26.3. Capture/Compare Modules

Each module can be configured to operate independently in one of six operation modes: Edge-triggered Capture, Software Timer, High Speed Output, Frequency Output, 8 to 11-Bit Pulse Width Modulator, or 16-Bit Pulse Width Modulator. Each module has Special Function Registers (SFRs) associated with it in the CIP-51 system controller. These registers are used to exchange data with a module and configure the module's mode of operation. Table 26.2 summarizes the bit settings in the PCA0CPMn and PCA0PWM registers used to select the PCA capture/compare module's operating mode. All modules set to use 8, 9, 10, or 11-bit PWM mode must use the same cycle length (8-11 bits). Setting the ECCFn bit in a PCA0CPMn register enables the module's CCFn interrupt.

Table 26.2. PCA0CPM and PCA0PWM Bit Settings for PCA Capture/Compare Modules

Operational Mode	PCA0CPMn								PCA0PWM				
Bit Number	7	6	5	4	3	2	1	0	7	6	5	4–2	1–0
Capture triggered by positive edge on CEXn	X	X	1	0	0	0	0	A	0	X	B	XXX	XX
Capture triggered by negative edge on CEXn	X	X	0	1	0	0	0	A	0	X	B	XXX	XX
Capture triggered by any transition on CEXn	X	X	1	1	0	0	0	A	0	X	B	XXX	XX
Software Timer	X	C	0	0	1	0	0	A	0	X	B	XXX	XX
High Speed Output	X	C	0	0	1	1	0	A	0	X	B	XXX	XX
Frequency Output	X	C	0	0	0	1	1	A	0	X	B	XXX	XX
8-Bit Pulse Width Modulator (7)	0	C	0	0	E	0	1	A	0	X	B	XXX	00
9-Bit Pulse Width Modulator (7)	0	C	0	0	E	0	1	A	D	X	B	XXX	01
10-Bit Pulse Width Modulator (7)	0	C	0	0	E	0	1	A	D	X	B	XXX	10
11-Bit Pulse Width Modulator (7)	0	C	0	0	E	0	1	A	D	X	B	XXX	11
16-Bit Pulse Width Modulator	1	C	0	0	E	0	1	A	0	X	B	XXX	XX

Notes:
1. X = Don't Care (no functional difference for individual module if 1 or 0).
2. A = Enable interrupts for this module (PCA interrupt triggered on CCFn set to 1).
3. B = Enable 8th, 9th, 10th or 11th bit overflow interrupt (Depends on setting of CLSEL[1:0]).
4. C = When set to 0, the digital comparator is off. For high speed and frequency output modes, the associated pin will not toggle. In any of the PWM modes, this generates a 0% duty cycle (output = 0).
5. D = Selects whether the Capture/Compare register (0) or the Auto-Reload register (1) for the associated channel is accessed via addresses PCA0CPHn and PCA0CPLn.
6. E = When set, a match event will cause the CCFn flag for the associated channel to be set.
7. All modules set to 8, 9, 10 or 11-bit PWM mode use the same cycle length setting.

26.3.1. Edge-triggered Capture Mode

In this mode, a valid transition on the CEXn pin causes the PCA to capture the value of the PCA counter/timer and load it into the corresponding module's 16-bit capture/compare register (PCA0CPLn and PCA0CPHn). The CAPPn and CAPNn bits in the PCA0CPMn register are used to select the type of transition that triggers the capture: low-to-high transition (positive edge), high-to-low transition (negative edge), or either transition (positive or negative edge). When a capture occurs, the Capture/Compare Flag (CCFn) in PCA0CN is set to logic 1. An interrupt request is generated if the CCFn interrupt for that module is enabled. The CCFn bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software. If both CAPPn and CAPNn bits are set to logic 1, then the state of the Port pin associated with CEXn can be read directly to determine whether a rising-edge or falling-edge caused the capture.

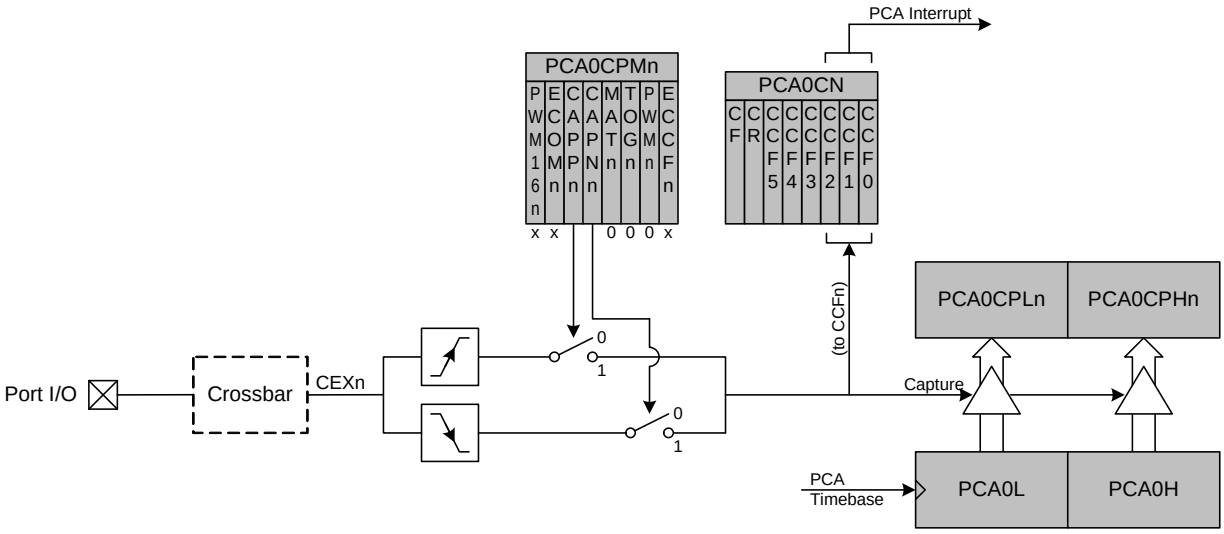


Figure 26.4. PCA Capture Mode Diagram

Note: The CEXn input signal must remain high or low for at least 2 system clock cycles to be recognized by the hardware.

26.3.2. Software Timer (Compare) Mode

In Software Timer mode, the PCA counter/timer value is compared to the module's 16-bit capture/compare register (PCA0CPHn and PCA0CPLn). When a match occurs, the Capture/Compare Flag (CCFn) in PCA0CN is set to logic 1. An interrupt request is generated if the CCFn interrupt for that module is enabled. The CCFn bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software. Setting the ECOMn and MATn bits in the PCA0CPMn register enables Software Timer mode.

Important Note About Capture/Compare Registers: When writing a 16-bit value to the PCA0 Capture/Compare registers, the low byte should always be written first. Writing to PCA0CPLn clears the ECOMn bit to 0; writing to PCA0CPHn sets ECOMn to 1.

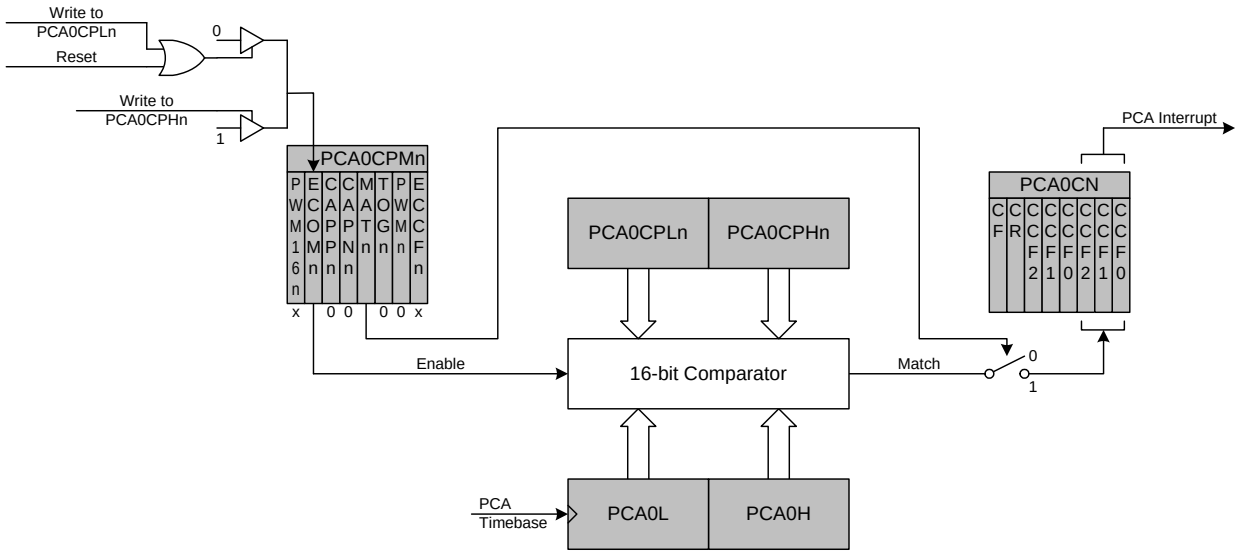


Figure 26.5. PCA Software Timer Mode Diagram

26.3.3. High-Speed Output Mode

In High-Speed Output mode, a module's associated CEXn pin is toggled each time a match occurs between the PCA Counter and the module's 16-bit capture/compare register (PCA0CPHn and PCA0CPLn). When a match occurs, the Capture/Compare Flag (CCFn) in PCA0CN is set to logic 1. An interrupt request is generated if the CCFn interrupt for that module is enabled. The CCFn bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software. Setting the TOGn, MATn, and ECOMn bits in the PCA0CPMn register enables the High-Speed Output mode. If ECOMn is cleared, the associated pin will retain its state, and not toggle on the next match event.

Important Note About Capture/Compare Registers: When writing a 16-bit value to the PCA0 Capture/Compare registers, the low byte should always be written first. Writing to PCA0CPLn clears the ECOMn bit to 0; writing to PCA0CPHn sets ECOMn to 1.

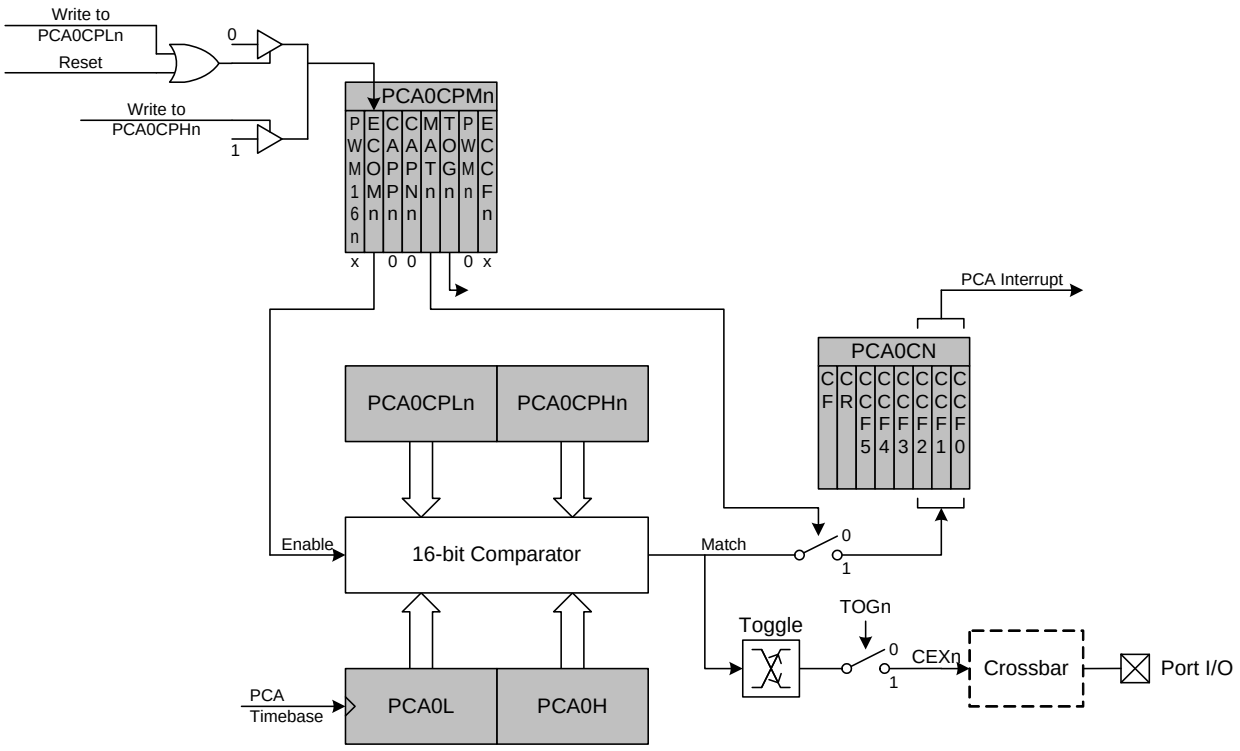


Figure 26.6. PCA High-Speed Output Mode Diagram

26.3.4. Frequency Output Mode

Frequency Output Mode produces a programmable-frequency square wave on the module's associated CEXn pin. The capture/compare module high byte holds the number of PCA clocks to count before the output is toggled. The frequency of the square wave is then defined by Equation 26.1.

$$F_{CEXn} = \frac{F_{PCA}}{2 \times PCA0CPHn}$$

Note: A value of 0x00 in the PCA0CPHn register is equal to 256 for this equation.

Equation 26.1. Square Wave Frequency Output

Where F_{PCA} is the frequency of the clock selected by the CPS[2:0] bits in the PCA mode register, PCA0MD. The lower byte of the capture/compare module is compared to the PCA counter low byte; on a match, CEXn is toggled and the offset held in the high byte is added to the matched value in PCA0CPLn. Frequency Output Mode is enabled by setting the ECOMn, TOGn, and PWMn bits in the PCA0CPMn register. Note that the MATn bit should normally be set to 0 in this mode. If the MATn bit is set to 1, the CCFn flag for the channel will be set when the 16-bit PCA0 counter and the 16-bit capture/compare register for the channel are equal.

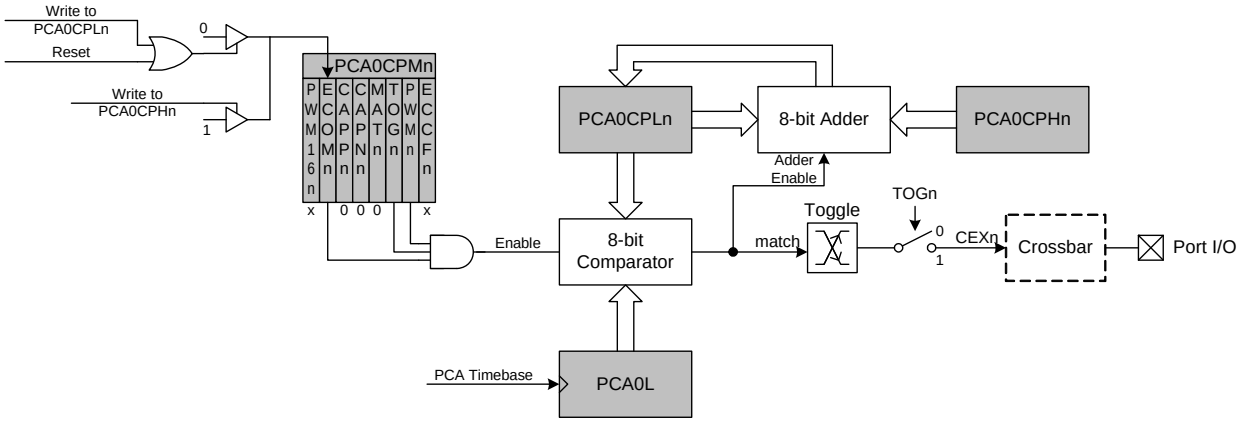


Figure 26.7. PCA Frequency Output Mode

26.3.5. 8-bit, 9-bit, 10-bit and 11-bit Pulse Width Modulator Modes

Each module can be used independently to generate a pulse width modulated (PWM) output on its associated CEXn pin. The frequency of the output is dependent on the timebase for the PCA counter/timer, and the setting of the PWM cycle length (8, 9, 10 or 11-bits). For backwards-compatibility with the 8-bit PWM mode available on other devices, the 8-bit PWM mode operates slightly different than 9, 10 and 11-bit PWM modes. **It is important to note that all channels configured for 8/9/10/11-bit PWM mode will use the same cycle length.** It is not possible to configure one channel for 8-bit PWM mode and another for 11-bit mode (for example). However, other PCA channels can be configured to Pin Capture, High-Speed Output, Software Timer, Frequency Output, or 16-bit PWM mode independently.

26.3.5.1. 8-bit Pulse Width Modulator Mode

The duty cycle of the PWM output signal in 8-bit PWM mode is varied using the module's PCA0CPLn capture/compare register. When the value in the low byte of the PCA counter/timer (PCA0L) is equal to the value in PCA0CPLn, the output on the CEXn pin will be set. When the count value in PCA0L overflows, the CEXn output will be reset (see Figure 26.8). Also, when the counter/timer low byte (PCA0L) overflows from 0xFF to 0x00, PCA0CPLn is reloaded automatically with the value stored in the module's capture/compare high byte (PCA0CPHn) without software intervention. Setting the ECOMn and PWMn bits in the PCA0CPMn register, and setting the CLSEL bits in register PCA0PWM to 00b enables 8-Bit Pulse Width Modulator mode. If the MATn bit is set to 1, the CCFn flag for the module will be set each time an 8-bit comparator match (rising edge) occurs. The COVF flag in PCA0PWM can be used to detect the overflow (falling edge), which will occur every 256 PCA clock cycles. The duty cycle for 8-Bit PWM Mode is given in Equation 26.2.

Important Note About Capture/Compare Registers: When writing a 16-bit value to the PCA0 Capture/Compare registers, the low byte should always be written first. Writing to PCA0CPLn clears the ECOMn bit to 0; writing to PCA0CPHn sets ECOMn to 1.

$$\text{Duty Cycle} = \frac{(256 - \text{PCA0CPHn})}{256}$$

Equation 26.2. 8-Bit PWM Duty Cycle

Using Equation 26.2, the largest duty cycle is 100% (PCA0CPHn = 0), and the smallest duty cycle is 0.39% (PCA0CPHn = 0xFF). A 0% duty cycle may be generated by clearing the ECOMn bit to 0.

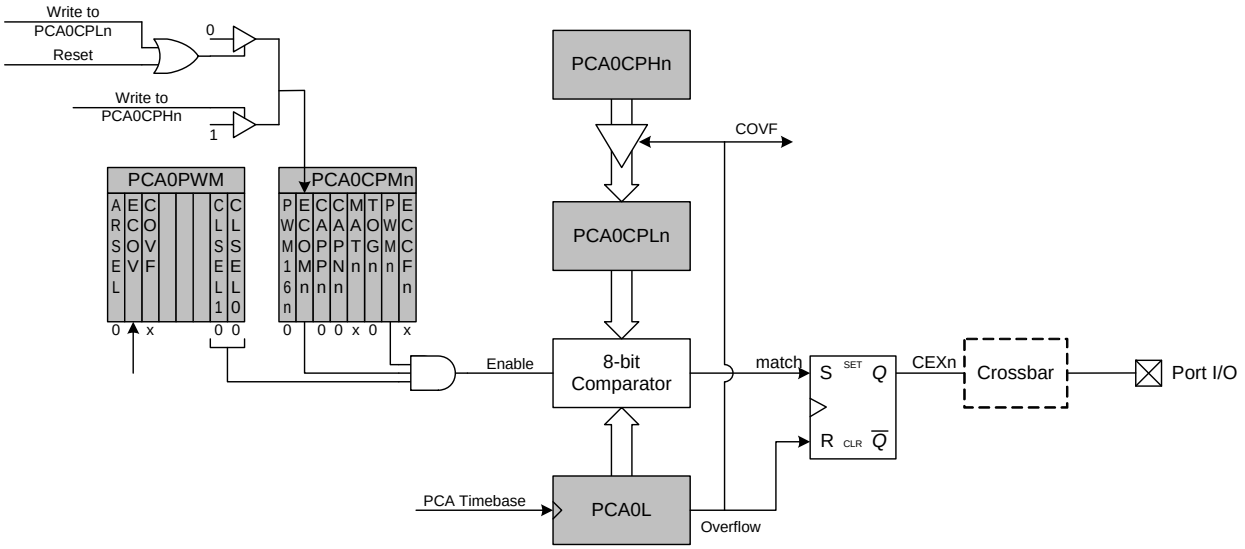


Figure 26.8. PCA 8-Bit PWM Mode Diagram

26.3.5.2. 9/10/11-bit Pulse Width Modulator Mode

The duty cycle of the PWM output signal in 9/10/11-bit PWM mode should be varied by writing to an "Auto-Reload" Register, which is dual-mapped into the PCA0CPHn and PCA0CPLn register locations. The data written to define the duty cycle should be right-justified in the registers. The auto-reload registers are accessed (read or written) when the bit ARSEL in PCA0PWM is set to 1. The capture/compare registers are accessed when ARSEL is set to 0.

When the least-significant N bits of the PCA0 counter match the value in the associated module's capture/compare register (PCA0CPn), the output on CEXn is asserted high. When the counter overflows from the Nth bit, CEXn is asserted low (see Figure 26.9). Upon an overflow from the Nth bit, the COVF flag is set, and the value stored in the module's auto-reload register is loaded into the capture/compare register. The value of N is determined by the CLSEL bits in register PCA0PWM.

The 9, 10 or 11-bit PWM mode is selected by setting the ECOMn and PWMn bits in the PCA0CPMn register, and setting the CLSEL bits in register PCA0PWM to the desired cycle length (other than 8-bits). If the MATn bit is set to 1, the CCFn flag for the module will be set each time a comparator match (rising edge) occurs. The COVF flag in PCA0PWM can be used to detect the overflow (falling edge), which will occur every 512 (9-bit), 1024 (10-bit) or 2048 (11-bit) PCA clock cycles. The duty cycle for 9/10/11-Bit PWM Mode is given in Equation 26.2, where N is the number of bits in the PWM cycle.

Important Note About PCA0CPHn and PCA0CPLn Registers: When writing a 16-bit value to the PCA0CPn registers, the low byte should always be written first. Writing to PCA0CPLn clears the ECOMn bit to 0; writing to PCA0CPHn sets ECOMn to 1.

$$\text{Duty Cycle} = \frac{(2^N - \text{PCA0CPn})}{2^N}$$

Equation 26.3. 9, 10, and 11-Bit PWM Duty Cycle

A 0% duty cycle may be generated by clearing the ECOMn bit to 0.

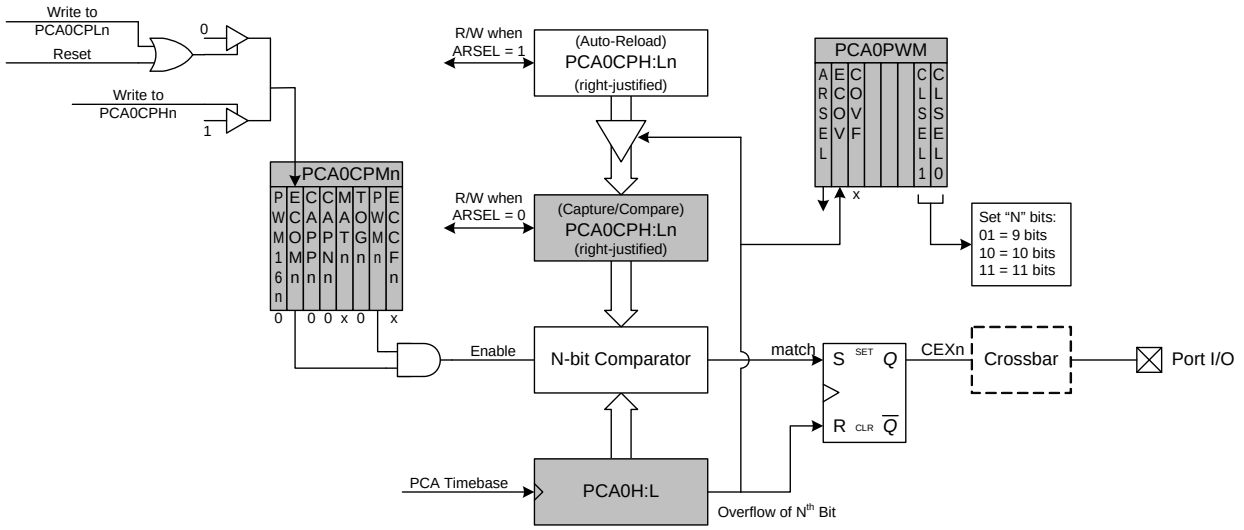


Figure 26.9. PCA 9, 10 and 11-Bit PWM Mode Diagram

26.3.6. 16-Bit Pulse Width Modulator Mode

A PCA module may also be operated in 16-Bit PWM mode. 16-bit PWM mode is independent of the other (8/9/10/11-bit) PWM modes. In this mode, the 16-bit capture/compare module defines the number of PCA clocks for the low time of the PWM signal. When the PCA counter matches the module contents, the output on CEXn is asserted high; when the 16-bit counter overflows, CEXn is asserted low. To output a varying duty cycle, new value writes should be synchronized with PCA CCFn match interrupts. 16-Bit PWM Mode is enabled by setting the ECOMn, PWMn, and PWM16n bits in the PCA0CPMn register. For a varying duty cycle, match interrupts should be enabled (ECCFn = 1 AND MATn = 1) to help synchronize the capture/compare register writes. If the MATn bit is set to 1, the CCFn flag for the module will be set each time a 16-bit comparator match (rising edge) occurs. The CF flag in PCA0CN can be used to detect the overflow (falling edge). The duty cycle for 16-Bit PWM Mode is given by Equation 26.4.

Important Note About Capture/Compare Registers: When writing a 16-bit value to the PCA0 Capture/Compare registers, the low byte should always be written first. Writing to PCA0CPLn clears the ECOMn bit to 0; writing to PCA0CPHn sets ECOMn to 1.

$$\text{Duty Cycle} = \frac{(65536 - \text{PCA0CPn})}{65536}$$

Equation 26.4. 16-Bit PWM Duty Cycle

Using Equation 26.4, the largest duty cycle is 100% (PCA0CPn = 0), and the smallest duty cycle is 0.0015% (PCA0CPn = 0xFFFF). A 0% duty cycle may be generated by clearing the ECOMn bit to 0.

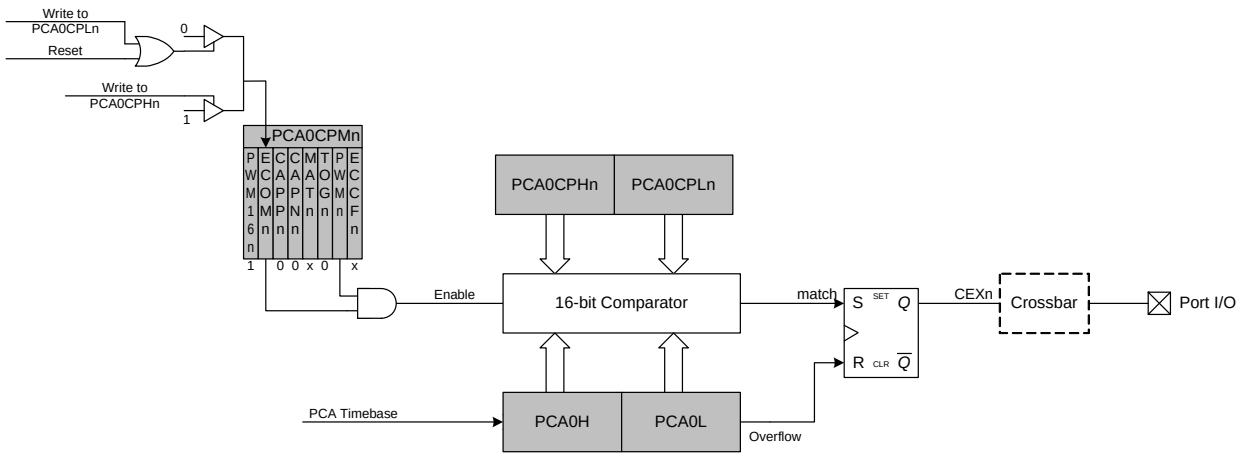


Figure 26.10. PCA 16-Bit PWM Mode

26.4. Watchdog Timer Mode

A programmable watchdog timer (WDT) function is available through the PCA Module 5. The WDT is used to generate a reset if the time between writes to the WDT update register (PCA0CPH5) exceed a specified limit. The WDT can be configured and enabled/disabled as needed by software.

With the WDTE bit set in the PCA0MD register, Module 5 operates as a watchdog timer (WDT). The Module 5 high byte is compared to the PCA counter high byte; the Module 5 low byte holds the offset to be used when WDT updates are performed. **The Watchdog Timer is enabled on reset. Writes to some PCA registers are restricted while the Watchdog Timer is enabled.** The WDT will generate a reset shortly after code begins execution. To avoid this reset, the WDT should be explicitly disabled (and optionally re-configured and re-enabled if it is used in the system).

26.4.1. Watchdog Timer Operation

While the WDT is enabled:

- PCA counter is forced on.
- Writes to PCA0L and PCA0H are not allowed.
- PCA clock source bits (CPS[2:0]) are frozen.
- PCA Idle control bit (CIDL) is frozen.
- Module 5 is forced into software timer mode.
- Writes to the Module 5 mode register (PCA0CPM5) are disabled.

While the WDT is enabled, writes to the CR bit will not change the PCA counter state; the counter will run until the WDT is disabled. The PCA counter run control bit (CR) will read zero if the WDT is enabled but user software has not enabled the PCA counter. If a match occurs between PCA0CPH5 and PCA0H while the WDT is enabled, a reset will be generated. To prevent a WDT reset, the WDT may be updated with a write of any value to PCA0CPH5. Upon a PCA0CPH5 write, PCA0H plus the offset held in PCA0CPL5 is loaded into PCA0CPH5 (See Figure 26.11).

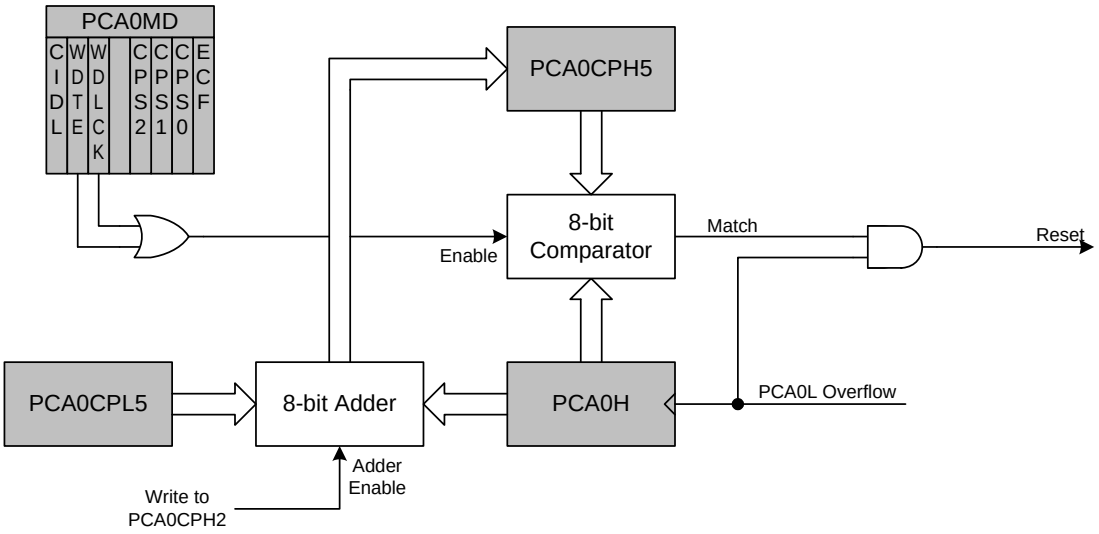


Figure 26.11. PCA Module 2 with Watchdog Timer Enabled

Note that the 8-bit offset held in PCA0CPH5 is compared to the upper byte of the 16-bit PCA counter. This offset value is the number of PCA0L overflows before a reset. Up to 256 PCA clocks may pass before the first PCA0L overflow occurs, depending on the value of the PCA0L when the update is performed. The total offset is then given (in PCA clocks) by Equation 26.5, where PCA0L is the value of the PCA0L register at the time of the update.

$$Offset = (256 \times PCA0CPL5) + (256 - PCA0L)$$

Equation 26.5. Watchdog Timer Offset in PCA Clocks

The WDT reset is generated when PCA0L overflows while there is a match between PCA0CPH5 and PCA0H. Software may force a WDT reset by writing a 1 to the CCF5 flag (PCA0CN.5) while the WDT is enabled.

26.4.2. Watchdog Timer Usage

To configure the WDT, perform the following tasks:

- Disable the WDT by writing a 0 to the WDTE bit.
- Select the desired PCA clock source (with the CPS[2:0] bits).
- Load PCA0CPL5 with the desired WDT update offset value.
- Configure the PCA Idle mode (set CIDL if the WDT should be suspended while the CPU is in Idle mode).
- Enable the WDT by setting the WDTE bit to 1.
- Reset the WDT timer by writing to PCA0CPH5.

The PCA clock source and Idle mode select cannot be changed while the WDT is enabled. The watchdog timer is enabled by setting the WDTE or WDLCK bits in the PCA0MD register. When WDLCK is set, the WDT cannot be disabled until the next system reset. If WDLCK is not set, the WDT is disabled by clearing the WDTE bit.

The WDT is enabled following any reset. The PCA0 counter clock defaults to the system clock divided by 12, PCA0L defaults to 0x00, and PCA0CPL5 defaults to 0x00. Using Equation 26.5, this results in a WDT timeout interval of 256 PCA clock cycles, or 3072 system clock cycles. Table 26.3 lists some example timeout intervals for typical system clocks.

Table 26.3. Watchdog Timer Timeout Intervals[1]

System Clock (Hz)	PCA0CPL5	Timeout Interval (ms)
24,000,000	255	32.8
24,000,000	128	16.5
24,000,000	32	4.2
3,000,000	255	262.1
3,000,000	128	132.1
3,000,000	32	33.8
187,500[2]	255	4194
187,500[2]	128	2114
187,500[2]	32	541

Notes:

1. Assumes SYSCLK/12 as the PCA clock source, and a PCA0L value of 0x00 at the update time.
2. Internal SYSCLK reset frequency = Internal Oscillator divided by 128.

26.5. Register Descriptions for PCA0

Following are detailed descriptions of the special function registers related to the operation of the PCA.

SFR Definition 26.1. PCA0CN: PCA Control

Bit	7	6	5	4	3	2	1	0
Name	CF	CR	CCF5	CCF4	CCF3	CCF2	CCF1	CCF0
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD8; Bit-Addressable; SFR Page = 0x00

Bit	Name	Function
7	CF	**PCA Counter/Timer Overflow Flag.** Set by hardware when the PCA Counter/Timer overflows from 0xFFFF to 0x0000. When the Counter/Timer Overflow (CF) interrupt is enabled, setting this bit causes the CPU to vector to the PCA interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.
6	CR	**PCA Counter/Timer Run Control.** This bit enables/disables the PCA Counter/Timer. 0: PCA Counter/Timer disabled. 1: PCA Counter/Timer enabled.
5	CCF5	**PCA Module 5 Capture/Compare Flag.** This bit is set by hardware when a match or capture occurs. When the CCF5 interrupt is enabled, setting this bit causes the CPU to vector to the PCA interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.
4	CCF4	**PCA Module 4 Capture/Compare Flag.** This bit is set by hardware when a match or capture occurs. When the CCF4 interrupt is enabled, setting this bit causes the CPU to vector to the PCA interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.
3	CCF3	**PCA Module 3 Capture/Compare Flag.** This bit is set by hardware when a match or capture occurs. When the CCF3 interrupt is enabled, setting this bit causes the CPU to vector to the PCA interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.
2	CCF2	**PCA Module 2 Capture/Compare Flag.** This bit is set by hardware when a match or capture occurs. When the CCF2 interrupt is enabled, setting this bit causes the CPU to vector to the PCA interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.
1	CCF1	**PCA Module 1 Capture/Compare Flag.** This bit is set by hardware when a match or capture occurs. When the CCF1 interrupt is enabled, setting this bit causes the CPU to vector to the PCA interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.
0	CCF0	**PCA Module 0 Capture/Compare Flag.** This bit is set by hardware when a match or capture occurs. When the CCF0 interrupt is enabled, setting this bit causes the CPU to vector to the PCA interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.

SFR Definition 26.2. PCA0MD: PCA Mode

Bit	7	6	5	4	3	2	1	0
Name	CIDL	WDTE	WDLCK		CPS[2:0]			ECF
Type	R/W	R/W	R/W	R	R/W	R/W	R/W	R/W
Reset	0	1	0	0	0	0	0	0

SFR Address = 0xD9; SFR Page = 0x00

Bit	Name	Function
7	CIDL	**PCA Counter/Timer Idle Control.** Specifies PCA behavior when CPU is in Idle Mode. 0: PCA continues to function normally while the system controller is in Idle Mode. 1: PCA operation is suspended while the system controller is in Idle Mode.
6	WDTE	**Watchdog Timer Enable** If this bit is set, PCA Module 5 is used as the watchdog timer. 0: Watchdog Timer disabled. 1: PCA Module 5 enabled as Watchdog Timer.
5	WDLCK	**Watchdog Timer Lock** This bit locks/unlocks the Watchdog Timer Enable. When WDLCK is set, the Watchdog Timer may not be disabled until the next system reset. 0: Watchdog Timer Enable unlocked. 1: Watchdog Timer Enable locked.
4	Unused	Read = 0b, Write = Don't care.
3:1	CPS[2:0]	**PCA Counter/Timer Pulse Select.** These bits select the timebase source for the PCA counter 000: System clock divided by 12 001: System clock divided by 4 010: Timer 0 overflow 011: High-to-low transitions on ECI (max rate = system clock divided by 4) 100: System clock 101: External clock divided by 8 (synchronized with the system clock) 11x: Reserved
0	ECF	**PCA Counter/Timer Overflow Interrupt Enable.** This bit sets the masking of the PCA Counter/Timer Overflow (CF) interrupt. 0: Disable the CF interrupt. 1: Enable a PCA Counter/Timer Overflow interrupt request when CF (PCA0CN.7) is set.
Note: When the WDTE bit is set to 1, the other bits in the PCA0MD register cannot be modified. To change the contents of the PCA0MD register, the Watchdog Timer must first be disabled.		

SFR Definition 26.3. PCA0PWM: PCA PWM Configuration

Bit	7	6	5	4	3	2	1	0
Name	ARSEL	ECOV	COVF				CLSEL[1:0]	
Type	R/W	R/W	R/W	R	R	R	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD9; SFR Page = 0x0F

Bit	Name	Function
7	ARSEL	**Auto-Reload Register Select.** This bit selects whether to read and write the normal PCA capture/compare registers (PCA0CPn), or the Auto-Reload registers at the same SFR addresses. This function is used to define the reload value for 9, 10, and 11-bit PWM modes. In all other modes, the Auto-Reload registers have no function. 0: Read/Write Capture/Compare Registers at PCA0CPHn and PCA0CPLn. 1: Read/Write Auto-Reload Registers at PCA0CPHn and PCA0CPLn.
6	ECOV	**Cycle Overflow Interrupt Enable.** This bit sets the masking of the Cycle Overflow Flag (COVF) interrupt. 0: COVF will not generate PCA interrupts. 1: A PCA interrupt will be generated when COVF is set.
5	COVF	**Cycle Overflow Flag.** This bit indicates an overflow of the 8th, 9th, 10th, or 11th bit of the main PCA counter (PCA0). The specific bit used for this flag depends on the setting of the Cycle Length Select bits. The bit can be set by hardware or software, but must be cleared by software. 0: No overflow has occurred since the last time this bit was cleared. 1: An overflow has occurred since the last time this bit was cleared.
4:2	Unused	Read = 000b; Write = Don't care.
1:0	CLSEL[1:0]	**Cycle Length Select.** When 16-bit PWM mode is not selected, these bits select the length of the PWM cycle, between 8, 9, 10, or 11 bits. This affects all channels configured for PWM which are not using 16-bit PWM mode. These bits are ignored for individual channels configured to16-bit PWM mode. 00: 8 bits. 01: 9 bits. 10: 10 bits. 11: 11 bits.

SFR Definition 26.4. PCA0CPMn: PCA Capture/Compare Mode

Bit	7	6	5	4	3	2	1	0
Name	PWM16n	ECOMn	CAPPn	CAPNn	MATn	TOGn	PWMn	ECCFn
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Addresses: PCA0CPM0 = 0xDA, PCA0CPM1 = 0xDB, PCA0CPM2 = 0xDC; PCA0CPM3 = 0xDD, PCA0CPM4 = 0xDE, PCA0CPM5 = 0xDF, SFR Page (all registers) = 0x00

Bit	Name	Function
7	PWM16n	**16-bit Pulse Width Modulation Enable.** This bit enables 16-bit mode when Pulse Width Modulation mode is enabled. 0: 8 to 11-bit PWM selected. 1: 16-bit PWM selected.
6	ECOMn	**Comparator Function Enable.** This bit enables the comparator function for PCA module n when set to 1.
5	CAPPn	**Capture Positive Function Enable.** This bit enables the positive edge capture for PCA module n when set to 1.
4	CAPNn	**Capture Negative Function Enable.** This bit enables the negative edge capture for PCA module n when set to 1.
3	MATn	**Match Function Enable.** This bit enables the match function for PCA module n when set to 1. When enabled, matches of the PCA counter with a module's capture/compare register cause the CCFn bit in PCA0MD register to be set to logic 1.
2	TOGn	**Toggle Function Enable.** This bit enables the toggle function for PCA module n when set to 1. When enabled, matches of the PCA counter with a module's capture/compare register cause the logic level on the CEXn pin to toggle. If the PWMn bit is also set to logic 1, the module operates in Frequency Output Mode.
1	PWMn	**Pulse Width Modulation Mode Enable.** This bit enables the PWM function for PCA module n when set to 1. When enabled, a pulse width modulated signal is output on the CEXn pin. 8 to 11-bit PWM is used if PWM16n is cleared; 16-bit mode is used if PWM16n is set to logic 1. If the TOGn bit is also set, the module operates in Frequency Output Mode.
0	ECCFn	**Capture/Compare Flag Interrupt Enable.** This bit sets the masking of the Capture/Compare Flag (CCFn) interrupt. 0: Disable CCFn interrupts. 1: Enable a Capture/Compare Flag interrupt request when CCFn is set.
Note: When the WDTE bit is set to 1, the PCA0CPM5 register cannot be modified, and module 5 acts as the watchdog timer. To change the contents of the PCA0CPM5 register or the function of module 5, the Watchdog Timer must be disabled.		

SFR Definition 26.5. PCA0L: PCA Counter/Timer Low Byte

Bit	7	6	5	4	3	2	1	0
Name	PCA0[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xF9; SFR Page = 0x00

Bit	Name	Function
7:0	PCA0[7:0]	**PCA Counter/Timer Low Byte.** The PCA0L register holds the low byte (LSB) of the 16-bit PCA Counter/Timer.

Note: When the WDTE bit is set to 1, the PCA0L register cannot be modified by software. To change the contents of the PCA0L register, the Watchdog Timer must first be disabled.

SFR Definition 26.6. PCA0H: PCA Counter/Timer High Byte

Bit	7	6	5	4	3	2	1	0
Name	PCA0[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xFA; SFR Page = 0x00

Bit	Name	Function
7:0	PCA0[15:8]	**PCA Counter/Timer High Byte.** The PCA0H register holds the high byte (MSB) of the 16-bit PCA Counter/Timer. Reads of this register will read the contents of a “snapshot” register, whose contents are updated only when the contents of PCA0L are read (see Section 26.1).

Note: When the WDTE bit is set to 1, the PCA0H register cannot be modified by software. To change the contents of the PCA0H register, the Watchdog Timer must first be disabled.

SFR Definition 26.7. PCA0CPLn: PCA Capture Module Low Byte

Bit	7	6	5	4	3	2	1	0
Name	PCA0CPn[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Addresses: PCA0CPL0 = 0xFB, PCA0CPL1 = 0xE9, PCA0CPL2 = 0xEB, PCA0CPL3 = 0xED, PCA0CPL4 = 0xFD, PCA0CPL5 = 0xCE; SFR Page (all registers) = 0x00

Bit	Name	Function
7:0	PCA0CPn[7:0]	**PCA Capture Module Low Byte.** The PCA0CPLn register holds the low byte (LSB) of the 16-bit capture module n. This register address also allows access to the low byte of the corresponding PCA channel's auto-reload value for 9, 10, or 11-bit PWM mode. The ARSEL bit in register PCA0PWM controls which register is accessed.
Note: A write to this register will clear the module's ECOMn bit to a 0.		

SFR Definition 26.8. PCA0CPHn: PCA Capture Module High Byte

Bit	7	6	5	4	3	2	1	0
Name	PCA0CPn[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Addresses: PCA0CPH0 = 0xFC, PCA0CPH1 = 0xEA, PCA0CPH2 = 0xEC, PCA0CPH3 = 0xEE, PCA0CPH4 = 0xFE, PCA0CPH5 = 0xCF; SFR Page (all registers) = 0x00

Bit	Name	Function
7:0	PCA0CPn[15:8]	**PCA Capture Module High Byte.** The PCA0CPHn register holds the high byte (MSB) of the 16-bit capture module n. This register address also allows access to the high byte of the corresponding PCA channel's auto-reload value for 9, 10, or 11-bit PWM mode. The ARSEL bit in register PCA0PWM controls which register is accessed.
Note: A write to this register will set the module's ECOMn bit to a 1.		

27. C2 Interface

C8051F55x/56x/57x devices include an on-chip Silicon Labs 2-Wire (C2) debug interface to allow Flash programming and in-system debugging with the production part installed in the end application. The C2 interface uses a clock signal (C2CK) and a bi-directional C2 data signal (C2D) to transfer information between the device and a host system. See the C2 Interface Specification for details on the C2 protocol.

27.1. C2 Interface Registers

The following describes the C2 registers necessary to perform Flash programming through the C2 interface. All C2 registers are accessed through the C2 interface as described in the C2 Interface Specification.

C2 Register Definition 27.1. C2ADD: C2 Address

Bit	7	6	5	4	3	2	1	0
Name	C2ADD[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

Bit	Name	Function	
7:0	C2ADD[7:0]	**C2 Address.** The C2ADD register is accessed via the C2 interface to select the target Data register for C2 Data Read and Data Write commands.	
		Address	**Description**
		0x00	Selects the Device ID register for Data Read instructions
		0x01	Selects the Revision ID register for Data Read instructions
		0x02	Selects the C2 Flash Programming Control register for Data Read/Write instructions
		0xB4	Selects the C2 Flash Programming Data register for Data Read/Write instructions

C2 Register Definition 27.2. DEVICEID: C2 Device ID

Bit	7	6	5	4	3	2	1	0
Name	DEVICEID[7:0]							
Type	R/W							
Reset	0	0	0	1	0	1	0	0

C2 Address = 0xFD; SFR Address = 0xFD; SFR Page = 0xF

Bit	Name	Function
7:0	DEVICEID[7:0]	**Device ID.** This read-only register returns the 8-bit device ID: 0x22 (C8051F55x/56x/57x).

C2 Register Definition 27.3. REVID: C2 Revision ID

Bit	7	6	5	4	3	2	1	0
Name	REVID[7:0]							
Type	R/W							
Reset	Varies	Varies	Varies	Varies	Varies	Varies	Varies	Varies

C2 Address = 0xFE; SFR Address = 0xFE; SFR Page = 0xF

Bit	Name	Function
7:0	REVID[7:0]	**Revision ID.** This read-only register returns the 8-bit revision ID. For example: 0x00 = Revision A.

C2 Register Definition 27.4. FPCTL: C2 Flash Programming Control

Bit	7	6	5	4	3	2	1	0
Name	FPCTL[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

C2 Address: 0x02

Bit	Name	Function
7:0	FPCTL[7:0]	**Flash Programming Control Register.** This register is used to enable Flash programming via the C2 interface. To enable C2 Flash programming, the following codes must be written in order: 0x02, 0x01. Note that once C2 Flash programming is enabled, a system reset must be issued to resume normal operation.

C2 Register Definition 27.5. FPDAT: C2 Flash Programming Data

Bit	7	6	5	4	3	2	1	0
Name	FPDAT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

C2 Address: 0xB4

Bit	Name	Function	
7:0	FPDAT[7:0]	**C2 Flash Programming Data Register.** This register is used to pass Flash commands, addresses, and data during C2 Flash accesses. Valid commands are listed below.	
		Code	**Command**
		0x06	Flash Block Read
		0x07	Flash Block Write
		0x08	Flash Page Erase
		0x03	Device Erase

27.2. C2 Pin Sharing

The C2 protocol allows the C2 pins to be shared with user functions so that in-system debugging and Flash programming may be performed. This is possible because C2 communication is typically performed when the device is in the halt state, where all on-chip peripherals and user software are stalled. In this halted state, the C2 interface can safely ‘borrow’ the C2CK (RST) and C2D pins. In most applications, external resistors are required to isolate C2 interface traffic from the user application. A typical isolation configuration is shown in Figure 27.1.

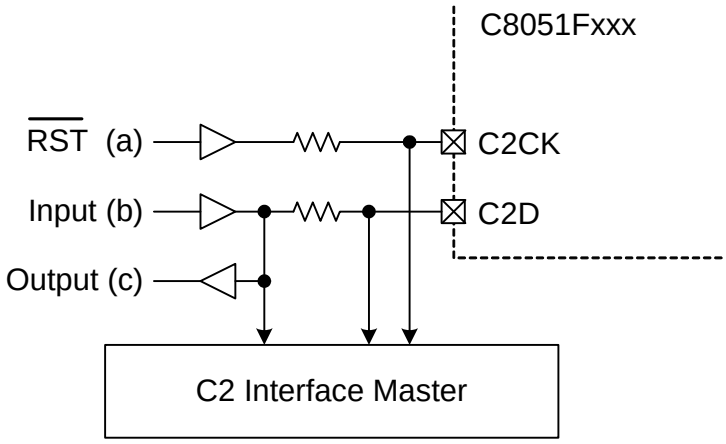


Figure 27.1. Typical C2 Pin Sharing

The configuration in Figure 27.1 assumes the following:

1. The user input (b) cannot change state while the target device is halted.
2. The RST pin on the target device is used as an input only.

Additional resistors may be necessary depending on the specific application.

DOCUMENT CHANGE LIST

Revision 0.5 to Revision 1.0

- Updated “2. Ordering Information” to include -A (Automotive) devices and automotive qualification information.
- Updated Figure 4.8 on page 35.
- Updated supply current related specifications throughout “5. Electrical Characteristics” .
- Updated SFR Definition 7.1 to change VREF high setting to 2.20 V from 2.25 V.
- Updated Figure 8.1 to indicate that Comparators are powered from V_{IO} and not V_{DDA}.
- Updated the Gain Table in “6.3.1. Calculating the Gain Value” to fix the ADC0GNH Value in the last row.
- Updated Table 10.1 with correct timing for all branch instructions, MOVC, and CPL A.
- Updated “14.2. Non-volatile Data Storage” to clarify behavior of 8-bit MOVX instructions and when writing/erasing Flash.
- Updated SFR Definition 14.3 (FLSCL) to include FLEWT bit definition. This bit must be set before writing or erasing Flash. Also updated Table 5.5 to reflect new Flash Write and Erase timing.
- Updated “16.7. Flash Error Reset” with an additional cause of a Flash Error reset.
- Updated “19.1.3. Interfacing Port I/O in a Multi-Voltage System” to remove note regarding interfacing to voltages above VIO.
- Updated “22. SMBus” to remove all hardware ACK features, including SMB0ADM and SMB0ADR SFRs.
- Updated SFR Definition 23.1 (SCON0) to correct SFR Page to 0x00 from All Pages.
- All items from the C8051F55x-F56x-57x Errata dated November 5th, 2009 are incorporated into this data sheet.

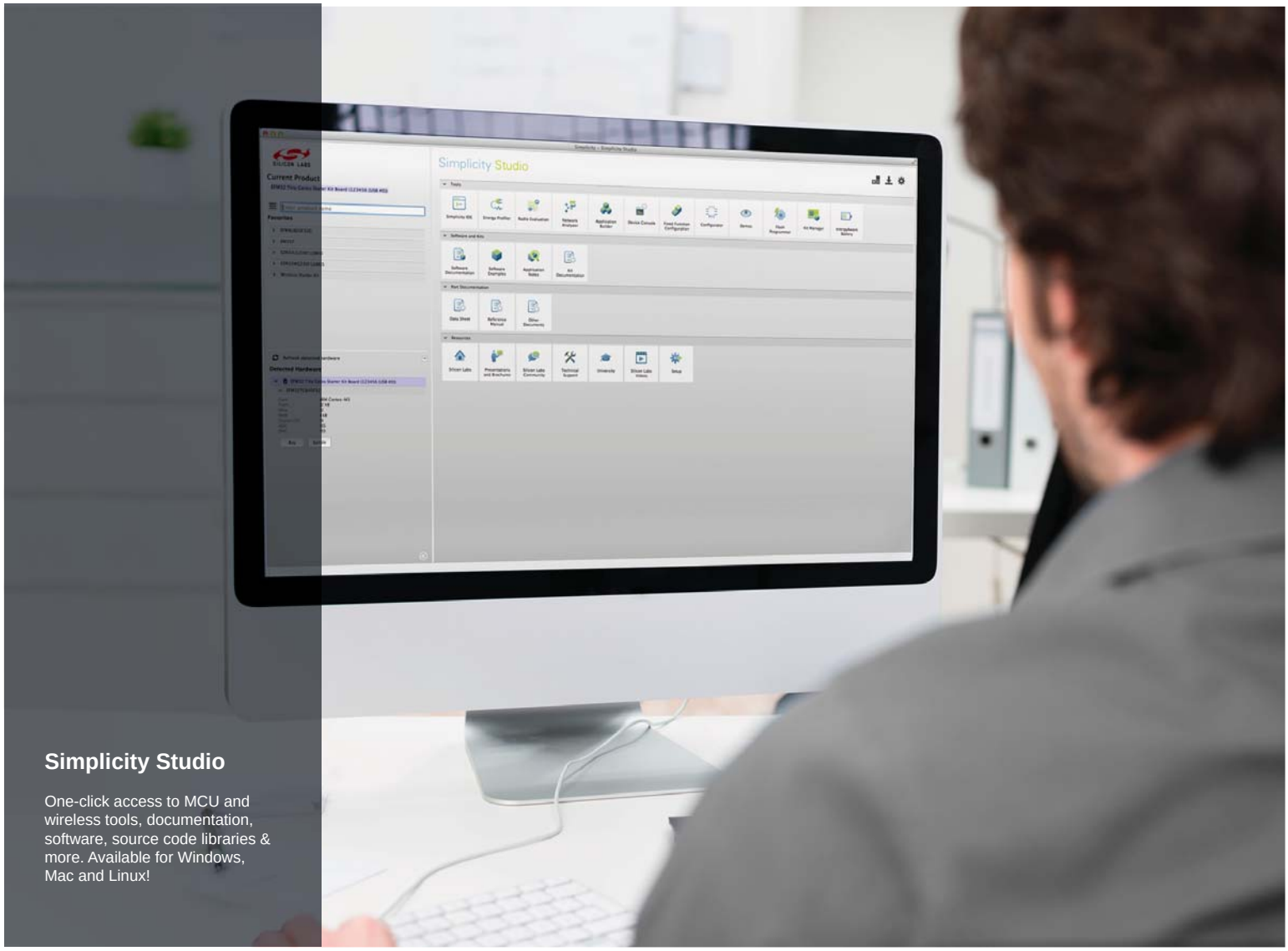
Revision 1.0 to Revision 1.1

- Updated “1. System Overview” with a voltage range specification for the internal oscillator.
- Updated Table 5.6, “Internal High-Frequency Oscillator Electrical Characteristics,” on page 42 with new conditions for the internal oscillator accuracy. The internal oscillator accuracy is dependent on the operating voltage range.
- Updated “5. Electrical Characteristics” to remove the internal oscillator curve across temperature diagram.
- Updated Figure 6.4 on Page 51 with new timing diagram when using CNVSTR pin.
- Updated SFR Definition 7.1 (REF0CN) with oscillator suspend requirement for ZTCEN.
- Fixed incorrect cross references in “8. Comparators” .
- Updated SFR Definition 9.1 (REG0CN) with a new definition for Bit 6. The bit 6 reset value is 1b and must be written to 1b.
- Update “15.3. Suspend Mode” with note regarding ZTCEN.
- Added Port 2 Event and Port 3 Events to wake-up sources in “18.2.1. Internal Oscillator Suspend Mode”
- Updated “20. Local Interconnect Network (LIN0)” with a voltage range specification for the internal oscillator.
- Updated LIN Register Definitions 20.9 and 20.10 with correct reset values.
- Updated “21. Controller Area Network (CAN0)” with a voltage range specification for the internal oscillator.
- Updated C2 Register Definitions 27.2 and 27.3 with correct C2 and SFR Addresses.

Revision 1.1 to Revision 1.2

- Updated the note in “Power-Fail Reset/VDD Monitor” on page 140 to use a larger font.
- Added the note regarding the voltage regulator and VDD monitor in the high setting from “Power-Fail Reset/VDD Monitor” on page 140 to “Voltage Regulator (REG0)” on page 79 and “V_{DD} Maintenance and the V_{DD} monitor” on page 129.
- Updated the steps in “V_{DD} Maintenance and the V_{DD} monitor” on page 129 to mention using the VDD monitor in the high setting during flash write/erase operations.
- Updated the SUSPEND bit description in OSCICN (SFR Definition 18.2) to mention that firmware must set the ZTCEN bit in REF0CN (SFR Definition 7.1) before entering suspend.
- Added a note to the IFRDY flag in the OSCICN register (SFR Definition 18.2) that the flag may not accurately reflect the state of the oscillator.
- Added VREGIN Ramp Time for Power On spec to Table 5.4, “Reset Electrical Characteristics,” on page 41.
- Updated “V_{DD} Maintenance and the V_{DD} monitor” on page 129 to refer to V_{REGIN} ramp time instead of V_{DD} ramp time.
- Added a note regarding programming at cold temperatures on –I devices to “Programming The Flash Memory” on page 124 and added Temperature during Programming Operations specification to Table 5.5, “Flash Electrical Characteristics,” on page 41.
- Added a note regarding P0.0/VREF when VDD is used as the reference to Table 19.1, “Port I/O Assignment for Analog Functions,” on page 171 and to the description of the REFSL bit in REF0CN (SFR Definition 7.1).
- Added a note regarding a potential unknown state on GPIO during power up if VIO ramps significantly before VDD to “Port Input/Output” on page 169 and “Reset Sources” on page 138.
- Added steps to set the FLEWT bit in the FLSCL register (SFR Definition 14.3) in the flash write/erase procedures in “Flash Erase Procedure” on page 125, “Flash Write Procedure” on page 125, and “Flash Write Optimization” on page 126.
- Added a note regarding fast changes on VDD causing the V_{DD} Monitor to trigger to “Power-Fail Reset/VDD Monitor” on page 140.
- Added notes regarding UART TX and RX behavior in “Data Transmission” on page 238, “Data Reception” on page 238, and the THRE0 description in the SCON0 register (SFR Definition 23.1).
- Added a note regarding an issue with /RST low time on some older devices to “16.1. Power-On Reset” .

NOTES:



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